

AQ-T256

Transformer protection device

Instruction manual



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Disclaimer

Please read these instructions carefully before using the equipment or taking any other actions with respect to the equipment. Only trained and qualified persons are allowed to perform installation, operation, service or maintenance of the equipment. Such qualified persons have the responsibility to take all appropriate measures, including e.g. use of authentication, encryption, anti-virus programs, safe switching programs etc. necessary to ensure a safe and secure environment and usability of the equipment. The warranty granted to the equipment remains in force only provided that the instructions contained in this document have been strictly complied with.

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1 Document information

1.1 Version 2 revision notes

Table. 1.1 - 1. Version 2 revision notes

Revision	2.00
Date	6.6.2019
Changes	<ul style="list-style-type: none"> - New more consistent look. - Improved descriptions generally in many chapters. - Improved readability of a lot of drawings and images. - Updated protection functions included in every manual. - Every protection relay type now has connection drawing, application example drawing with function block diagram and application example with wiring. - Added current measurement side selection description to functions with such feature. - Added General-menu description.
Revision	2.01
Date	6.11.2019
Changes	<ul style="list-style-type: none"> - Added description for LED test and button test. - Added display sleep timer description. - Complete rewrite of every chapter. - Improvements to many drawings and formula images. - Order codes revised. - Added double ST 100 Mbps Ethernet communication module and Double RJ45 10/100 Mbps Ethernet communication module descriptions
Revision	2.02
Date	7.7.2020
Changes	- A number of image descriptions improved.
Revision	2.03
Date	27.8.2020

Changes	<ul style="list-style-type: none"> - Terminology consistency improved (e.g. binary inputs are now always called digital inputs). - Tech data modified to be more informative about what type of measurement inputs are used (phase currents/voltages, residual currents/voltages), what component of that measurement is available (RMS, TRMS, peak-to-peak) and possible calculated measurement values (powers, impedances, angles etc.). - Tech data updated: non-directional overcurrent - Tech data updated: non-directional earthfault - Tech data updated: current unbalance - Tech data updated: transformer differential - Improvements to many drawings and formula images. - Added 6th harmonic to harmonic overcurrent protection function. - Changed disturbance recorder maximum digital channel amount from 32 to 95. - Added residual current coarse and fine measurement data to disturbance recorder description. - Event read mode parameter added to Modbus description. - HSO1 and HSO2 connection swapped in arc protection card (was way wrong before). - Updated I01 and I02 rated current range. - Added inches to Dimensions and installation chapter. - Added raising frames, wall mounting bracket, combiflex frame to order code. - Added logical input and logical output function descriptions. - Additions to Abbreviations chapter. - Added button test description to Local panel structure chapter. - Added note to Configuring user levels and passwords chapter that AQ-250 frame units generate a time-stamped event from locking and unlocking user levels. - Added note to Configuring user levels and passwords chapter that user level with a password automatically locks itself after 30 minutes of inactivity. - Added more "Tripped stage" indications and fault types to Measurement value recorder function. - Updated: Digital input activation and release threshold setting ranges and added drop-off delay setting. - Added sample rate to voltage and current measurement tech data.
Revision	2.04
Date	8.6.2021
Changes	<ul style="list-style-type: none"> - Increased the consistency in terminology - Various image upgrades - Visual update to the order codes
Revision	2.05
Date	22.6.2021
Changes	<ul style="list-style-type: none"> - Fixed phase current measurement continuous thermal withstand from 30A to 20A. - Fixed lots of timing errors written to registers table. "Prefault" is -200 ms from Start event, "Pretrigger" is -20 ms from trip (or start if fault doesn't progress to trip), "Fault" is start (or trip if fault doesn't progress to trip). - Added event history technical data
Revision	2.06
Date	21.6.2022

Changes	<ul style="list-style-type: none"> - Improved descriptions generally in many chapters. - Improved readability of a lot of drawings and images. - Order codes have been revised. - Added LN mode parameters to all functions (On, Blocked, Test, Test/Blocked, Off). - Added color themes parameter description. - Improved color sleep mode description. - Improved alarm function color behavior description and images. - Added operation time with different measurement values vs setting ratio in instant operation mode to non-directional overcurrent function description. - Fixed bias calculation formula for restricted earth fault function. Was correctly in the code, just written wrong in the manual. - Added power measurement side selection to power functions. - Added 30 s pretriggering time for disturbance recorder (AQ-250 devices only). - Added new trip detections and fault types to measurement value recorder. - Added user description parameter descriptions for digital inputs, digital outputs, logical inputs, logical outputs and GOOSE inputs. - Arc point sensor HSO1 and HSO2 position fixed. - Added spare part codes and compatibilities to option cards.
Revision	2.07
Date	7.7.2022
Changes	<ul style="list-style-type: none"> - Fixed number of logical inputs. - Added common signals function description. - Added PTP time synchronization description. - Added Modbus Gateway description.
Revision	2.08
Date	8.9.2022
Changes	<ul style="list-style-type: none"> - Added stage forcing parameter to function descriptions. - Fixes to "Real time signals to comm" description. - Added "Ethernet port" parameter description to IEC61850, IEC104 and Modbus TCP descriptions. - Removed "Measurement update interval" settings from Modbus description. No longer in use. - Renamed "System integration" chapter to "Communication" and restructured the chapters to be closer to how they are in the menus. - Added "Event logger" chapter. - Added more descriptions to new IEC 61850 ed2 GOOSE parameters. - Added "Condition monitoring / CB wear" description to object description. - Added "User button" description. - Added logical device and logical node mode descriptions.
Revision	2.09
Date	14.3.2023
Changes	<ul style="list-style-type: none"> - Updated the Arcteq logo on the cover page and refined the manual's visual look. - Added the "Safety information" chapter and changed the notes throughout the document accordingly. - Changed the "IED user interface" chapter's title to "Device user interface" and replaced all 'IED' terms with 'device' or 'unit'. - Updated the rated values for the change-over CPU digital outputs in "Technical data". - Added double ethernet port configuration parameters to "Connections menu" chapter. - Added event overload detection description to "Event logger" chapter.

Revision	2.10
Date	19.6.2023
Changes	- Updated order codes.
Revision	2.11
Date	29.11.2023
Changes	<ul style="list-style-type: none"> - Added the 5 ms update time in the measurement chapters. - Added spring lock cage options for connectors. See the "Ordering information" chapter. - Updated the contact address for technical support in the "Contact and reference information" chapter. - Circuit breaker wear is not integrated to the objects.
Revision	2.12
Date	January 2024
Changes	- Added Chinese and Kazakh languages as language options in " General menu ".
Revision	2.13
Date	September 2024
Changes	<ul style="list-style-type: none"> - Added 5th harmonic maximum uptime parameter to transformer differential protection function. - Corrected the number of devices that fit a 19 in rack in the "Dimensions and installation" chapter.
Revision	2.14
Date	June 2025
Changes	<ul style="list-style-type: none"> - Increased phase current measurement range. See the current measurement section in the Technical data chapter. - Added clarification that transformer differential protection can be used for motor differential protection. - Updated the product and packaging weights. - Added new "User access control" description. - Added circuit breaker wear to "Object control and monitoring" description. - Added "High-speed and high-current output" option card description. - Added "Milliampere input module (4x mA in & 1x mA out)" option card description. - Added "Double SFP Ethernet & IRIG-B communication module" option card description. - Order code table updated.
Revision	2.15
Date	January 2026
Changes	<ul style="list-style-type: none"> - Updated the Connections images. - Updated the make-and-carry of the Point sensor arc protection module.
Revision	2.16
Date	June 2026

Changes	<ul style="list-style-type: none"> - General improvements to descriptions. - IEC61850 integration time description improved. - Added CBW abrasion (SCBR) calculation description. - Added measurements to Programmable stages. - Added OPCUA communication protocol. - Added Cold load pick-up.
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1.2 Version 1 revision notes

Table. 1.2 - 2. Version 1 revision notes

Revision	1.00
Date	13.4.2016
Changes	<ul style="list-style-type: none"> • The first revision for AQ-T256 and T257.
Revision	1.01
Date	10.2.2017
Changes	<ul style="list-style-type: none"> • Added the programmable stage description. • Order code updated.
Revision	1.02
Date	9.1.2018
Changes	<ul style="list-style-type: none"> • Measurement value recorder description added. • ZCT connection added to the current measurement description. • Internal harmonics blocking added to the I> and IO> function descriptions. • Non-standard delay curves added. • Event lists revised on several functions. • RTD & mA card description improved. • Ring-lug CT card option description added. • New U> and U< function measurement modes documented. • Order code revised.
Revision	1.03
Date	14.8.2018
Changes	<ul style="list-style-type: none"> • Added the mA output option card description and updated the order code. • Added the HMI display technical data.

1.3 Safety information

This document contains important instructions that should be saved for future use. Read the document carefully before installing, operating, servicing, or maintaining this equipment. Please read and follow all the instructions carefully to prevent accidents, injury and damage to property.

Additionally, this document may contain four (4) types of special messages to call the reader's attention to useful information as follows:

**NOTICE!**

"Notice" messages indicate relevant factors and conditions to the concept discussed in the text, as well as to other relevant advice.

**CAUTION!**

"Caution" messages indicate a potentially hazardous situation which, if not avoided, **could** result in minor or moderate personal injury, in equipment/property damage, or software corruption.

**WARNING!**

"Warning" messages indicate a potentially hazardous situation which, if not avoided, **could** result in death or serious personal injury as well as serious damage to equipment/property.

**DANGER!**

"Danger" messages indicate an imminently hazardous situation which, if not avoided, **will** result in death or serious personal injury.

These symbols are added throughout the document to ensure all users' personal safety and to avoid unintentional damage to the equipment or connected devices.

Please note that although these warnings relate to direct damage to personnel and/or equipment, it should be understood that operating damaged equipment may also lead to further, indirect damage to personnel and/or equipment. Therefore, we expect any user to fully comply with these special messages.

1.4 Abbreviations

AI	–	Analog input
AR	–	Auto-recloser
ASDU	–	Application service data unit
AVR	–	Automatic voltage regulator
BCD	–	Binary-coded decimal
CB	–	Circuit breaker
CBFP	–	Circuit breaker failure protection
CLPU	–	Cold load pick-up
CPU	–	Central processing unit
CT	–	Current transformer
CTM	–	Current transformer module
CTS	–	Current transformer supervision
DG	–	Distributed generation
DHCP	–	Dynamic Host Configuration Protocol
DI	–	Digital input
DO	–	Digital output
DOL	–	Direct-on-line
DR	–	Disturbance recorder
DT	–	Definite time
FF	–	Fundamental frequency
FFT	–	Fast Fourier transform
FTP	–	File Transfer Protocol
GI	–	General interrogation
HMI	–	Human-machine interface
HR	–	Holding register
HV	–	High voltage
HW	–	Hardware
IDMT	–	Inverse definite minimum time
IGBT	–	Insulated-gate bipolar transistor

I/O – Input and output

IRIG-B – Inter-range instruction group, timecode B

LCD – Liquid-crystal display

LED – Light emitting diode

LV – Low voltage

NC – Normally closed

NO – Normally open

NTP – Network Time Protocol

RMS – Root mean square

RSTP – Rapid Spanning Tree Protocol

RTD – Resistance temperature detector

RTU – Remote terminal unit

SCADA – Supervisory control and data acquisition

SG – Setting group

SOTF – Switch-on-to-fault

SW – Software

THD – Total harmonic distortion

TRMS – True root mean square

VT – Voltage transformer

VTM – Voltage transformer module

VTS – Voltage transformer supervision

2 General

The AQ-T256 transformer protection device is a member of the AQ 250 product line. The hardware and software are modular: the hardware modules are assembled and configured according to the application's I/O requirements and the software determines the available functions. This manual describes the specific application of the AQ-T256 transformer protection device. For other AQ 200 and AQ 250 series products please consult their respective device manuals.

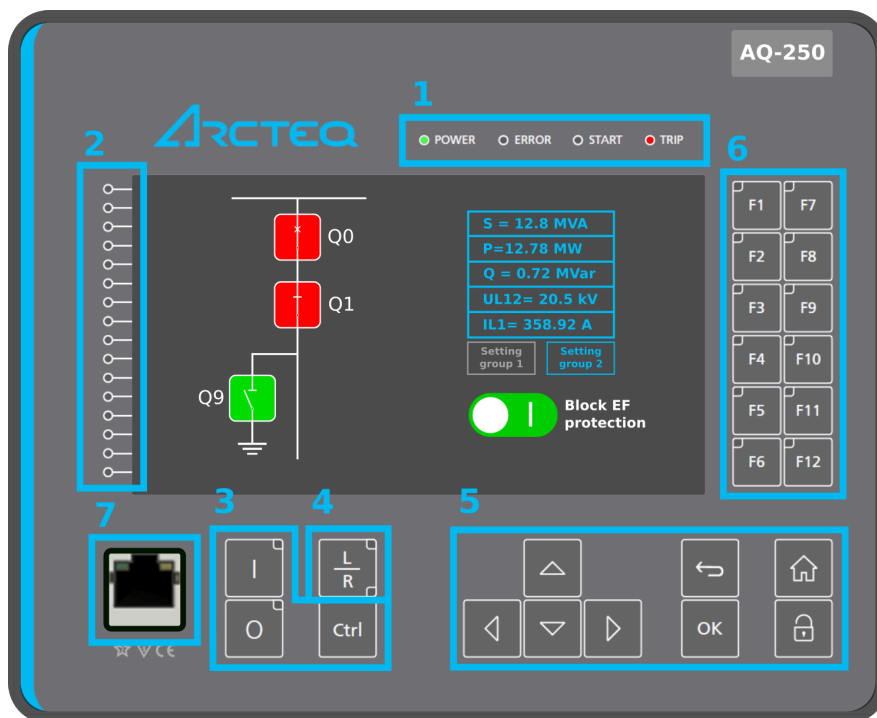
AQ-T256 is a transformer protection device with a sophisticated and easy-to-use differential protection function. The AQ-T256 transformer protection device provides both low-side and high-side overcurrent, earth fault, negative sequence and two independent restricted earth fault instances. There are up to ten (10) option card slots available for additional I/O or communication cards for more comprehensive monitoring and control applications. AQ-T256 communicates using various protocols including the IEC 61850 substation communication standard.

3 Device user interface

3.1 Local panel structure

The front panel of AQ-250 series devices have multiple LEDs, control buttons and a local RJ-45 Ethernet port for configuration. Each unit is also equipped with an RS-485 serial interface and an RJ-45 Ethernet interface on the back of the device.

Figure. 3.1 - 1. Local panel structure.



1. Four (4) default LEDs: "Power", "Error", "Start" (configurable) and "Trip" (configurable).
2. Sixteen (16) freely configurable LEDs (red, orange, green) with programmable legend texts.
3. Three (3) object control buttons: Choose the controllable object with the Ctrl button and control the breaker or other object with the I and the O buttons.
4. The L/R button switches between the local and the remote control modes.
5. Eight (8) buttons for device local programming: the four navigation arrows, the Back and the OK buttons, the Home and the password activation buttons).
6. Twelve (12) freely configurable function buttons (F1...F12). Each button has a freely configurable LED (red, orange, green).
7. One (1) RJ-45 Ethernet port for device configuration.

When the unit is powered on, the green "Power" LED is lit. When the red "Error" LED is lit, the device has an internal (hardware or software) error that affects the operation of the unit. The activation of the yellow "Start" LED and the red "Trip" LED are based on the setting the user has put in place in the software.

The sixteen freely configurable LEDs are located on the left side of the display. Their activation and color (green, orange, red) are based on the settings the user has put in place in the software.

The view in the screen is freely configurable. Virtual switches and buttons can be added which can be used to change the setting groups or control the device's general logic locally or remotely. The status of the object (circuit breaker, disconnecter) can be displayed on the screen. All measured and calculated values regardless of the magnitude category (current, voltage, power, energy, frequency, etc.) can be shown on the screen.

Holding the I (object control) button down for five seconds brings up the button test menu. It displays all the physical buttons on the front panel. Pressing any of the listed buttons marks them as tested. When all buttons are marked as having been tested, the device will return back to the default view.

4 Functions

4.1 Functions included in AQ-T256

The AQ-T256 transformer protection device includes the following functions as well as the number of stages in those functions.

Table. 4.1 - 3. Protection functions of AQ-T256.

Name (number of stages)	IEC	ANSI	Description
NOC (4)	I> I>> I>>> I>>>>	50/51	Non-directional overcurrent protection
NEF (4)	I0> I0>> I0>>> I0>>>>	50N/51N	Non-directional earth fault protection
CUB (4)	I2> I2>> I2>>> I2>>>>	46/46R/46L	Negative sequence overcurrent/ phase current reversal/ current unbalance protection
HOC (4)	Ih> Ih>> Ih>>> Ih>>>>	50H/51H/ 68H	Harmonic overcurrent protection
CBFP (1)	CBFP	50BF/52BF	Circuit breaker failure protection
TRF	-	-	Transformer status monitoring
DIF (1)	I _{db} >/I _{di} >/I _{dHV} >/I _{dLV} >	87T/87M/ 87G/87N	Generator/ motor / transformer differential protection with integrated restricted earth fault protection
TOLT (1)	TT>	49T	Transformer thermal overload protection
RTD (1...16)	-	-	RTD alarms (Resistance temperature detector)
PGS (1)	PGx>/<	99	Programmable stage
ARC (1)	I _{Arc} >/I _{0Arc} >	50Arc/ 50NArc	Arc fault protection (optional)

Table. 4.1 - 4. Control functions of AQ-T256.

Name	IEC	ANSI	Description
SGS	-	-	Setting group selection (8 setting groups available)

Name	IEC	ANSI	Description
OBJ	-	-	Object control and monitoring (10 objects available)
CIN	-	-	Indicator object monitoring (10 objects available)
CLPU	CLPU	-	Cold load pick-up
SOTF	SOTF	-	Switch-on-to-fault

Table. 4.1 - 5. Monitoring functions of AQ-T256.

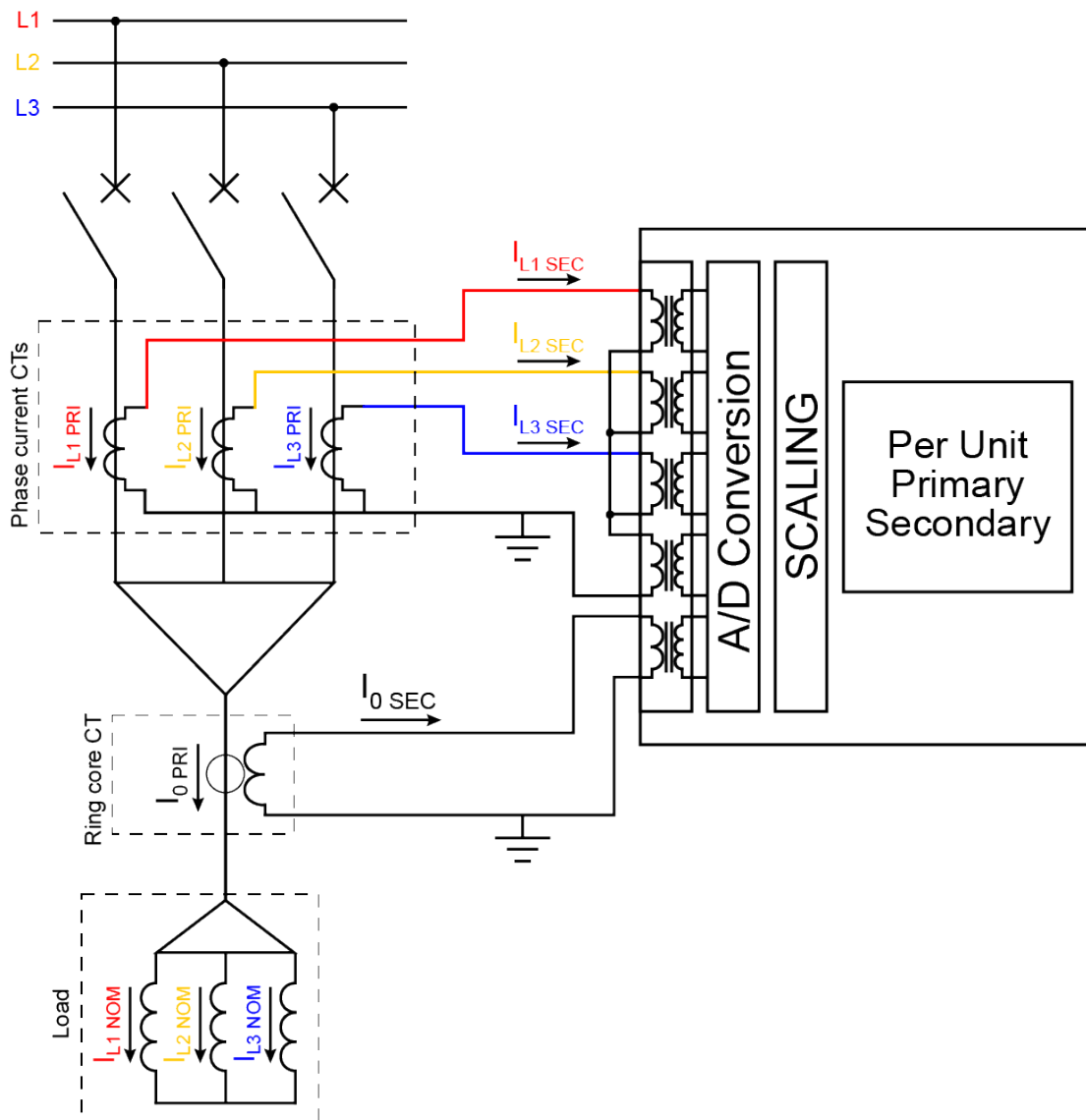
Name	IEC	ANSI	Description
CTS (2)	-	-	Current transformer supervision
DR	-	-	Disturbance recorder
CBW	-	-	Circuit breaker wear monitor
THD	-	-	Total harmonic distortion
RHC	-	-	Running hour counter
MREC	-	-	Measurement recorder
VREC	-	-	Fault register

4.2 Measurements

4.2.1 Current measurement and scaling in differential applications

The current measurement module (CT module, or CTM) is used for measuring the currents from current transformers. The current measurements are updated every 5 milliseconds. The measured values are processed into the measurement database and they are used by measurement and protection functions. It is essential to understand the concept of current measurements to be able to get correct measurements.

Figure. 4.2.1 - 2. Current measurement terminology.



PRI: The primary current, i.e. the current which flows in the primary circuit and through the primary side of the current transformer.

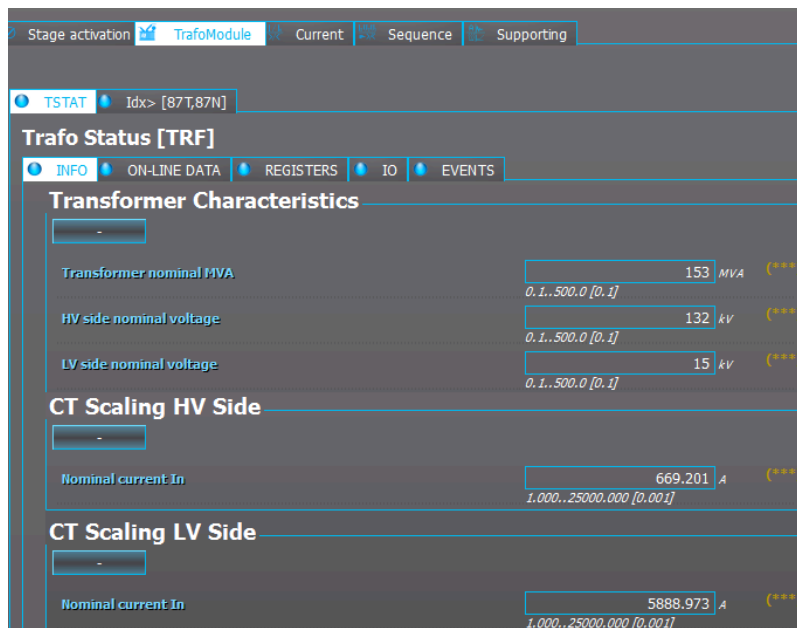
SEC: The secondary current, i.e. the current which the current transformer transforms according to its ratios. This current is measured by the device.

NOM: The nominal primary current of the protected transformer. The nominal current on the HV side differs from that on the LV side according to the transformer voltage ratio. The nominal current is calculated based on the transformer's MVA and the nominal voltage on each winding.

For the measurements to be correct the user needs to ensure that the measurement signals are connected to the correct inputs, that the current direction is connected correctly, and that the scaling is set correctly.

The device calculates the scaling factors based on the set values of the CT primary, the CT secondary and the nominal current. The device measures the secondary current, the current output from the current transformer installed into application's primary circuit. The rated primary and secondary currents of the CT need to be set for the device to "know" the primary and per-unit values. In power transformers, the protected unit's nominal current in both windings is calculated based on the given nominal power (MVA) and the nominal voltage. The settings can only give the apparatus nominal in p.u. (per-unit) when the nominal current is known. Also, knowing what the transformer's nominal current is makes the unit protection much easier and more straightforward to configure. In modern protection devices this scaling calculation is done internally after the current transformer's primary current, secondary current and machine nominal current are set.

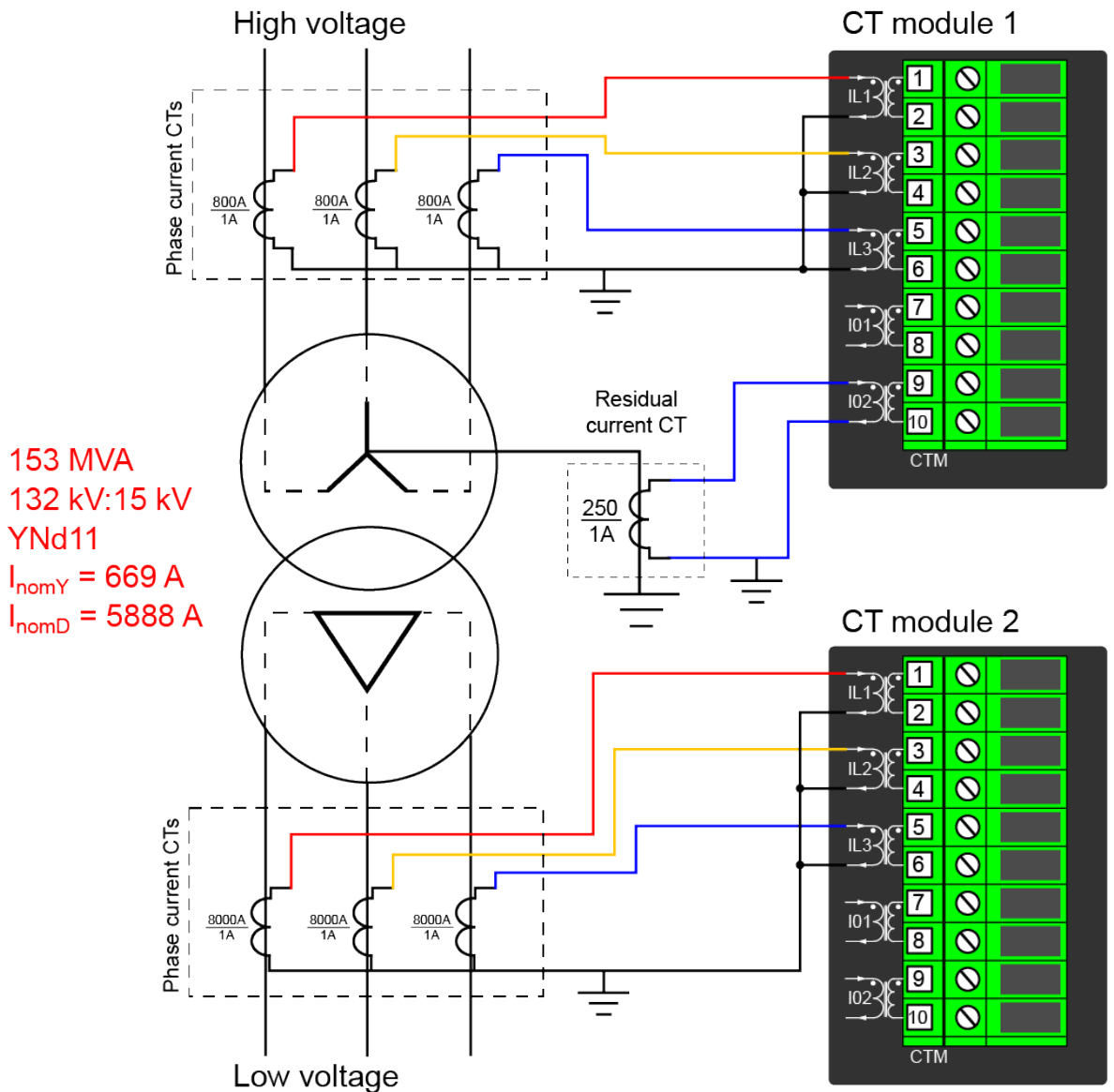
Figure. 4.2.1 - 3. Nominal current calculation in differential protection devices.



Example of CT scaling (application 1)

The following figure presents how CTs are connected to the device's measurement inputs. It also shows the CT ratings and the transformer nominal current. Note that S1 is always connected to an odd connector regardless of the CT direction. The CT direction is selected in the settings of the transformer differential protection function.

Figure. 4.2.1 - 4. Connections (application 1).



Because of the direction of the CTs and because the CTs' P1/S1 side is always wired to the modules' odd inputs, the "Differential calculation mode" setting has to be set to "Subtract" (*Protection* → *TrafoModule* → *Idx* > [87T,87N] → *Settings*). This way the direction of the measured currents are checked correctly from the device's perspective.

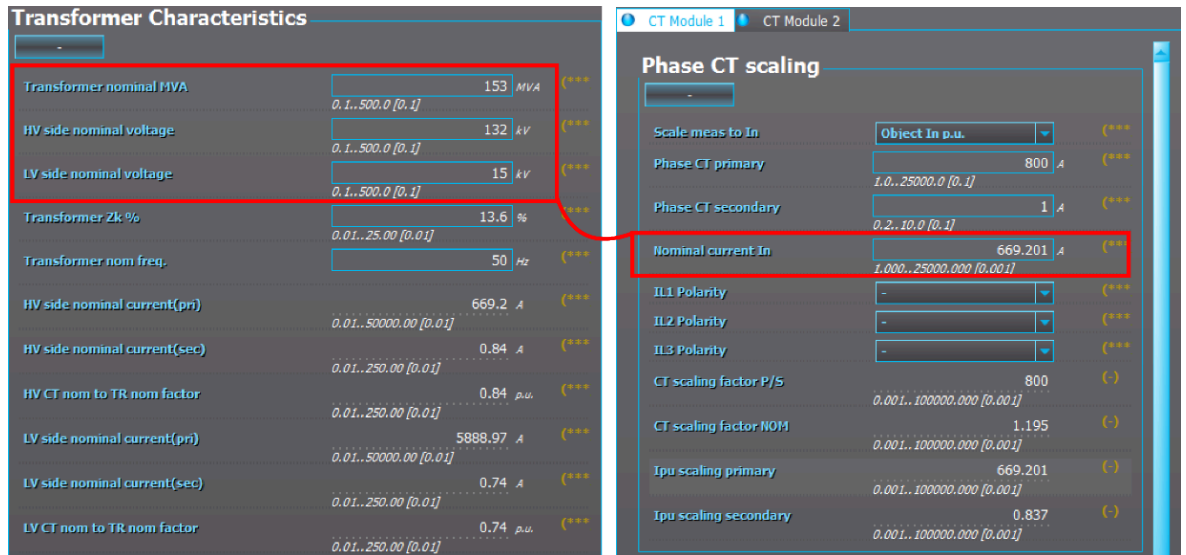
The following table presents the initial data of the connection as well as the ratings.

Table. 4.2.1 - 6. Initial data.

<p>High-voltage side CT:</p> <ul style="list-style-type: none"> CT primary: 800 A CT secondary: 1 A <p>High-voltage side nominal current: 669 A</p>	<p>Ring core CT in Input I02:</p> <ul style="list-style-type: none"> 3I0CT primary: 250 A 3I0CT secondary: 1 A 	<p>Low-voltage side CT:</p> <ul style="list-style-type: none"> CT primary: 8 000 A CT secondary: 1 A <p>Low-voltage side nominal current: 5 888 A</p>
<ul style="list-style-type: none"> Both CTs are pointing through the transformer (HV-S2 and LV-S2 are pointing in the same direction). 		

The nominal current for both the HV and LV sides of the protected transformer are calculated based on the values set in the *Transformer characteristics* menu (*Protection* → *TrafoModule* → *TSTAT* → *INFO*). The ratio between the CT modules 1 and 2 can be set in their respective tabs at *Measurement* → *Transformers*. The per-unit scaling ("Scale meas. to In") is automatically set to "Object in p.u." in all machine protection devices and it cannot be changed.

Figure. 4.2.1 - 5. Phase CT scaling to machine nominal.



As seen in the image above, device calculates both the HV side nominal current (669.2 A) and the LV side nominal current (5,888.97 A). The nominal current calculations are done according to the following formulas:

$$\text{HV side nominal current (pri)} = \frac{\text{trafo}_{\text{nom}}/\sqrt{3}}{U_{\text{HV}}/\sqrt{3}} = \frac{153\,000\,000/\sqrt{3}}{132\,000/\sqrt{3}} \approx 669.201 \text{ A}$$

$$\text{LV side nominal current (pri)} = \frac{\text{trafo}_{\text{nom}}/\sqrt{3}}{U_{\text{LV}}/\sqrt{3}} = \frac{153\,000\,000/\sqrt{3}}{15\,000/\sqrt{3}} \approx 5888.97 \text{ A}$$

The HV and LV side nominal current can also be calculated in per unit values as follows:

$$\text{HV CT nom to TR nom factor} = \frac{\text{HV side nominal current (pri)}}{\text{Phase CT primary}} = \frac{669.2 \text{ A}}{800 \text{ A}} \approx 0.84 \text{ p. u.}$$

$$\text{LV CT nom to TR nom factor} = \frac{\text{LV side nominal current (pri)}}{\text{Phase CT primary}} = \frac{5888.97 \text{ A}}{8000 \text{ A}} \approx 0.74 \text{ p. u.}$$

The secondary nominal current (in amperes) is the result of multiplying the per unit value with the phase CT secondary side current. This current can be used when the unit is commissioned and when the directions of CTs are checked. See the example calculation below:

$$\begin{aligned} &\text{HV side nominal current (sec)} \\ &= \text{HV CT nom to TR nom factor} \times \text{Phase CT secondary} = 0.84 \text{ p. u.} \times 1 \text{ A} = 0.84 \text{ A} \end{aligned}$$

$$\begin{aligned} &\text{LV side nominal current (sec)} \\ &= \text{LV CT nom to TR nom factor} \times \text{Phase CT secondary} = 0.74 \text{ p. u.} \times 1 \text{ A} = 0.74 \text{ A} \end{aligned}$$

In case the phase current CTs are connected to the module via a Holmgren (summing) connection, the use of coarse residual current measurement settings is required: the "I01 CT" settings are set according to the phase current CTs' ratings (800/1 A).

Figure. 4.2.1 - 6. Residual I01 CT scaling (coarse).

Setting	Value	Unit	Range	Resolution	Warning
I01 CT primary	800	A	0.20..25000.00	[0.10]	***
I01 CT secondary	1	A	0.10..10.00	[0.10]	***
I01 Polarity	-				***
CT scaling factor P/S	800		0.001..100000.000	[0.001]	(-)

The residual current CT is connected to the first CTM directly, which requires the use of sensitive residual current measurement settings: the "Residual I02 CT scaling" settings are set according to the residual current CT's ratings (250/1 A).

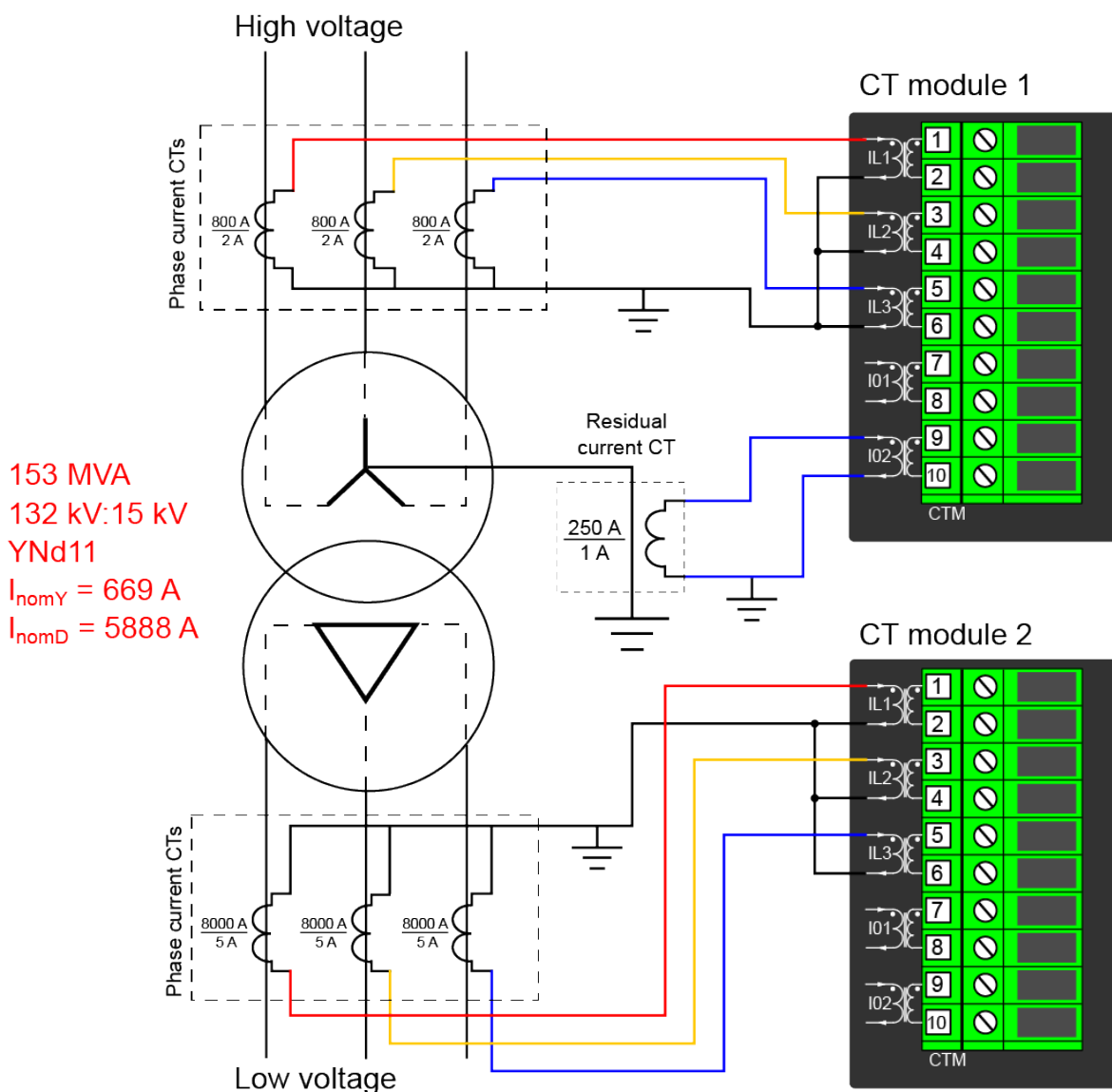
Figure. 4.2.1 - 7. Residual I02 CT scaling (sensitive).

Setting	Value	Unit	Range	Resolution	Warning
I02 CT primary	250	A	0.20..25000.00	[0.10]	***
I02 CT secondary	1	A	0.10..10.00	[0.10]	***
I02 Polarity	-				***
CT scaling factor P/S	250		0.001..100000.000	[0.001]	(-)

Example of CT scaling (application 2)

The following figure presents how the CTs are connected to the device's measurement inputs. It also shows the CT ratings and the transformer nominal current. Note that S1 is always connected to an odd connector regardless of the CT direction. The CT direction is selected in the settings of the transformer differential protection function.

Figure. 4.2.1 - 8. Connections (application 2).



Because of the direction of the CTs and because the CTs' P1/S1 side is always wired to the modules' odd inputs, the "Differential calculation mode" has to be set to "Add" (*Protection* → *TrafoModule* → *Idx* → [87T,87N] → *Settings*). The difference with the first application is that here the CTs point towards the protected object instead of pointing through it.

The following table presents the initial data of the connection as well as the ratings.

Table. 4.2.1 - 7. Initial data.

Machine nominal power: 153 MVA Machine high voltage side nominal amplitude: 132 kV Machine low voltage side nominal amplitude: 15 kV		
High voltage side CT: <ul style="list-style-type: none"> CT primary: 800 A CT secondary: 2 A High-voltage side nominal current: 669 A	Residual current CT in Input I02: <ul style="list-style-type: none"> 3I0CT primary: 250 A 3I0CT secondary: 1 A 	Low voltage side CT. <ul style="list-style-type: none"> CT primary: 8 000 A CT secondary: 5 A Low-voltage side nominal current: 5 888 A

- Both CTs are pointing towards the protected object (HV-S2 and LV-S2 are pointing at each other).

The nominal currents on both the HV and the LV sides are the same as in Application 1. However, the CTs' secondary current levels have been changed to 2 A (on the HV side) and to 5 A (on the LV side). The nominal currents are still calculated the same way:

$$\text{HV side nominal current (pri)} = \frac{\text{trafo}_{nom}/3}{U_{HV}/\sqrt{3}} = \frac{153\,000\,000/3}{132\,000/\sqrt{3}} \approx 669.201 \text{ A}$$

$$\text{LV side nominal current (pri)} = \frac{\text{trafo}_{nom}/3}{U_{LV}/\sqrt{3}} = \frac{153\,000\,000/3}{15\,000/\sqrt{3}} \approx 5888.97 \text{ A}$$

The HV and LV side nominal current can also be calculated in per unit values as follows:

$$\text{HV CT nom to TR nom factor} = \frac{\text{HV side nominal current (pri)}}{\text{Phase CT primary}} = \frac{669.2 \text{ A}}{800 \text{ A}} \approx 0.84 \text{ p. u.}$$

$$\text{LV CT nom to TR nom factor} = \frac{\text{LV side nominal current (pri)}}{\text{Phase CT primary}} = \frac{5888.97 \text{ A}}{8000 \text{ A}} \approx 0.74 \text{ p. u.}$$

The secondary nominal current (in amperes) is the result of multiplying the per unit value with the phase CT secondary side current. This current can be used when the unit is commissioned and when the directions of CTs are checked. In Application 2 it is necessary to inject higher amplitudes to the CTs via the secondary injection tool in order to reach the nominal currents. See the example calculation below:

HV side nominal current (sec)


$$= \text{HV CT nom to TR nom factor} \times \text{Phase CT secondary} = 0.84 \text{ p. u.} \times 2 \text{ A} = 1.68 \text{ A}$$

LV side nominal current (sec)

$$= \text{LV CT nom to TR nom factor} \times \text{Phase CT secondary} = 0.74 \text{ p. u.} \times 5 \text{ A} = 3.70 \text{ A}$$

Settings

Table. 4.2.1 - 8. Settings of the Phase CT scaling.

Name	Unit	Range	Step	Default	Description
Scale measurement to In	-	<ul style="list-style-type: none"> • CT nom p.u. • Object In p.u. 	-	<ul style="list-style-type: none"> • CT nom p.u. 	<p>The selection of the reference used in the device's per-unit system scaling. Either the set phase current CT primary or the protected object's nominal current.</p> <div style="border: 1px solid yellow; padding: 5px; margin-top: 10px;">  <p>CAUTION! Not applicable in machine protection!</p> </div>
Phase CT primary	A	1...25 000	0.001	100	The rated primary current of the current transformer.

Name	Unit	Range	Step	Default	Description
Phase CT secondary	A	0.2...10	0.001	5	The rated secondary current of the current transformer.
Nominal current In	A	1...25 000	0.001	100	The nominal current of the protected object. This setting is only visible if the option "Object In p.u." has been selected in the "Scale meas. to In" setting.
IL1 Polarity	-	<ul style="list-style-type: none"> • - • Invert 	-	• -	The selection of the first current measurement channel's (IL1) polarity (direction). The default setting is for the positive current to flow from connector 1 to connector 2, with the secondary currents' starpoint pointing towards the line.
IL2 Polarity	-	<ul style="list-style-type: none"> • - • Invert 	-	• -	The selection of the second current measurement channel's (IL2) polarity (direction). The default setting is for the positive current to flow from connector 3 to connector 4, with the secondary currents' starpoint pointing towards the line.
IL3 Polarity	-	<ul style="list-style-type: none"> • - • Invert 	-	• -	The selection of the third current measurement channel's (IL3) polarity (direction). The default setting is for the positive current to flow from connector 5 to connector 6, with the secondary currents' starpoint pointing towards the line.
CT scaling factor P/S	-	-	-	-	A feedback value; the calculated scaling factor that is the ratio between the primary current and the secondary current.
CT scaling factor NOM	-	-	-	-	A feedback value; the calculated scaling factor that is the ratio between the set primary current and the set nominal current.
Ipu scaling primary	-	-	-	-	A feedback value; the scaling factor for the primary current's per-unit value.
Ipu scaling secondary	-	-	-	-	A feedback value; the scaling factor for the secondary current's per-unit value.

Table. 4.2.1 - 9. Settings of the Residual I01 CT scaling.

Name	Unit	Range	Step	Default	Description
I01 CT primary	A	0.2...25 000	0.000 01	100	The rated primary current of the current transformer.
I01 CT secondary	A	0.1...10	0.000 01	1.0	The rated secondary current of the current transformer.

Name	Unit	Range	Step	Default	Description
I01 Polarity	-	<ul style="list-style-type: none"> • - • Invert 	-	-	The selection of the coarse residual measurement channel's (I01) polarity (direction). The default setting is for the positive current to flow from connector 7 to connector 8.
CT scaling factor P/S	-	-	-	-	A feedback value; the calculated scaling factor that is the ratio between the primary current and the secondary current.

Table. 4.2.1 - 10. Settings of the Residual I02 CT scaling.

Name	Unit	Range	Step	Default	Description
I02 CT primary	A	1...25 000	0.000 01	100	The rated primary current of the current transformer.
I02 CT secondary	A	0.001...10	0.000 01	0.2	The rated secondary current of the current transformer.
I02 Polarity	-	<ul style="list-style-type: none"> • - • Invert 	-	-	The selection of the sensitive residual measurement channel's (I02) polarity (direction). The default setting is for the positive current to flow from connector 9 to connector 10.
CT scaling factor P/S	-	-	-	-	A feedback value; the calculated scaling factor that is the ratio between the primary current and the secondary current.

Measurements

The following measurements are available in the measured current channels.

Table. 4.2.1 - 11. Per-unit phase current measurements.

Name	Unit	Range	Step	Description
Pha.curr.ILx	× In	0.000...1 250.000	0.001	The RMS current measurement (in p.u.) from each of the phase current channels.
Pha.curr.ILx TRMS	× In	0.000...1 250.000	0.001	The TRMS current (inc. harmonics up to 31 st) measurement (in p.u.) from each of the phase current channels.
P-P curr.ILx	× In	0.000...500.000	0.001	The peak-to-peak current measurement (in p.u.) from each of the phase current channels.

Table. 4.2.1 - 12. Primary phase current measurements.

Name	Unit	Range	Step	Description
Pri.Pha.curr.ILx	A	0.000...1 000 000.000	0.001	The primary RMS current measurement from each of the phase current channels.
Pha.curr.ILx TRMS Pri	A	0.000...1 000 000.000	0.001	The primary TRMS current (inc. harmonics up to 31 st) measurement from each of the phase current channels.

Table. 4.2.1 - 13. Secondary phase current measurements.

Name	Unit	Range	Step	Description
Sec.Pha.curr.ILx	A	0.000...300.000	0.001	The primary RMS current measurement from each of the phase current channels.
Pha.curr.ILx TRMS Sec	A	0.000...300.000	0.001	The primary TRMS current (inc. harmonics up to 31 st) measurement from each of the phase current channels.

Table. 4.2.1 - 14. Phase current angle measurements.

Name	Unit	Range	Step	Description
Pha.angle ILx	deg	0.000...360.000	0.001	The phase angle measurement from each of the three phase current inputs.

Table. 4.2.1 - 15. Per-unit residual current measurements.

Name	Unit	Range	Step	Description
Res.curr.I0x	× In	0.000...1 250.000	0.001	The RMS current measurement (in p.u.) from the residual current channel I01 or I02.
Calculated I0	× In	0.000...1 250.000	0.001	The RMS current measurement (in p.u.) from the calculated I0 current channel.
Res.curr.I0x TRMS	× In	0.000...1 250.000	0.001	The TRMS current (inc. harmonics up to 31 st) measurement (in p.u.) from the residual current channel I01 or I02.
P-P curr.I0x	× In	0.000...500.000	0.001	The peak-to-peak current measurement (in p.u.) from the residual current channel I01 or I02.

Table. 4.2.1 - 16. Primary residual current measurements.

Name	Unit	Range	Step	Description
Pri.Res.curr.I0x	A	0.000...1 000 000.000	0.001	The primary RMS current measurement from the residual current channel I01 or I02.
Pri.calc.I0	A	0.000...1 000 000.000	0.001	The primary RMS current measurement from the calculated current channel I0.
Res.curr.I01 TRMS Pri	A	0.000...1 000 000.000	0.001	The TRMS current (inc. harmonics up to 31 st) measurement from the primary residual current channel I01 or I02.

Table. 4.2.1 - 17. Secondary residual current measurements.

Name	Unit	Range	Step	Description
Sec.Res.curr.I0x	A	0.000...300.000	0.001	The secondary RMS current measurement from the residual current channel I01 or I02.

Name	Unit	Range	Step	Description
Sec.calc.I0	A	0.000...300.000	0.001	The secondary RMS current measurement from the calculated current channel I0.
Res.curr.I0x TRMS Sec	A	0.000...300.000	0.001	The secondary TRMS current (inc. harmonics up to 31 st) measurement from the secondary residual current channel I01 or I02.

Table. 4.2.1 - 18. Residual current phase angle measurements.

Name	Unit	Range	Step	Description
Res.curr.angle I0x	deg	0.000...360.000	0.001	The residual current angle measurement from the I01 or I02 current input.
Calculated I0 angle	deg	0.000...360.000	0.001	The calculated residual current angle measurement.

Table. 4.2.1 - 19. Per-unit sequence current measurements.

Name	Unit	Range	Step	Description
Positive sequence curr.	× In	0.00...1 250.0	0.001	The measurement (in p.u.) from the calculated positive sequence current.
Negative sequence curr.	× In	0.00...1 250.0	0.001	The measurement (in p.u.) from the calculated negative sequence current.
Zero sequence curr.	× In	0.00...1 250.0	0.001	The measurement (in p.u.) from the calculated zero sequence current.

Table. 4.2.1 - 20. Primary sequence current measurements.

Name	Unit	Range	Step	Description
Pri.Positive sequence curr.	A	0.00...1 000 000.0	0.001	The primary measurement from the calculated positive sequence current.
Pri.Negative sequence curr.	A	0.00...1 000 000.0	0.001	The primary measurement from the calculated negative sequence current.
Pri.Zero sequence curr.	A	0.00...1 000 000.0	0.001	The primary measurement from the calculated zero sequence current.

Table. 4.2.1 - 21. Secondary sequence current measurements.

Name	Unit	Range	Step	Description
Sec.Positive sequence curr.	A	0.000...300.000	0.001	The secondary measurement from the calculated positive sequence current.
Sec.Negative sequence curr.	A	0.000...300.000	0.001	The secondary measurement from the calculated negative sequence current.

Name	Unit	Range	Step	Description
Sec.Zero sequence curr.	A	0.000...300.000	0.001	The secondary measurement from the calculated zero sequence current.

Table. 4.2.1 - 22. Sequence phase angle measurements.

Name	Unit	Range	Step	Description
Positive sequence curr.angle	deg	0.000...360.0	0.001	The calculated positive sequence current angle.
Negative sequence curr.angle	deg	0.000...360.0	0.001	The calculated negative sequence current angle.
Zero sequence curr.angle	deg	0.000...360.0	0.001	The calculated zero sequence current angle.

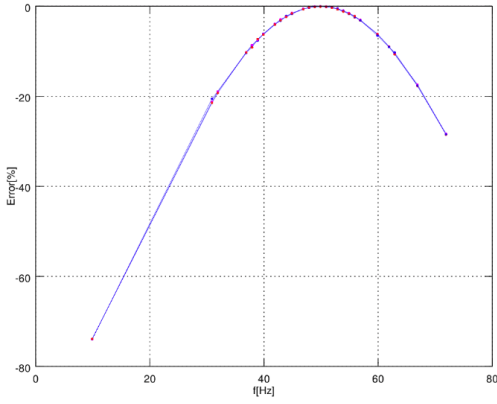
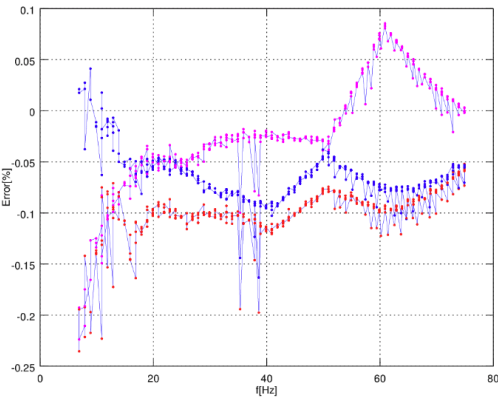
Table. 4.2.1 - 23. Harmonic current measurements.

Name	Unit	Range	Step	Default	Description
Harm Abs.pr Perc.	-	<ul style="list-style-type: none"> Percent Absolute 	-	Percent	Defines whether the harmonics are calculated as percentage or absolute values.
Harmonics display	-	<ul style="list-style-type: none"> Per unit Primary A Secondary A 	-	Per unit	Defines how the harmonics are displayed: in p.u. values, as primary current values, or as secondary current values.
IxxMaximum harmonic	A	0.000...1 000 000.000	0.001	-	Displays the maximum harmonics value of the selected current input ILx or IOx.
Ixx fundamental	A	0.000...1 000 000.000	0.001	-	Displays the current value of the fundamental frequency measurement (RMS) from the selected current input ILx or IOx.
Ixx harmonics (2 nd ...31 st harmonic)	A	0.000...1 000 000.000	0.001	-	Displays the selected harmonic from the current input ILx or IOx.

4.2.2 Frequency tracking and scaling

Measurement sampling can be set to the frequency tracking mode or to the fixed user-defined frequency sampling mode. The benefit of frequency tracking is that the measurements are within a pre-defined accuracy range even when the fundamental frequency of the power system changes.

Table. 4.2.2 - 24. Frequency tracking effect (FF changes from 6 Hz to 75 Hz).

	
<p>The measurement error with a fixed 50 Hz sampling frequency when the frequency changes. The constant current is 5 A, the frequency sweep is from 6 Hz to 75 Hz.</p>	<p>The measurement error with frequency tracking when the frequency changes. The constant current is 5 A, the frequency sweep is from 6 Hz to 75 Hz.</p>

As the figures above show, the sampling frequency has a major effect on the device's measurement accuracy. If the sampling is not tracked to the system frequency, for example a 10 Hz difference between the measured and the set system frequency can give a measurement error of over 5 %. The figures also show that when the frequency is tracked and the sampling is adjusted according to the detected system frequency, the measurement accuracy has an approximate error of 0.1... - 0.2 % error in the whole frequency range.

The device has a measurement accuracy that is independent of the system frequency. This has been achieved by adjusting the sample rate of the measurement channels according to the measured system frequency; this way the FFT calculation always has a whole power cycle in the buffer. The measurement accuracy is further improved by Arcteq's patented calibration algorithms that calibrate the analog channels against eight (8) system frequency points for both magnitude and angle. This frequency-dependent correction compensates the frequency dependencies in the used, non-linear measurement hardware and improves the measurement accuracy significantly. Combined, these two methods give an accurate measurement result that is independent of the system frequency.

Troubleshooting

When the measured current, voltage or frequency values differ from the expected values, the following table offers possible solutions for the problems.

Problem	Check / Resolution
<p>The measured current or voltage amplitude is lower than it should be./ The values are "jumping" and are not stable.</p>	<p>The set system frequency may be wrong. Please check that the frequency settings match the local system frequency, or change the measurement mode to "Tracking" (<i>Measurement</i> → <i>Frequency</i> → "Sampling mode") so the device adjusts the frequency itself.</p>
<p>The frequency readings are wrong.</p>	<p>In Tracking mode the device may interpret the frequency incorrectly if no current is injected into the CT (or voltage into the VT). Please check the frequency measurement settings (<i>Measurement</i> → <i>Frequency</i>).</p>

Settings

Table. 4.2.2 - 25. Settings of the frequency tracking.

Name	Range	Step	Default	Description
Sampling mode	<ul style="list-style-type: none"> Fixed Tracking 	-	Fixed	Defines which measurement sampling mode is in use: the fixed user-defined frequency, or the tracked system frequency.
System nominal frequency	7.000...75.000Hz	0.001Hz	50Hz	The user-defined system nominal frequency that is used when the "Sampling mode" setting has been set to "Fixed".
Tracked system frequency	0.000...75.000Hz	0.001Hz	-	Displays the rough measured system frequency.
Sampling frequency in use	0.000...75.000Hz	0.001Hz	-	Displays the tracking frequency that is in use at that moment.
Frequency reference 1	<ul style="list-style-type: none"> None CT1IL1 CT2IL1 VT1U1 VT2U1 	-	CT1IL1	The first reference source for frequency tracking.
Frequency reference 2	<ul style="list-style-type: none"> None CT1IL2 CT2IL2 VT1U2 VT2U2 	-	CT1IL2	The second reference source for frequency tracking.
Frequency reference 3	<ul style="list-style-type: none"> None CT1IL3 CT2IL3 VT1U3 VT2U3 	-	CT1IL3	The third reference source for frequency tracking.
Frequency tracking quality	<ul style="list-style-type: none"> No trackable channels Reference 1 trackable Reference 2 trackable References 1 & 2 trackable Reference 3 trackable Reference 1 & 3 trackable References 2 & 3 trackable All references trackable 	-	-	Defines the frequency tracker quality. If the measured current (or voltage) amplitude is below the threshold, the channel tracking quality is 0 and cannot be used for frequency tracking. If all channels' magnitudes are below the threshold, there are no trackable channels.
Frequency measurement in use	<ul style="list-style-type: none"> No track ch Ref1 Ref2 Ref3 	-	-	Indicates which reference is used at the moment for frequency tracking.

Name	Range	Step	Default	Description
Start behavior	<ul style="list-style-type: none"> Start tracking immediately First nominal or tracked 	-	Start tracking immediately	Defines the how the tracking starts. Tracking can start immediately, or there can be a set delay time between the receiving of the first trackable channel and the start of the tracking.
Start sampling with	<ul style="list-style-type: none"> Use track frequency Use nom frequency 	-	Use track frequency	Defines the start of the sampling. Sampling can begin with a previously tracked frequency, or with a user-set nominal frequency.
Use nominal frequency until	0...1800.000s	0.005s	0.100s	Defines how long the nominal frequency is used after the tracking has started. This setting is only valid when the "Sampling mode" setting is set to "Tracking" and when the "Start behavior" is set to "First nominal or tracked".
Tracked f channel A	0.000...75.000Hz	0.001Hz	-	Displays the rough value of the tracked frequency in Channel A.
Tracked f channel B	0.000...75.000Hz	0.001Hz	-	Displays the rough value of the tracked frequency in Channel B.
Tracked f channel C	0.000...75.000Hz	0.001Hz	-	Displays the rough value of the tracked frequency in Channel C.
System measured frequency	<ul style="list-style-type: none"> One f measured Two f measured Three f measured 	-	-	Displays the amount of frequencies that are measured.
f.atm. Protections	0.000...75.000Hz	0.001Hz	-	Frequency measurement value used by protection functions. When frequency is not measurable this value returns to value set to "System nominal frequency" parameter.
f.atm. Display	0.000...75.000Hz	0.001Hz	-	Frequency measurement value used in display. When frequency is not measurable this value is "0 Hz".
f measurement from	<ul style="list-style-type: none"> Not measurable Avg Ref 1 Avg Ref 2 Avg Ref 3 Track Ref 1 Track Ref 2 Track Ref 3 Fast Ref 1 Fast Ref 2 Fast Ref 3 	-	-	Displays which reference is used for frequency measurement.
SS1.meas.frqs	0.000...75.000Hz	0.001Hz	-	Displays frequency used by "system set" channel 1 and 2.
SS2.meas.frqs				

Name	Range	Step	Default	Description
SS1f meas.from	<ul style="list-style-type: none"> Not measurable Fast Ref U3 Fast Ref U4 	-	-	Displays which voltage channel frequency reference is used by "system set" voltage channel.
SS2f meas.from	<ul style="list-style-type: none"> Not measurable Fast Ref U4 	-	-	Displays if U4 channel frequency reference is measurable or not when the channel has been set to "system set" mode.

4.3 General menu

The *General* menu consists of basic settings and indications of the device. Additionally, the all activated functions and their status are displayed in the *Protection*, *Control* and *Monitor* profiles.

Table. 4.3 - 26. The *General* menu read-only parameters

Name	Description
Serial number	The unique serial number identification of the unit.
Firmware version	The firmware software version of the unit.
Hardware configuration	The order code identification of the unit.
System phase rotating order at the moment	The selected system phase rotating order. Can be changed with parameter "System phase rotating order".
UTC time	The UTC time value which the device's clock uses.

Table. 4.3 - 27. Parameters and indications in the *General* menu.

Name	Range	Default	Description
Device name	-	Unitname	The file name uses these fields when loading the .aqc configuration file from the device.
Device location	-	Unitlocation	
Enable stage forcing	<ul style="list-style-type: none"> Disabled Enabled 	Disabled	When this parameter is enabled it is possible for the user to force the protection, control and monitoring functions to different statuses like START and TRIP. This is done in the function's <i>Info</i> page with the <i>Force status to</i> parameter.
Allow setting of device mode	<ul style="list-style-type: none"> Prohibited From HMI/setting tool only Allowed 	Prohibited	Allows global mode to be modified from setting tool, HMI and IEC61850. Prohibited: Cannot be changed. From HMI/setting tool only: Can only be changed from the setting tool or HMI Allowed: Can be changed from the setting tool, HMI, and IEC 61850 client.

Name	Range	Default	Description
Allow setting of individual LN mode	<ul style="list-style-type: none"> Prohibited From HMI/setting tool only Allowed 	Prohibited	<p>Allow local modes to be modified from setting tool, HMI and IEC61850.</p> <p>Prohibited: Cannot be changed.</p> <p>From HMI/setting tool only: Can only be changed from the setting tool or HMI</p> <p>Allowed: Can be changed from the setting tool, HMI, and IEC 61850 client.</p>
System phase rotating order	<ul style="list-style-type: none"> A-B-C A-C-B 	A-B-C	Allows the user to switch the expected order in which the phase measurements are wired to the unit.
Language	<ul style="list-style-type: none"> User defined English Finnish Chinese Spanish French German Russian Ukrainian Kazakh 	English	Changes the language of the parameter descriptions in the HMI. If the language has been set to "Other" in the settings of the AQtivate setting tool, AQtivate follows the value set into this parameter.
AQtivate ethernet port	<ul style="list-style-type: none"> All COM A Double Ethernet card 	All	If the device has a double Ethernet option card it is possible to choose which ports are available for connecting with AQtivate software.
Clear events	<ul style="list-style-type: none"> - Clear 	-	Clears the event history recorded in the device.
Display brightness	0...8	4	Changes the display brightness. Brightness level 0 turns the display off.
Display sleep timeout	0...3600s	0s	<p>If no buttons are pressed after a set time, the display changes the brightness to whatever is set on the "Display sleep brightness" parameter. If set to 0 s, this feature is not in use.</p> <p>When the device is in sleep mode, all button actions are disabled. Pressing any of the buttons on the front panel will wake up the display, which enables the buttons again.</p>
Display sleep brightness	0...8	0	Defines the brightness of the display when the set display sleep timeout has elapsed. The brightness level "0" turns the display off.
Return to default view	0...3600s	0s	If the user navigates to a menu and gives no input after a period of time defined with this parameter, the unit automatically returns to the default view. If set to 0 s, this feature is not in use.
LED test	<ul style="list-style-type: none"> - Activated 	-	When activated, all LEDs are lit up. LEDs with multiple possible colors blink each color.
HMI restart	<ul style="list-style-type: none"> - Restart 	-	When activated, display restarts.
Display color theme	<ul style="list-style-type: none"> Light theme Dark theme 	Light theme	Defines the color theme used in the HMI.

Name	Range	Default	Description
Reset latches	<ul style="list-style-type: none"> - Reset 	-	Resets the latched signals in the logic and the matrix. When a reset command is given, the parameter automatically returns back to "-".
Measurement recorder	<ul style="list-style-type: none"> Disabled Enabled 	Disabled	Enables the measurement recorder tool, further configured in <i>Tools</i> → <i>Misc</i> → <i>Measurement recorder</i> .
I/O default object selection	<ul style="list-style-type: none"> OBJ1 OBJ2 OBJ3 OBJ4 OBJ5 OBJ6 OBJ7 OBJ8 OBJ9 OBJ10 	OBJ1	"I" and "O" push buttons on the front panel of the device have an indication LED. This parameter defines which objects' status push buttons follow when lighting up the LEDs.
Device Mode	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	On	Set mode of device block. This parameter is visible only when <i>Allow setting of device mode</i> is enabled in <i>General</i> menu.
Reconfigure mimic	<ul style="list-style-type: none"> - Reconfigure 	-	Reloads the mimic to the unit.

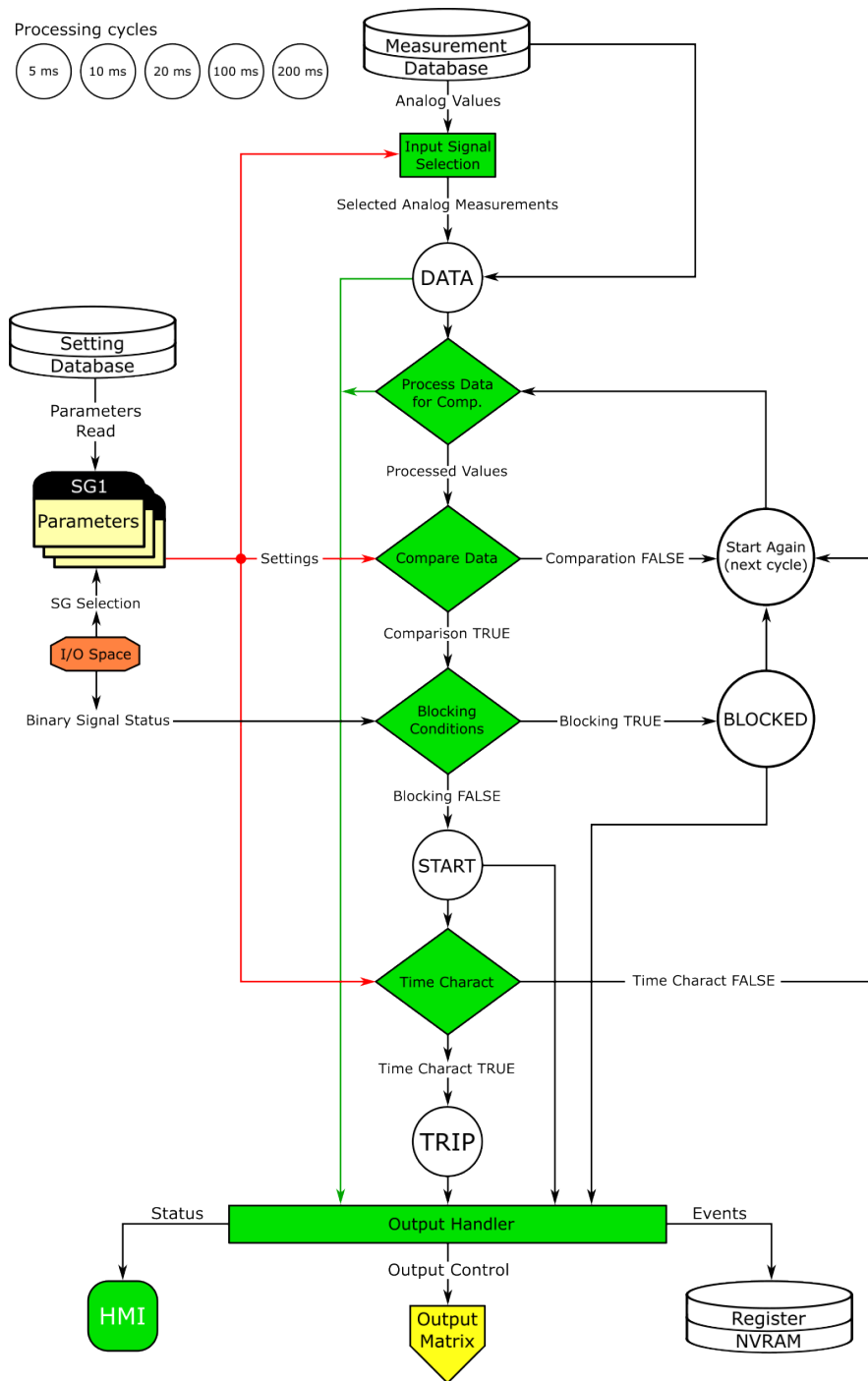
Table. 4.3 - 28. General menu logical inputs.

Name	Description
Reset last fault registers	Signal set to this point can be used for resetting latest recorded fault register.
Reset latches	Signals set to this point can be used for resetting latched signals. An alternative to using the "Back" button on the front panel of the device.
Ph.Rotating Logic control 0=A-B-C, 1=A-C-B	Signals set to this point can be used for switching the expected phase rotating order.

4.4 Protection functions

4.4.1 General properties of a protection function

The following flowchart describes the basic structure of any protection function. The basic structure is composed of analog measurement values being compared to the pick-up values and operating time delay characteristics.



The protection function is run in a completely digital environment with a protection CPU microprocessor which also processes the analog signals transformed into the digital form.

In the following chapters the common functionalities of protection functions are described. If a protection function deviates from this basic structure, the difference is described in the corresponding chapter of the manual.

Pick-up

The X_{set} parameter defines the pick-up level of the function, and this in turn defines the maximum or minimum allowed measured magnitude (in per unit, absolute or percentage value) before the function takes action. The function constantly calculates the ratio between the pick-up parameter set by the user and the measured magnitude (X_m). The reset ratio of 97 % is built into the function and is always relative to the X_{set} value. If a function's pick-up characteristics vary from this description, they are defined in the function section in the manual.

Figure. 4.4.1 - 9. Pick up and reset.

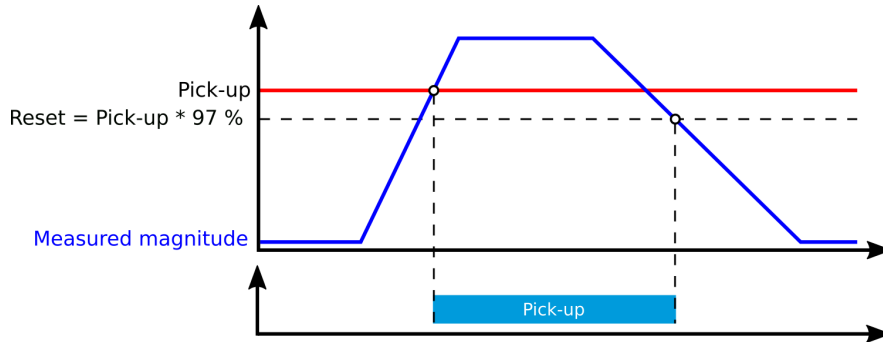
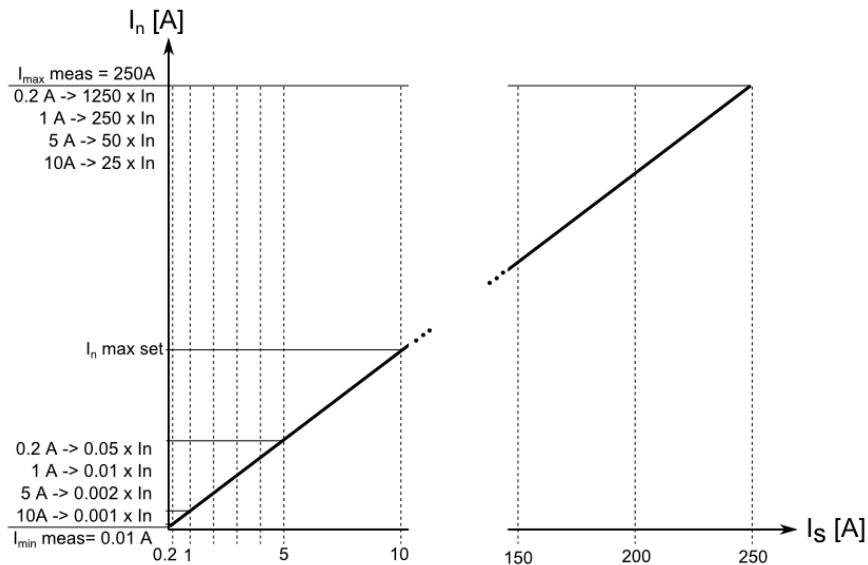


Figure. 4.4.1 - 10. Measurement range in relation to the nominal current.



The I_n magnitude refers to the user set nominal current which can range from 0.2...10 A, typically 0.2 A, 1A or 5 A. With its own current measurement card, the device will measure secondary currents from 0.001 A up to 250 A. To this relation the pick-up setting in secondary amperes will vary.

Function blocking

The blocking signal is evaluated at the start of each program cycle. The blocking signals are connected to the function's dedicated input, which can be configured in the *IO* → *Blocking Input Control* tab of the function.

- When the pick-up element activates and the blocking signal is not active, a START signal is generated, and the function starts or continues with the trip time countdown.
- When the pick-up element activates and the blocking signal is active, a BLOCKED signal is generated, and the function does not process the event further.

- When a START signal is already active and the blocking input signal becomes active, the START signal is reset and BLOCKED signal is generated. The release time characteristics are then processed in the same way as when the pick-up signal is reset.

The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time. Blocking of the function causes a time stamped blocking event with information of the startup current values and its fault type to be issued.

Some functions also offer an optional internal inrush harmonic blocking feature. If the inrush harmonic pick-up is active at the same time as the protection function pick-up element, the trip delay timer continues counting down as normal. Once the countdown reaches zero, if the pick-up element remains active and the second harmonic value has dropped, the function issues a trip.

Table. 4.4.1 - 29. Internal inrush harmonic blocking settings.

Name	Range	Step	Default	Description
Inrush harmonic blocking (internal-only trip)	<ul style="list-style-type: none"> No Yes 	-	<ul style="list-style-type: none"> No 	Enables and disables the 2 nd harmonic blocking.
2 nd harmonic blocking limit (I _{harm} /I _{fund})	0.10...50.00%I _{fund}	0.01%I _{fund}	0.01%I _{fund}	Defines the limit of the 2 nd harmonic blocking.

Operating time characteristics

Three basic modes are available for delaying function operation:

- Instant operation: activates the trip signal simultaneously with the start signal with no additional time delay.
- Definite time operation (DT): activates the trip signal after a user-defined time delay regardless of the magnitude of the measured value(s) as long as the pick-up element is active.
- Inverse definite minimum time (IDMT): activates the trip signal after a time which is in relation to the set pick-up value and the measured value.

Both IEC and IEEE/ANSI standard characteristics as well as user settable parameters are available for the IDMT operation. Please note that in the IDMT mode *Definite (minimum) operating time delay* also determines the minimum time for protection tripping (see the figure below). If this function is not desired the parameter should be set to 0 seconds.

Figure. 4.4.1 - 11. Operating time delay: *Definite (minimum) operating time delay* and the minimum for tripping.

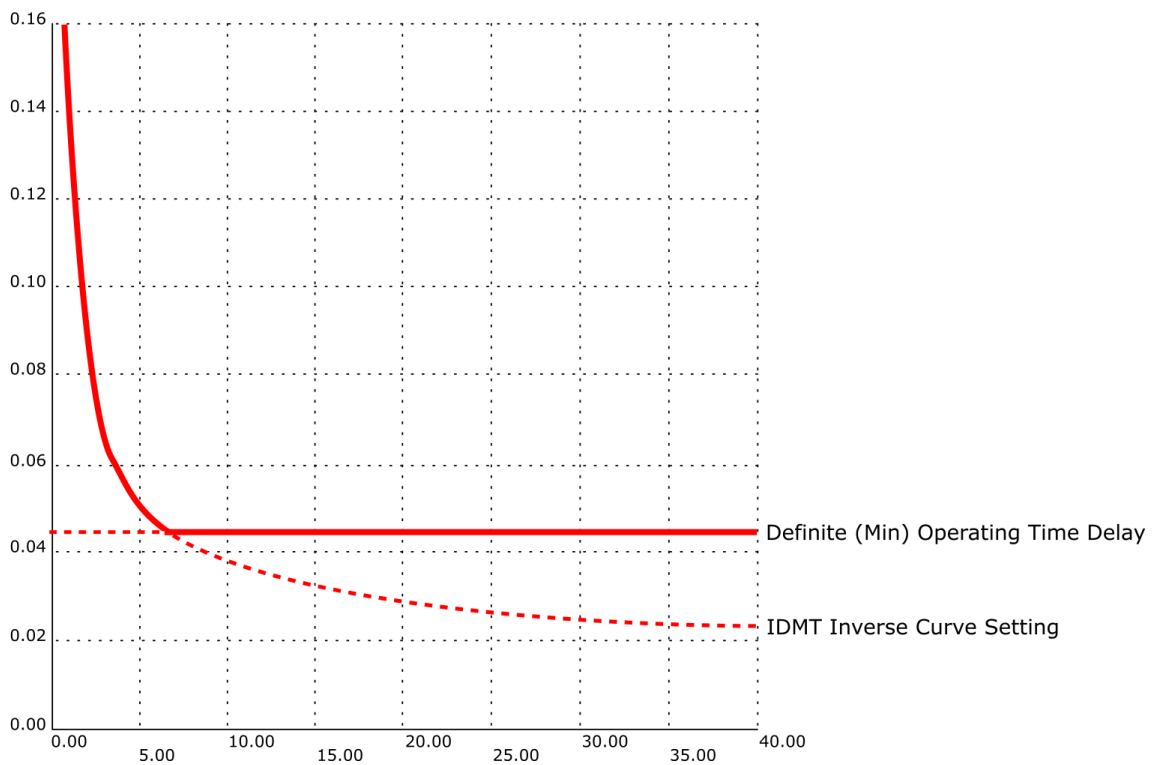


Table. 4.4.1 - 30. Operating time characteristics setting parameters (general).

Name	Range	Step	Default	Description
Delay type	<ul style="list-style-type: none"> DT IDMT 	-	DT	Selects the delay type for the time counter. The selection is made between "Inverse definite minimum time" (IDMT) and "Definite time operation" (DT) characteristics.
Definite (minimum) operating time delay	0.000...1800.000s	0.005s	0.040s	When the "Delay type" parameter is set to "DT", this parameter acts as the expected operating time for the protection function. When set to 0 s, the stage operates instantaneously without any additional delay. When the parameter is set to 0.005...1800 s, the stage operates as independent delayed. When the "Delay type" parameter has been set to "IDMT", this parameter can be used to determine the minimum operating time for the protection function. Example of this is presented in the figure above.
Delay curve series	<ul style="list-style-type: none"> IEC IEEE 	-	IEC	Selects whether the delay curve series for an IDMT operation follows either IEC or IEEE/ANSI standard defined characteristics. This setting is active and visible when the "Delay type" parameter is set to "IDMT".

Name	Range	Step	Default	Description
Delay characteristics IEC	<ul style="list-style-type: none"> • NI • EI • VI • LTI • Param 	-	NI	<p>Selects the IEC standard delay characteristics.</p> <p>The options include the following: Normally Inverse ("NI"), Extremely Inverse ("EI"), Very Inverse ("VI") and Long Time Inverse ("LTI") characteristics. Additionally, the "Param" option allows the tuning of the constants A and B which then allows the setting of characteristics following the same formula as the IEC curves mentioned here.</p> <p>This setting is active and visible when the "Delay type" parameter is set to "IDMT" and the "Delay curve series" parameter is set to "IEC".</p>
Delay characteristics IEEE	<ul style="list-style-type: none"> • ANSI NI • ANSI VI • ANSI EI • ANSI LTI • IEEE MI • IEEE VI • IEEE EI • Param 	-	ANSI NI	<p>Selects the IEEE and ANSI standard delay characteristics.</p> <p>The options for ANSI include the following: Normal Inverse ("ANSI NI"), Very Inverse ("ANSI VI"), Extremely inverse ("ANSI EI"), Long time inverse ("ANSI LTI") characteristics. IEEE: Moderately Inverse ("IEEE MI"), Very Inverse ("IEEE VI"), Extremely Inverse ("IEEE EI") characteristics. Additionally, the "Param" option allows the tuning of the constants A, B and C which then allows the setting of characteristics following the same formula as the IEEE curves mentioned here.</p> <p>This setting is active and visible when the "Delay type" parameter is set to "IDMT" and the "Delay curve series" parameter is set to "IEEE".</p>
Time dial setting k	0.01...25.00s	0.01s	0.05s	<p>Defines the time dial/multiplier setting for IDMT characteristics.</p> <p>This setting is active and visible when the "Delay type" parameter is set to "IDMT".</p>
A	0.0000...250.0000	0.0001	0.0860	<p>Defines the Constant A for IEC/IEEE characteristics.</p> <p>This setting is active and visible when the "Delay type" parameter is set to "IDMT" and the "Delay characteristic" parameter is set to "Param".</p>
B	0.0000...250.0000	0.0001	0.1850	<p>Defines the Constant B for IEC/IEEE characteristics.</p> <p>This setting is active and visible when the "Delay type" parameter is set to "IDMT" and the "Delay characteristic" parameter is set to "Param".</p>
C	0.0000...250.0000	0.0001	0.0200	<p>Defines the Constant C for IEEE characteristics.</p> <p>This setting is active and visible when the "Delay type" parameter is set to "IDMT" and the "Delay characteristic" parameter is set to "Param".</p>

Figure. 4.4.1 - 12. Inverse definite minimum time formulas for IEC and IEEE standards.

IEC	IEEE/ANSI																																																			
$t = \frac{kA}{\left(\frac{I_m}{I_{set}}\right)^B - 1}$	$t = k \left(\frac{A}{\left(\frac{I_m}{I_{set}}\right)^C - 1} + B \right)$																																																			
<p>t = Operating delay (s) k = Time dial setting I_m = Measured maximum current I_{set} = Pick-up setting A = Operating characteristics constant B = Operating characteristics constant</p>	<p>t = Operating delay (s) k = Time dial setting I_m = Measured maximum current I_{set} = Pick-up setting A = Operating characteristics constant B = Operating characteristics constant C = Operating characteristics constant</p>																																																			
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Non-standard delay characteristics

In addition to the previously mentioned delay characteristics, some functions also have delay characteristics that deviate from the IEC or IEEE standards. These functions are the following:

- non-directional overcurrent stages
- non-directional earth fault stages
- directional overcurrent stages
- directional earth fault stages.

The setting parameters and their ranges are documented in the chapters of the respective function blocks.

Table. 4.4.1 - 31. Inverse definite minimum time formulas for nonstandard characteristics.

RI-type	RD-type
Used for getting the time grading with mechanical relays.	Mostly used in earth fault protection which grants selective tripping even in non-directional protection.
$t = \frac{k}{0.339 - 0.236 * \frac{I_{set}}{I_m}}$	$t = 5.8 - 1.35 * \ln \left(\frac{I_m}{k * I_{set}} \right)$
<p>t = Operation delay (s) k = Time dial setting I_m = Measured maximum current I_{set} = Pick-up setting</p>	<p>t = Operation delay (s) k = Time dial setting I_m = Measured maximum current I_{set} = Pick-up setting</p>

**NOTICE!**

When using RD-type and "k" has been set lower than 0.3 calculated operation time can be lower than 0 seconds with some measurement values. In these cases operation time will be instant.

When using the release delay option where the operating time counter is calculating the operating time during the release time, the function will not trip if the input signal is not activated again during the release time counting.

The behavior of the stages with different release time configurations are presented in the figures below.

Table. 4.4.1 - 32. Setting parameters for reset time characteristics.

Name	Range	Step	Default	Description
Delayed pick-up release	<ul style="list-style-type: none"> No Yes 	-	Yes	Resetting characteristics selection (either time-delayed or instant) after the pick-up element is released. If set to "Yes", the START signal is reset after a set release time delay.
Release time delay	0.000...150.000s	0.005s	0.06s	Resetting time. The time allowed between pick-ups if the pick-up has not led into a trip operation. If the "Delayed pick-up release" setting is set to "Yes", the START signal is held on for the duration of the timer.
Op.Time calculation reset after release time	<ul style="list-style-type: none"> No Yes 	-	Yes	Operating timer resetting characteristics selection. When set to "Yes", the operating time counter is reset after a set release time if the pick-up element is not activated during this time. When set to "No", the operating time counter is reset directly after the pick-up element is reset.
Continue time calculation during release time	<ul style="list-style-type: none"> No Yes 	-	No	Time calculation characteristics selection. If set to "Yes", the operating time counter continues until a set release time even if the pick-up element is reset.

Figure. 4.4.1 - 13. No delayed pick-up release.

Delayed pick-up release: Disabled

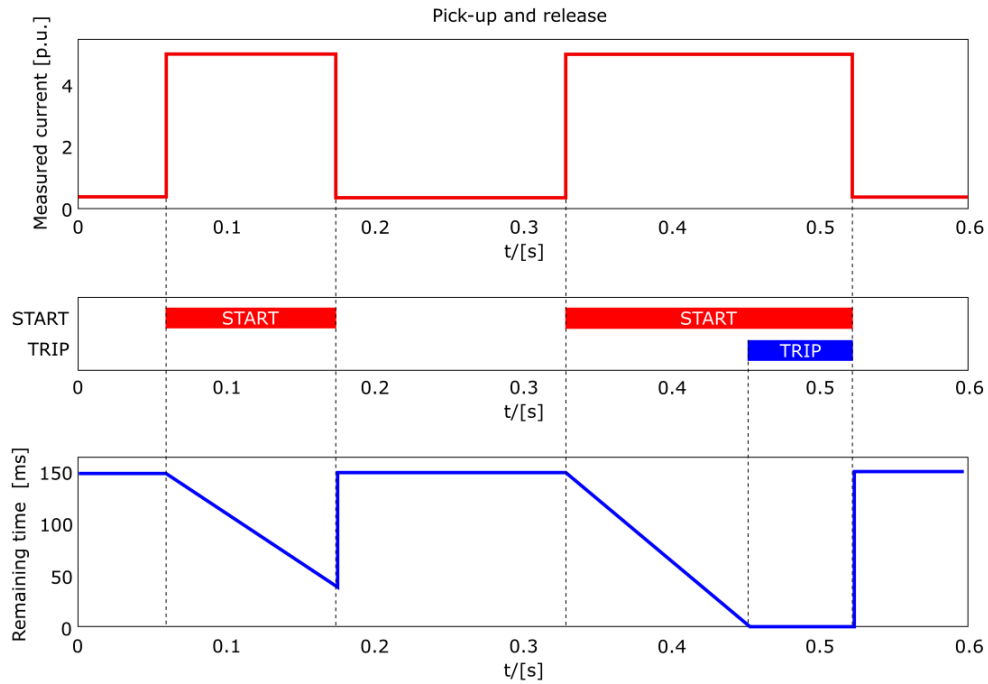


Figure. 4.4.1 - 14. Delayed pick-up release, delay counter is reset at signal drop-off.

Delayed pick-up release: Enabled
Op.time calc reset after release time: Disabled
Continue time calculation during release time: Disabled

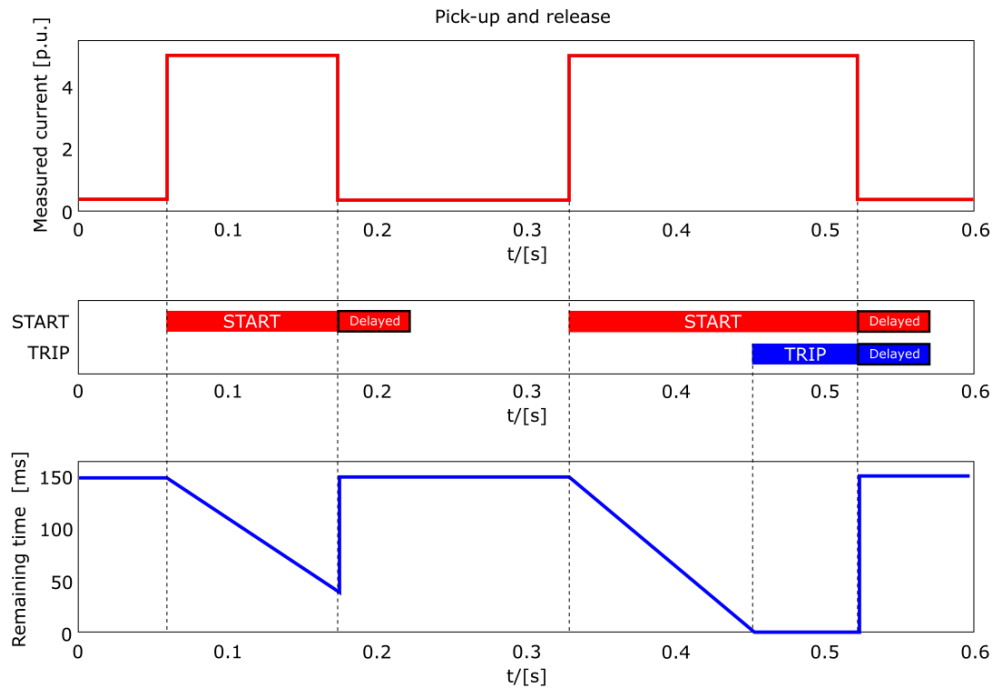


Figure. 4.4.1 - 15. Delayed pick-up release, delay counter value is held during the release time.

Delayed pick-up release: Enabled
Op.time calc reset after release time: Enabled
Continue time calculation during release time: Disabled

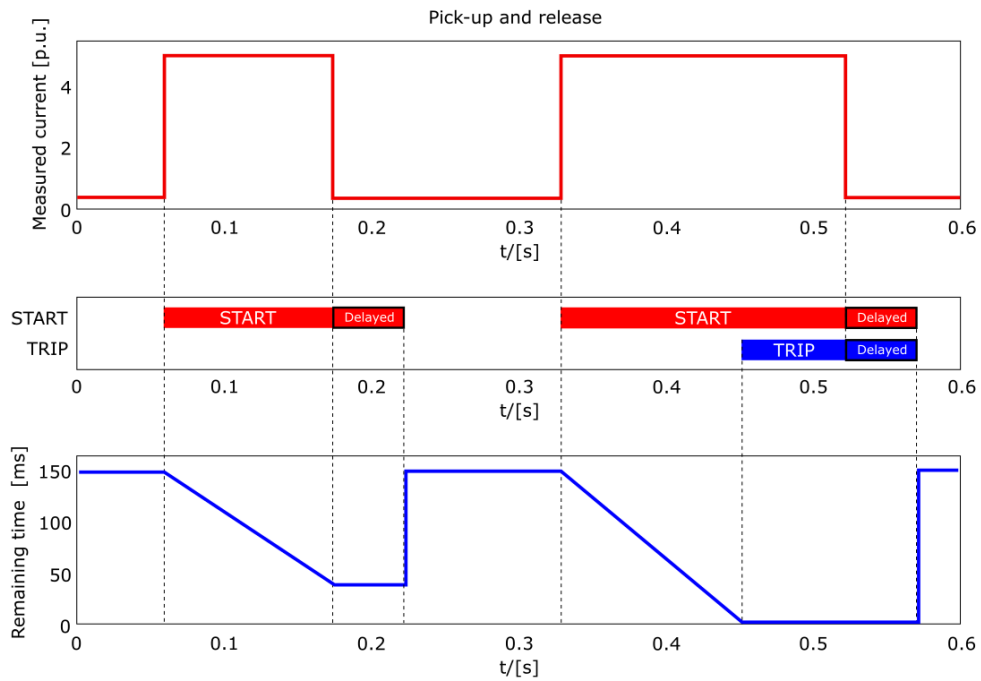
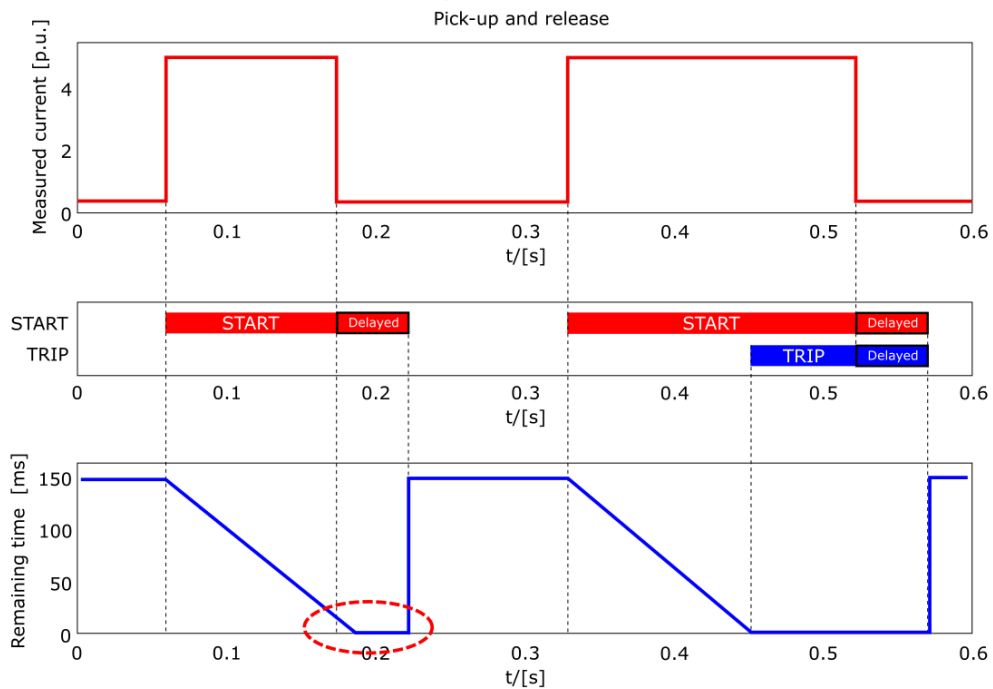


Figure. 4.4.1 - 16. Delayed pick-up release, delay counter value is decreasing during the release time.

Delayed pick-up release: Enabled
Op.time calc reset after release time: Enabled
Continue time calculation during release time: Enabled



Stage forcing

It is possible to test the logic, event processing and the operation of the device's logic by controlling the state of the protection functions manually without injecting any current into the device with stage forcing. To enable *Stage forcing* set the *Enable stage forcing* to ENABLED in the *General* menu. After this it is possible to control the status of a protection function (Normal, Start, Trip, Blocked etc.) in the *Info* page of the function.



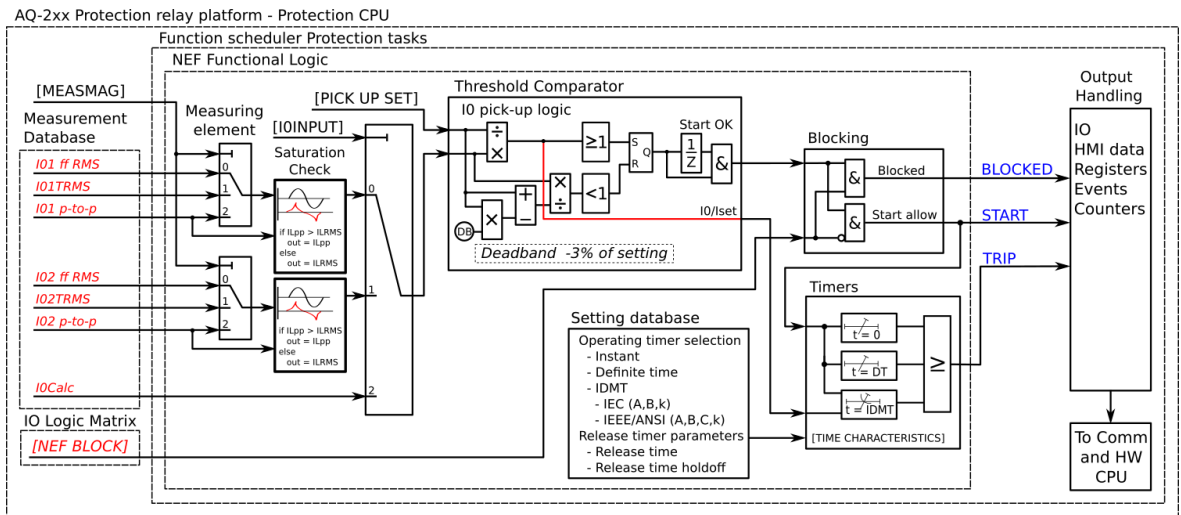
NOTICE!

When *Stage forcing* is enabled protection functions will also change state through user input. Injected currents/voltages also affect the behavior of the device. Regardless, it is recommended to disable *Stage Forcing* after testing has ended.

4.4.2 Non-directional earth fault protection (I0>; 50N/51N)

The non-directional earth fault function is used for instant and time-delayed earth fault protection. The number of stages in the function depend on the device model. The operating characteristics are based on the selected neutral current magnitude which the function measures constantly.

Figure. 4.4.2 - 17. Simplified function block diagram of the I0> function.



Measured input

The function block uses residual current measurement values. The available analog measurement channels are I₀₁ and I₀₂ (residual current measurement) and I_{0Calc} (residual current calculated from phase current). The user can select the monitored magnitude to be equal either to RMS values (fundamental frequency component), to TRMS values from the whole harmonic specter of 32 components, or to peak-to-peak values.

Table. 4.4.2 - 33. Measurement inputs of the I0> function.

Signal	Description
I ₀₁ RMS	Fundamental frequency component of coarse residual current measurement input I01
I ₀₁ TRMS	TRMS measurement of coarse residual current measurement input I01
I ₀₁ PP	Peak-to-peak measurement of coarse residual current measurement input I01

Signal	Description
I02RMS	Fundamental frequency component of sensitive residual current measurement input I02
I02TRMS	TRMS measurement of coarse sensitive current measurement input I02
I02PP	Peak-to-peak measurement of sensitive residual current measurement input I02
I0Calc	Fundamental frequency component of the calculated zero sequence current calculated from the three phase currents

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.2 - 34. General settings of the function.

Name	Range	Default	Description
Setting control from comm bus	<ul style="list-style-type: none"> Disabled Allowed 	Disabled	Activating this parameter permits changing the pick-up level of the protection stage via SCADA.
I0> LN mode	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	On	Set mode of NEF block. This parameter is visible only when Allow setting of individual LN mode is enabled in General menu.
I0> force status to	<ul style="list-style-type: none"> Normal Start Trip Blocked 	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
Measured magnitude	<ul style="list-style-type: none"> RMS TRMS Peak-to-peak 	RMS	Defines which available measured magnitude is used by the function. This parameter is available when "Input selection" has been set to "I01" or "I02".
Measurement side	<ul style="list-style-type: none"> Side 1 Side 2 	Side 1	Defines which current measurement module is used by the function.
Input selection	<ul style="list-style-type: none"> I01 I02 I0Calc 	I01	Defines which measured residual current is used by the function.

Pick-up settings

The I_{0set} setting parameter controls the the pick-up of the I0> function. This defines the maximum allowed measured current before action from the function. The function constantly calculates the ratio between the I_{0set} and the measured magnitude (I_m) for each of the three phases. The reset ratio of 97 % is built into the function and is always relative to the I_{0set} value. The setting value is common for all measured phases. When the I_m exceeds the I_{0set} value (in single, dual or all phases) it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.2 - 35. Pick-up settings.

Name	Range	Step	Default	Description
I _{0set}	0.0001...40.00 × I _N	0.0001 × I _N	1.20 × I _N	Pick-up setting

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.2 - 36. Information displayed by the function.

Name	Range	Step	Description
I ₀ > LN behaviour	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	-	Displays the mode of NEF block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
I ₀ > condition	<ul style="list-style-type: none"> Normal Start Trip Blocked 	-	Displays status of the protection function.
Detected I ₀ angle	-360.00...360.00 deg	0.01 deg	Angle of I ₀ against reference. If phase voltages are available, positive sequence voltage angle is used as reference. If voltages are not available, positive sequence current angle is used as reference.
Detected fault type	<ul style="list-style-type: none"> - A-G-R B-G-F C-G-R A-G-F B-G-R C-G-F 	-	Displays the detected fault type and direction of previous fault. "A/B/C" stand for one of the three phases. "G" stands for "ground". "F" stands for "forward" direction and "R" stands for "reverse" direction.
Expected operating time	-1800.000...1800.000 s	0.005 s	Displays the expected operating time when a fault occurs. When IDMT mode is used, the expected operating time depends on the measured current value. If the measured current changes during a fault, the expected operating time changes accordingly.
Time remaining to trip	0.000...1800.000 s	0.005 s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.
I _{meas} /I _{set} at the moment	0.00...1250.00	0.01	The ratio between the measured current and the pick-up value.

Function blocking

The blocking signal is evaluated at the start of each program cycle. The blocking signals are connected to the function's dedicated input, which can be configured in the *IO* → *Blocking Input Control* tab of the function.

- When the pick-up element activates and the blocking signal is not active, a START signal is generated, and the function starts or continues with the trip time countdown.
- When the pick-up element activates and the blocking signal is active, a BLOCKED signal is generated, and the function does not process the event further.
- When a START signal is already active and the blocking input signal becomes active, the START signal is reset and BLOCKED signal is generated. The release time characteristics are then processed in the same way as when the pick-up signal is reset.

The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

The function also offers an optional internal inrush harmonic blocking feature. If the inrush harmonic pick-up is active at the same time as the protection function pick-up element, the trip delay timer continues counting down as normal. Once the countdown reaches zero, if the pick-up element remains active and the second harmonic value has dropped, the function issues a trip.

Table. 4.4.2 - 37. Internal inrush harmonic blocking settings.

Name	Range	Step	Default	Description
Inrush harmonic blocking (internal-only trip)	<ul style="list-style-type: none"> • No • Yes 	-	<ul style="list-style-type: none"> • No 	Enables and disables the 2 nd harmonic blocking.
2 nd harmonic blocking limit (I _{harm} /I _{fund})	0.10...50.00%I _{fund}	0.01%I _{fund}	0.01%I _{fund}	Defines the limit of the 2 nd harmonic blocking.

Operating time characteristics for trip and reset

This function supports definite time delay (DT) and inverse definite minimum time delay (IDMT). For detailed information on these delay types please refer to the chapter "[General properties of a protection function](#)" and its section "[Operating time characteristics](#)".

Events and registers

The non-directional earth fault function (abbreviated "NEF" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

The function offers four (4) independent stages; the events are segregated for each stage operation.

Table. 4.4.2 - 38. Event messages.

Event block name	Event names
NEF1...NEF4	Start ON/OFF

Event block name	Event names
NEF1...NEF4	Trip ON/OFF
NEF1...NEF4	Block ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.2 - 39. Register content.

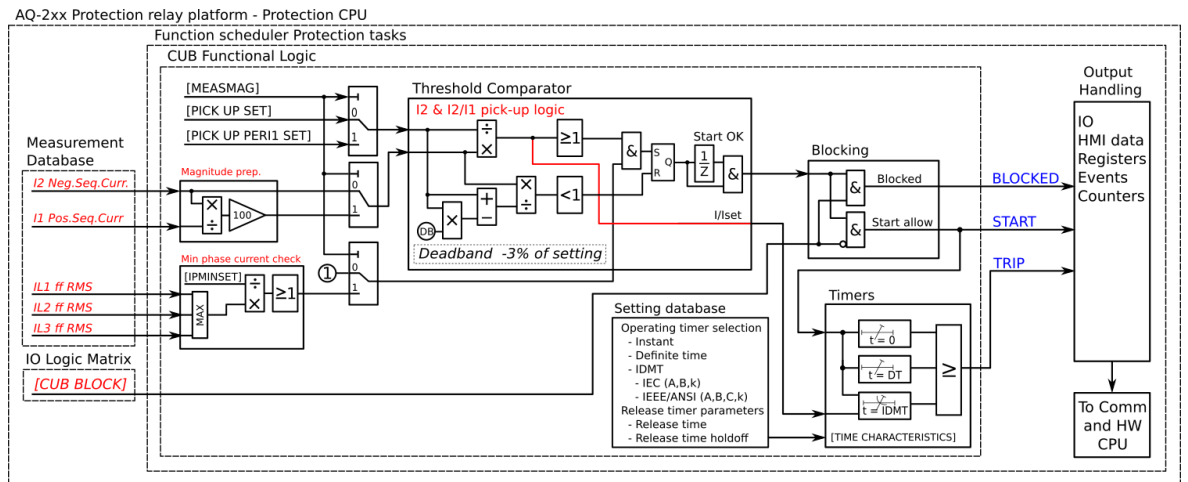
Name	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Fault type	A-G-R...C-G-F
Pre-trigger current	Start/Trip -20ms current
Fault current	Start/Trip current
Pre-fault current	Start -200ms current
Trip time remaining	0 ms...1800s
Setting group in use	Setting group 1...8 active.

4.4.3 Negative sequence overcurrent/ phase current reversal/ current unbalance protection (I2>; 46/46R/46L)

The current unbalance function is used for instant and time-delayed unbalanced network protection and for detecting broken conductors. The number of stages in the function depends on the device model. The operating decisions are based on negative and positive sequence current magnitudes which the function constantly measures. In the broken conductor mode (I2/I1) the minimum allowed loading current is also monitored in the phase current magnitudes.

There are two possible operating modes available: the I2 mode monitors the negative sequence current, while the I2/I1 mode monitors the ratio between the negative sequence current and the positive sequence current. The device calculates the symmetrical component magnitudes in use from the phase current inputs I_{L1} , I_{L2} and I_{L3} . The zero sequence current is also recorded into the registers as well as the angles of the positive, negative and zero sequence currents in order to better verify any fault cases.

Figure. 4.4.3 - 18. Simplified function block diagram of the I2> function.



Measured input

The function block uses positive and negative sequence currents calculated from the phase current measurement channels. In the broken conductor mode (I2/I1) the function also uses fundamental frequency component of all phase currents to check the minimum current. Zero sequence and component sequence angles are used for fault registering and for fault analysis processing.

Table. 4.4.3 - 40. Measurement inputs of the I2> function.

Signal	Description
I1	Positive sequence current magnitude
I2	Negative sequence current magnitude
IZ	Zero sequence current magnitude
I1 ANG	Positive sequence current angle
I2 ANG	Negative sequence current angle
IZ ANG	Zero sequence current angle
IL1RMS	Fundamental frequency component of phase L1 (A) current measurement
IL2RMS	Fundamental frequency component of phase L2 (B) current measurement
IL3RMS	Fundamental frequency component of phase L3 (C) current measurement

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.3 - 41. General settings of the function.

Name	Range	Default	Description
I2> LN mode	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	On	Set mode of CUB block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
I2> force status to	<ul style="list-style-type: none"> Normal Start Trip Blocked 	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
Measurement side	<ul style="list-style-type: none"> Side 1 Side 2 	Side 1	Defines which current measurement module is used by the function. Visible if the unit has more than one current measurement module.
Measured magnitude	<ul style="list-style-type: none"> I2pu I2/I1 	I2pu	Defines whether the ratio between the positive and the negative sequence currents are supervised or whether only the negative sequence is used in detecting unbalance.

Pick-up settings

The setting parameters I_{2set} and $I_{2/I1set}$ control the the pick-up of the I2> function. They define the maximum allowed measured negative sequence current or the negative/positive sequence current ratio before action from the function. The function constantly calculates the ratio between the I_{set} and the measured magnitude (I_m). The reset ratio of 97 % is built into the function and is always relative to the I_{xset} value. The reset ratio is the same for both modes.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.3 - 42. Pick-up settings.

Name	Range	Step	Default	Description
I2set	0.01...40.00×I _n	0.01×I _n	0.2×I _n	Pick-up setting for I2 mode
I2/I1set	1...200%	0.01%	20%	Pick-up setting for I2/I1 mode

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.3 - 43. Information displayed by the function.

Name	Range	Description
I2> LN behaviour	On Blocked Test Test/ Blocked Off	Displays the mode of CUB block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
I2> condition	Normal Start Trip Blocked	Displays the status of the protection function.

Function blocking

The blocking signal is evaluated at the start of each program cycle. The blocking signals are connected to the function's dedicated input, which can be configured in the *IO* → *Blocking Input Control* tab of the function.

- When the pick-up element activates and the blocking signal is not active, a START signal is generated, and the function starts or continues with the trip time countdown.
- When the pick-up element activates and the blocking signal is active, a BLOCKED signal is generated, and the function does not process the event further.
- When a START signal is already active and the blocking input signal becomes active, the START signal is reset and BLOCKED signal is generated. The release time characteristics are then processed in the same way as when the pick-up signal is reset.

The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

The operating timers' behavior during a function can be set for TRIP signal and also for the release of the function in case the pick-up element is reset before the trip time has been reached. There are three basic operating modes available for the function:

- Instant operation: gives the TRIP signal with no additional time delay simultaneously with the start signal.
- Definite time operation (DT): gives the TRIP signal after a user-defined time delay regardless of the measured current as long as the current is above or below the i_{set} value and thus the pick-up element is active (independent time characteristics).
- Inverse definite minimum time (IDMT): gives the TRIP signal after a time which is in relation to the set pick-up value I_{set} and the measured current I_m (dependent time characteristics).

Both IEC and IEEE/ANSI standard characteristics as well as user settable parameters are available for the IDMT operation.

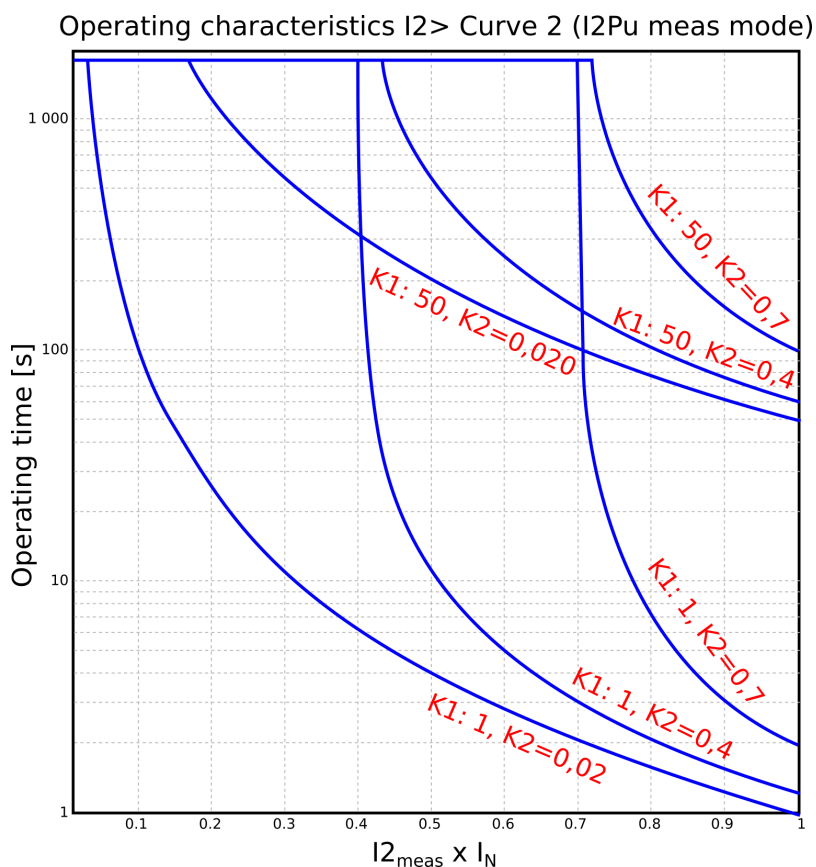
Unique to the current unbalance protection is the availability of the "Curve2" delay which follows the formula below:

$$t = \frac{k}{I_{2meas}^2 - I_{set}^2}$$

- t = Operating time
- I_{2meas} = Calculated negative sequence

- k = Constant k value (user settable delay multiplier)
- I_{set} = Pick-up setting of the function

Figure. 4.4.3 - 19. Operation characteristics curve for I2> Curve2.



For a more detailed description on the time characteristics and their setting parameters, please refer to the "[General properties of a protection function](#)" chapter and its "[Operating time characteristics](#)" section.

Events and registers

The current unbalance function (abbreviated "CUB" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

The function offers four (4) independent stages; the events are segregated for each stage operation.

Table. 4.4.3 - 44. Event messages.

Event block name	Event names
CUB1...CUB4	Start ON/OFF
CUB1...CUB4	Trip ON/OFF
CUB1...CUB4	Block ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

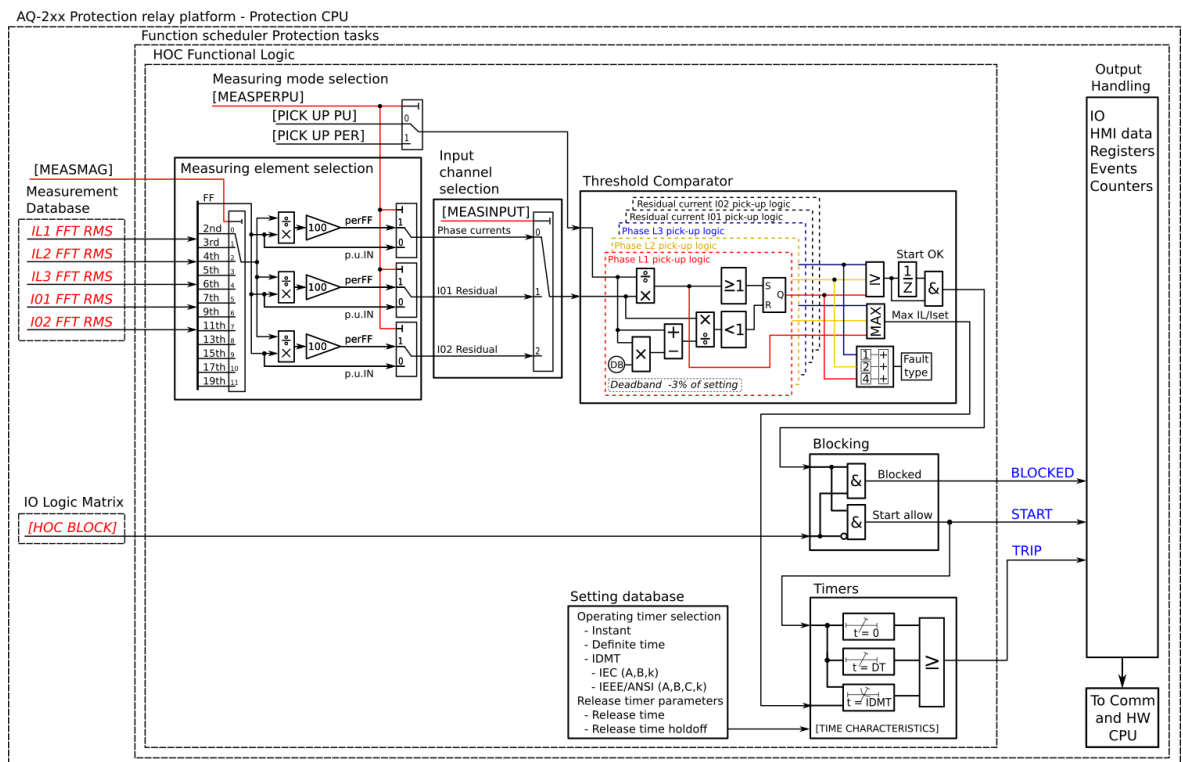
Table. 4.4.3 - 45. Register content.

Register	Description
Event	Event name
Date and time	dd.mm.yyyy hh:mm:ss.mss
Pre-trigger current	Start/Trip -20ms current
Fault current	Start/Trip current
Pre-fault current	Start -200ms current
Fault currents	I1, I2, IZ mag. and ang.
Trip time remaining	0 ms...1800s
Setting group in use	Setting group 1...8 active

4.4.4 Harmonic overcurrent protection (Ih>; 50H/51H/68H)

The harmonic overcurrent function is used for non-directional instant and time-delayed overcurrent detection and clearing. The number of stages in the function depends on the device model. The function constantly measures the selected harmonic component of the selected measurement channels, the value being either absolute value or relative to the RMS value.

Figure. 4.4.4 - 20. Simplified function block diagram of the Ih> function.



Measured input

The function block uses analog current measurement values from phase or residual currents. Each measurement input of the function block uses RMS (fundamental frequency component) values and harmonic components of the selected current input. The user can select the monitored magnitude to be equal to the per-unit RMS values of the harmonic component, or to the harmonic component percentage content compared to the RMS values.

Table. 4.4.4 - 46. Measurement inputs of the lh> function.

Signal	Description
I _{L1} FFT	<p>The magnitudes (RMS) of phase L1 (A) current components:</p> <ul style="list-style-type: none"> - Fundamental - 2nd harmonic - 3rd harmonic - 4th harmonic - 5th harmonic - 6th harmonic - 7th harmonic - 9th harmonic - 11th harmonic - 13th harmonic - 15th harmonic - 17th harmonic - 19th harmonic.
I _{L2} FFT	<p>The magnitudes (RMS) of phase L2 (B) current components:</p> <ul style="list-style-type: none"> - Fundamental - 2nd harmonic - 3rd harmonic - 4th harmonic - 5th harmonic - 6th harmonic - 7th harmonic - 9th harmonic - 11th harmonic - 13th harmonic - 15th harmonic - 17th harmonic - 19th harmonic.

Signal	Description
I _{L3} FFT	The magnitudes (RMS) of phase L3 (C) current components: <ul style="list-style-type: none"> - Fundamental - 2nd harmonic - 3rd harmonic - 4th harmonic - 5th harmonic - 6th harmonic - 7th harmonic - 9th harmonic - 11th harmonic - 13th harmonic - 15th harmonic - 17th harmonic - 19th harmonic.
I ₀₁ FFT	The magnitudes (RMS) of residual I ₀₁ current components: <ul style="list-style-type: none"> - Fundamental - 2nd harmonic - 3rd harmonic - 4th harmonic - 5th harmonic - 6th harmonic - 7th harmonic - 9th harmonic - 11th harmonic - 13th harmonic - 15th harmonic - 17th harmonic - 19th harmonic.
I ₀₂ FFT	The magnitudes (RMS) of residual I ₀₂ current components: <ul style="list-style-type: none"> - Fundamental - 2nd harmonic - 3rd harmonic - 4th harmonic - 5th harmonic - 6th harmonic - 7th harmonic - 9th harmonic - 11th harmonic - 13th harmonic - 15th harmonic - 17th harmonic - 19th harmonic.

General settings

The function can be set to monitor the ratio between the measured harmonic and either the measured fundamental component or the per unit value of the harmonic current. The user must select the correct measurement input.

Table. 4.4.4 - 47. Operating mode selection settings.

Name	Range	Default	Description
lh> LN mode	<ul style="list-style-type: none"> • On • Blocked • Test • Test/ Blocked • Off 	On	Set mode of HOC block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
lh> force status to	<ul style="list-style-type: none"> • Normal • Start • Trip • Blocked 	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
lh> measurement side	<ul style="list-style-type: none"> • Side 1 • Side 2 	Side 1	Defines which current measurement module is used by the function. Visible if the unit has more than one current measurement module.
Harmonic selection	<ul style="list-style-type: none"> • 2nd harmonic • 3rd harmonic • 4th harmonic • 5th harmonic • 6th harmonic • 7th harmonic • 9th harmonic • 11th harmonic • 13th harmonic • 15th harmonic • 17th harmonic • 19th harmonic 	2 nd harmonic	Selection of the monitored harmonic component.
Per unit or relative	<ul style="list-style-type: none"> • $\times I_n$ • lh/IL 	$\times I_n$	Selection of the monitored harmonic mode. Either directly per unit $\times I_n$ or in relation to the fundamental frequency magnitude.
Measurement input	<ul style="list-style-type: none"> • IL1/IL2/ IL3 • I01 • I02 	IL1/IL2/ IL3	Selection of the measurement input (either phase current or residual current).

Pick-up settings

The setting parameter I_{hset} per unit or I_h/IL (depending on the selected operating mode) controls the pick-up of the $I_h >$ function. This defines the maximum allowed measured current before action from the function. The function constantly calculates the ratio between the I_{hset} per unit or I_h/IL and the measured magnitude (I_m) for each of the three phases. The reset ratio of 97 % is built into the function and is always relative to the I_{hset} per unit or I_h/IL value. The setting value is common for all measured phases, and when the I_m exceeds the I_{set} value (in single, dual or all phases) it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.4 - 48. Pick-up settings.

Name	Range	Step	Default	Description
I_{hset} pu	0.05...2.00× I_n	0.01× I_n	0.20× I_n	Pick-up setting (per unit monitoring)
I_h/IL	5.00...200.00%	0.01%	20.00%	Pick-up setting (percentage monitoring)

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.4 - 49. Information displayed by the function.

Name	Range	Step	Description
$I_h >$ behaviour	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	-	Displays the mode of HOC block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
$I_h >$ condition	<ul style="list-style-type: none"> Normal Start Trip Blocked 	-	Displays the status of the protection function.
I_h meas/ I_h set now	0.00...100000.00 I_m/I_{set}	0.01 I_m/I_{set}	The ratio between the monitored residual current and the pick-up value.
Expected operating time	0.000...1800.000s	0.005s	Displays the expected operating time when a fault occurs. When IDMT mode is used, the expected operating time depends on the measured voltage value. If the measured voltage changes during a fault, the expected operating time changes accordingly.
Time remaining to trip	-1800.000...1800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.

Function blocking

The blocking signal is evaluated at the start of each program cycle. The blocking signals are connected to the function's dedicated input, which can be configured in the *IO* → *Blocking Input Control* tab of the function.

- When the pick-up element activates and the blocking signal is not active, a START signal is generated, and the function starts or continues with the trip time countdown.
- When the pick-up element activates and the blocking signal is active, a BLOCKED signal is generated, and the function does not process the event further.
- When a START signal is already active and the blocking input signal becomes active, the START signal is reset and BLOCKED signal is generated. The release time characteristics are then processed in the same way as when the pick-up signal is reset.

The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

This function supports definite time delay (DT) and inverse definite minimum time delay (IDMT). For detailed information on these delay types please refer to the chapter "[General properties of a protection function](#)" and its section "[Operating time characteristics](#)".

Events and registers

The harmonic overcurrent function (abbreviated "HOC" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The START signal can be used to block other stages; if the situation lasts longer, the TRIP signal can be used on other actions as time-delayed. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

The function offers four (4) independent stages; the events are segregated for each stage operation.

Table. 4.4.4 - 50. Event description.

Event block name	Event names
HOC1...HOC4	Start ON/OFF
HOC1...HOC4	Trip ON/OFF
HOC1...HOC4	Block ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.4 - 51. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss

Register	Description
Event	Event name
Fault type	L1-G...L1-L2-L3
Pre-trigger current	Start/Trip -20ms current
Fault current	Start/Trip current
Pre-fault current	Start -200ms current
Trip time remaining	0 ms...1800s
Setting group in use	Setting group 1...8 active

4.4.5 Circuit breaker failure protection (CBFP; 50BF/52BF)

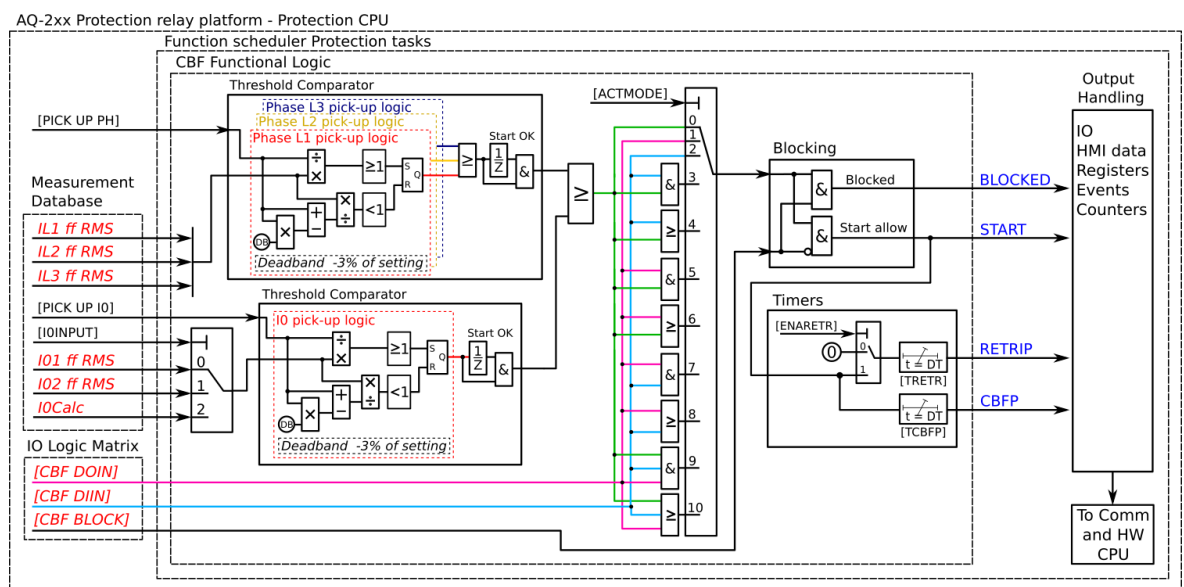
The circuit breaker failure protection function is used for monitoring the circuit breaker operation after it has received a TRIP signal. The function can also be used to retrip a failing breaker; if the retrip fails, an incoming feeder circuit breaker can be tripped by using the function's CBFP output. The retrip functionality can be disabled if the breaker does not have two trip coils.

The function can be triggered by the following:

- overcurrent (phase and residual)
- digital output monitor
- digital signal
- any combination of the above-mentioned triggers.

In the current-dependent mode the function constantly measures phase current magnitudes and the selected residual current. In the signal-dependent mode any of the device's binary signals (trips, starts, logical signals etc.) can be used to trigger the function. In the digital output-dependent mode the function monitors the status of the selected output relay control signal.

Figure. 4.4.5 - 21. Simplified function block diagram of the CBFP function.



Measured input

The function block uses fundamental frequency component of phase current and residual current measurement values. The user can select I01, I02 or the calculated I0 for the residual current measurement.

Table. 4.4.5 - 52. Measurement inputs of the CBFP function.

Signal	Description
I _{L1} RMS	Fundamental frequency component of phase L1 (A) current measurement
I _{L2} RMS	Fundamental frequency component of phase L2 (B) current measurement
I _{L3} RMS	Fundamental frequency component of phase L3 (C) current measurement
I ₀₁ RMS	Fundamental frequency component of residual input I ₀₁ measurement
I ₀₂ RMS	Fundamental frequency component of residual input I ₀₂ measurement
I _{0Calc}	Calculated residual current from the phase current inputs

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.5 - 53. CBFP monitoring signal definitions.

Name	Description
Signal in monitor	Defines which TRIP events of the used protection functions trigger the CBFP countdown. For the CBFP function to monitor the signals selected here, the "Operation mode selection" parameter must be set to a mode that includes signals (e.g. "Signals only", "Signals or DO", "Current and signals and DO").
Trip monitor	Defines which output relay of the used protection functions trigger the CBFP countdown. For the CBFP function to monitor the output relays selected here, the "Operation mode selection" parameter must be set to a mode that includes digital outputs (e.g. "DO only", "Current and DO", "Current or signals or DO").

Table. 4.4.5 - 54. General settings of the function.

Name	Range	Default	Description
CBFP LN mode	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	On	Set mode of CBF block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
CBFP force status to	<ul style="list-style-type: none"> • Normal • Start • ReTrip • CBFP • Blocked 	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.

Name	Range	Default	Description
Measurement side	<ul style="list-style-type: none"> Side 1 Side 2 	Side 1	Defines which current measurement module is used by the function.

Pick-up settings

The setting parameters I_{set} and I_{Oset} control the pick-up and the activation of the current-dependent CBFP function. They define the minimum allowed measured current before action from the function. The function constantly calculates the ratio between the I_{set} or the I_{Oset} and the measured magnitude (I_m) for each of the three phases and the selected residual current input. The reset ratio of 97 % is built into the function and is always relative to the I_{set} value. The setting value is common for all measured phases. When the I_m exceeds the I_{set} value (in single, dual or all phases) it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.5 - 55. Operating mode and input signals selection.

Name	Range	Step	Default	Description
I0Input	<ul style="list-style-type: none"> Not in use I01 I02 I0Calc 	-	Not in use	Selects the residual current monitoring source, which can be either from the two separate residual measurements (I01 and I02) or from the phase current's calculated residual current.
Actmode	<ul style="list-style-type: none"> Current only DO only Signals only Current and DO Current or DO Current and signals Current or signals Signals and DO Signals or DO Current or DO or signals Current and DO and Signals 	-	Current only	Selects the operating mode. The mode can be dependent on current measurement, binary signal status, output relay status ("DO"), or a combination of the three.

Table. 4.4.5 - 56. Pick-up settings.

Name	Range	Step	Default	Description
I _{set}	0.01...40.00×I _n	0.01×I _n	0.20×I _n	The pick-up threshold for the phase current measurement. This setting limit defines the upper limit for the phase current pick-up element.
I _{0set}	0.005...40.000×I _n	0.001×I _n	1.200×I _n	The pick-up threshold for the residual current measurement. This setting limit defines the upper limit for the phase current pick-up element.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.5 - 57. Information displayed by the function.

Name	Range	Description
CBFP LN behaviour	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	<p>Displays the mode of CBF block.</p> <p>This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.</p>
CBFP condition	<ul style="list-style-type: none"> • Normal • Start • ReTrip • CBFP On • Blocked 	<p>Displays status of the protection function.</p>

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and processes the release time characteristics similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics

The operating timers' behavior during a function can be set depending on the application. The same pick-up signal starts both timers. When retrip is used the time grading should be set as follows: the sum of specific times (i.e. the retrip time, the expected operating time, and the pick-up conditions' release time) is shorter the set CBFP time. This way, when retripping another breaker coil clears the fault, any unnecessary function triggers are avoided.

The following table presents the setting parameters for the function's operating time characteristics.

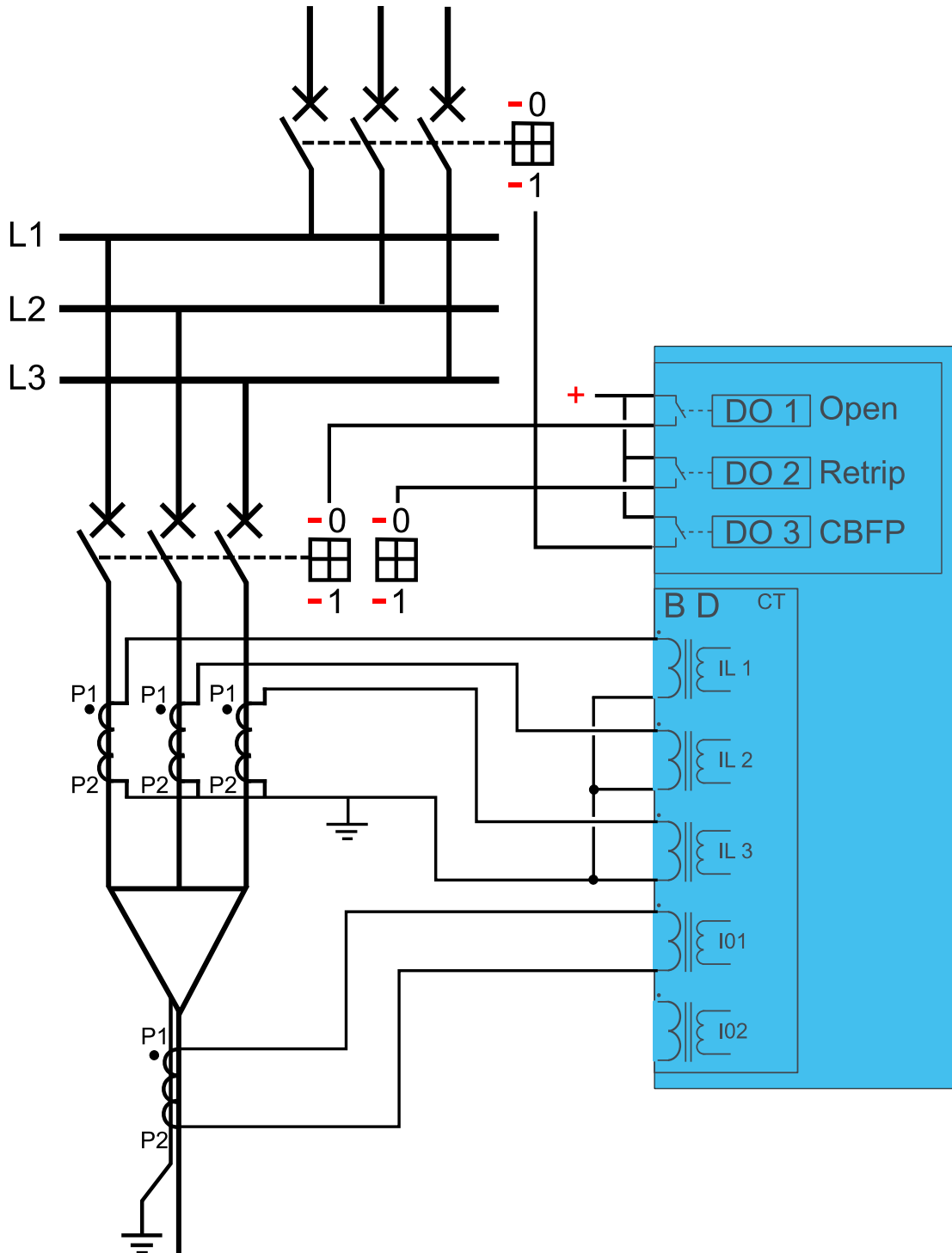
Table. 4.4.5 - 58. Setting parameters for operating time characteristics.

Name	Range	Step	Default	Description
Retrip	<ul style="list-style-type: none"> • No • Yes 	-	Yes	Retrip enabled or disabled. When the retrip is disabled, the output will not be visible and the TRetr setting parameter will not be available.
Retrip time delay	0.000...1800.000s	0.005s	0.100s	Retrip start the timer. This setting defines how long the starting condition has to last before a RETRIP signal is activated.
CBFP	0.000...1800.000s	0.005s	0.200s	CBFP starts the timer. This setting defines how long the starting condition has to last before the CBFP signal is activated.

The following figures present some typical cases of the CBFP function.

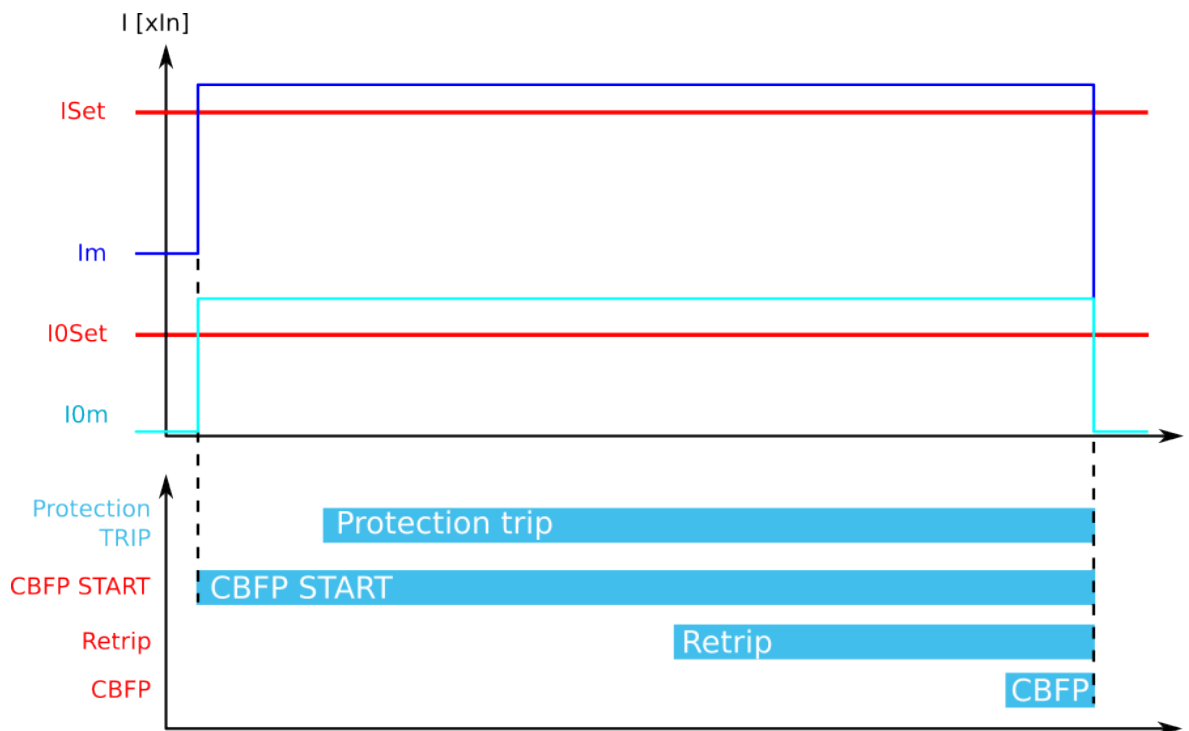
Trip, Retrip and CBFP in the device configuration

Figure. 4.4.5 - 22. Wiring diagram when Trip, Retrip and CBFP are configured to the device.



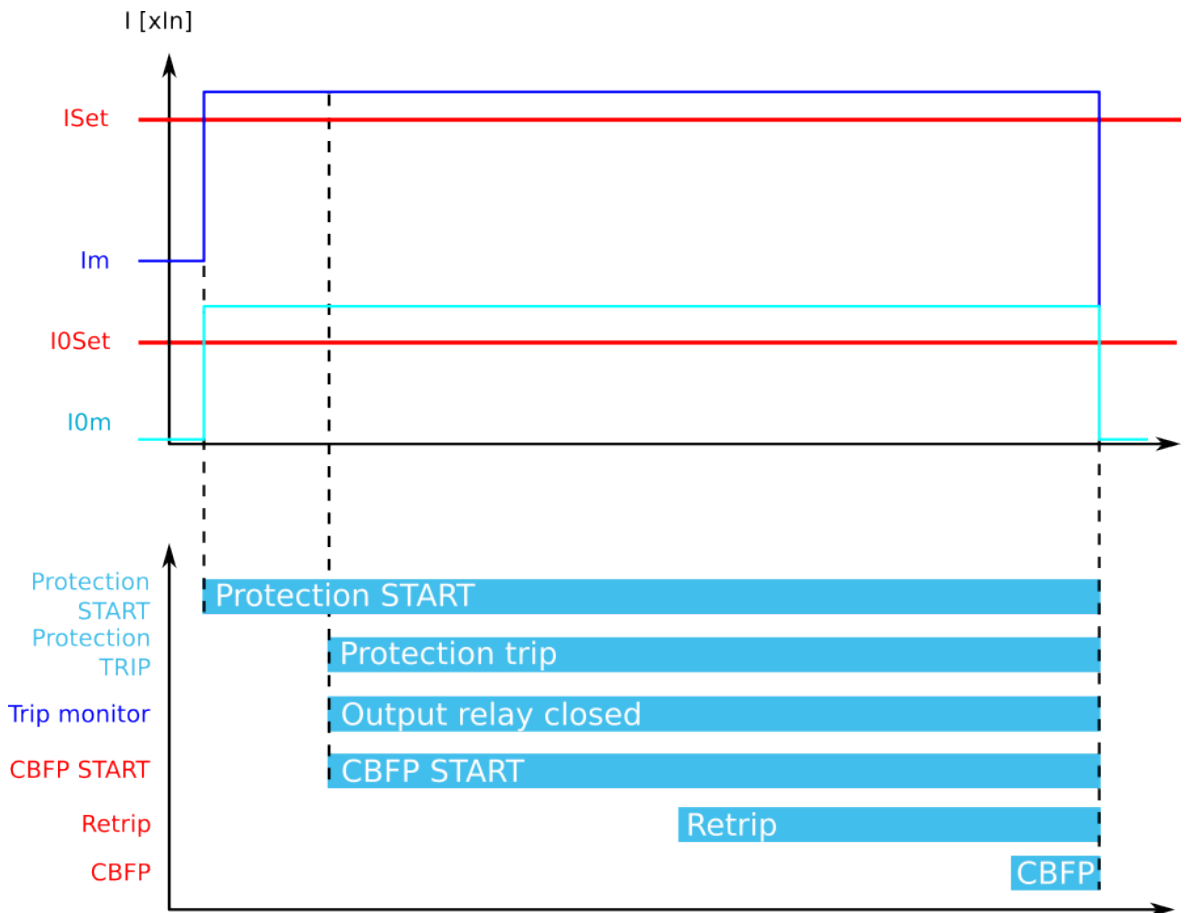
The retrip functionality can be used in applications whose circuit breaker has a retrip or a redundant trip coil available. The TRIP signal is normally wired to the breaker's trip coil from the device's trip output. The retrip is wired from its own device output contact in parallel with the circuit breaker's redundant trip coil. The CBFP signal is normally wired from its device output contact to the incoming feeder circuit breaker. Below are a few operational cases regarding the various applications.

Figure. 4.4.5 - 23. Retrip and CBFP when "Current" is the selected criterion.



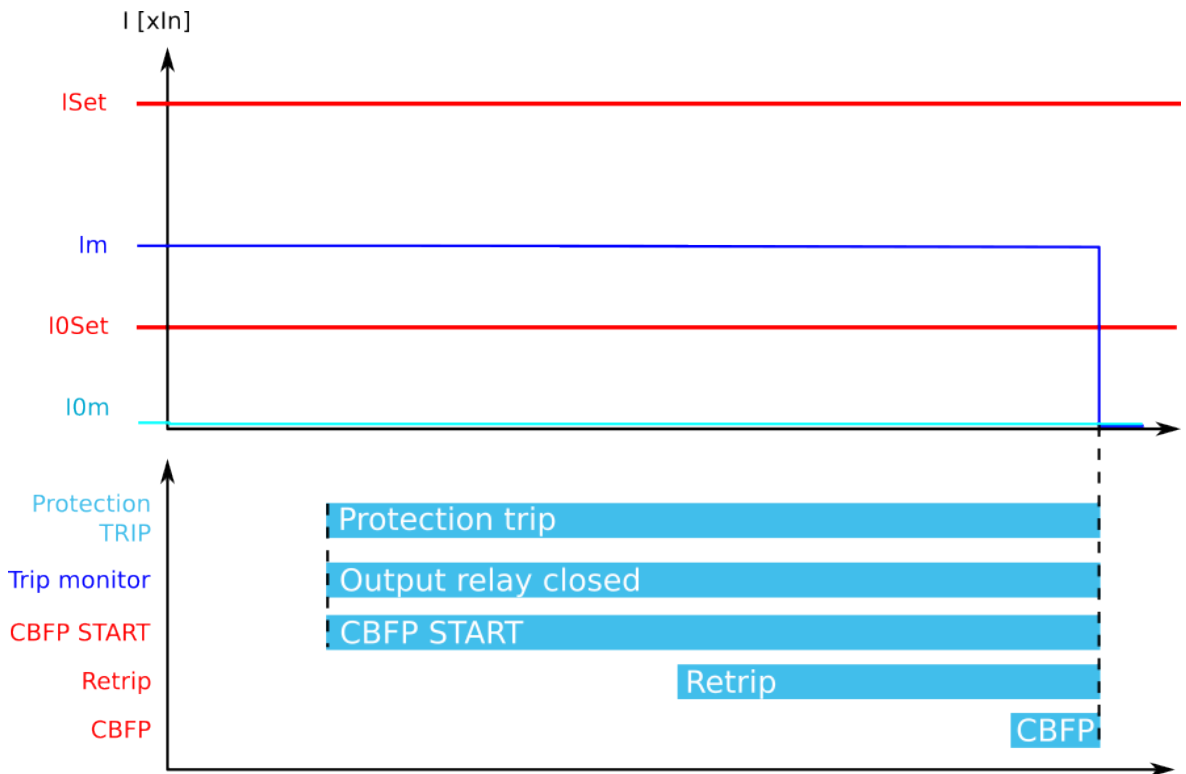
When the current threshold setting of I_{Set} and/or $I_{O_{Set}}$ is exceeded, the current-based protection is activated and the counters for RETRIP and CBFP start calculating the set operating time. The tripping of the primary protection stage is not monitored in this configuration. Therefore, if the current is not reduced below the setting limit, a RETRIP signal is sent to the redundant trip coil. If the current is not reduced within the set time limit, the function also sends a CBFP signal to the incoming feeder breaker. If the primary protection function clears the fault, both counters (RETRIP and CBFP) are reset as soon as the measured current is below the threshold settings.

Figure. 4.4.5 - 24. Retrip and CBFP when "Current and DO" is the selected criterion.



When the current threshold setting of I_{set} and/or I_{Oset} is exceeded, the current-based protection is activated. At the same time, the counters for RETRIP and CBFP are halted until the monitored output contact is controlled (that is, until the primary protection operates). When the tripping signal reaches the primary protection stage, the RETRIP and CBFP counters start calculating the set operating time. The tripping of the primary protection stage is constantly monitored in this configuration. If the current is not reduced below the setting limit or the primary stage tripping signal is not reset, a RETRIP signal is sent to the redundant trip coil. If the retripping fails and the current is not reduced below the setting limit or the primary stage tripping signal is not reset, the function also sends a CBFP signal to the incoming feeder circuit breaker. If the primary protection function clears the fault, both counters (RETRIP and CBFP) are reset as soon as the measured current is below the threshold settings or the tripping signal is reset. This configuration allows the CBFP to be controlled with current-based functions alone, and other function trips can be excluded from the CBFP functionality.

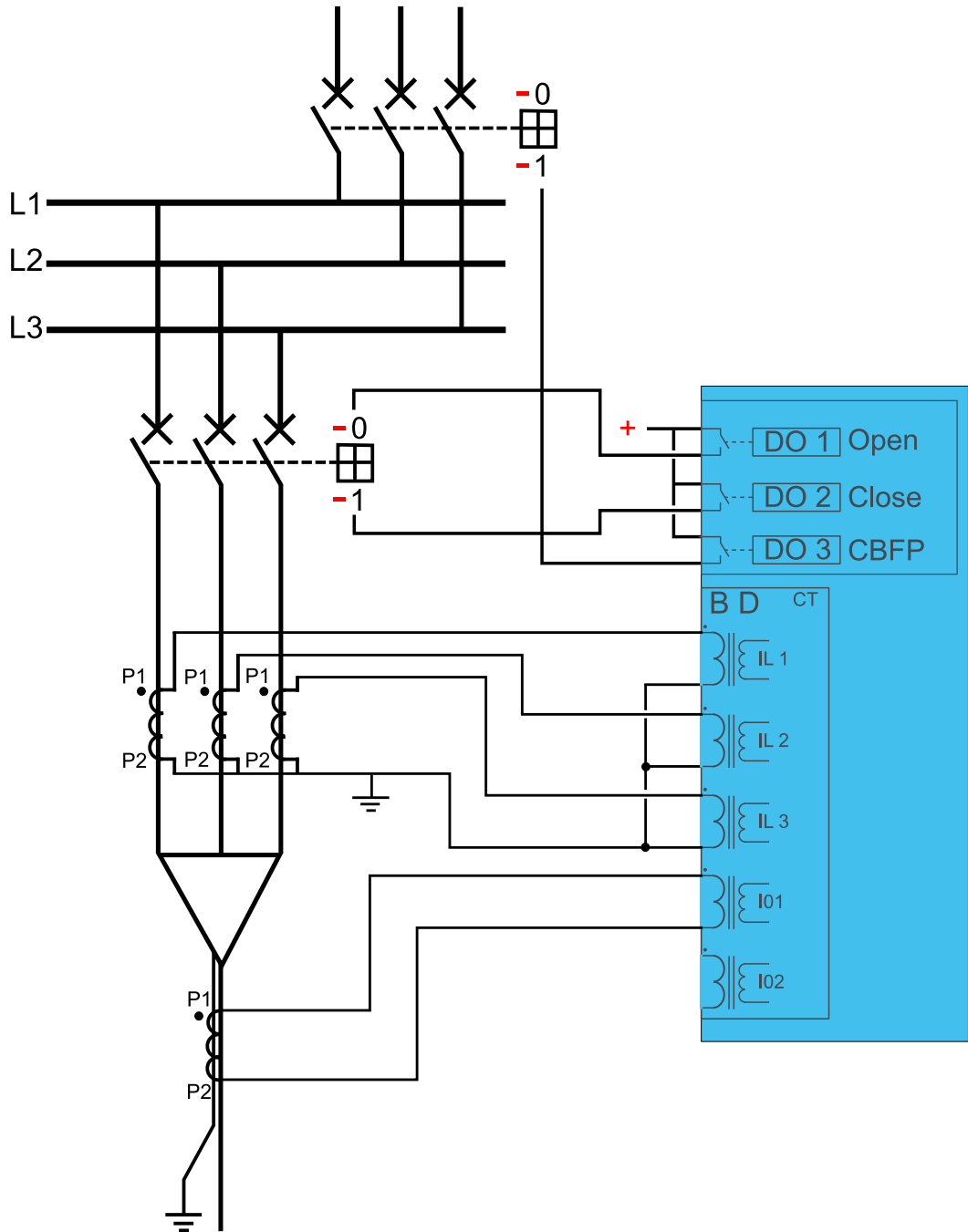
Figure. 4.4.5 - 25. Retrip and CBFP when "Current or DO" is the selected criterion.



When the current threshold setting of I_{set} and/or I_{Oset} is exceeded, or the TRIP signal reaches the primary protection stage, the function starts counting down towards the RETRIP and CBFP signals. The tripping of the primary protection stage is constantly monitored in this configuration regardless of the current's status. The pick-up of the CBFP is active unless the current is reduced below the setting limit and the primary stage tripping signal is reset. If either of these conditions is met (i.e. the current is above the limit or the signal is active) for the duration of the set RETRIP time delay, a RETRIP signal is sent to the redundant trip coil. If either of the conditions is active for the duration of the set CBFP time delay, a CBFP signal is sent to the incoming feeder circuit breaker. If the primary protection function clears the fault, both counters (RETRIP and CBFP) are reset as soon as the measured current is below the threshold settings and the tripping signal is reset. This configuration allows the CBFP to be controlled with current-based functions alone, with added security from current monitoring. Other function trips can also be included in the CBFP functionality.

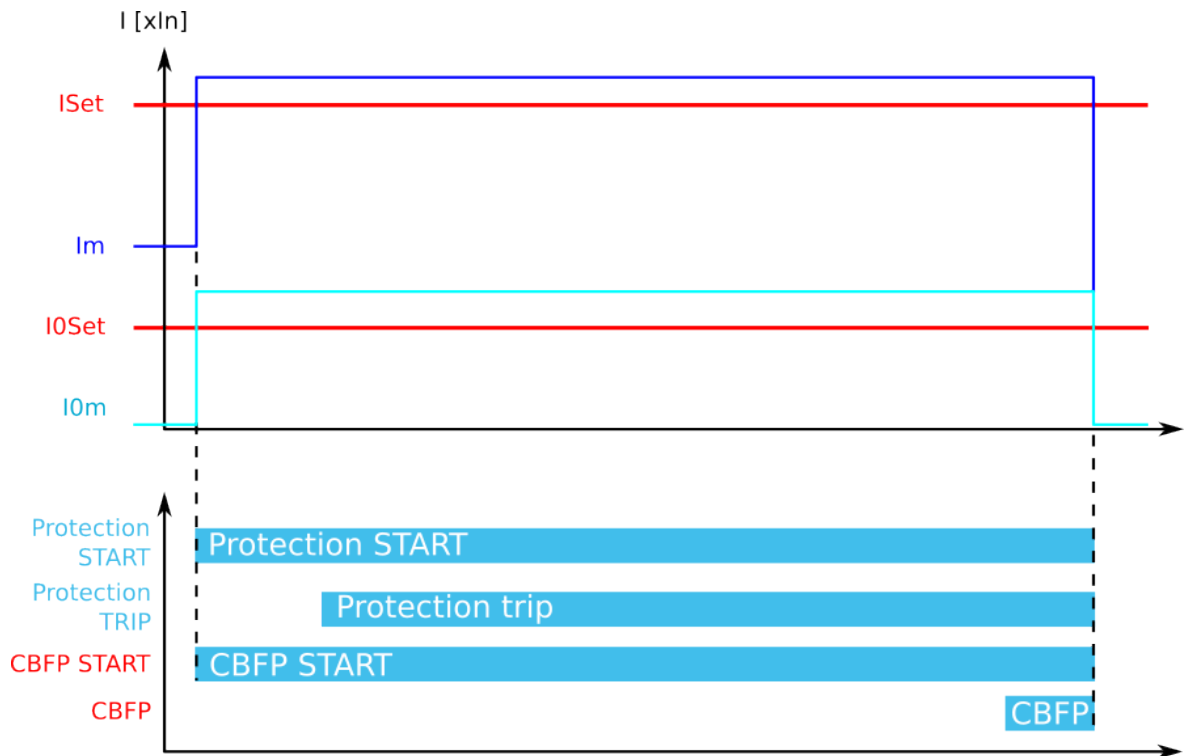
Trip and CBFP in the device configuration

Figure. 4.4.5 - 26. Wiring diagram when Trip and CBFP are configured to the device.



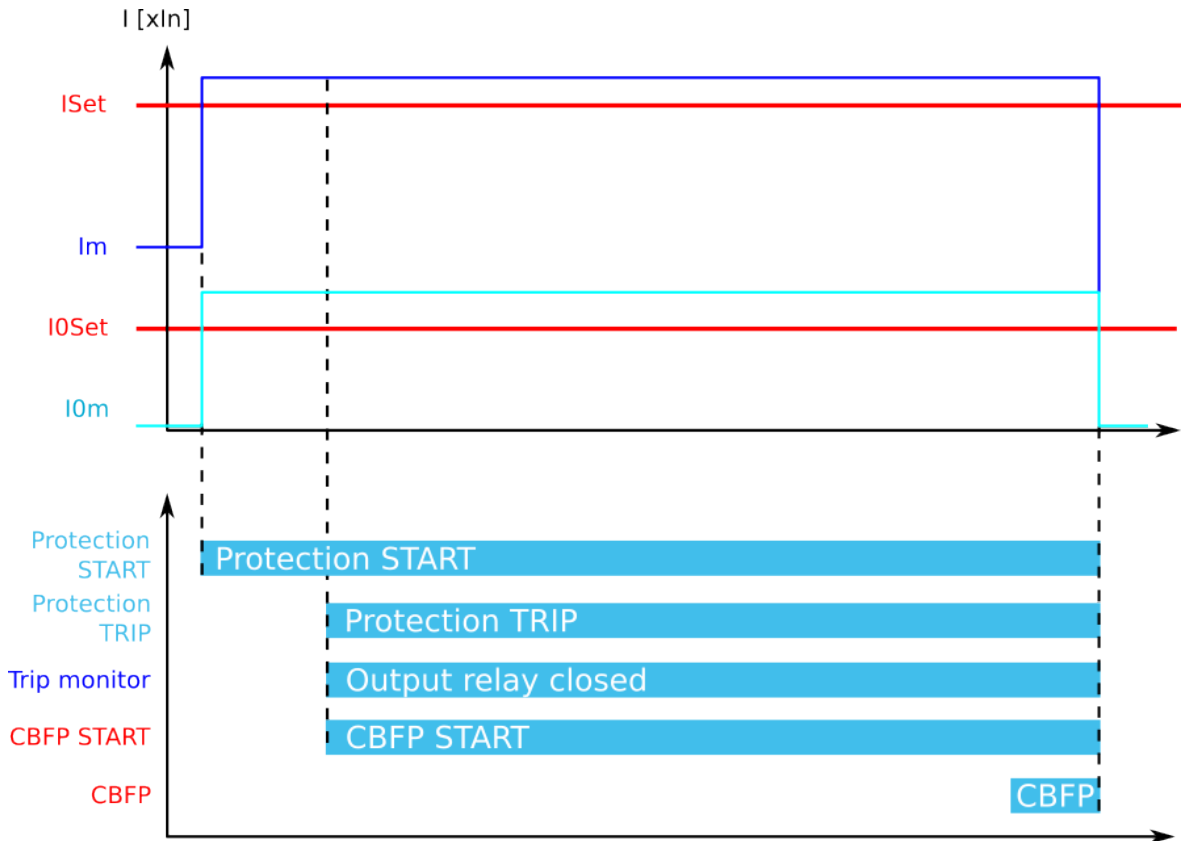
Probably the most common application is when the device's trip output controls the circuit breaker trip coil, while one dedicated CBFP contact controls the CBFP function. Below are a few operational cases regarding the various applications and settings of the CBFP function.

Figure. 4.4.5 - 27. CBFP when "Current" is the selected criterion.



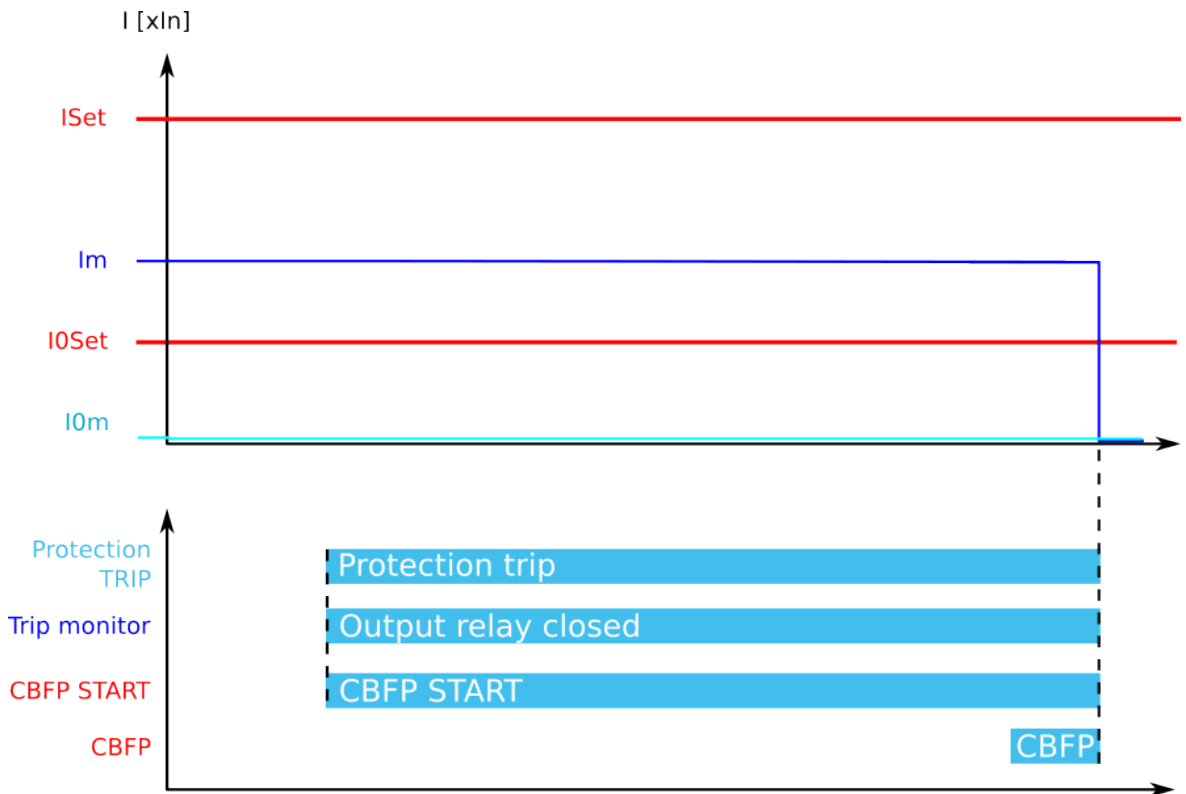
When the current threshold setting of I_{Set} and/or I_{OSet} is exceeded, the current-based protection is activated and the counter for CBFP starts calculating the set operating time. The tripping of the primary protection stage is not monitored in this configuration. Therefore, if the current is not reduced below the setting limit, a CBFP signal is sent to the incoming feeder circuit breaker. If the primary protection function clears the fault, the counter for CBFP resets as soon as the measured current is below the threshold settings.

Figure. 4.4.5 - 28. CBFP when "Current and DO" is the selected criterion.



When the current threshold setting of I_{set} and/or I_{Oset} is exceeded, the current-based protection is activated. At the same time, the counter for CBFP is halted until the monitored output contact is controlled (that is, until the primary protection operates). When the tripping signal reaches the primary protection stage, the CBFP counter starts calculating the set operating time. The tripping of the primary protection stage is constantly monitored in this configuration. If the current is not reduced below the setting limit or the primary stage tripping signal is not reset, a CBFP signal is sent to the incoming feeder circuit breaker. The time delay counter for CBFP is reset as soon as the measured current is below the threshold settings or the tripping signal is reset. This configuration allows the CBFP to be controlled by current-based functions alone, and other function trips can be excluded from the CBFP functionality.

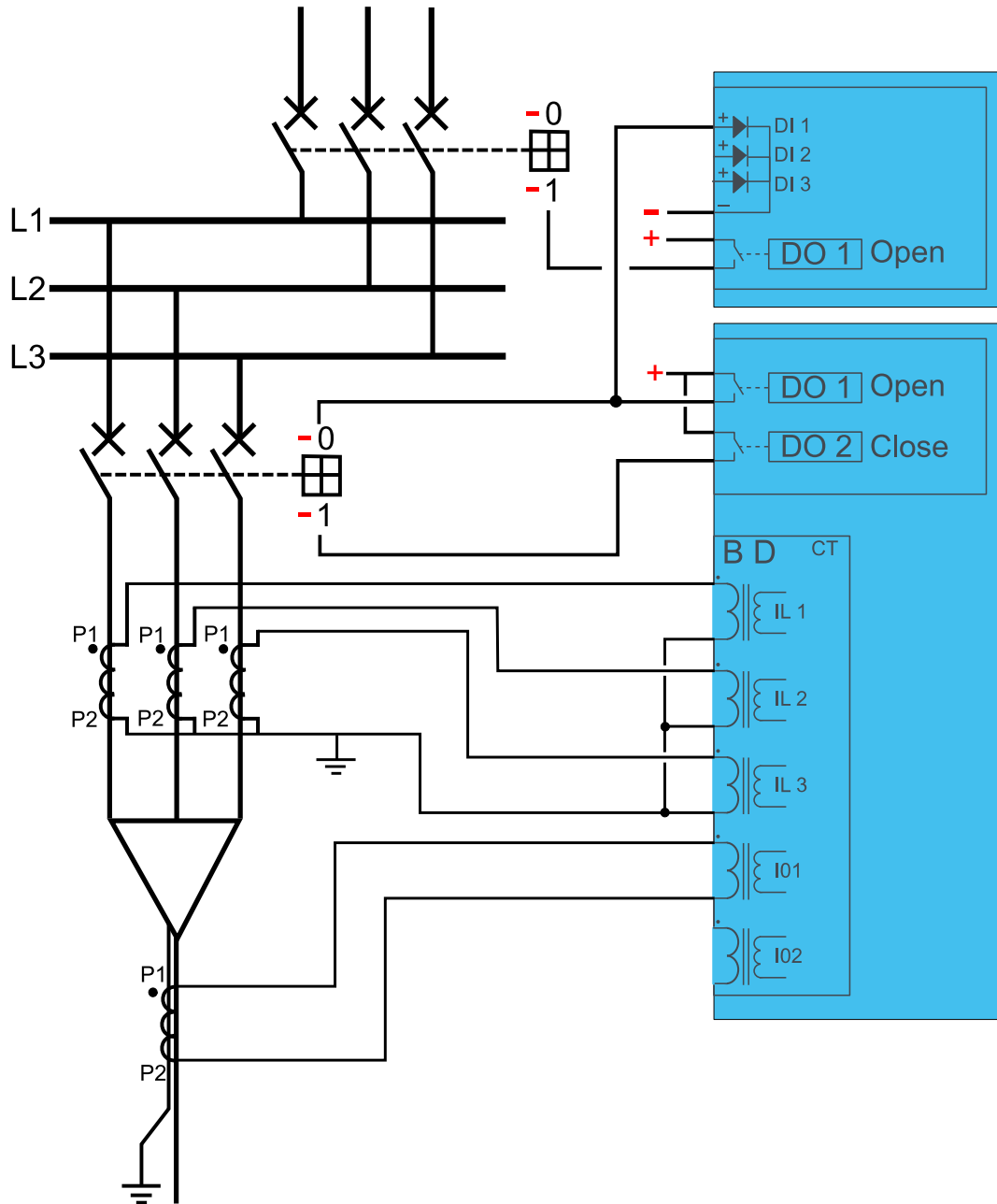
Figure. 4.4.5 - 29. CBFP when "Current or DO" is the selected criterion.



When the current threshold setting of I_{Set} and/or I_{OSet} is exceeded, or the TRIP signal reaches the primary protection stage, the function starts counting down towards the CBFP signal. The tripping of the primary protection stage is constantly monitored in this configuration regardless of the current's status. The pick-up of the CBFP is active unless the current is reduced below the setting limit and the primary stage tripping signal is reset. If either of these conditions is met (i.e. the current is above the limit or the signal is active) for the duration of the set CBFP time delay, a CBFP signal is sent to the incoming feeder circuit breaker. The time delay counter for CBFP is reset as soon as the measured current is below the threshold settings and the tripping signal is reset. This configuration allows the CBFP to be controlled by current-based functions alone, with added security from current monitoring. Other function trips can also be included to the CBFP functionality.

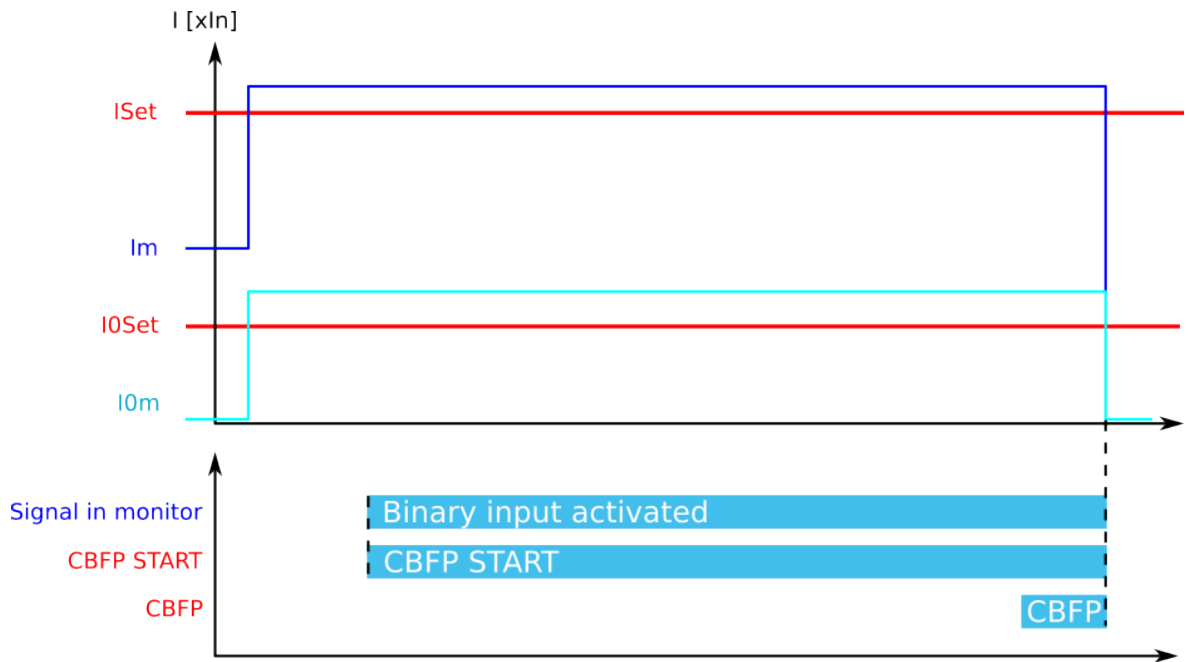
Device configuration as a dedicated CBFP unit

Figure. 4.4.5 - 30. Wiring diagram when the device is configured as a dedicated CBFP unit.



Some applications require a dedicated circuit breaker protection unit. When the CBFP function is configured to operate with a digital input signal, it can be used in these applications. When a device is used for this purpose, the tripping signal is wired to the device's digital input and the device's own TRIP signal is used only for the CBFP purpose. In this application's incoming feeder the RETRIP and CBFP signals are also available with different sets of requirements. The RETRIP signal can be used for tripping the section's feeder breaker and the CBFP signal for tripping the incoming feeder. The following example does not use retripping and the CBFP signal is used as the incoming feeder trip from the outgoing breaker trip signal. The TRIP signal can also be transported between different devices by using GOOSE messages.

Figure. 4.4.5 - 31. Dedicated CBFP operation from digital input signal.



In this mode the CBFP operates only from a digital input signal. Both current and output relay monitoring can be used. The counter for the CBFP signal begins when the digital input is activated. If the counter is active until the CBFP counter is used, the device issues a CBFP command to the incoming feeder circuit breaker. In this application the device tripping signals from all outgoing feeders can be connected to one, dedicated CBFP device which operates either on current-based protection or on all possible faults' CBFP protection.

Events and registers

The circuit breaker failure protection function (abbreviated "CBF" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counters for RETRIP, CBFP, CBFP START and BLOCKED events.

Table. 4.4.5 - 59. Event messages.

Event block name	Event names
CBF1	Start ON/OFF
CBF1	Retrip ON/OFF
CBF1	CBFP ON/OFF
CBF1	Block ON/OFF
CBF1	DO monitor ON/OFF
CBF1	Signal ON/OFF
CBF1	Phase current ON/OFF
CBF1	Res current ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for ACTIVATED, BLOCKED, etc. The table below presents the structure of the function's register content.

Table. 4.4.5 - 60. Register content.

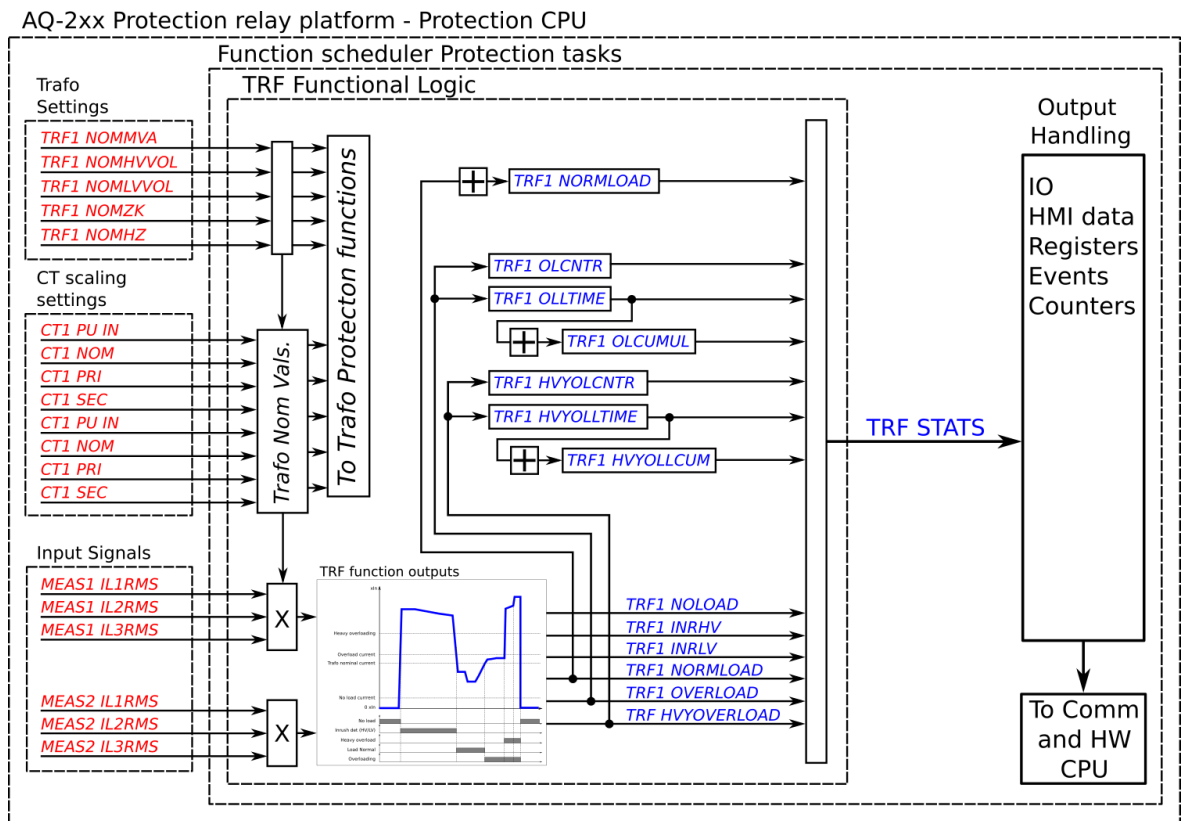
Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Max phase current	Highest phase current
Residual current	I01, I02 channel or calculated residual current
Time to RETR	Time remaining to retrip activation
Time to CBFP	Time remaining to CBFP activation
Setting group in use	Setting group 1...8 active

4.4.6 Transformer status monitoring

The transformer status monitoring function is designed to be the one place where the user can set up all necessary transformer data and select the used transformer protection functions. Settings related to the protection functions can also be edited inside each function and any changes are updated into this function as well. The function calculates many transformer-related properties which are used in functions that protect and monitor the transformer. Standard transformers require only name plate data and CT scalings to get the protection device to automatically scale all measurement signals to the transformer. In special transformers manually set values can be applied to cover the transformer properties that are rarely met. Additionally, the function counts a transformer's cumulative overloading and high overcurrent time.

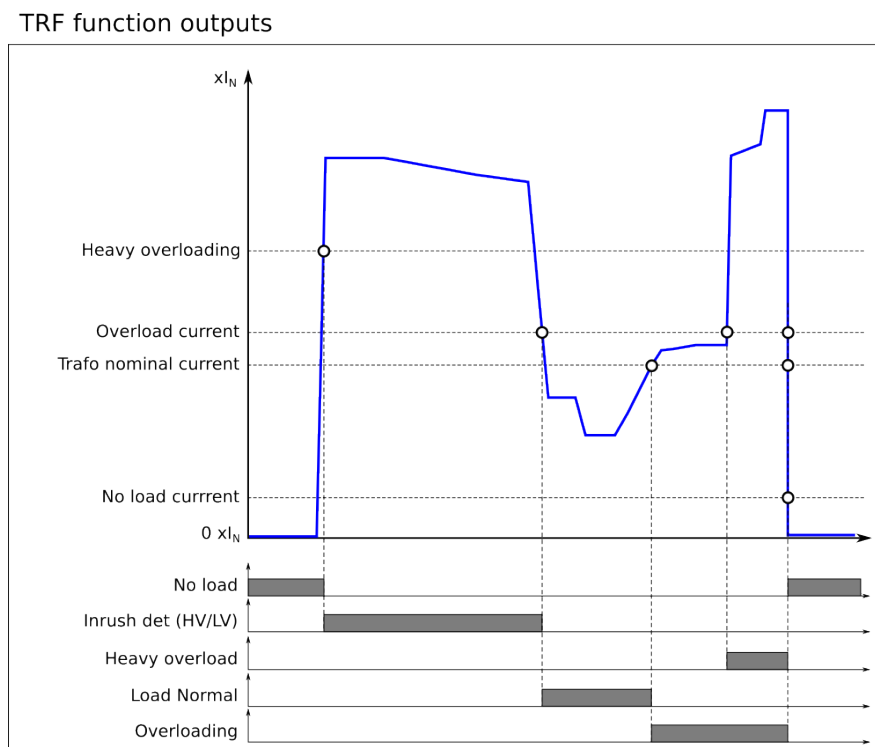
These signals can be used in indication or in logic programming, and they are the basis for the events the function generates (if so chosen).

Figure. 4.4.6 - 32. Simplified function block diagram of the transformer status monitoring function.



The function's outputs are dependent on the set transformer data because the measured currents (in p.u.) are related to the transformer nominal values. The following diagram presents the function's outputs in various situations.

Figure. 4.4.6 - 33. Activation of the function's outputs.



The **No load** signal is activated when the current dips below the "No load current" limit ($= 0.2 \times I_n$) for longer than ten milliseconds. If the current increases from this situation up to the "Heavy overloading" limit ($> 1.3 \times I_n$), the **HV inrush detection** and **LV inrush detection** signals are activated. If the measured current is between the "No load current" limit and the "Nominal current" limit, the **Load normal** signal is activated. If the measured current is between the "Nominal" and the "Heavy overloading" currents, the **Overloading** signal is activated.

These signals can be used for multiple purposes: information, transformer-related logics, and monitoring. A constant, long-lasting heavy overloading can cause oil ageing in the transformer, and thus more frequent maintenance is recommended to prevent possible problems in the transformer.

Settings and signals

The settings of the transformer status monitoring function are mostly shared with other transformer protection functions in the transformer module of the device. The following table shows these other functions that also use these settings.

Table. 4.4.6 - 61. Settings of the transformer status monitoring function and how they are shared by other protection functions.

Name	Range	Step	Default	Description
TRF LN mode	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	-	On	Set mode of MST block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
TRF LN behaviour	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	-	-	Displays the mode of MST block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
Transformer parameters controlled by SG	<ul style="list-style-type: none"> No Yes 	-	No	If this parameter is set to "Yes" it is possible to change transformer nameplate values instantly by switching between up to eight (8) setting groups. See "Transformer setting groups" section below.
TRF force status to	<ul style="list-style-type: none"> NoForce Light/No-load HV inrush LV inrush Normload Overload High Overload 	-	NoForce	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
Transformer nominal	0.1...500.0MVA	0.1MVA	1.0MVA	The nominal MVA of the transformer. This value is used to calculate the nominal currents on both the HV and the LV side.
HV side nominal voltage	0.1...500.0kV	0.1kV	110.0kV	The HV side nominal voltage of the transformer. This value is used to calculate the nominal currents of the HV side.

Name	Range	Step	Default	Description
LV side nominal voltage	0.1...500.0kV	0.1kV	110.0kV	The LV side nominal voltage of the transformer. This value is used to calculate the nominal currents of the LV side.
Transformer Zk%	0.01...25.00%	0.01%	3.00%	The transformer's short-circuit impedance in percentages. Used for calculating short-circuit current.
Transformer nom. freq.	10...75Hz	1Hz	50Hz	The transformer's nominal frequency. Used for calculating the transformer's nominal short-circuit inductance.
Transf. vect. group	<ul style="list-style-type: none"> • Manual set • Yy0 • Yyn0 • YNy0 • YNyn0 • Yy6 • Yyn6 • YNy6 • YNyn6 • Yd1 • YNd1 • Yd7 • YNd7 • Yd11 • YNd11 • Yd5 • YNd5 • Dy1 • Dyn1 • Dy7 • Dyn7 • Dy11 • Dyn11 • Dy5 • Dyn5 • Dd0 • Dd6 	-	Yy0	<p>The selection of the transformer's vector group. The selection values (1–26) are predefined so that the scaling and vector matching are applied in the protection device automatically when the correct vector group is selected.</p> <p>The predefinitions assume that the HV side is connected to the CT1 module and that the LV side is connected to the CT2 module.</p> <p>If the protected transformer vector group is not found in the predefined list, it can be manually set by selecting the option "Manual set".</p>
HV side Star or Zigzag / Delta	<ul style="list-style-type: none"> • Star/Zigzag • Delta 	-	Star/ Zigzag	The selection of the HV side connection. Can be selected between star or zigzag and delta. This selection is visible only if the option "Manual set" is selected for the vector group setting.
HV side earthed	<ul style="list-style-type: none"> • Not earthed • Earthed 	-	Not earthed	The selection of whether or not the zero sequence compensation is applied in the HV side current calculation. The selection is visible only if the option "Manual set" is selected for the vector group setting.
HV side lead or lag LV	<ul style="list-style-type: none"> • Lead • Lag 	-	Lead	The selection of whether the HV side leads or lags the LV side. The selection is visible only if the option "Manual set" is selected for the vector group setting.
LV side Star or Zigzag / Delta	<ul style="list-style-type: none"> • Star/Zigzag • Delta 	-	Star/ Zigzag	The selection of the LV side connection. Can be selected between star or zigzag and delta. This selection is visible only if the option "Manual set" is selected for the vector group setting.
LV side earthed	<ul style="list-style-type: none"> • Not earthed • Earthed 	-	Not earthed	The selection of whether or not the zero sequence compensation is applied in the LV side current calculation. The selection is visible only if the option "Manual set" is selected for the vector group setting.

Name	Range	Step	Default	Description
LV side lead or lag HV	<ul style="list-style-type: none"> Lead Lag 	-	Lead	The selection of whether the LV side leads or lags the HV side. The selection is visible only if the option "Manual set" is selected for the vector group setting.
HV-LV side phase angle	0.0...360.00deg	0.1 deg	0.0deg	The angle correction factor for HV/LV sides, looked from the HV side. E.g. if the transformer is Dy1, this is set to 30 degrees. The selection is visible only if the option "Manual set" is selected for the vector group setting.
HV-LV side mag correction	0.0...100.0xI _n	0.1xI _n	0.0xI _n	The magnitude correction for the HV-LV side currents (in p.u.), if the currents are not directly matched through the calculations of the nominal values. The selection is visible only if the option "Manual set" for the vector group setting.
Check online HV-LV configuration	<ul style="list-style-type: none"> - Check 	-	-	The selection of whether or not the function checks the current going through the transformer and then compares it to the settings. For this to work, the transformer needs to have a current flowing on both sides and "see" no faults. The selection is visible only if the option "Manual set" is selected for the vector group setting.

Table. 4.4.6 - 62. Calculations of the transformer status monitoring function.

Name	Range	Step	Default	Description
HV side nominal current (pri)	0.01...50 000.00A	0.01A	0.00A	The calculated primary current of the transformer's HV side primary current.
HV side nominal current (sec)	0.01...250.00A	0.01A	0.00A	The calculated primary current of the transformer's HV side secondary current.
HV CT nom. to TR nom. factor	0.01...250.00p.u.	0.01p.u.	0.00p.u.	The transformer's HV side calculated nominal to the CT primary rate.
LV side nominal current (pri)	0.01...50 000.00A	0.01A	0.00A	The calculated primary current of the transformer's LV side primary current.
LV side nominal current (sec)	0.01...250.00A	0.01A	0.00A	The calculated primary current of the transformer's LV side secondary current.
LV CT nom. to TR nom. factor	0.01...250.00p.u.	0.01p.u.	0.00p.u.	The transformer's LV side calculated nominal to the CT primary rate.
Transformer nom. impedance	0.01...250.00Ω	0.01Ω	0.00Ω	The calculated nominal impedance of the transformer.
Transformer nom. Z _k	0.01...250.00Ω	0.01Ω	0.00Ω	The calculated nominal short-circuit impedance of the transformer.
Transformer nom. SC inductance	0.001...250.000μH	0.01μH	0.000μH	The calculated nominal short-circuit inductance of the transformer.

Name	Range	Step	Default	Description
Transformer ratio	0.01...250.00	0.01	0.00	The transformer's calculated ratio (= HV/LV).
LV side max. 3ph SC curr.	0.001...500.000kA	0.001kA	0.000kA	The calculated maximum three-phase short-circuit current in the LV poles of the transformer.
LV side 3ph SC to HV side	0.001...500.000kA	0.001kA	0.000kA	Shows how the calculated maximum three-phase short-circuit current in the LV side is seen in the HV side.
LV side max. 2ph SC curr.	0.001...500.000kA	0.001kA	0.000kA	The calculated maximum two-phase short-circuit current in the LV poles of the transformer.
LV side 2ph SC to HV side	0.001...500.000kA	0.001kA	0.000kA	Shows how the calculated maximum two-phase short-circuit current in the LV side is seen in the HV side.

Table. 4.4.6 - 63. Output signals of the transformer status monitoring function.

Name	Description
No/Light load	The signal is active, when the function detects a current below the "No load current" limit. This signal presents a situation where there is a very light load, or only one or no side of the transformer is energized.
HV side inrush detected	The signal is active, when the detected current rises above the "High overcurrent" limit in the HV side.
LV side inrush detected	The signal is active, when the detected current rises above the "High overcurrent" limit in the LV side.
Load normal	The signal is active when the measured current is below the "Nominal current" but above the "No load current" limit.
Overloading	The signal is active, when the measured current is between the "Nominal current" and the "High overcurrent" limits.
Heavy overloading (HVY overloading)	The signal is active, when the measured current is above the "High overcurrent" limit.

Events

The transformer status monitoring function (abbreviated "TRF" in event block names) generates events from the detected transformer energizing status. The data register is available, based on the events.

Table. 4.4.6 - 64. Event messages.

Event block name	Event names
TRF1	Light/No load ON/OFF
TRF1	HV side inrush ON/OFF
TRF1	LV side inrush ON/OFF

Event block name	Event names
TRF1	Load normal ON/OFF
TRF1	Overloading ON/OFF
TRF1	High overload ON/OFF
TRF1	Setting changes, calculating new transformer data
TRF1	Calculation finished, possible restart

The function registers its operation into the last twelve (12) time-stamped registers. The table below presents the structure of the function's register content.

Table. 4.4.6 - 65. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
HV L1 current	HV side's Phase L1 current x I _n
HV L2 current	HV side's Phase L2 current x I _n
HV L3 current	HV side's Phase L3 current x I _n
LV L1 current	LV side's Phase L1 current x I _n
LV L2 current	LV side's Phase L2 current x I _n
LV L3 current	LV side's Phase L3 current x I _n

Transformer setting groups

If "Transformer parameters controlled by SG" parameter has been set to "Yes" it is possible to instantly change transformer parameters by changing the active setting group. Transformer parameter setting groups are controlled separately from the general setting group control. This allows for changing the following transformer nameplate values without changing the protection parameters:

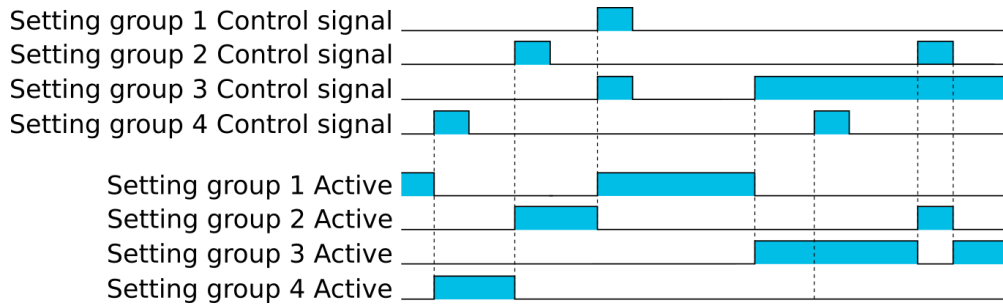
- Transformer nominal MVA
- HV side nominal voltage
- LV side nominal voltage
- Transformer vector group
- Transformer Zk %
- Transformer nominal frequency

Setting group selection can be applied to each of the setting groups individually by activating one of the various internal logic inputs or connected digital inputs. The user can also force any of the setting groups on when the "Force SG change" setting is enabled by giving the wanted quantity of setting groups as a number in the communication bus or in the local HMI, or by selecting the wanted setting group from *Control* → *Setting groups*. When the forcing parameter is enabled, the automatic control of the local device is overridden and the full control of the setting groups is given to the user until the "Force SG change" is disabled again.

Setting groups can be controlled either by pulses or by signal levels. The setting group controller block gives setting groups priority values for situations when more than one setting group is controlled at the same time: the request from a higher-priority setting group is taken into use.

Setting groups follow a hierarchy in which setting group 1 has the highest priority, setting group 2 has second highest priority etc. If a static activation signal is given for two setting groups, the setting group with higher priority will be active. If setting groups are controlled by pulses, the setting group activated by pulse will stay active until another setting groups receives and activation signal.

Figure. 4.4.6 - 34. Example sequences of group changing (control with pulse only, or with both pulses and static signals).



The settings of the setting group control function include the active setting group selection, the forced setting group selection, the enabling (or disabling) of the forced change, the selection of the number of active setting groups in the application, as well as the selection of the setting group changed remotely. If the setting group is forced to change, the corresponding setting group must be enabled and the force change must be enabled. Then, the setting group can be set from communications or from HMI to any available group. If the setting group control is applied with static signals right after the "Force SG" parameter is released, the application takes control of the setting group selection.

Table. 4.4.6 - 66. Settings of the setting group selection function.

Name	Range	Default	Description
Active setting group	<ul style="list-style-type: none"> • SG1 • SG2 • SG3 • SG4 • SG5 • SG6 • SG7 • SG8 	SG1	Displays which setting group is active.
Force setting group	<ul style="list-style-type: none"> • None • SG1 • SG2 • SG3 • SG4 • SG5 • SG6 • SG7 • SG8 	None	The selection of the overriding setting group. After "Force SG change" is enabled, any of the configured setting groups in the device can be overridden. This control is always based on the pulse operating mode. It also requires that the selected setting group is specifically controlled to ON after "Force SG" is disabled. If there are no other controls, the last set setting group remains active.
Force setting group change	<ul style="list-style-type: none"> • Disabled • Enabled 	Disabled	The selection of whether the setting group forcing is enabled or disabled. This setting has to be active before the setting group can be changed remotely or from a local HMI. This parameter overrides the local control of the setting groups and it remains on until the user disables it.

Name	Range	Default	Description
Used setting groups	<ul style="list-style-type: none"> • SG1 • SG1...2 • SG1...3 • SG1...4 • SG1...5 • SG1...6 • SG1...7 • SG1...8 	SG1	The selection of the activated setting groups in the application. Newly-enabled setting groups use default parameter values.
Remote setting group change	<ul style="list-style-type: none"> • None • SG1 • SG2 • SG3 • SG4 • SG5 • SG6 • SG7 • SG8 	None	This parameter can be controlled through SCADA to change the setting group remotely. Please note that if a higher priority setting group is being controlled by a signal, a lower priority setting group cannot be activated with this parameter.

Table. 4.4.6 - 67. Signals of the setting group selection function.

Name	Description
Setting group 1	The selection of Setting group 1 ("SG1"). Has the highest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, no other SG requests will be processed.
Setting group 2	The selection of Setting group 2 ("SG2"). Has the second highest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, no requests with a lower priority than SG1 will be processed.
Setting group 3	The selection of Setting group 3 ("SG3"). Has the third highest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, no requests with a lower priority than SG1 and SG2 will be processed.
Setting group 4	The selection of Setting group 4 ("SG4"). Has the fourth highest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, no requests with a lower priority than SG1, SG2 and SG3 will be processed.
Setting group 5	The selection of Setting group 5 ("SG5"). Has the fourth lowest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, SG6, SG7 and SG8 requests will not be processed.
Setting group 6	The selection of Setting group 6 ("SG6"). Has the third lowest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, SG7 and SG8 requests will not be processed.
Setting group 7	The selection of Setting group 7 ("SG7"). Has the second lowest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, only SG8 requests will not be processed.
Setting group 8	The selection of Setting group 8 ("SG8"). Has the lowest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, all other SG requests will be processed regardless of the signal status of this setting group.

The setting group selection function block (abbreviated "SGS2" in event block names) generates events from its controlling status, its applied input signals, enabling and disabling of setting groups, as well as unsuccessful control changes. The events triggered by the function are recorded with a time stamp.

Table. 4.4.6 - 68. Event messages.

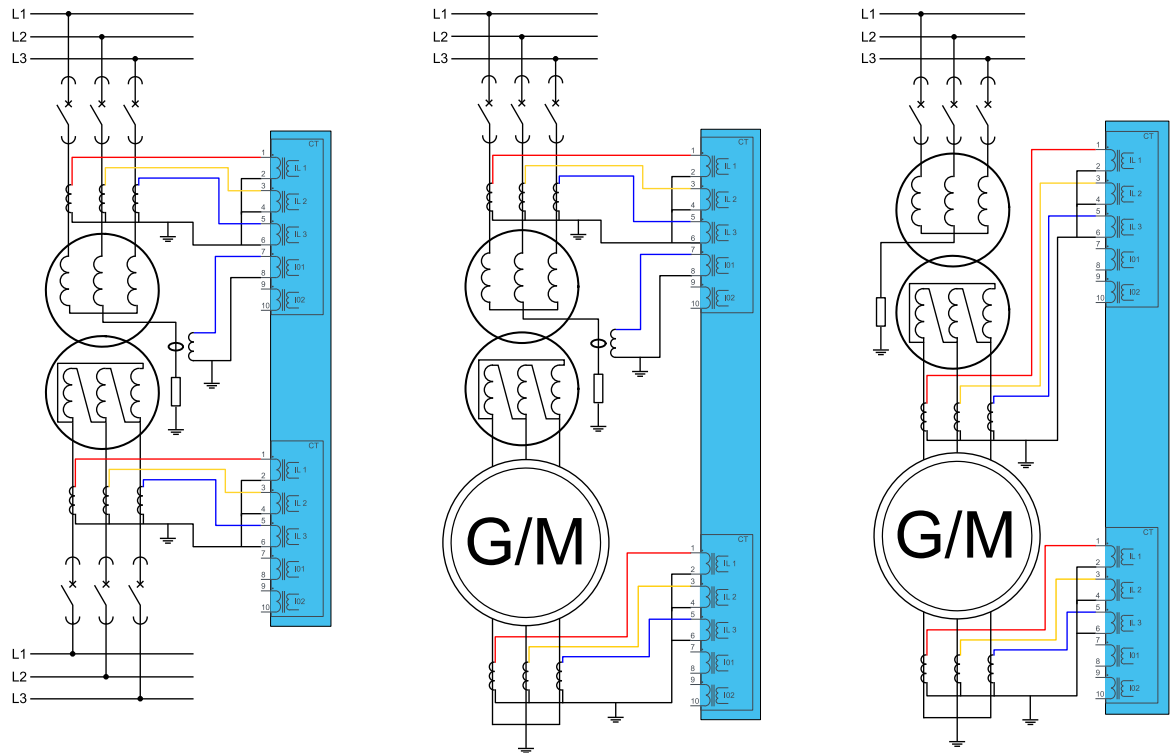
Event block name	Event names
SGS2	SG2...SG8 Enabled/Disabled
SGS2	SG1...SG8 Request ON/OFF
SGS2	Remote Change SG Request ON/OFF
SGS2	Local Change SG Request ON/OFF
SGS2	Force Change SG ON/OFF
SGS2	SG Request Fail Not configured SG ON/OFF
SGS2	Force Request Fail Force ON/OFF
SGS2	SG Req. Fail Lower priority Request ON/OFF
SGS2	SG1...SG8 Active ON/OFF

4.4.7 Generator/motor/transformer differential protection (Idb>/Idi>/I0dHV>/I0dLV>; 87T/87G/87M/87N)

The function is used for differential protection of two-winding transformers, motors and generators. Differential protection function is based on calculating the difference between the ingoing and outgoing currents. If the operating status is normal, all power that comes in also goes out. If this is not the case, the transformer has an internal fault and the device should be de-energized as soon as possible to avoid extensive damage to the protected object(s).

Differential protection is very sensitive and it is scaled internally to the loading and fault current flowing through the transformer. For example, an interturn fault in the transformer's windings could go entirely unnoticed by an overcurrent relay while a differential relay could trip it in the very first power cycle. The same goes for internal earth faults: they can be impossible for conventional earth fault protection to notice until the fault causes heavier fault currents (such as when the fault location is close to the neutral side inside the star winding).

Figure. 4.4.7 - 35. Differential protection function can be used for protecting transformers, machines (generators/ motors) and both at the same time.



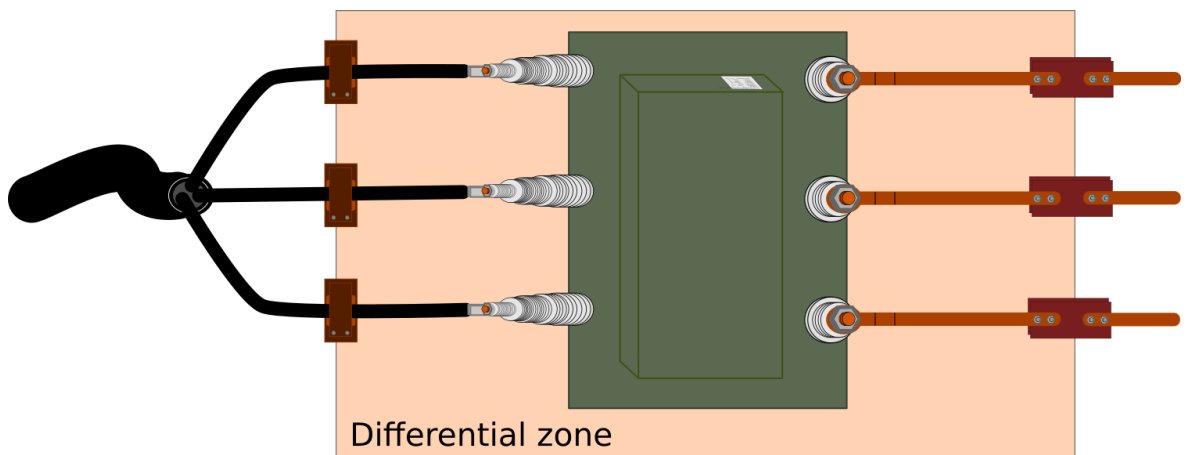
Transformer properties and basic concepts for differential protection

Setting the differential protection requires some initial data of the transformer to be known. At minimum, the following data needs to be available:

- the transformer's nominal power
- the nominal voltages of the HV side and the LV side
- the transformer's special properties, such as tap changer and auxiliary windings
- the transformer's vector group (for matching the transformer vectors in p.u.)
- the ratios and properties of the transformers HV and LV sides.

This chapter shows the setting and the principle of transformer differential protection step by step.

Figure. 4.4.7 - 36. Transformer and its components forming the differential zone.



The differential protection area is the area between the current transformers. This is called the differential zone which means that the currents going in from one side must come out from the other side. This is true whether the signal is scaled higher or lower, or whether the phase angle is shifted. Unless both side currents match there is a problem within the protected zone which either blocks or keeps the current inside the zone.

Figure. 4.4.7 - 37. Transformer name plate data.

MGT		M.G.TRAFO & Sons. Co. Ltd.	
PHASE	3		
POWER	2000	kVA	
VECTOR	Yd1		
IMP.Zk%	4.95	%	
VOLT.H.	10 000	V	
VOLT.L.	1000	V	
AMP.H.	116	A	
AMP.L.	1155	A	
FREQUENCY	50	Hz	

According to the data on this example name plate, this transformer is designed for three-phase usage and has two windings. The nominal power of the transformer is 2 MVA. Its vector group is Yd1: this means that the high-voltage side is connected to the Y and the low-voltage side to the delta, resulting in the LV side having a 30-degree lag in relation to the HV side. Additionally, the HV side's nominal voltage is 10 kV, on the LV side the nominal voltage is 1kV. The transformer's short-circuit impedance is 4.95 %; it is based on the transformer's final test and presents how much short-circuit current the transformer is able to feed. The transformer's frequency is 50 Hz. If the transformer has a tap changer, its information is usually also available in the name plate data.

Nominal current matching is the first thing to consider in differential protection. Modern numerical protection relays can calculate these factors themselves as long as the transformer's nominal power and voltage levels are known. However, if one feels inclined to calculate the amplitude matching factor, they can do so with the formulas presented below.

For this example, let us say we want to do these calculation for the transformer whose name plate we have in the image above. Let us further say the HV side current transformers are 150/5 A and the LV side current transformers are 1200/5 A. The primary side factor (p.u.) and current are then calculated as follows:

$$I_{n,HV} = \frac{S_n}{\sqrt{3} \times U_{HV}} = \frac{2\,000\,000\text{ VA}}{\sqrt{3} \times 10\,000\text{ V}} = 115.47\text{ A}$$

$$I_{pu,pri,HV} = \frac{I_{n,HV}}{CT_{pri,HV}} = \frac{115.47\text{ A}}{150\text{ A}} = 0.77$$

$$I_{pu,sec,HV} = I_{pu,pri,HV} \times CT_{sec,HV} = 0.77 \times 5\text{ A} = 3.85\text{ A}$$

Then, the secondary side factor (p.u.) and current are calculated as follows:

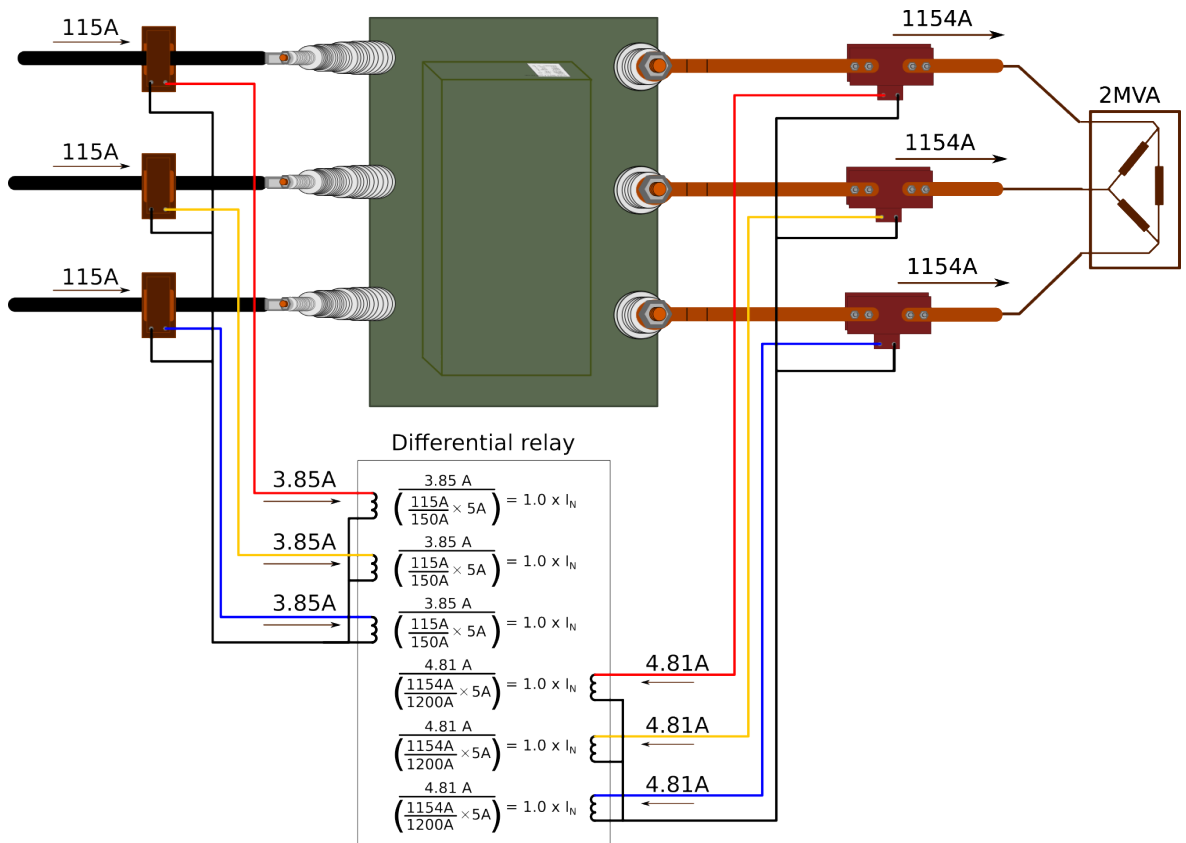
$$I_{n,LV} = \frac{S_n}{\sqrt{3} \times U_{LV}} = \frac{2\,000\,000\text{ VA}}{\sqrt{3} \times 1\,000\text{ V}} = 1154.7\text{ A}$$

$$I_{pu,pri,LV} = \frac{I_{n,LV}}{CT_{pri,LV}} = \frac{1154.7\text{ A}}{1200\text{ A}} = 0.96$$

$$I_{pu,sec,LV} = I_{pu,pri,LV} \times CT_{sec,LV} = 0.96 \times 5\text{ A} = 4.81\text{ A}$$

The calculations show that if 2 MVA of power go through the transformer the CT's secondary current on the high-voltage side will be 3.85 A and the CT secondary current on the low-voltage side will be 4.81 A. The differential function uses these values to change them into measured currents in per unit. Therefore, it would show $1.0 \cdot I_n$ for both HV and LV side measurements, even though the measured currents are different. This is called amplitude matching of the HV and LV sides. In modern differential relays this is done automatically when the nominal values and CT ratings are set for the transformer. Thus, these calculations only have nice-to-know informational value.

Figure. 4.4.7 - 38. Amplitude scaling to match the nominal currents and CTs in the differential relay.

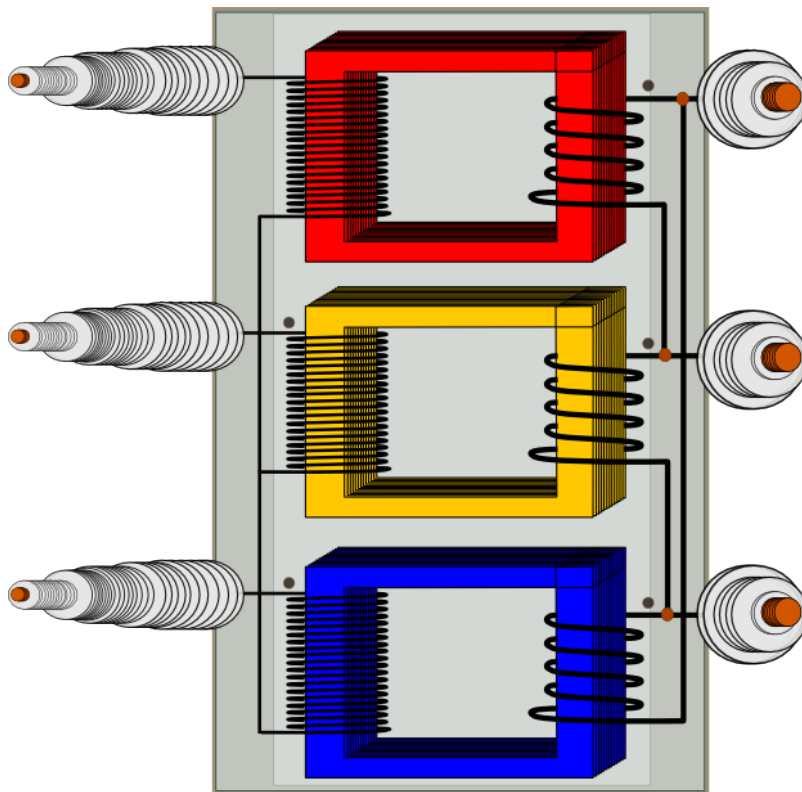


Nominal current matching is only part of the differential protection settings. The vector group of the transformer is also important, since the differential function is interested in the angle difference of the measured current vectors. In this example the transformer's vector group is Yd1, which means that the transformer's HV side is connected to the Y and the LV side to the delta. Therefore, the LV side is in 30-degree lag in relation to the HV side vectors.

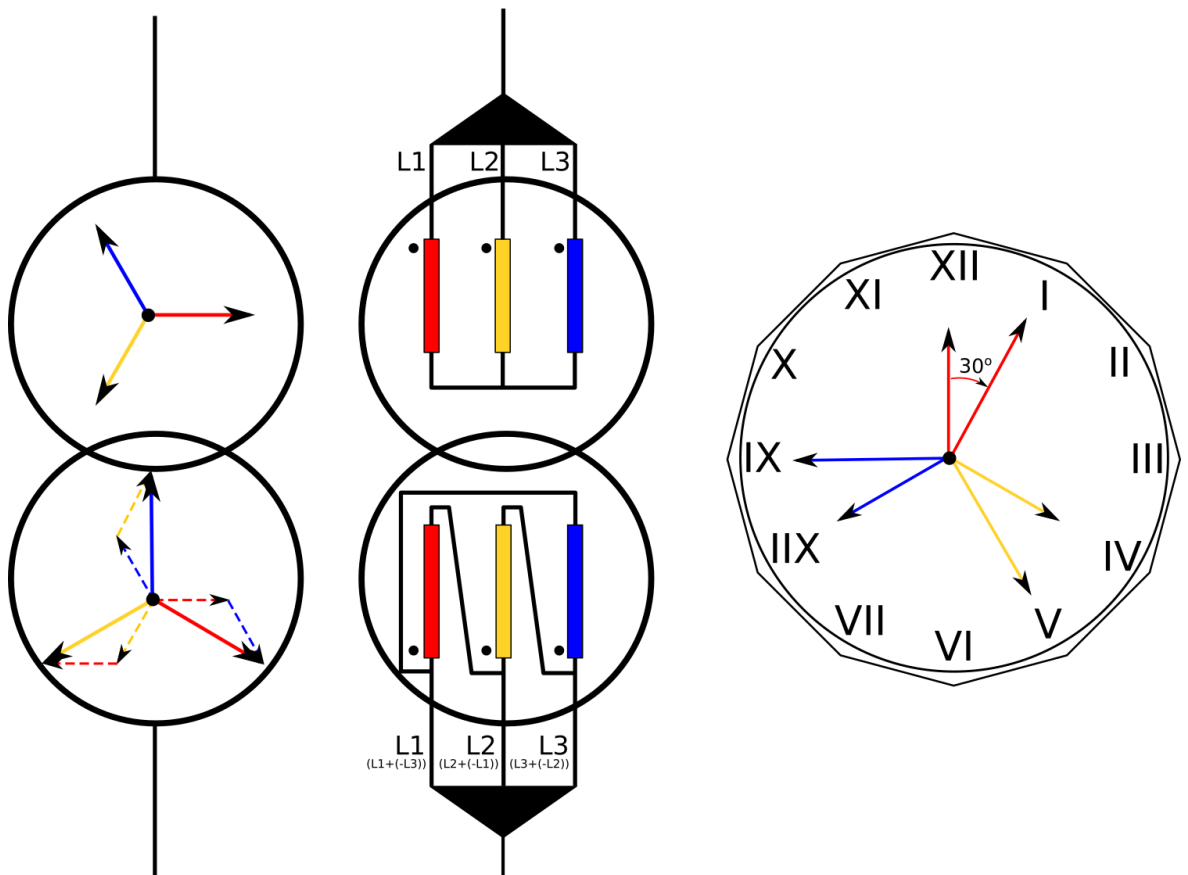
The number '1' in the vector group's name comes from the angle in the phase current difference between the HV and the LV side. If one imagines the HV side current's Y placed upside down on the face of a clock (with the Y's leg pointing at 12), the LV side's delta would be pointing at 1. Likewise, '11' means that the LV side is leading 30 degrees; '5' and '7' are just the other ends of the windings thus causing a 180-degree difference between the '1' and '11' clock numbers.

The following example explains transformer current vectors and what a connection might look like.

Figure. 4.4.7 - 39. Yd1 transformer's internal connection (in theory).



Yd1



In modern protection relays these standard vector groups (Y or delta, lead or lag) are defined by a setting selection and there is no need for interposing transformers. Even if the transformer's vector group is not standard it should still be settable within the protection relay (such as with zigzag transformers).

In this example, the function translates the delta side currents. The correction applies not only to the angles but also to the amplitudes because the delta side (in p.u.) is relative to the amplitude difference with the Y-connected side.

$$\overline{IL1DS}_{LV} = \frac{(\overline{IL1}_{LV} - \overline{IL2}_{LV})}{\sqrt{3}}$$

$$\overline{IL2DS}_{LV} = \frac{(\overline{IL2}_{LV} - \overline{IL3}_{LV})}{\sqrt{3}}$$

$$\overline{IL3DS}_{LV} = \frac{(\overline{IL3}_{LV} - \overline{IL1}_{LV})}{\sqrt{3}}$$

This process is called vector group matching for the currents (in p.u.) of the transformer. This matching is necessary whenever one side is connected to the delta and another to the Y. Previously in non-numerical relays, this matching was done by interposing CTs which connected the power transformer's Y side to the delta, and the transformer's delta side to the Y. This got the HV and LV side vectors to match each other. Then the currents in the protection relay inputs are summed up. If there is no difference (as the HV and LV side currents negate each other), the pick-up is not triggered. If the currents do have a difference, the current flows to the protection relay input and with enough difference causes a pick-up and a trip. However, as modern differential relays do this transformation by calculating the corrected vector internally, this is also just nice-to-know information not related to the actual operation of the relay.

In Manual Set mode, the differential protection allows adjustment of the angle offset and a magnitude correction factor. If a winding side is configured as delta, the relay automatically applies the inherent 30° phase shift. This means the user must take that into account when calculating the additional manual angle offset. The magnitude correction is used to scale current magnitude's using the set factor. Phase remapping is not supported in this mode, so connection groups that rely on it (e.g. Yy2) cannot be used.

Figure. 4.4.7 - 40. Expected phase shifts from HV side to LV side (a symmetrical situation).

	Phase angles HV side				Phase angles LV side			
	Shift(deg)	IL1	IL2	IL3	IL1"	IL2"	IL3"	
Yy0, Yyn0, YNy0, Dd0	0	0	240	120	0	240	120	
Yy6, Yyn6, YNy6, YNyn6, Dd6	180	0	240	120	180	60	300	
Yd1, YNd1, Dy1, Dyn1	-30	0	240	120	330	210	90	
Yd11, YNd11, Dy11, Dyn11	30	0	240	120	30	270	150	
Yd5, YNd5, Dy5, Dyn5	-150	0	240	120	210	90	330	
Yd7, YNd7, Dy7, Dyn7	150	0	240	120	150	30	270	

The direction of the CTs' Y legs on the HV and LV sides affects how the differential calculation method is set. The "add" mode is used when the CT's starpoints are either pointing towards each other or away from each other. The "subtract" mode is used when those points are pointing in the same direction. In this example above the correct setting would be the "add" mode because the CTs in the main circuit are connected to the opposite and thus the measured currents from the CTs are also opposite. The user selects how they want the signals to be shown: the CTs' currents can be negated with the "subtract" option, resulting in a one Y-connected vector diagram.

The images below present the differential algorithm itself; first the "subtract" formulas, then the "add" formulas.

Figure. 4.4.7 - 41. "Subtract" formula.

$$L1DIFF_{Subt} = |\overline{IL1_{HV}} - \overline{IL1_{LV}}|$$

$$L2DIFF_{Subt} = |\overline{IL2_{HV}} - \overline{IL2_{LV}}|$$

$$L3DIFF_{Subt} = |\overline{IL3_{HV}} - \overline{IL3_{LV}}|$$

Figure. 4.4.7 - 42. "Add" formula.

$$L1DIFF_{Add} = |\overline{IL1_{HV}} + \overline{IL1_{LV}}|$$

$$L2DIFF_{Add} = |\overline{IL2_{HV}} + \overline{IL2_{LV}}|$$

$$L3DIFF_{Add} = |\overline{IL3_{HV}} + \overline{IL3_{LV}}|$$

Figure. 4.4.7 - 43. CTs' starpoints requiring the "Add" mode.

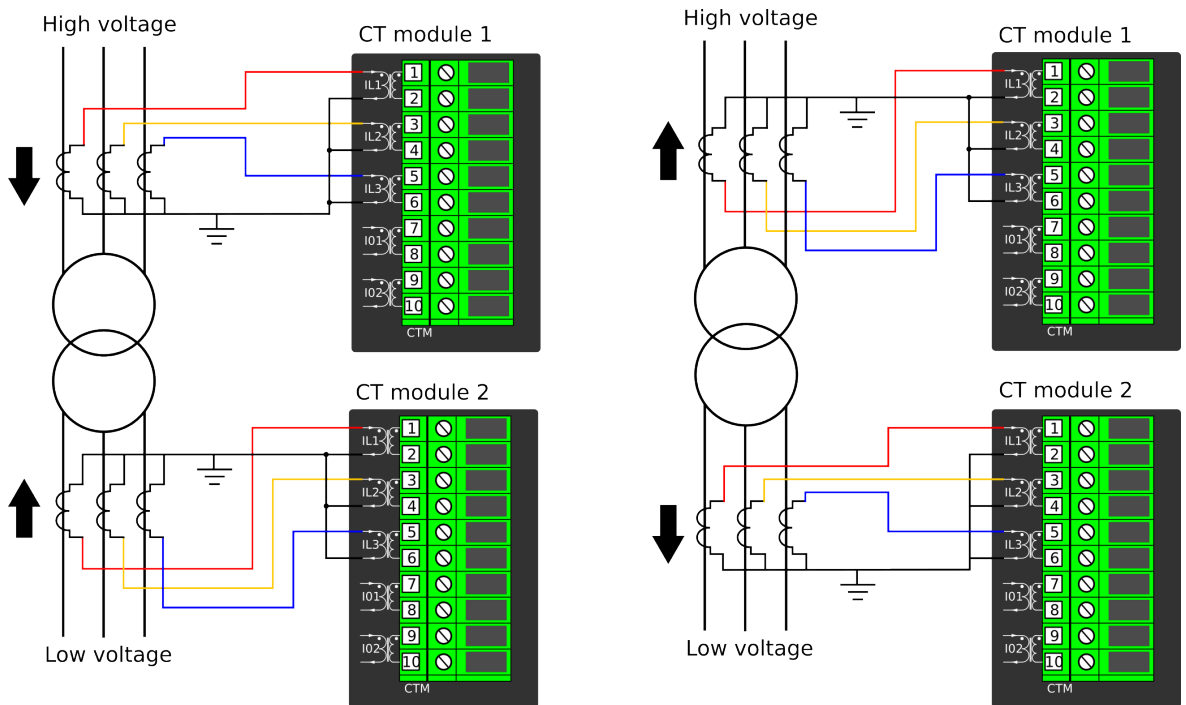
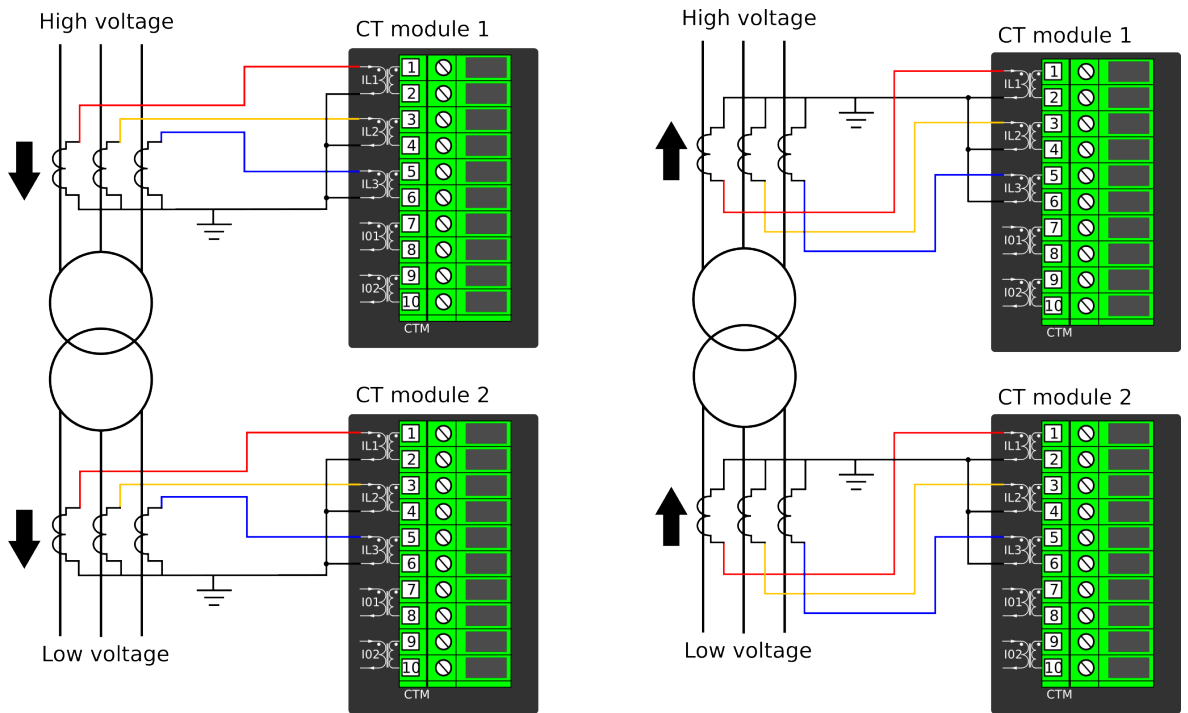


Figure. 4.4.7 - 44. CTs' starpoints requiring the "Subtract" mode.



The differential protection function has two separate operating stages:

- Non-restraint stage: This stage utilizes only the above mentioned comparison formulas as its evaluation basis.
- Restraint stage: In this stage, a *bias calculation* is performed for each phase. The purpose of this calculation is to adapt the sensitivity of the differential element to the magnitude of the measured currents, which improves stability under varying load and fault conditions.

Bias calculation can be sensitive or coarse (see the following formulas).

Figure. 4.4.7 - 45. Average mode (sensitive biasing).

$$L1BIAS_{AVG} = \frac{|IL1_{HV}| + |IL1_{LV}|}{2}$$

$$L2BIAS_{AVG} = \frac{|IL2_{HV}| + |IL2_{LV}|}{2}$$

$$L3BIAS_{AVG} = \frac{|IL3_{HV}| + |IL3_{LV}|}{2}$$

Figure. 4.4.7 - 46. Max mode (coarse biasing).

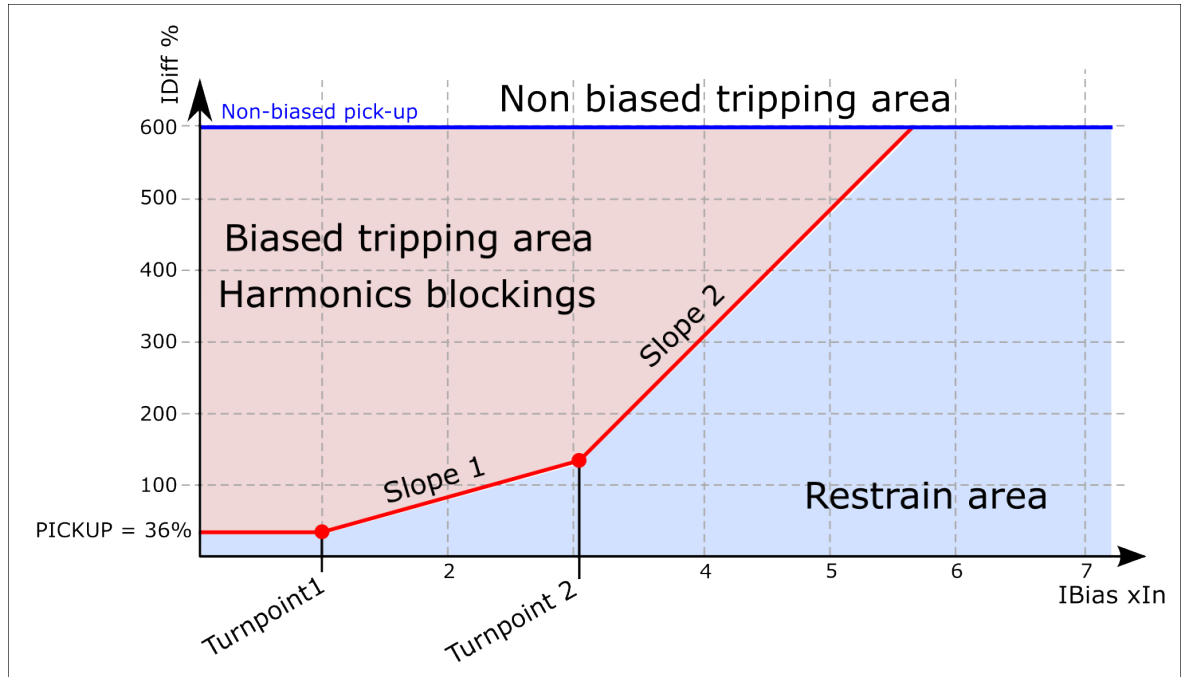
$$L1BIAS_{MAX} = \max(|IL1_{HV}|, |IL1_{LV}|)$$

$$L2BIAS_{MAX} = \max(|IL2_{HV}|, |IL2_{LV}|)$$

$$L3BIAS_{MAX} = \max(|IL3_{HV}|, |IL3_{LV}|)$$

Next, these two formulas (bias and differential calculation) are combined in a graph: the y-axis presents the measured differential current, and the x-axis presents the calculated bias current. The following graph shows the differential function characteristic, both biased and non-biased.

Figure. 4.4.7 - 47. Differential function characteristic, biased and non-biased.



The graph is the function of measured biasing current and the differential protection current. The red line presents the allowed differential current in percentages. In this example the non-biased pick-up is set lower than in a normal transformer application. The settings and the ranges of the differential protection function are presented in the "Settings and signals" section of this topic.

The biasing characteristic is formed with the following formulas:

$$Diff_{bias < TP1} = I_{d > pick-up}$$

$$Diff_{bias TP1...TP2} = SL1 \times (Ix - TP1) + I_{d > pick-up}$$

$$Diff_{bias > TP2} = SL2 \times (Ix - TP2) + SL1 \times (TP2 - TP1) + I_{d > pick-up}$$

These form a straight line from zero current to Turnpoint (TP1). From TP1 to TP2 is the first slope (Slope 1) which causes the set biasing to be coarser when the measured current amplitude increases. When the measured current is higher than the TP2 set value, the second slope (Slope 2) is used.

Differential characteristics settings

One needs to understand what the various parts of the characteristics mean in order to set the characteristics for the transformer application.

$$Diff_{bias < TP1} = I_{d > pick-up}$$

This is the first straight line which represents the differential current created by the transformer's normal operation. It takes into account measurement errors, possible variations caused by the transformer's tap changer (if available), and the various reasons why the application might have caused a different load inside the protected differential zone. In differential relays this is known as the pick-up current ($I_{d>pick-up}$). It is the basic sensitivity limit: when the measured differential current is below this limit, the transformer still operates normally and the protection does not trigger. In other words, the pick-up current setting must be higher than the combination of all the normal operation factors that cause differential currents.

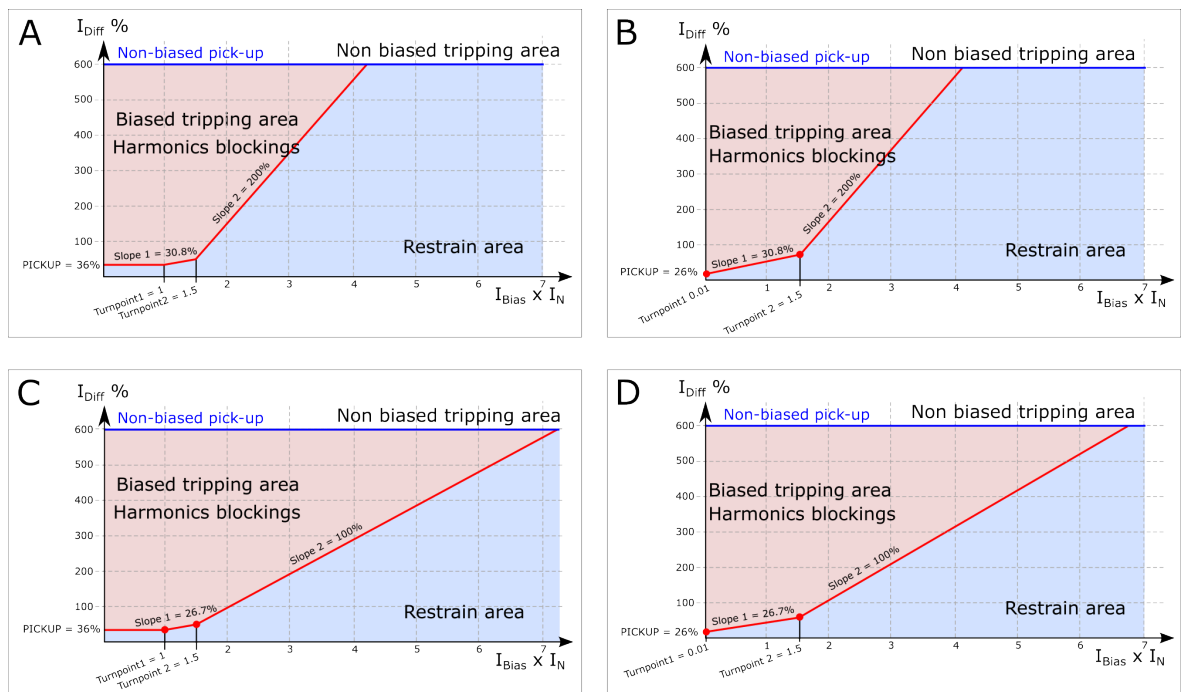
Slope 1 settings present the protection relay's restrain characteristics over the transformer's load current range. This slope should be effective up to the maximum transformer loading. This value for power transformers is usually around 1.0 to $2.0 \times I_n$; for large power transformer a typical value is $1.5 \times I_n$. The purpose is to compensate the measurement errors caused by a relatively high current, including the tap changer effect.

Slope 2 settings are used for biasing the differential characteristics against heavy faults outside the differential zone that can cause heavy saturation on one or both sides of the CTs causing heavy differential current in the measurements even though the transformer itself does not have a fault.

Calculating the generated differential current — The non-biased settings $I_{d>Pick-up}$

The purpose of this stage is to ensure fast and selective tripping of faults inside the differential zone, and also to ensure a stable operation on heavy outside faults. This stage operates only on the measured absolute differential current and is not blocked by harmonics or bias restraints. The setting of the stage should be based on the weakest full saturation of the CT under worst-case fault conditions because then only the other side current is measured and all current seen is differential current.

Figure. 4.4.7 - 48. Example differential characteristics

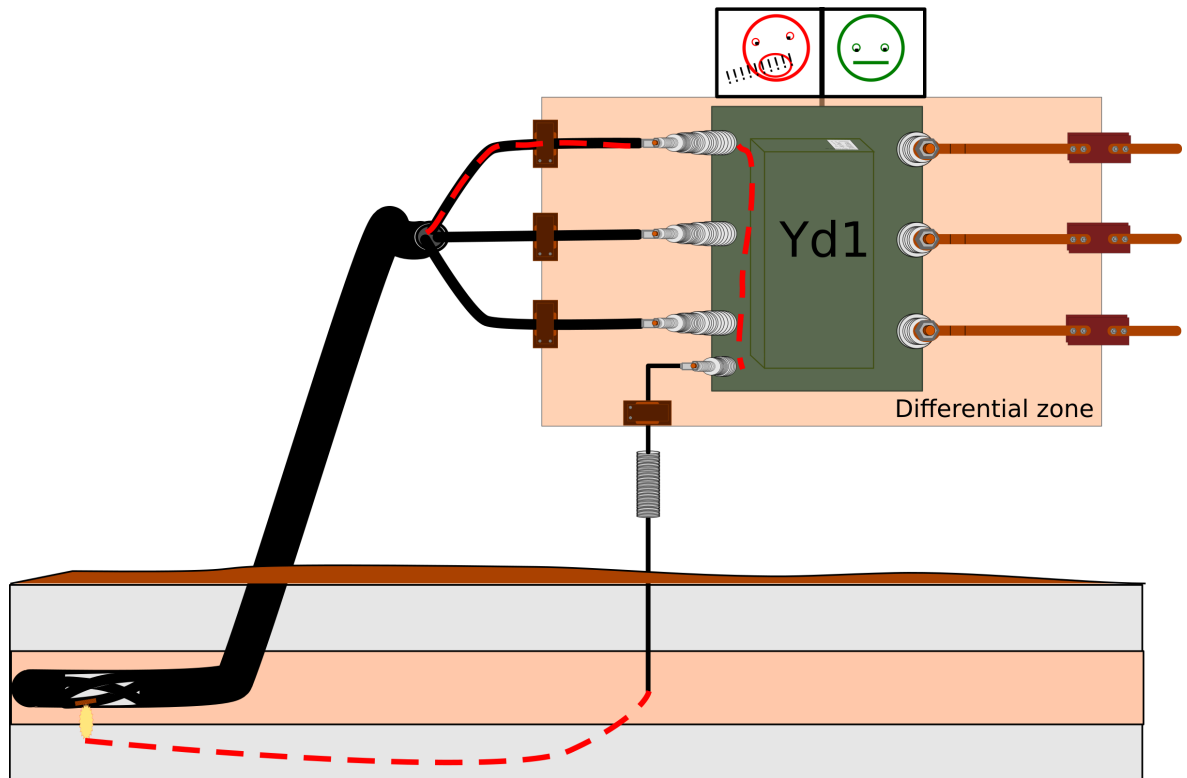


The four characteristics (the image above) present the setting variations based to the Average restraint calculation mode (figures A and B) and the Maximum restraint calculation modes (figures C and D). The characteristics are set to be equally sensitive in each of them. You can also see the variations in Turnpoint 1 settings: in Figures A and C it is set at $1.0 \times I_n$, whereas in Figures B and D it is set at $0.01 \times I_n$.

Zero sequence compensation for external earth faults

A very common transformer type is the kind where the star side (HV, LV, or both) is earthed and thus forms a route outside the differential zone (see the image below).

Figure. 4.4.7 - 49. Transformer earthing settings that do not compensate for external earth faults.



The differential relay looks at this situation and sees a fault inside the differential zone. This is because the other side is not affected at all by the fault (or only very little), and the relay sees a high current entering but not exiting the zone.

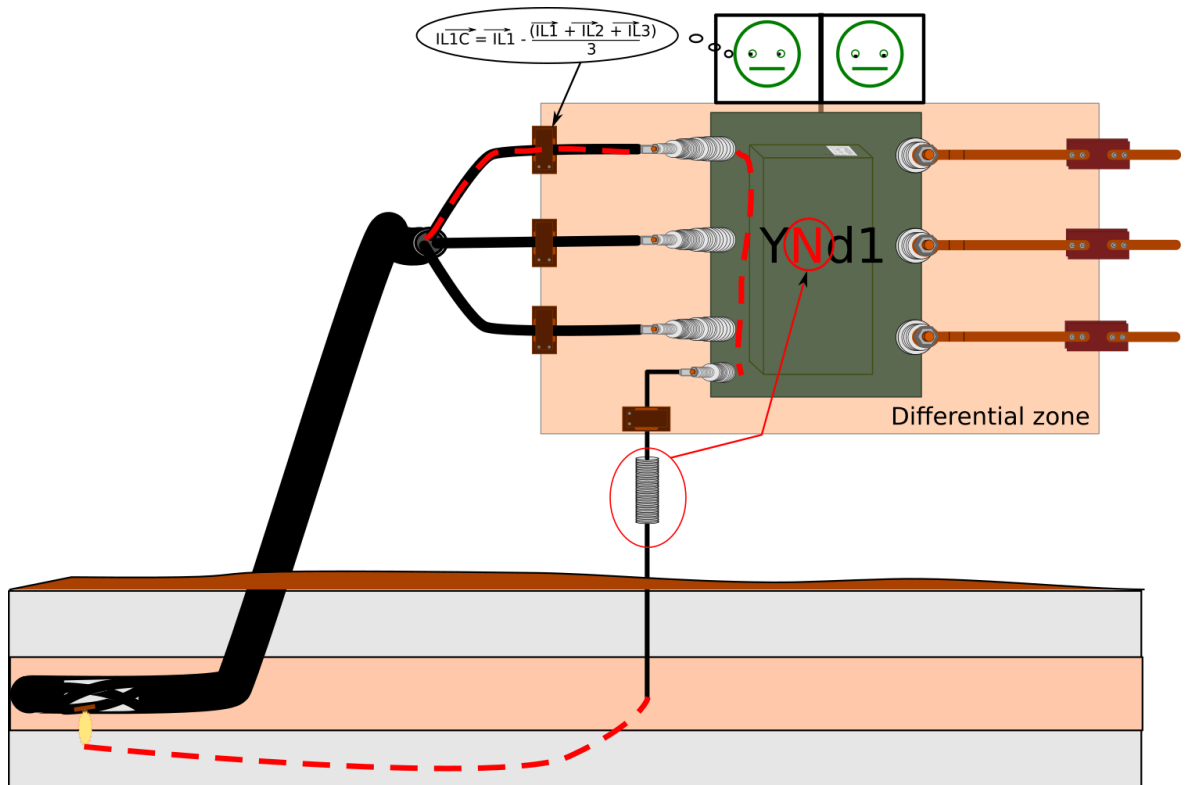
In many cases the zero sequence current is monitored by the CT in the earthing.

Earthing (directly or via a resistor) forms a route outside the differential zone.

When an external earth fault happens, only the earthed side of the transformer is involved in the fault.

The differential earthing requires the earthing to be known: if not compensated, any low-impedance earth fault outside the differential zone causes a differential current and possibly trips the differential protection. This is why the calculated zero sequence compensation is used. The vector group selection has either "N" or "n" to signify either HV side or LV side earthing. The selection then deducts the calculated zero sequence current from the currents (in p.u.) before differential calculation and thus negates the effect of an external earth fault. Correctly selected transformer settings prevent the differential function from being tripped by out-of-zone earth faults (see the image below).

Figure. 4.4.7 - 50. Transformer earthing settings that compensates for external earth faults.



When the transformer settings are correct, the differential relay compensates the zero sequence current and does not trip due to earth faults outside the differential zone.

Earthing (directly or via a resistor) forms a route outside the differential zone.

When an external earth fault happens, only the earthed side of the transformer is involved in the fault.

The "N" or "n" selection applies the correction and eliminates the zero sequence effect with the following formulas:

$$\vec{I}_{L1_{corr}} = \vec{I}_{L1} - \frac{\vec{I}_{L1} + \vec{I}_{L2} + \vec{I}_{L3}}{3}$$

$$\vec{I}_{L2_{corr}} = \vec{I}_{L2} - \frac{\vec{I}_{L1} + \vec{I}_{L2} + \vec{I}_{L3}}{3}$$

$$\vec{I}_{L3_{corr}} = \vec{I}_{L3} - \frac{\vec{I}_{L1} + \vec{I}_{L2} + \vec{I}_{L3}}{3}$$

Note! When you enable the zero sequence compensation by selecting the "N" or "n" in the transformer vector group, the sensitivity to single-phase one end fault decreases by a third simultaneously. This is why restricted earth fault protection ($I_{0>}$, REF) should be enabled for the side where the zero sequence is compensated. However, enabling the REF protection requires that both the phase current measurements and the starpoint current are available and can be connected to the relay's residual current channel on the corresponding (HV/LV) side measurement.

Restricted earth fault

When the transformer's earthed side is compensated with afore-mentioned zero sequence compensation, that side will be a third (appr. 33 %) less sensitive in detecting single-phase faults inside the differential zone. For this reason it is advised that the restricted earth fault (REF) stage is activated on the transformer side that compensates the zero sequence current. Additionally, it should be enabled whenever the Y side of the starpoint is earthed; normal phase differential protection cannot be set to provide the maximum sensitivity to detect single-phase (earth) faults within the differential area because the properties dependant on the transformer and the application that were described in the previous section. This differential stage monitors the incoming calculated residual current and compares it to the outgoing starpoint current. If the single-phase (earth) fault occurs outside the differential zone, this function does not operate; if the fault occurs inside the differential zone, this function operates quickly. This protection's sensitivity to earth faults only within the protection zone is referred to as the "restricted earth fault protection".

The transformer differential functions offers two stages of low-impedance, restricted earth fault protection.

The operating characters of the restricted earth fault function ($I_{0d>}$) on both the high voltage and the low voltage side are more similar to each other than to the percentage characteristics presented by the $I_{db>}$ function, even though both sides are independent and can be set freely. The calculation of differential and biasing currents on both sides is as follows (the HV side on the left, the LV side on the right).

$HV_{I_{0d>} bias\ avg} = \frac{ (\overline{IL1}_{HV} + \overline{IL2}_{HV} + \overline{IL3}_{HV}) + \overline{I0}_{HV\ meas} }{2}$	$LV_{I_{0d>} bias\ avg} = \frac{ (\overline{IL1}_{LV} + \overline{IL2}_{LV} + \overline{IL3}_{LV}) + \overline{I0}_{LV\ meas} }{2}$
$HV_{I_{0d>} bias\ max} = \max((\overline{IL1}_{HV} + \overline{IL2}_{HV} + \overline{IL3}_{HV}), \overline{I0}_{HV\ meas})$	$LV_{I_{0d>} bias\ max} = \max((\overline{IL1}_{LV} + \overline{IL2}_{LV} + \overline{IL3}_{LV}), \overline{I0}_{LV\ meas})$
$HV_{I_{0d>} diff\ add} = (\overline{IL1}_{HV} + \overline{IL2}_{HV} + \overline{IL3}_{HV}) + \overline{I0}_{HV\ meas} $	$LV_{I_{0d>} diff\ add} = (\overline{IL1}_{LV} + \overline{IL2}_{LV} + \overline{IL3}_{LV}) + \overline{I0}_{LV\ meas} $
$HV_{I_{0d>} diff\ subtract} = (\overline{IL1}_{HV} + \overline{IL2}_{HV} + \overline{IL3}_{HV}) - \overline{I0}_{HV\ meas} $	$LV_{I_{0d>} diff\ subtract} = (\overline{IL1}_{LV} + \overline{IL2}_{LV} + \overline{IL3}_{LV}) - \overline{I0}_{LV\ meas} $

Similarly to the phase differential stages, both sides with the restricted earth fault stages have options between the average and the maximum bias current calculation, as well as the option between the add and the subtract current calculation. The use of these stages depends on the CTs' installation directions and the desired sensitivity for bias calculation.

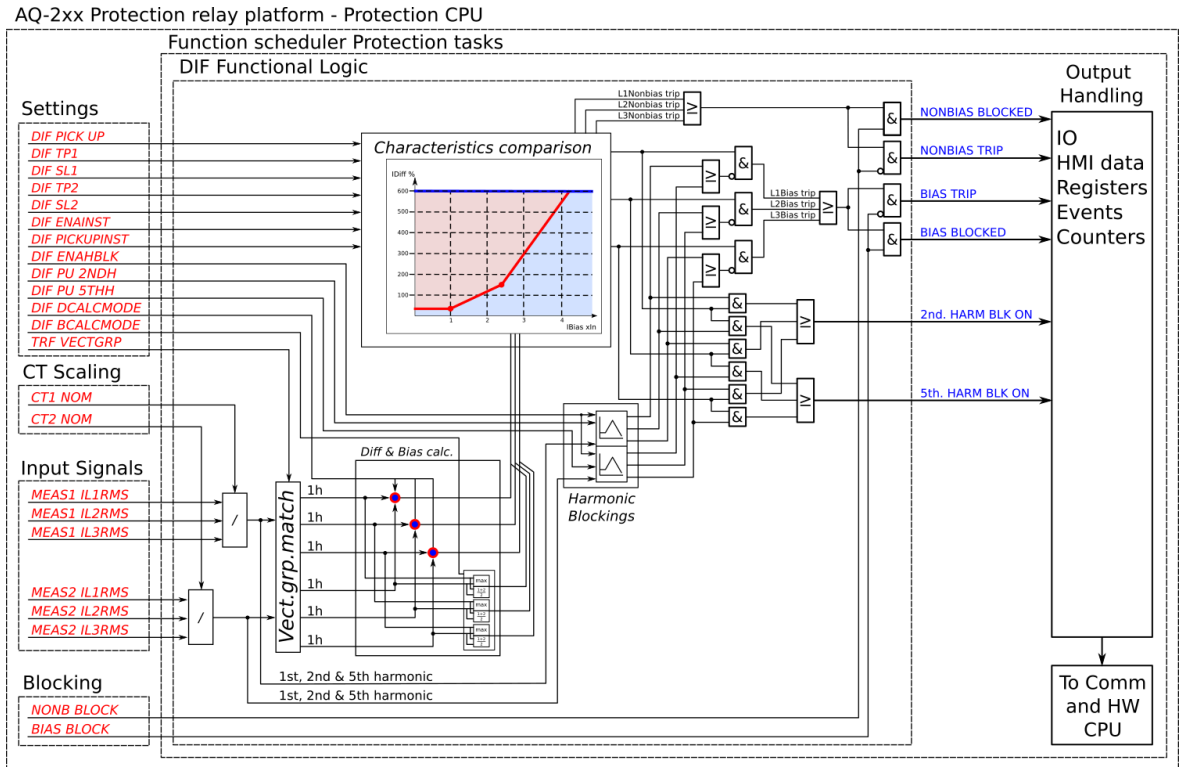
In the transformer differential stage the reference current for the REF protection is always the protected side nominal current, which is calculated in the relay's Transformer status monitoring (TRF) module.

Blockings from harmonics (2nd and 5th)

In transformer protection harmonics are always present in energizing situations: they are generated by the high current in the transformer inductances when the coils are energized. They are also present in the currents during overfluxing and overvoltage situations. Energizing situations generate even harmonics: the 2nd harmonic is the most commonly used harmonic in inrush blocking. Overvoltage (and overexcitation) situations generate odd harmonics: the 5th harmonic is mainly used for blocking (the 3rd harmonic is also present in Y windings but absent in delta windings which is why the 5th harmonic has been chosen for overfluxing and excitation detection). In this chapter 'blocking' refers to the $I_{db>}$ (the biased differential) stage and it has both these blocking (2nd and 5th) applied internally. If the $I_{di>}$ stage (the non-biased differential) needs to be blocked, external blocking must be used.

Differential function details

Figure. 4.4.7 - 51. Simplified function block diagram of the transformer differential function.



The transformer differential function outputs TRIP and BLOCKED signals from the biased and non-biased functions as well as the 2nd and 5th harmonic block activation signals. These signals can be used in protection applications.

Settings and signals

The settings of the differential function are a combination of transformer monitor and differential stage function settings. The following table shows the function's settings, including the general settings (in p.u.) used for pre-calculations.

Table. 4.4.7 - 69. Settings related to the differential function's pre-calculation.

Name	Range	Step	Default	Function	Description
Idx> LN mode	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	-	On	-	Set mode of DIF block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.

Name	Range	Step	Default	Function	Description
Idx> force status to	<ul style="list-style-type: none"> • Normal • ldb Blocked • ldb Trip • ldi Blocked • ldi Trip • H2block On • H5block On • HV I0d> Block On • HV I0d> Trip On • LV I0d> Block On • LV I0d> Trip On 	-	Normal	-	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
Idx> LN behaviour	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	-	-	-	Displays the mode of DIF block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
Transformer nominal	0.1...500.0MVA	0.1MVA	1.0MVA	All	The nominal MVA of the transformer. This value is used to calculate the nominal currents onf both the HV and the LV side.
HV side nominal voltage	0.1...500.0kV	0.1kV	110.0kV	All	The HV side nominal voltage of the transformer. This value is used to calculate the nominal currents of the HV side.
LV side nominal voltage	0.1...500.0kV	0.1kV	110.0kV	All	The LV side nominal voltage of the transformer. This value is used to calculate the nominal currents of the LV side.
Transformer Zk%	0.01...25.00%	0.01%	3.00%	Info	The transformer's short-circuit impedance in percentages. Used for calculating short-circuit current.
Transformer nom. freq.	10...75Hz	1Hz	50Hz	Info	The transformer's nominal frequency. Used for calculating the transformer's nominal short-circuit inductance.

Name	Range	Step	Default	Function	Description
Transf. vect. group	<ul style="list-style-type: none"> • Manual • Yy0 • Yyn0 • YNy0 • YNyn0 • Yy6 • Yyn6 • YNy6 • YNyn6 • Yd1 • YNd1 • Yd7 • YNd7 • Yd11 • YNd11 • Yd5 • YNd5 • Dy1 • Dyn1 • Dy7 • Dyn7 • Dy11 • Dyn11 • Dy5 • Dyn5 • Dd0 • Dd6 	-	Yy0	<ul style="list-style-type: none"> - transformer status monitoring - transformer differential 	<p>The selection of the transformer's vector group. The selection values (1–26) are predefined so that the scaling and vector matching are applied in the relay automatically when the correct vector group is selected.</p> <p>The predefinitions assume that the HV side is connected to the CT1 module and that the LV side is connected to the CT2 module.</p> <p>If the protected transformer vector group is not found in the predefined list, it can be manually set by selecting the option "Manual set".</p>
HV side Star or Zigzag/ Delta	<ul style="list-style-type: none"> • Star/Zigzag • Delta 	-	Star/ Zigzag	<ul style="list-style-type: none"> - transformer status monitoring - transformer differential 	<p>The selection of the HV side connection. Can be selected between star or zigzag and delta. This selection is visible only if the option "Manual set" is selected for the vector group setting.</p>
HV side grounded	<ul style="list-style-type: none"> • Not grounded • Grounded 	-	Not grounded	<ul style="list-style-type: none"> - transformer status monitoring - transformer differential 	<p>The selection of whether or not the zero sequence compensation is applied in the HV side current calculation. The selection is visible only if the option "Manual set" is selected for the vector group setting.</p>
HV side lead or lag LV	<ul style="list-style-type: none"> • Lead • Lag 	-	Lead	<ul style="list-style-type: none"> - transformer status monitoring - transformer differential 	<p>The selection of whether the HV side leads or lags the LV side. The selection is visible only if the option "Manual set" is selected for the vector group setting.</p>
LV side Star/ Zigzag or Delta	<ul style="list-style-type: none"> • Star/Zigzag • Delta 	-	Star/ Zigzag	<ul style="list-style-type: none"> - transformer status monitoring - transformer differential 	<p>The selection of the LV side connection. Can be selected between star or zigzag and delta. This selection is visible only if the option "Manual set" is selected for the vector group setting.</p>
LV side grounded	<ul style="list-style-type: none"> • Not grounded • Grounded 	-	Not grounded	<ul style="list-style-type: none"> - transformer status monitoring - transformer differential 	<p>The selection of whether or not the zero sequence compensation is applied in the LV side current calculation. The selection is visible only if the option "Manual set" is selected for the vector group setting.</p>

Name	Range	Step	Default	Function	Description
LV side lead or lag HV	<ul style="list-style-type: none"> Lead Lag 	-	Lead	- transformer status monitoring - transformer differential	The selection of whether the LV side leads or lags the HV side. The selection is visible only if the option "Manual set" is selected for the vector group setting.
HV-LV side phase angle	0.0...360.00deg	0.1deg	0.0deg	- transformer status monitoring - transformer differential	The angle correction factor for HV/LV sides, looked from the HV side. The setting is visible only if the option "Manual set" is selected for the vector group setting.
HV-LV side mag correction	0.0...100.0×I _n	0.1×I _n	1.0×I _n	- transformer status monitoring - transformer differential	The magnitude correction for the HV-LV side currents (in p.u.), if the currents are not directly matched through the calculations of the nominal values. The selection is visible only if the option "Manual set" for the vector group setting.
Check online HV-LV configuration	<ul style="list-style-type: none"> - Check 	-	-	- transformer status monitoring - transformer differential	The selection of whether or not the function checks the current going through the transformer and then compares it to the settings. For this to work, the transformer needs to have a current flowing on both sides and "see" no faults. The selection is visible only if the option "Manual set" is selected for the vector group setting.
Enable I0d> (REF) HV side	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	- transformer status monitoring - transformer differential	The selection of whether the restricted earth fault stage on the HV side is enabled or disabled.
HV side starpoint meas.	<ul style="list-style-type: none"> I₀₁ I₀₂ 	-	I ₀₁	- transformer status monitoring - transformer differential	The selection of the starpoint measurement channel for the restricted earth fault protection on the HV side. This setting is only visible if the option "Enabled" is selected for the "Enable I0d> (REF) HV side" setting.
Enable I0d> (REF) LV side	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	- transformer status monitoring - transformer differential	The selection of whether the restricted earth fault stage on the LV side is enabled or disabled.
LV side starpoint meas.	<ul style="list-style-type: none"> I₀₁ I₀₂ 	-	I ₀₁	- transformer status monitoring - transformer differential	The selection of the starpoint measurement channel for the restricted earth fault protection on the LV side. This setting is only visible if the option "Enabled" is selected for the "Enable I0d> (REF) LV side" setting.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.7 - 70. Settings for the operating characteristics.

Name	Range	Step	Default	Description
Differential calculation mode	<ul style="list-style-type: none"> Add Subtract 	-	Subtract	The calculation mode of the differential current. The mode selection depends on the CTs' installation direction and the desired current directions. If the current flow on both sides is in the same direction, the differential current is subtracted. If the current flows are in the opposite directions, the differential current is added.
Bias calculation mode	<ul style="list-style-type: none"> Average Maximum 	-	Average	The calculation mode of the biasing current. With the average mode the operation may be set to be more sensitive. With the maximum mode the bias is always higher and thus provides a more stable operation.
I _{db} > Pick-up	0.01...100.00%	0.01%	10.00%	The base sensitivity for the differential characteristics.
Turnpoint 1	0.01...50.00×I _n	0.01×I _n	1.00×I _n	Turnpoint 1 for the differential characteristics.
Slope 1	0.01...250.00%	0.01%	10.00%	Slope 1 for the differential characteristics.
Turnpoint 2	0.01...50.00×I _n	0.01×I _n	3.00×I _n	Turnpoint 2 for the differential characteristics.
Slope 2	0.01...250.00%	0.01%	200.00%	Slope 2 of the differential characteristics-
Enable harmonic blocking	<ul style="list-style-type: none"> No harmonic blocking 2nd harmonic blocking 5th harmonic blocking 2nd and 5th harmonic blocking 	-	2 nd harmonic blocking	The selection of the internal blockings to be used for the detection of transformer normal operations that cause differential currents.
2 nd harmonic blocking pick-up	0.01...50.00%	0.01%	15.00%	The pick-up detection for the 2 nd harmonic blocking stage. This setting is only visible if the "Enable harmonic blocking" setting is set to "2nd harm" or "2nd and 5th harm".
5 th harmonic blocking pick-up	0.01...50.00%	0.01%	35.00%	The pick-up detection for the 5 th harmonic blocking stage. This setting is only visible if the "Enable harmonic blocking" setting is set to "5th harm" or "2nd and 5th harm".
2nd harmonic maximum uptime	0.000...10.000 s	0.010 s	0.000 s	Determines the maximum time the detection of 2nd harmonic can block the operation of the function. Not in use when set to zero.
5th harmonic maximum uptime	0.000...10.000 s	0.010 s	0.000 s	Determines the maximum time the detection of 5th harmonic can block the operation of the function. Not in use when set to zero.

Name	Range	Step	Default	Description
Enable I _d > stage	<ul style="list-style-type: none"> Disabled Enabled 	-	Enabled	The selection of whether the non-biased and the non-blocked differential stage is enabled or disabled.
I _d > Non-biased pick-up	200.00...1500.00%	0.01%	600.00%	The pick-up setting for the non-biased and non-blocked differential stage. This setting is only visible if the "Enable I _d > stage" is disabled.
HV I _{0d} > Pick-up	0.01...100.00%	0.01%	10.00%	The base sensitivity for the HV side restricted earth fault differential characteristics. This setting is only visible if the "Enable I _{0d} > (REF) HV side" setting is enabled.
HV I _{0d} > Turnpoint 1	0.01...50.00×I _n	0.01×I _n	1.00×I _n	Turnpoint 1 for the HV side restricted earth fault differential characteristics. This setting is only visible if the "Enable I _{0d} > (REF) HV side" setting is enabled.
HV I _{0d} > Slope 1	0.01...250.00%	0.01%	10.00%	Slope 1 of the HV side restricted earth fault differential characteristics. This setting is only visible if the "Enable I _{0d} > (REF) HV side" setting is enabled.
HV I _{0d} > Turnpoint 2	0.01...50.00×I _n	0.01×I _n	3.00×I _n	Turnpoint 2 for the HV side restricted earth fault differential characteristics. This setting is only visible if the "Enable I _{0d} > (REF) HV side" setting is enabled.
HV I _{0d} > Slope 2	0.01...250.00%	0.01%	200.00%	Slope 2 of the HV side restricted earth fault differential characteristics. This setting is only visible if the "Enable I _{0d} > (REF) HV side" setting is enabled.
LV I _{0d} > Pick-up	0.01...100.00%	0.01%	10.00%	The base sensitivity for the LV side restricted earth fault differential characteristics. This setting is only visible if the "Enable I _{0d} > (REF) LV side" setting is enabled.
LV I _{0d} > Turnpoint 1	0.01...50.00×I _n	0.01×I _n	1.00×I _n	Turnpoint 1 for the LV side restricted earth fault differential characteristics. This setting is only visible if the "Enable I _{0d} > (REF) LV side" setting is enabled.
LV I _{0d} > Slope 1	0.01...250.00%	0.01%	10.00%	Slope 1 of the LV side restricted earth fault differential characteristics. This setting is only visible if the "Enable I _{0d} > (REF) LV side" setting is enabled.
LV I _{0d} > Turnpoint2	0.01...50.00×I _n	0.01×I _n	3.00×I _n	Turnpoint 2 for the LV side restricted earth fault differential characteristics. This setting is only visible if the "Enable I _{0d} > (REF) LV side" setting is enabled.
LV I _{0d} > Slope 2	0.01...250.00%	0.01%	200.00%	Slope 2 of the LV side restricted earth fault differential characteristics. This setting is only visible if the "Enable I _{0d} > (REF) LV side" setting is enabled.

Table. 4.4.7 - 71. Calculations of the transformer differential function.

Name	Description
L1Bias	The calculated phase L1 bias current
L2Bias	The calculated phase L2 bias current
L3Bias	The calculated phase L3 bias current
L1Diff	The calculated phase L1 differential current

Name	Description
L2Diff	The calculated phase L2 differential current
L3Diff	The calculated phase L3 differential current
L1Char	The calculated phase L1 maximum differential current allowed with current bias level
L2Char	The calculated phase L1 maximum differential current allowed with current bias level
L3Char	The calculated phase L1 maximum differential current allowed with current bias level
HV I0d> Bias current	The calculated HV side restricted earth fault bias current
HV I0d> Diff current	The calculated HV side restricted earth fault differential current
HV I0d> Char current	The calculated HV side restricted earth fault differential current allowed with current bias level
LV I0d> Bias current	The calculated LV side restricted earth fault bias current
LV I0d> Diff current	The calculated LV side restricted earth fault differential current
LV I0d> Char current	The calculated LV side restricted earth fault differential current allowed with current bias level

Table. 4.4.7 - 72. Output signals of the transformer differential function.

Name	Description
Idb> Bias Trip	The TRIP output signal from the biased differential stage
Idi> Nobias Trip	The TRIP output signal from the non-biased and non-blocked differential stage
Idb> Bias Blocked	The BLOCKED output from the biased differential stage (external blocking)
Idi> Bias Blocked	The BLOCKED output from the non-biased and non-blocked differential stage (external blocking)
Idb> 2 nd harm block on	The output of the 2 nd harmonic activation signal
Idb> 5 th harm block on	The output of the 5 th harmonic activation signal
HV I0d> Trip	The TRIP output signal from the biased restricted earth fault differential stage on the HV side
HV I0d> Trip	The BLOCKED output signal from the biased restricted earth fault differential stage on the HV side
LV I0d> Trip	The TRIP output signal from the biased restricted earth fault differential stage on the LV side
LV I0d> Trip	The BLOCKED output signal from the biased restricted earth fault differential stage on the LV side

Function blocking

The blocking signal is evaluated at the start of each program cycle. The blocking signals are connected to the function's dedicated input, which can be configured in the *IO → Blocking Input Control* tab of the function.

- When the pick-up element activates and the blocking signal is not active, a TRIP signal is generated.
- When the pick-up element activates and the blocking signal is active, a BLOCKED signal is generated, and the function does not process the event further.

The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Events and registers

The transformer differential function (abbreviated "DIF" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the TRIP, 2nd Harmonic Block, 5th Harmonic Block, External Block events.

Table. 4.4.7 - 73. Event messages.

Event block name	Event names
DIF1	ldb> Trip ON/OFF
DIF1	ldb> Blocked (ext) ON/OFF
DIF1	ldi> Trip ON/OFF
DIF1	ldi> Blocked (ext) ON/OFF
DIF1	2 nd Harmonic Block ON/OFF
DIF1	5 th Harmonic Block ON/OFF
DIF1	L1 2 nd harmonic ON/OFF
DIF1	L2 2 nd harmonic ON/OFF
DIF1	L3 2 nd harmonic ON/OFF
DIF1	L1 5 th harmonic ON/OFF
DIF1	L2 5 th harmonic ON/OFF
DIF1	L3 5 th harmonic ON/OFF
DIF1	HV I0d> Block ON/OFF
DIF1	HV I0d> Trip ON/OFF
DIF1	LV I0d> Block ON/OFF

Event block name	Event names
DIF1	LV I0d> Trip ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers. The table below presents the structure of the function's register content.

Table. 4.4.7 - 74. Register content.

Name	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
L1 bias current	Phase L1 bias current
L1 diff. current	Phase L1 maximum differential current
L1 char. current	Phase L1 maximum differential current with bias
L2 bias current	Phase L2 bias current
L2 diff. current	Phase L2 maximum differential current
L2 char. current	Phase L2 maximum differential current with bias
L3 bias current	Phase L3 bias current
L3 diff. current	Phase L3 maximum differential current
L3 char. current	Phase L3 maximum differential current with bias
HV I0d> bias current	HV side REF bias current
HV I0d> differential current	HV side REF differential current
HV I0d> characteristics current	HV side REF maximum differential current with bias
LV I0d> bias current	LV side REF bias current
LV I0d> differential current	LV side REF differential current
LV I0d> characteristics current	LV side REF maximum differential current with bias
Setting group in use	Setting group in use
Ftype	Detected fault type (faulty phases)

4.4.8 Transformer thermal overload protection (TT>; 49T)

The transformer thermal overload protection function is used for monitoring and protecting thermal capacity in power transformers.

The function constantly monitors the instant values of phase TRMS currents (including harmonics up to 31st) and calculates the set thermal replica status in 5 ms cycles. The function includes a total memory function of the load current conditions according to IEC 60255-8.

The function is based on a thermal replica which represents the protected object's or cable's thermal loading in relation to the current going through the object. The thermal replica includes the calculated thermal capacity that the "memory" uses; it is an integral function which tells this function apart from a normal overcurrent function and its operating principle for overload protection applications.

The thermal image for the function is calculated according to the equation described below:

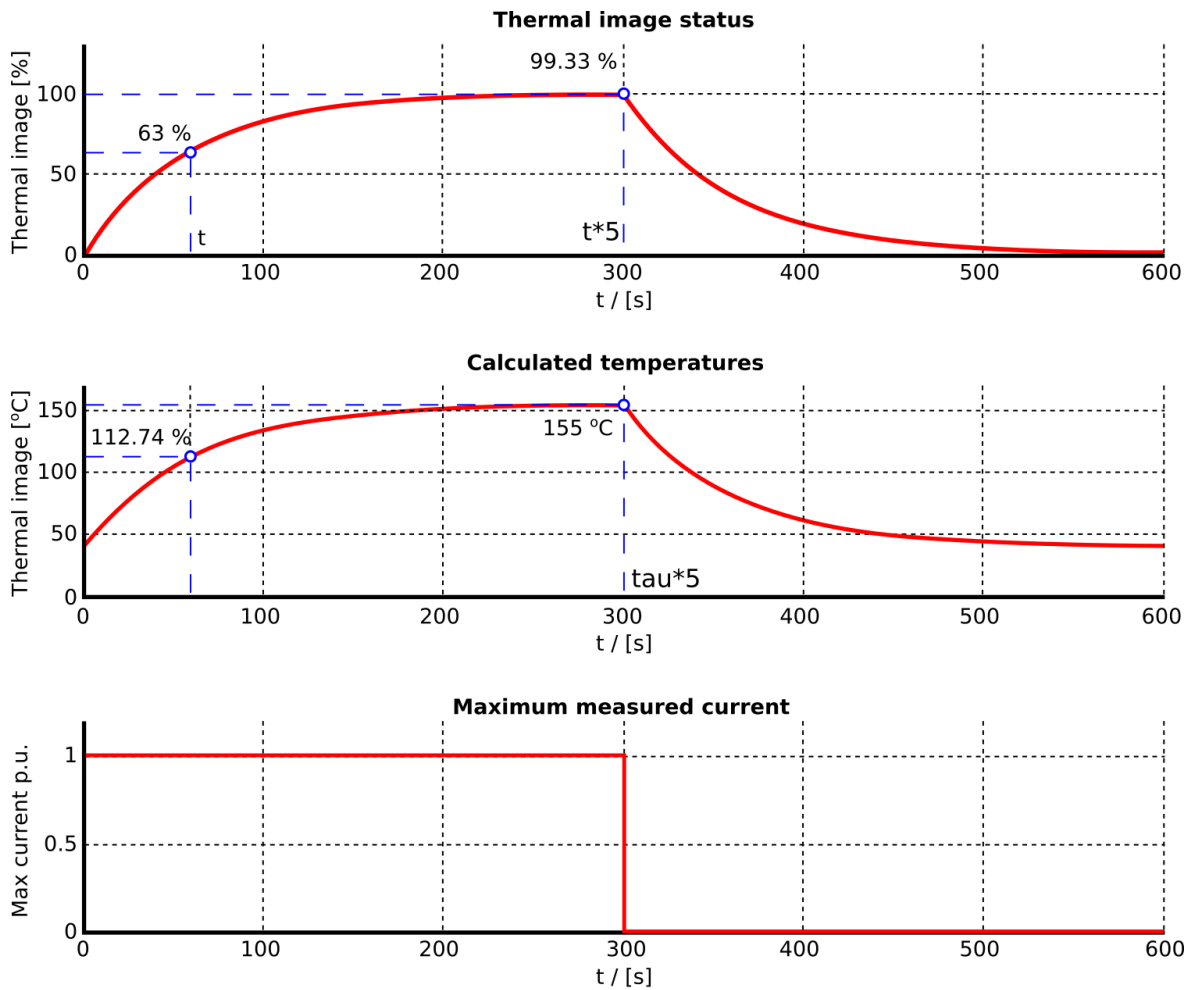
$$\theta_{t\%} = \left(\left(\theta_{t-1} - \left(\frac{I_{MAX}}{I_N \times k_{SF} \times k_{AMB}} \right)^2 \times e^{-\frac{t}{\tau_1/\tau_2}} \right) + \left(\frac{I_{MAX}}{I_N \times k_{SF} \times k_{AMB}} \right)^2 \right) \times 100\%$$

Where:

- $\theta_{t\%}$ = Thermal image status, percentage of the maximum available thermal capacity
- θ_{t-1} = Thermal image status, previous calculation cycle (the memory of the function)
- I_{max} = Measured maximum of the three TRMS phase currents
- I_N = Current for the 100 % thermal capacity to be used (pick-up current in p.u., t_{max} achieved in $\tau \times 5$)
- k_{SF} = Loading factor (service factor), maximum allowed load current (in p.u.) value, dependent on the protected object or cable/line installation
- k_{amb} = Temperature correction factor, either from a linear approximation or from a settable ten-point thermal capacity curve
- t = Calculation time step (0.005 s)
- e = Euler's number
- τ_1 = Thermal heating time constant of the protected object (in minutes)
- τ_2 = Thermal heating time constant of the protected object (in minutes)

The basic operating principle of the thermal replica is based on the nominal temperature rise, which is achieved when the protected object is loaded with a nominal load in a nominal ambient temperature. When the object is loaded with a nominal load for a time equal to its heating constant tau (τ), 63% of the nominal thermal capacity is used. When the loading continues until five times this given constant, the used thermal capacity approaches 100 % indefinitely but never exceeds it. With a single time constant model the cooling of the object follows this same behavior, the reverse of the heating when the current feeding is zero.

Figure. 4.4.8 - 52. Example of thermal image calculation with nominal conditions.



Settings

$I_N = 1.00$ p.u.	Max. temperature rise = 115 °C
$Q_{t-1} = 0.01$ %	Ambient temperature = 40 °C
$\tau = 1$ minutet	Max end temperature = 155 °C
Service factor = 1.00	Temperature k factor = 1.00

The described behavior is based on the assumption that the monitored object (whether a cable, a line or an electrical device) has a homogenous body which generates and dissipates heat with a rate proportional to the temperature rise caused by the current squared. This is usually the case with cables and other objects while the heat dissipation of overhead lines is dependent on the weather conditions. Weather conditions considering the prevailing conditions in the thermal replica are compensated with the ambient temperature coefficient which is constantly calculated and changing when using RTD sensor for the measurement. When the ambient temperature of the protected object is stable it can be set manually (e.g. underground cables).

The ambient temperature compensation takes into account the set minimum and maximum temperatures and the load capacity of the protected object as well as the measured or set ambient temperature. The calculated coefficient is a linear correction factor, as the following formula shows:

$$t_{Amb < t_{min}} = k_{min}$$

$$t_{Amb < t_{ref}} = \left(\frac{1 - k_{min}}{t_{ref} - t_{min}} \times (t_{AMB} - t_{min}) \right) + k_{min}$$

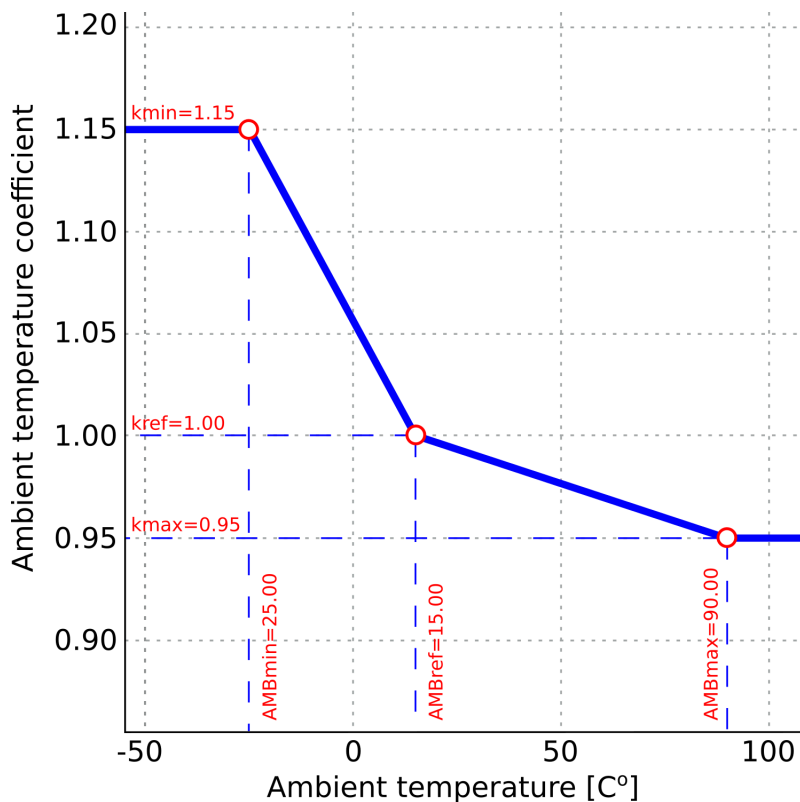
$$t_{Amb > t_{ref}} = \left(\frac{k_{max} - 1}{t_{max} - t_{ref}} \times (t_{AMB} - t_{ref}) \right) + 1.0$$

$$t_{Amb > t_{max}} = k_{max}$$

Where:

- t_{amb} = Measured (set) ambient temperature (can be set in °C or °F)
- t_{max} = Maximum temperature (can be set in °C or °F) for the protected object
- k_{max} = Ambient temperature correction factor for the maximum temperature
- t_{min} = Minimum temperature (can be set in °C or °F) for the protected object
- k_{min} = Ambient temperature correction factor for the minimum temperature
- t_{ref} = Ambient temperature reference (can be set in °C or °F, the temperature in which the manufacturer's temperature presumptions apply, the temperature correction factor is 1.0)

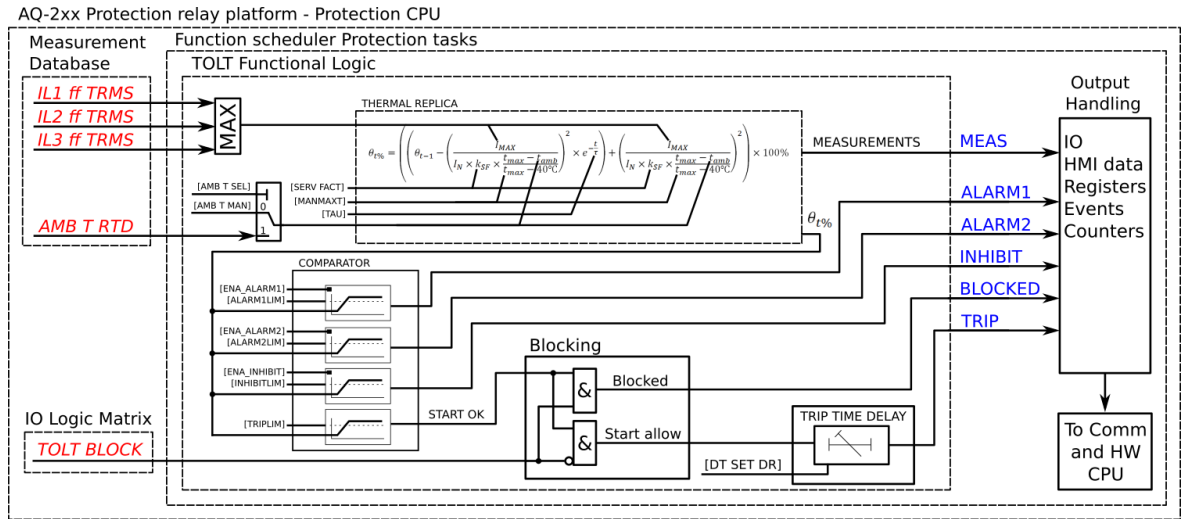
Figure. 4.4.8 - 53. Ambient temperature coefficient calculation (a three-point linear approximation and a settable correction curve).



Function inputs and outputs

The following figure presents a simplified function block diagram of the transformer thermal overload protection function.

Figure. 4.4.8 - 54. Simplified function block diagram of the TT> function.



Measured input

The function block uses phase current measurement values. The function block uses TRMS values from the whole harmonic spectrum of 32 components. RTD input can be used for measuring the ambient temperature.

Table. 4.4.8 - 75. Measurement inputs of the TT> function.

Signal	Description
I_{L1} TRMS	TRMS measurement of phase L1 (A) current
I_{L2} TRMS	TRMS measurement of phase L2 (B) current
I_{L3} TRMS	TRMS measurement of phase L3 (C) current
RTD	Temperature measurement for the ambient correction

Table. 4.4.8 - 76. General settings (not selectable under setting groups)

Name	Range	Default	Description
TT> LN mode	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	On	Set mode of TOLT block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
TT> mode	<ul style="list-style-type: none"> Disabled Activated 	Disabled	The selection of the function is activated or disabled in the configuration. By default it is not in use.

Name	Range	Default	Description
TT> force status to	<ul style="list-style-type: none"> • Normal • Blocked • Alarm1 On • Alarm2 On • Inhibit On • Trip On 	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
Temp C or F deg	<ul style="list-style-type: none"> • C • F 	C	The selection of whether the temperature values of the thermal image and RTD compensation are shown in Celsius or in Fahrenheit.

Table. 4.4.8 - 77. Settings for thermal replica.

Name	Range	Step	Default	Description
IN thermal cap current	0.10...40.00xI _n	0.01xI _n	1.00xI _n	The current for the 100 % thermal capacity to be used (the pick-up current in p.u., with t _{max} achieved in time τ x 5).
tau h (t const)	0.1...500.0min	0.1min	10.0min	The τ _h time constant setting. This time constant is used for the heating of the protected object.
tau c (t const)	0.1...500.0min	0.1min	10.0min	The τ _c time constant setting. This time constant is used for the cooling of the protected object.
ksF (service factor)	0.01...5.00	0.01	1.00	The service factor which corrects the value of the maximum allowed current according to installation and other conditions varying from the presumptive conditions.
Cold reset default theta	0.0...150.0%	0.1%	60.0%	The thermal image status in the restart of the function or the device. The value is given in percentages of the used thermal capacity of the protected object. It is also possible to reset the thermal element. This parameter can be used when testing the function to manually set the current thermal cap to any value.

Table. 4.4.8 - 78. Environmental settings

Name	Range	Step	Default	Description
Object max. temp. (t _{max} = 100%)	0...500deg	1deg	90deg	The maximum allowed temperature for the protected object. The default suits for Celsius range and for PEX-insulated cables.
Ambient temp. sel.	<ul style="list-style-type: none"> • Manual set • RTD 	-	Manual set	The selection of whether fixed or measured ambient temperature is used for the thermal image biasing.
Man. amb. temp. set	0...500deg	1deg	15deg	The manual fixed ambient temperature setting for the thermal image biasing. Underground cables usually use 15 °C. This setting is visible if "Manual set" is selected for the "Ambient temp. sel." setting.

Name	Range	Step	Default	Description
RTD amb. temp. read.	0...500deg	1deg	15deg	The RTD ambient temperature reading for the thermal image biasing. This setting is visible if "RTD" is selected for the "Ambient temp. sel." setting.
Ambient lin. or curve	<ul style="list-style-type: none"> Linear est. Set curve 	-	Linear est.	The selection of how to correct the ambient temperature, either by internally calculated compensation based on end temperatures or by a user-settable curve. The default setting is "Linear est." which means the internally calculated correction for ambient temperature.
Temp. reference (t _{ref}) k _{amb} =1.0	-60...500deg	1deg	15deg	The temperature reference setting. The manufacturer's temperature presumptions apply and the thermal correction factor is 1.00 (rated temperature). For underground cables the set value for this is usually 15 °C and for cables in the air it is usually 25 °C. This setting is visible if "Ambient lin. or curve" is set to "Linear est."
Max. ambient temp.	0...500deg	1deg	45deg	The maximum ambient temperature setting. If the measured temperature is more than the maximum set temperature, the set correction factor for the maximum temperature is used. This setting is visible if "Ambient lin. or curve" is set to "Linear est."
k at max. amb. temp.	0.01...5.00xI _n	0.01xI _n	1.00xI _n	The temperature correction factor for the maximum ambient temperature setting. This setting is visible if "Ambient lin. or curve" is set to "Linear est."
Min. ambient temp.	-60...500deg	1deg	0deg	The minimum ambient temperature setting. If the measured temperature is below the minimum set temperature, the set correction factor for minimum temperature is used. This setting is visible if "Ambient lin. or curve" is set to "Linear est."
k at min. amb. temp.	0.01...5.00xI _n	0.01xI _n	1.00xI _n	The temperature correction factor for the minimum ambient temperature setting. This setting is visible if "Ambient lin. or curve" is set to "Linear est."
Amb. temp. ref. 1...10	-50.0...500.0deg	0.1deg	15deg	The temperature reference points for the user-settable ambient temperature coefficient curve. This setting is visible if "Ambient lin. or curve" is set to "Set curve".
Amb. temp. k1...k10	0.01...5.00	1.00	0.01	The coefficient value for the temperature reference point. The coefficient and temperature reference points must be set as pairs. This setting is visible if "Ambient lin. or curve" is set to "Set curve".
Add curvepoint 3...10	<ul style="list-style-type: none"> Not used Used 	-	Not used	The selection of whether or not the curve temperature/coefficient pair is in use. The minimum number to be set for the temperature/coefficient curve is two pairs and the maximum is ten pairs. If the measured temperature is below the set minimum temperature reference or above the maximum set temperature reference, the used temperature coefficient is the first or last value in the set curve. This setting is visible if "Ambient lin. or curve" is set to "Set curve".

Pick-up settings

The operating characteristics of the machine thermal overload protection function are completely controlled by the thermal image. The thermal capacity value calculated from the thermal image can set the I/O controls with ALARM 1, ALARM 2, INHIBIT and TRIP signals.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.8 - 79. Pick-up settings.

Name	Range	Step	Default	Description
Enable TT> Alarm 1	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	Enabling/disabling the ALARM 1 signal and the I/O.
TT> Alarm 1 level	0.0...150.0%	0.1%	40%	ALARM 1 activation threshold.
Enable TT> Alarm 2	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	Enabling/disabling the ALARM 2 signal and the I/O.
TT> Alarm 2 level	0.0...150.0%	0.1%	40%	ALARM 2 activation threshold.
Enable TT> Rest Inhibit	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	Enabling/disabling the INHIBIT signal and the I/O.
TT> Inhibit level	0.0...150.0%	0.1%	80%	INHIBIT activation threshold.
Enable TT> Trip	<ul style="list-style-type: none"> Disabled Enabled 	-	Enabled	Enabling/disabling the TRIP signal and the I/O.
TT> Trip level	0.0...150.0%	0.1%	100%	TRIP activation threshold. This parameter is only visible when "Enable TT> Trip" is Enabled.
TT> Trip delay	0.000...3600.000s	0.005s	0.000s	The trip signal's additional delay. This delay delays the trip signal generation by a set time. The default setting is 0.000 s which does not give an added time delay for the trip signal. This parameter is only visible when "Enable TT> Trip" is Enabled.

Function blocking

The blocking signal is evaluated at the start of each program cycle. The blocking signals are connected to the function's dedicated input, which can be configured in the *IO* → *Blocking Input Control* tab of the function.

- When the pick-up element activates and the blocking signal is not active, a START signal is generated, and the function starts or continues with the trip time countdown.
- When the pick-up element activates and the blocking signal is active, a BLOCKED signal is generated, and the function does not process the event further.
- When a START signal is already active and the blocking input signal becomes active, the START signal is reset and BLOCKED signal is generated. The release time characteristics are then processed in the same way as when the pick-up signal is reset.

The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Measurements and indications

The function outputs measured process data from the following magnitudes:

Table. 4.4.8 - 80. General status codes.

Name	Range	Description
TT> LN behaviour	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	<p>Set mode of TOLT block.</p> <p>This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.</p>
TT> Condition	<ul style="list-style-type: none"> • Normal • Alarm 1 ON • Alarm 2 ON • Inhibit ON • Trip ON • Blocked 	<p>The function's operating condition at the moment considering binary IO signal status. No outputs are controlled when the status is "Normal".</p>
Thermal status	<ul style="list-style-type: none"> • Light/No load • High overload • Overloading • Load normal 	<p>The function's thermal image status. When the measured current is below 1 % of the nominal current, the status "Light/No load" is shown. When the measured current is below the trip limit, the status "Load normal" is shown. When the measured current is above the pick-up limit but below $2 \times I_n$, the status "Overloading" is shown. When the measured current is above $2 \times I_n$, the status "High overload" is shown.</p>
TT> Setting alarm	<ul style="list-style-type: none"> • SF setting ok • Service factor set fault. Override to 1.0 	<p>Indicates if SF setting has been set wrong and the actually used setting is 1.0. Visible only when there is a setting fault.</p>
TT> Setting alarm	<ul style="list-style-type: none"> • Ambient setting ok • Ambient t set fault. Override to 1.0 	<p>Indicates if ambient temperature settings have been set wrong and actually used setting is 1.0. Visible only when there is a setting fault.</p>

Name	Range	Description
TT> Setting alarm	<ul style="list-style-type: none"> Nominal current calc ok Nominal current set fault. Override to 1.0 	Indicates if nominal current calculation is set wrong and actually used setting is 1.0. Visible only when there is a setting fault.
TT> Setting alarm	<ul style="list-style-type: none"> Ambient setting ok Inconsistent setting of ambient k 	Indicates if ambient k setting has been set wrong. Visible only when there is a setting fault.

Table. 4.4.8 - 81. Measurements.

Name	Range	Description/values
Currents	<ul style="list-style-type: none"> Primary A Secondary A Per unit 	The active phase current measurement from IL1 (A), IL2 (B) and IL3 (C) phases in given scalings.
Thermal image	Thermal image calc.	<ul style="list-style-type: none"> - TT> Trip expect mode: No trip expected/Trip expected - TT> Time to 100 % theta: Time to reach the 100 % thermal cap - TT> Rreference T curr.: reference/pick-up value (IEQ) - TT> Active meas. curr.: the measured maximum TRMS current at a given moment - TT> T est. with act. curr.: estimation of the used thermal capacity including the current at a given moment - TT> T at a given moment: the thermal capacity used at that moment
	Temp. estimates	<ul style="list-style-type: none"> - TT> Used k for amb. temp: the ambient correction factor at a given moment - TT> Max. temp. rise all.: the maximum allowed temperature rise - TT> Temp. rise atm: the calculated temperature rise at a given moment - TT> Hot spot estimate: the estimated hot spot temperature including the ambient temperature - TT> Hot spot max. all.: the maximum allowed temperature for the object
	Timing status	<ul style="list-style-type: none"> - TT> Trip delay remaining: the time to reach 100% theta - TT> Trip time to rel.: the time to reach theta while staying below the trip limit during cooling - TT> Alarm 1 time to rel.: the time to reach theta while staying below the Alarm 1 limit during cooling - TT> Alarm 2 time to rel.: the time to reach theta while staying below the Alarm 2 limit during cooling - TT> Inhibit time to rel.: the time to reach theta while staying below the Inhibit limit during cooling

Table. 4.4.8 - 82. Counters.

Name	Description / values
Alarm1 inits	The number of times the function has activated the Alarm 1 output
Alarm2 inits	The number of times the function has activated the Alarm 2 output

Name	Description / values
Restart inhibits	The number of times the function has activated the Restart inhibit output
Trips	The number of times the function has tripped
Trips Blocked	The number of times the function trips has been blocked

Events and registers

The line thermal overload protection function (abbreviated "TOLT" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the ALARM, INHIBIT, TRIP and BLOCKED events.

Table. 4.4.8 - 83. Event messages.

Event block name	Event names
TOLT1	Alarm1 ON/OFF
TOLT1	Alarm2 ON/OFF
TOLT1	Inhibit ON/OFF
TOLT1	Trip ON/OFF
TOLT1	Block ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for TRIP, BLOCKED, etc. signals. The table below presents the structure of the function's register content.

Table. 4.4.8 - 84. Register content.

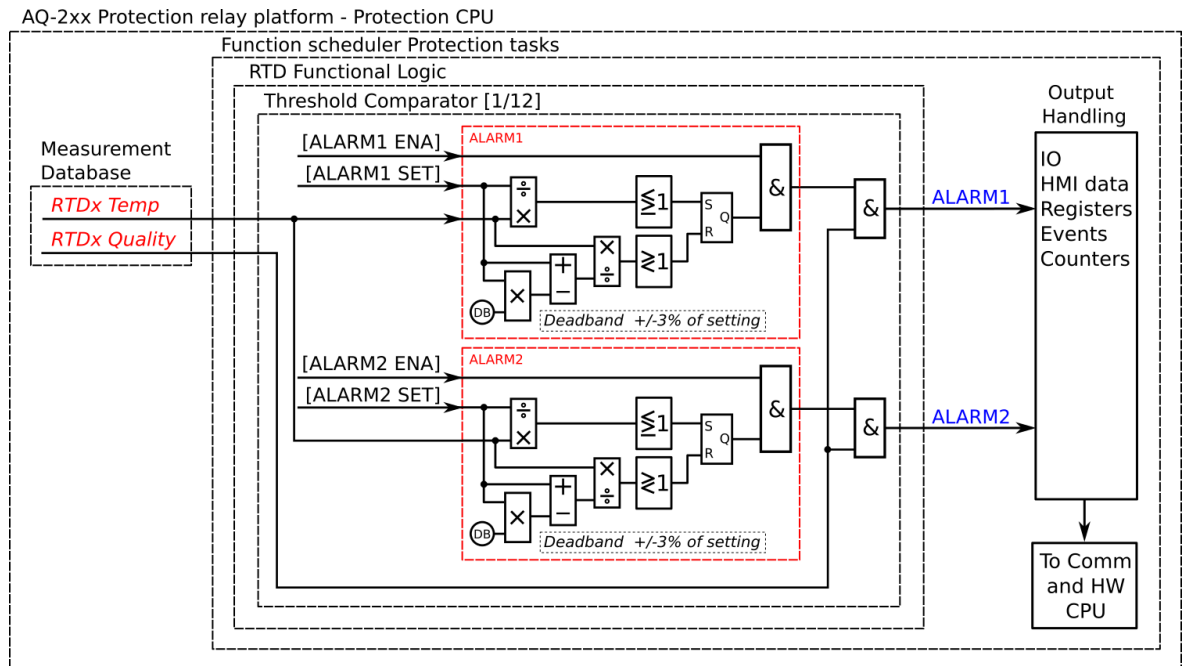
Name	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Time to reach 100 % theta	seconds
Ref. T current	$x I_n$
Active meas. current	$x I_n$
T at a given moment	%
Max. temp. rise allowed	degrees
Temp. rise at a given moment	degrees
Hot spot estimate	degrees

Name	Description
Hot spot maximum allowed	degrees
Trip delay rem.	seconds
Setting group in use	Setting group 1...8 active

4.4.9 Resistance temperature detectors (RTD)

Resistance temperature detectors (or RTDs) can be used to measure both temperatures of motors/ generators and ambient temperatures. Typically an RTD is a thermocouple or of type PT100. Up to three (3) separate RTD modules based on an external Modbus are supported; each can hold up to eight (8) measurement elements. Up to two (2) separate RTD option cards are supported by this function. Sixteen (16) individual element monitors can be set for this alarm function, and each of those can be set to alarm two (2) separate alarms from one selected input. The user can set alarms and measurements to be either in degrees Celsius or Fahrenheit.

Figure. 4.4.9 - 55. Simplified function block diagram of the resistance temperature detection function.



Settings

Table. 4.4.9 - 85. General settings of the function.

Name	Range	Default	Description
RTD LN mode	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	On	Set mode of RTD block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.

Name	Range	Default	Description
RTD LN behaviour	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	-	<p>Displays the mode of RTD block.</p> <p>This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.</p>

Setting up an RTD measurement, the user first needs to set the measurement module to scan the wanted RTD elements. A multitude of Modbus-based modules are supported. Communication requires bitrate, databits, parity, stopbits and Modbus I/O protocol to be set; this is done at *Communication* → *Connections*. Once communication is set, the wanted channels are selected at *Communication* → *Protocols* → *ModbusIO*. Then the user selects the measurement module from the three (3) available modules (A, B and C), as well as the poll address. Additionally, both the module type and the polled channels need to be set. When using a thermocouple module, the thermo element type also needs to be set for each of the measurement channels. Once these settings are done the RTDs are ready for other functions.

Table. 4.4.9 - 86. Function settings for Channel x (Sx).

Name	Range	Step	Default	Description
S1...S16 enable	No Yes	-	No	Enables/disables the selection of sensor measurements and alarms.
S1...S16 module	<ul style="list-style-type: none"> InternalRTD1 InternalRTD2 ExtModuleA ExtModuleB ExtModuleC 	-	InternalRTD1	Selects the measurement module. Internal RTD modules are option cards installed to the device. External modules are Modbus based external devices.
S1...S16 channel	<ul style="list-style-type: none"> Channel 0 Channel 1 Channel 2 Channel 3 Channel 4 Channel 5 Channel 6 Channel 7 	-	Channel 0	Selects the measurement channel in the selected module.
S1...S16 Deg C/Dec F	<ul style="list-style-type: none"> Deg C Deg F 	-	Deg C	Selects the measurement temperature scale (Celsius or Fahrenheit).
S1...S16 Measurement	-	-	-	Displays the measurement value in the selected temperature scale.
S1...S16 Sensor	<ul style="list-style-type: none"> Ok Invalid 	-	-	Displays the measured sensor's data validity. If the sensor reading has any problems, the sensor data is set to "Invalid" and the alarms are not activated.
S1...S16 Enable alarm 1	<ul style="list-style-type: none"> Disable Enable 	-	Disable	Enables/disables the selection of Alarm 1 for the measurement channel x.
S1...S16 Alarm1 >/<	<ul style="list-style-type: none"> > < 	-	>	Selects whether the alarm activates when measurement is above or below the pick-up setting value.

Name	Range	Step	Default	Description
S1...S16 Alarm1	-101.0...2000.0deg	0.1deg	0.0deg	Sets the pick-up value for Alarm 1. The alarm is activated if the measurement goes above or below this setting mode (depends on the selected mode in "Sx Alarm1 >/<").
S1...S16 sensor	<ul style="list-style-type: none"> • Ok • Invalid 	-	-	Displays the measured sensor's data validity. If the sensor reading has any problems, the sensor data is set to "Invalid" and the alarms are not activated.
S1...S16 Enable alarm 2	<ul style="list-style-type: none"> • Disable • Enable 	-	Disable	Enables/disables the selection of Alarm 2 for the measurement channel x.
S1...S16 Alarm2 >/<	<ul style="list-style-type: none"> • > • < 	-	>	Selects whether the measurement is above or below the setting value.
S1...S16 Alarm2	-101.0...2000.0deg	0.1deg	0.0deg	Sets the value for Alarm 2. The alarm is activated if the measurement goes above or below this setting mode (depends on the selected mode in "Sx Alarm2 >/<").

Function can be set to monitor the measurement data from previously set RTD channels. A single channel can be set to have several alarms if the user sets the channel to multiple sensor inputs. In each sensor setting the user can select the monitored module and channel, as well as the monitoring and alarm setting units (°C or °F). The alarms can be enabled, given a setting value (in degrees), and be set to trigger either above or below the setting value. There are sixteen (16) available sensor inputs in the function. An active alarm requires a valid channel measurement. It can be invalid if communication is not working or if a sensor is broken.

When the RTDs have been set, the values can be read to SCADA (or some other control system). The alarms can also be used for direct output control as well as in logics.

Events

The resistance temperature detector function (abbreviated "RTD" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the ALARM events.

The function offers sixteen (16) independent stages; the events are segregated for each stage operation.

Table. 4.4.9 - 87. Event messages.

Event block name	Event names
RTD1	S1...S16 Alarm1 ON/OFF
RTD1	S1...S16 Alarm2 ON/OFF
RTD1	S1...S16 Meas Ok/Invalid

4.4.10 Programmable stage (PSx>/<; 99)

The programmable stage is a stage that the user can program to create more advanced applications, either as an individual stage or together with programmable logic. The device has ten programmable stages, and each can be set to follow one to three analog measurements. The programmable stages have three available pick up terms options: overX, underX and rate-of-change of the selected signal. Each stage includes a definite time delay to trip after a pick-up has been triggered.

The programmable stage cycle time is 5 ms. The pick-up delay depends on which analog signal is used as well as its refresh rate (typically under a cycle in a 50 Hz system).

The number of programmable stages to be used is set in the *INFO* tab. When this function has been set as "Activated", the number of programmable stages can be set anywhere between one (1) and ten (10) depending on how many the application needs. In the image below, the number of programmable stages have been set to two which makes PS1 and PS2 to appear. Inactive stages are hidden until they are activated.

Please note that setting the number of available stages does not activate those stages, as they also need to be enabled individually with the *PSx >/< Enabled* parameter. When enabled an active stage shows its current state (condition), the expected operating time and the time remaining to trip under the activation parameters. If a stage is not active the *PSx>/< condition* parameter will merely display "Disabled".

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.10 - 88. General settings of the function.

Name	Range	Description
PSx >/< LN mode	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	Set mode of PSx block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
PSx >/< LN behaviour	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	Displays the mode of PSx block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
PSx >/< Available stages	1...10	Defines the available amount of stages.
PSx >/< Enabled	<ul style="list-style-type: none"> • Disabled • Enabled 	Enables the stage.
PSx >/< Force status to	<ul style="list-style-type: none"> • Normal • Start • Trip • Blocked 	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.

Name	Range	Description
PSx >/< Measurement setting	<ul style="list-style-type: none"> • One magnitude comp • Two magnitude comp • Three magnitude comp 	Defines how many measurement magnitudes are used by the stage.
PSx >/< Magnitude handling ("Two magnitude comp" selected)	Mag1 x Mag2	Multiplies Signal 1 by Signal 2. The comparison uses the product of this calculation.
	Mag1 / Mag2	Divides Signal 1 by Signal 2. The comparison uses the product of this calculation.
	Max (Mag1, Mag2)	The bigger value of the chosen signals is used in the comparison.
	Min (Mag1, Mag2)	The smaller value of the chosen signals is used in the comparison.
	Mag1 OR Mag2	Either of the chosen signals has to fulfill the pick-up condition. Both signals have their own pick-up setting.
	Mag1 AND Mag2	Both of the chosen signals have to fulfill the pick-up condition. Both signals have their own pick-up setting.
	Mag1 – Mag2	Subtracts Signal 2 from Signal 1. The comparison uses the product of this calculation.
PSx >/< Magnitude handling ("Three magnitude comp" selected)	Mag1 x Mag2 x Mag3	Multiplies Signals 1, 2 and 3. The comparison uses the product of this calculation.
	Max (Mag1, Mag2, Mag3);	The biggest value of the chosen signals is used in the comparison.
	Min (Mag1, Mag2, Mag3)	The smallest value of the chosen signals is used in the comparison.
	Mag1 OR Mag2 OR Mag3	Any of the signals fulfills the pick-up condition. Each signal has their own pick-up setting.
	Mag1 AND Mag2 AND Mag3	All of the signals need to fulfill the pick-up condition. Each signal has their own pick-up setting.
	(Mag1 OR Mag2) AND Mag3	Signals 1 OR 2 AND 3 need to fulfill the pick-up condition. Each signal has their own pick-up setting.
PSx Magnitude selection	<ul style="list-style-type: none"> • Currents • Voltages • Powers • Impedances and admittances • Others 	Defines the measurement type used by the stage
PSx MagnitudeX	See table below.	Defines the measurement used by the stage. Available parameters depend on selected measurement type.

Name	Range	Description
PSx MagnitudeX multiplier	-5 000 000...5 000 000	Multiplies the selected measurement. 1 by default (no multiplication). See section "Magnitude multiplier" for more information.

Analog values

The numerous analog signals have been divided into categories to help the user find the desired value.

Table. 4.4.10 - 89. Phase and residual current measurements (IL1, IL2, IL3, Io1 and Io2)

Name	Description
ILx ff (p.u.)	Fundamental frequency RMS value (in p.u.)
ILx 2 nd h.	ILx 2 nd harmonic value (in p.u.)
ILx 3 rd h.	ILx 3 rd harmonic value (in p.u.)
ILx 4 th h.	ILx 4 th harmonic value (in p.u.)
ILx 5 th h.	ILx 5 th harmonic value (in p.u.)
ILx 7 th h.	ILx 7 th harmonic value (in p.u.)
ILx 9 th h.	ILx 9 th harmonic value (in p.u.)
ILx 11 th h.	ILx 11 th harmonic value (in p.u.)
ILx 13 th h.	ILx 13 th harmonic value (in p.u.)
ILx 15 th h.	ILx 15 th harmonic value (in p.u.)
ILx 17 th h.	ILx 17 th harmonic value (in p.u.)
ILx 19 th h.	ILx 19 th harmonic value (in p.u.)
ILx TRMS	ILx TRMS value (in p.u.)
ILx Ang	ILx Angle (degrees)

Table. 4.4.10 - 90. Other current measurements

Name	Description
IOZ Mag	Zero sequence current value (in p.u.)
IOCALC Mag	Calculated IO value (in p.u.)
I1 Mag	Positive sequence current value (in p.u.)
I2 Mag	Negative sequence current value (in p.u.)
IOCALC Ang	Angle of calculated residual current (degrees)

Name	Description
I1 Ang	Angle of positive sequence current (degrees)
I2 Ang	Angle of negative sequence current (degrees)
I01ResP	I01 primary current of a current-resistive component
I01CapP	I01 primary current of a current-capacitive component
I01ResS	I01 secondary current of a current-resistive component
I01CapS	I01 secondary current of a current-capacitive component
I02ResP	I02 primary current of a current-resistive component
I02CapP	I02 primary current of a current-capacitive component
I02ResS	I02 secondary current of a current-resistive component
I02CapS	I02 secondary current of a current-capacitive component

Table. 4.4.10 - 91. Voltage measurements

Name	Description
UL12Mag	UL12 Primary voltage V
UL23Mag	UL23 Primary voltage V
UL31Mag	UL31 Primary voltage V
UL1Mag	UL1 Primary voltage V
UL2Mag	UL2 Primary voltage V
UL3Mag	UL3 Primary voltage V
UL12Ang	UL12 angle (degrees)
UL23Ang	UL23 angle (degrees)
UL31Ang	UL31 angle (degrees)
UL1Ang	UL1 angle (degrees)
UL2Ang	UL2 angle (degrees)
UL3Ang	UL3 angle (degrees)
U0Ang	UL0 angle (degrees)
U0CalcMag	Calculated residual voltage
U1 pos.seq.V Mag	Positive sequence voltage
U2 neg.seq.V Mag	Negative sequence voltage
U0CalcAng	Calculated residual voltage angle (degrees)
U1 pos.seq.V Ang	Positive sequence voltage angle (degrees)

Name	Description
U2 neg.seq.V Ang	Negative sequence voltage angle (degrees)
U3SMag	U3 channel voltage magnitude when the channel is set to "SS" mode
U3SAng	U3 channel voltage angle when the channel is set to "SS" mode
U4SMag	U4 channel voltage magnitude when the channel is set to "SS" mode
U4SAng	U4 channel voltage angle when the channel is set to "SS" mode
T1 Tap U	Voltage measured by the AVR function in the T1 device (in parallel tap changer mode)
T2 Tap U	Voltage measured by the AVR function in the T2 device (in parallel tap changer mode)
T3 Tap U	Voltage measured by the AVR function in the T3 device (in parallel tap changer mode)
T4 Tap U	Voltage measured by the AVR function in the T4 device (in parallel tap changer mode)

Table. 4.4.10 - 92. Power measurements

Name	Description
S3PH	Three-phase apparent power S (kVA)
P3PH	Three-phase active power P (kW)
Q3PH	Three-phase reactive power Q (kvar)
tanfi3PH	Three-phase active power direction
cosfi3PH	Three-phase reactive power direction
SLx	Phase apparent power L1 / L2 / L3 S (kVA)
PLx	Phase active power L1 / L2 / L3 P (kW)
QLx	Phase reactive power L1 / L2 / L3 Q (kVar)
tanfiLx	Phase active power direction L1 / L2 / L3
cosfiLx	Phase reactive power direction L1 / L2 / L3
PoFaLx	Phase power factor L1 / L2 / L3
PoFa3PH	Three-phase power factor

Table. 4.4.10 - 93. Phase-to-phase and phase-to-neutral impedances, resistances and reactances

Name	Description
RLxPri	Resistance R L12, L23, L31, L1, L2, L3 primary (Ω)
XLxPri	Reactance X L12, L23, L31, L1, L2, L3 primary (Ω)
ZLxPri	Impedance Z L12, L23, L31, L1, L2, L3 primary (Ω)
RLxSec	Resistance R L12, L23, L31, L1, L2, L3 secondary (Ω)

Name	Description
XLxSec	Reactance X L12, L23, L31, L1, L2, L3 secondary (Ω)
ZLxSec	Impedance Z L12, L23, L31, L1, L2, L3 secondary (Ω)
ZLxAngle	Impedance Z L12, L23, L31, L1, L2, L3 angle

Table. 4.4.10 - 94. Other impedances, resistances and reactances

Name	Description
RSeqPri	Positive Resistance R primary (Ω)
XSeqPri	Positive Reactance X primary (Ω)
RSeqSec	Positive Resistance R secondary (Ω)
XSeqSec	Positive Reactance X secondary (Ω)
ZSeqPri	Positive Impedance Z primary (Ω)
ZSeqSec	Positive Impedance Z secondary (Ω)
ZSeqAngle	Positive Impedance Z angle

Table. 4.4.10 - 95. Conductances, susceptances and admittances (L1, L2, L3)

Name	Description
GLxPri	Conductance G L1, L2, L3 primary (mS)
BLxPri	Susceptance B L1, L2, L3 primary (mS)
YLxPriMag	Admittance Y L1, L2, L3 primary (mS)
GLxSec	Conductance G L1, L2, L3 secondary (mS)
BLxSec	Susceptance B L1, L2, L3 secondary (mS)
YLxSecMag	Admittance Y L1, L2, L3 secondary (mS)
YLxAngle	Admittance Y L1, L2, L3 angle (degrees)

Table. 4.4.10 - 96. Other conductances, susceptances and admittances

Name	Description
G0Pri	Conductance G0 primary (mS)
B0Pri	Susceptance B0 primary (mS)
G0Sec	Conductance G0 secondary (mS)
B0Sec	Susceptance B0 secondary (mS)
Y0Pri	Admittance Y0 primary (mS)

Name	Description
Y0Sec	Admittance Y0 secondary (mS)
Y0Angle	Admittance Y0 angle

Table. 4.4.10 - 97. Other measurements

Name	Description
System f.	System frequency
Ref f1	Reference frequency 1
Ref f2	Reference frequency 2
M Thermal T	Motor thermal temperature
F Thermal T	Feeder thermal temperature
T Thermal T	Transformer thermal temperature
RTD meas 1...16	RTD measurement channels 1...16
Ext RTD meas 1...8	External RTD measurement channels 1...8 (ADAM)
mA input 7,8,15,16	mA input channels 7, 8, 15, 16
ASC 1...4	Analog scaled curves 1...4
mAln1...4 (Tcard1/2)	mA input channels in T option card(s)

Magnitude multiplier

Programmable stages can be set to follow one, two or three analog measurements with the *PSx >/< Measurement setting* parameter. The user must choose a measurement signal value to be compared to the set value, and possibly also set a scaling for the signal. The image below is an example of scaling: a primary zero sequence voltage has been scaled to a percentage value for easier handling when setting up the comparator.

The scaling factor was calculated by taking the inverse value of a 20 kV system:

$$k = \frac{1}{20\,000\text{ V}/\sqrt{3}} = 0.008\,66$$

When this multiplier is in use, the full earth fault zero sequence voltage is 11 547 V primary which is then multiplied with the above-calculated scaling factor, inverting the final result to 100%. This way a pre-processed signal is easier to set, although it is also possible to just use the scaling factor of 1.0 and set the desired pick-up limit as the primary voltage. Similarly, any chosen measurement value can be scaled to the desired form.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.10 - 98. Information displayed by the function.

Name	Range	Description
PSx >/< LN behaviour	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	Displays the mode of PSx block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
Condition	<ul style="list-style-type: none"> • Normal • Start • Trip • Blocked 	Displays status of the function.
Expected operating time	-1800.000...1800.000s	Displays the expected operating time when a fault occurs.
Time remaining to trip	0.000...1800.000s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.
PSx Scaled magnitude X	-5 000 000...5 000 000	Displays measurement value after multiplying it the value set to <i>PSx Magnitude multiplier</i> .
PSx >/< MeasMag1/ MagSet1 at the moment	-5 000 000...5 000 000	The ratio between measured magnitude and the pick-up setting.
PSx >/< MeasMag2/ MagSet2 at the moment	-5 000 000...5 000 000	The ratio between measured magnitude and the pick-up setting.
PSx >/< MeasMag3/ MagSet3 at the moment	-5 000 000...5 000 000	The ratio between measured magnitude and the pick-up setting.
PSx >/< CalcMeasMag/ MagSet at the moment	-5 000 000...5 000 000	The ratio between calculated magnitude and the pick-up setting.

Pick-up settings

The *Pick-up setting Mag* setting parameter controls the pick-up of the PSx>/< function. This defines the maximum or minimum allowed measured magnitude before action from the function. The function constantly calculates the ratio between the set and the measured magnitudes. The user can set the reset hysteresis in the function (by default 3 %). It is always relative to the *Pick-up setting Mag* value.

Table. 4.4.10 - 99. Pick-up settings.

Name	Range	Step	Default	Description
PS# Pick-up term Mag#	<ul style="list-style-type: none"> Over > Over (abs) > Under < Under (abs) < Delta set (%) +/- > Delta abs (%) > Delta +/- measval Delta abs measval 	-	Over	Comparator mode for the magnitude. See "Comparator modes" section below for more information.
PS# Pick-up setting Mag#/calc >/<	-5 000 000.0000...5 000 000.0000	0.0001	0.01	Pick-up magnitude
PS# Setting hysteresis Mag#	0.0000...50.0000%	0.0001%	3%	Setting hysteresis
Definite operating time delay	0.000...1800.000s	0.005s	0.04s	Delay setting
Release time delays	0.000...1800.000s	0.005s	0.06s	Pick-up release delay

Comparator modes

When setting the comparators, the user must first choose a comparator mode.

Table. 4.4.10 - 100. Comparator modes

Mode	Description
Over >	Greater than. If the measured signal is greater than the set pick-up level, the comparison condition is fulfilled.
Over (abs) >	Greater than (absolute). If the absolute value of the measured signal is greater than the set pick-up level, the comparison condition is fulfilled.
Under <	Less than. If the measured signal is less than the set pick-up level, the comparison condition is fulfilled. The user can also set a blocking limit: the comparison is not active when the measured value is less than the set blocking limit.
Under (abs) <	Less than (absolute). If the absolute value of the measured signal is less than the set pick-up level, the comparison condition is fulfilled. The user can also set a blocking limit: the comparison is not active when the measured value is less than the set blocking limit.
Delta set (%) +/- >	Relative change over time. If the measured signal changes more than the set relative pick-up value in 20 ms, the comparison condition is fulfilled. The condition is dependent on direction.
Delta abs (%) >	Relative change over time (absolute). If the measured signal changes more than the set relative pick-up value in 20 ms in either direction, the comparison condition is fulfilled. The condition is not dependent on direction.

Mode	Description
Delta +/- measval	Change over time. If the measured signal changes more than the set pick-up value in 20 ms, the comparison condition is fulfilled. The condition is dependent on direction.
Delta abs measval	Change over time (absolute). If the measured signal changes more than the set pick-up value in 20 ms in either direction, the comparison condition is fulfilled. The condition is not dependent on direction.

The pick-up level is set individually for each comparison. When setting up the pick-up level, the user needs to take into account the modes in use as well as the desired action. The pick-up limit can be set either as positive or as negative. Each pick-up level has a separate hysteresis setting which is 3 % by default.

The user can set the operating and releasing time delays for each stage.

Function blocking

The blocking signal is evaluated at the start of each program cycle. The blocking signals are connected to the function's dedicated input, which can be configured in the *IO* → *Blocking Input Control* tab of the function.

- When the pick-up element activates and the blocking signal is not active, a START signal is generated, and the function starts or continues with the trip time countdown.
- When the pick-up element activates and the blocking signal is active, a BLOCKED signal is generated, and the function does not process the event further.
- When a START signal is already active and the blocking input signal becomes active, the START signal is reset and BLOCKED signal is generated. The release time characteristics are then processed in the same way as when the pick-up signal is reset.

The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Events and registers

The programmable stage function (abbreviated "PSx" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

Table. 4.4.10 - 101. Event messages.

Event block name	Event names
PSx	PS1...10 >/< Start ON/OFF
PSx	PS1...10 >/< Trip ON/OFF
PSx	PS1...10 >/< Block ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.10 - 102. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
>/< Mag#	The numerical value of the magnitude
Mag#/Set#	Ratio between the measured magnitude and the pick-up setting
Trip time remaining	0 ms...1800s
Setting group in use	Setting group 1...8 active

4.4.11 Arc fault protection (IArc>/IOArc>; 50Arc/50NArc)

Arc faults occur for a multitude of reasons: e.g. insulation failure, incorrect operation of the protected device, corrosion, overvoltage, dirt, moisture, incorrect wiring, or even because of aging caused by electric load. It is important to detect the arc as fast as possible in order to minimize its effects. Using arc sensors to detect arc faults is much faster than merely measuring currents and voltages. In busbar protection devices with normal protection can be too slow to disconnect arcs within a safe time frame. For example, it may be necessary to delay operation time for hundreds of milliseconds when setting up an overcurrent protection relay to control the feeder breakers to achieve selectivity. This delay can be avoided by using arc protection. The arc protection card has a high-speed output to trip signals faster as well as to extend the speed of arc protection.

The arc protection card has four (4) sensor channels, and up to three (3) arc point sensors can be connected to each channel. The sensor channels support Arcdaq AQ-01 (light detecting) and AQ-02 (pressure and light detecting) sensors. Optionally, the protection function can also be applied with a phase current or a residual current condition: the function trips only if the light and overcurrent conditions are met.

Table. 4.4.11 - 103. Output signals of the IArc>/IOArc> function.

Outputs	Activation condition
Channel 1 Light In Channel 2 Light In Channel 3 Light In Channel 4 Light In	The arc protection card's sensor channel detects light.
ARC Binary input signal	The arc protection card's binary input is energized.
I/O Arc> Ph. curr. START I/O Arc> Res. curr. START	The measured phase current or the residual current is over the set limit.
I/O Arc> Ph. curr. BLOCKED I/O Arc> Res. curr. BLOCKED	The phase current or the residual current measurement is blocked by an input.

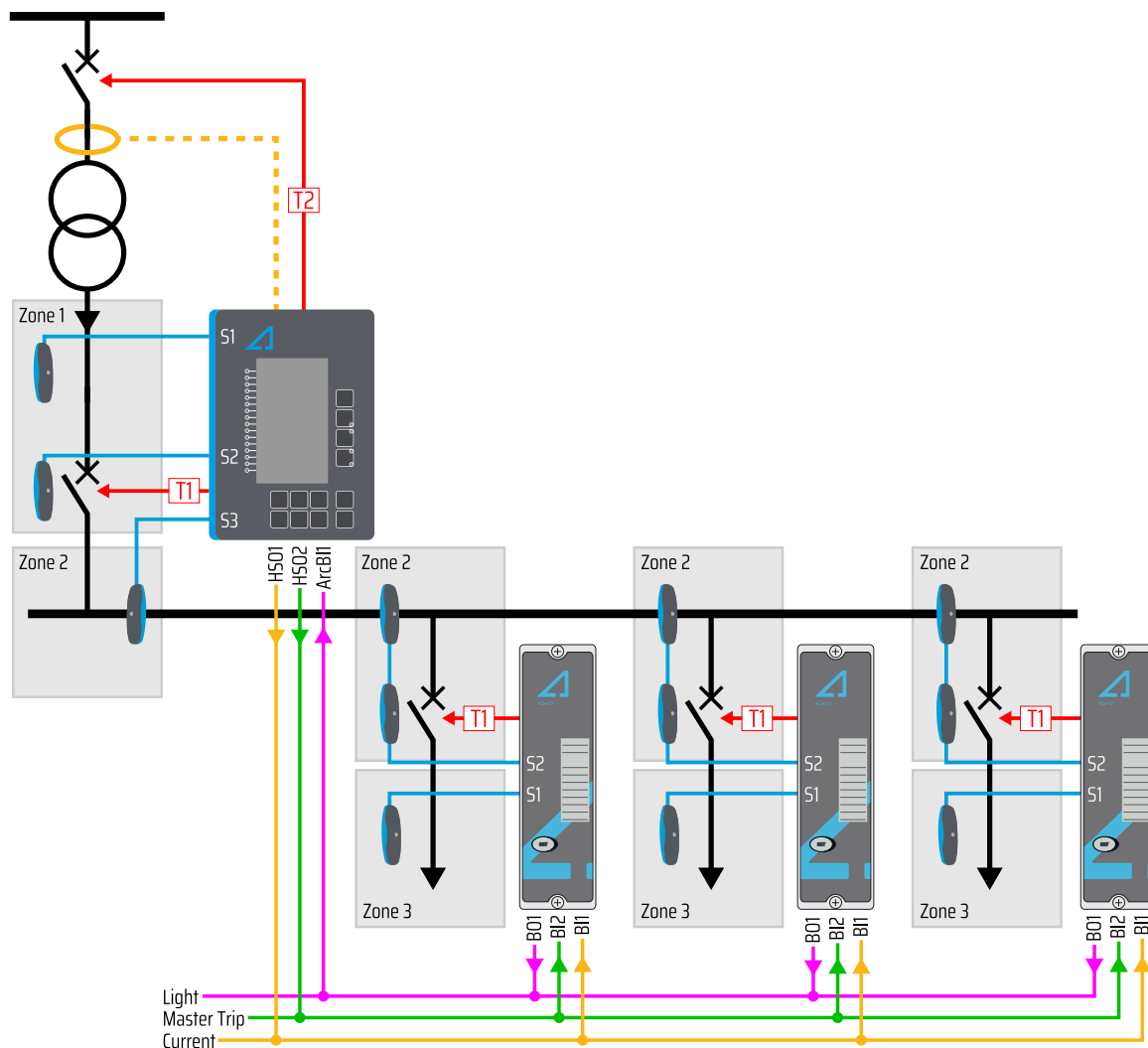
Outputs	Activation condition
I/O Arc> Zone 1 TRIP I/O Arc> Zone 2 TRIP I/O Arc> Zone 3 TRIP I/O Arc> Zone 4 TRIP	All required conditions for tripping the zone are met (light OR light and current).
I/O Arc> Zone 1 BLOCKED I/O Arc> Zone 2 BLOCKED I/O Arc> Zone 3 BLOCKED I/O Arc> Zone 4 BLOCKED	All required conditions for tripping the zone are met (light OR light and current) but the tripping is blocked by an input.
I/O Arc> S1 Sensor fault I/O Arc> S2 Sensor fault I/O Arc> S3 Sensor fault I/O Arc> S4 Sensor fault	The detected number of sensors in the channel does not match the settings.
I/O Arc> IO unit fault	The number of connected AQ-100 series units does not match the number of units set in the settings.

Example of scheme setting

The following examples help the user better understand how the arc protection function is set. In the examples AQ-101 models are used to extend the protection of Zone 2 and to protect each outgoing feeder (Zone 3).

This scheme is a single-line diagram with a protection relay equipped with an arc protection option card at the incoming feeder and with AQ-101 arc protection relays installed to the outgoing feeders.

Figure. 4.4.11 - 56. Scheme with AQ-101 arc protection relays.



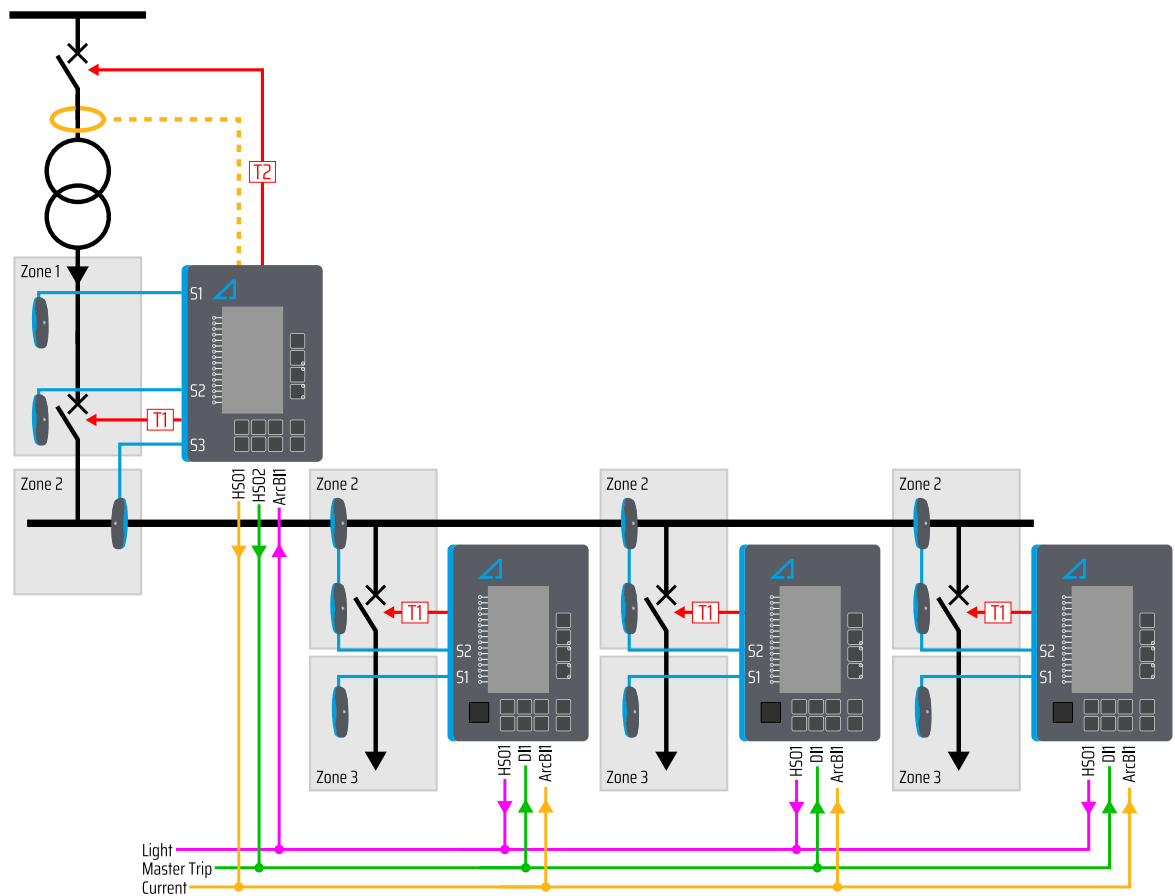
To set the zones for the device installed to the incoming feeder, start by enabling the protected zones (in this case, Zones 1 and 2). Then define which sensor channels are sensing which zones:

- Channel 1: Installed to incoming feeder cable compartment. Enabled in Zone 1.
- Channel 2: Installed to incoming feeder circuit breaker compartment. Enabled in Zone 1.
- Channel 3: Installed to busbar. Enabled in Zone 2.

The high-speed output contacts HSO1 and HSO2 have been set to send overcurrent and master trip signals to the AQ-101 arc protection relays. The AQ 100 series devices binary outputs (BO1) send test pulses once a second to check the health of the wiring between the AQ 100 series units and the binary input "ArcBI1" in the device installed to the incoming feeder. The parameter *I/O Arc > Self supervision test pulse* should be activated when connecting the AQ 100 series units to the main unit to prevent the pulses from activating ArcBI1.

The next example is similar to the previous one. However, this time each outgoing feeder has an AQ 250 protection device instead of an AQ-101 arc protection relay.

Figure. 4.4.11 - 57. Scheme with protection devices.



The settings for the device supervising the incoming feeder are the same as in the first example. The devices supervising the busbar and the outgoing feeder, however, use different settings:

- Channel 1: Installed to outgoing feeder cable compartment. Enabled in Zone 3.
- Channel 2: Installed to outgoing feeder circuit breaker compartment and the busbar. Enabled in Zone 2.

If either phase overcurrent or residual overcurrent is needed for the tripping decision, they can be enabled in the same way as light sensors in the zone. When a current channel is enabled, the measured current needs to be above the set current limit in addition to light sensing for the zone to trip.

Measured input

Arc protection uses samples based on current measurements. If the required number of samples is found to be above the setting limit, the current condition activates. The arc protection can use either phase currents, residual currents or both.

Table. 4.4.11 - 104. Measurement inputs of the U1/U2>/< function.

Signal	Description
I _{L1} samples	Samples received by I _{L1} current measurement channel
I _{L2} samples	Samples received by I _{L2} current measurement channel
I _{L3} samples	Samples received by I _{L3} current measurement channel

Signal	Description
l01 samples	Samples received by l01 current measurement channel
l02 samples	Samples received by l02 current measurement channel

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.11 - 105. General settings of the function.

Name	Range	Default	Description
I/I0 Arc> LN mode	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	On	Set mode of ARC block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
I/I0 Arc> force status to	<ul style="list-style-type: none"> • Normal • PH curr blocked • PH curr Start • ResCurr Blocked • ResCurr Start • Zone 1 Trip Blocked • Zone1 Blocked • Zone2 Trip Blocked • Zone2 Blocked • Zone3 Trip Blocked • Zone3 Blocked • Zone4 Trip Blocked • Zone4 Blocked 	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
Channel 1 sensors	<ul style="list-style-type: none"> • No sensors • 1 sensor • 2 sensors • 3 sensors 	No sensors	Defines the number of sensors connected to the channel (channels 1/2/3/4). Used for supervising the health of the connection.
Channel 2 sensors			
Channel 3 sensors			
Channel 4 sensors			

Name	Range	Default	Description
Channel 1 sensor status	<ul style="list-style-type: none"> Sensors OK Configuration fault state 	-	Displays the status of the sensor channel. If the number of sensors connected to the channel does not match with the set "Channel 1/2/3/4 sensors" setting, this parameter will go to the "Configuration fault" state.
Channel 2 sensor status			
Channel 3 sensor status			
Channel 4 sensor status			

Pick-up settings

The pick-up of each zone of the `Iarc>/I0arc>` function is controlled by one of the following: the phase current pick-up setting, the residual current pick-up setting, or the sensor channels. The pick-up setting depends on which of these are activated in the zone.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.11 - 106. Enabled Zone pick-up settings.

Name	Range	Step	Default	Description
Phase current pick-up	0.05...40.00 $\times I_n$	0.01 $\times I_n$	1.2 $\times I_n$	The phase current measurement's pick-up value (in p.u.).
I0 input selection	<ul style="list-style-type: none"> None I01 I02 	-	None	Selects the residual current channel (I01 or I02).
Res.current pick-up	0.05...40.00 $\times I_{0n}$	0.01 $\times I_{0n}$	1.2 $\times I_{0n}$	The residual current measurement's pick-up value (in p.u.).
ZoneX Enabled	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	Enables the chosen zone. Up to 4 zones can be enabled.
ZoneX Ph. curr. Enabled	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	The phase overcurrent allows the zone to trip when light is detected.
ZoneX Res. curr. Enabled	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	The residual overcurrent allows the zone to trip when light is detected.
ZoneX Light 1 Enabled	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	Light detected in sensor channel 1 trips the zone.

Name	Range	Step	Default	Description
ZoneX Light 2 Enabled	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	Light detected in sensor channel 2 trips the zone.
ZoneX Light 3 Enabled	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	Light detected in sensor channel 3 trips the zone.
ZoneX Light 4 Enabled	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	Light detected in sensor channel 4 trips the zone.
ZoneX DI Enabled	<ul style="list-style-type: none"> Disabled Light In Current In 	-	Disabled	Arc protection option card digital input function selection. "Light In" mode trips the zone when digital input is active. In "Current In" mode digital input must be active at the same time as any of the sensor channels for the zone to trip.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.11 - 107. Information displayed by the function.

Name	Range	Description
I/O Arc> LN behaviour	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	Displays the mode of ARC block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
I/O Arc> condition	<ul style="list-style-type: none"> Z1 Trip Z1 Blocked Z2 Trip Z2 Blocked Z3 Trip Z3 Blocked Z4 Trip Z4 Blocked 	Displays status of the protection function.

Sensor status	<ul style="list-style-type: none"> • Ph Curr Blocked • Ph Curr Start • Res Curr Blocked • Res Curr Start • Channel1 Light Pressure • Channel1 Pressure • Channel2 Light Pressure • Channel2 Pressure • Channel3 Light Pressure • Channel3 Pressure • Channel4 Light Pressure • Channel4 Pressure • Digital input • I/O Arc> Sensor 1 Fault • I/O Arc> Sensor 2 Fault • I/O Arc> Sensor 3 Fault • I/O Arc> Sensor 4 Fault • I/O Arc> I/O-unit Fault 	Displays the general status of sensors.
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Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a TRIP signal is generated.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Events and registers

The arc fault protection function (abbreviated "ARC" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the events.

Table. 4.4.11 - 108. Event messages.

Event block name	Event names
ARC1	Zone 1...4 Trip ON/OFF

Event block name	Event names
ARC1	Zone 1...4 Block ON/OFF
ARC1	Phase current Blocked ON/OFF
ARC1	Phase current Start ON/OFF
ARC1	Residual current Blocked ON/OFF
ARC1	Residual current Start ON/OFF
ARC1	Channel 1...4 Light ON/OFF
ARC1	DI Signal ON/OFF
ARC1	I/I0 Arc> Sensor 1...4 Fault ON/OFF
ARC1	I/I0 Arc> sub-unit count error ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers. The table below presents the structure of the function's register content.

Table. 4.4.11 - 109. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Phase A current	Trip current
Phase B current	
Phase C current	
Residual current	
Active sensors	1...4
Setting group in use	Setting group 1...8 active

4.5 Control functions

4.5.1 Common signals

Common signals function has all protection function start and trip signals internally connected to Common START and TRIP output signals. When any of the activated protection functions generate a START or a TRIP signal, Common signals function will also generate the same signal.

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.5.1 - 110. General settings of the function.

Name	Range	Default	Description
Common force status to	<ul style="list-style-type: none"> Normal Start Trip 	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.

Common signals function has all START and TRIP signals of protection functions internally connected to Common START and TRIP output signals. But it is also possible to assign extra signals to activate Common START and TRIP.

Table. 4.5.1 - 111. Common signals extra inputs.

Name	Description
Common Start In	Assign extra signals to activate common START signal. Please note that all protection function START signals are already assigned internally to Common START.
Common Trip In	Assign extra signals to activate common TRIP signal. Please note that all protection function TRIP signals are already assigned internally to Common TRIP.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.5.1 - 112. Information displayed by the function.

Name	Range	Description
Common signals condition	<ul style="list-style-type: none"> Normal Start Trip 	Displays status of the function.

Function blocking

Common signals function itself doesn't have blocking input signals. Blocking of tripping should be done in each protection function settings.

Events

The common signals function (abbreviated "GNSIG" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START and TRIP events.

The events triggered by the function are recorded with a time stamp.

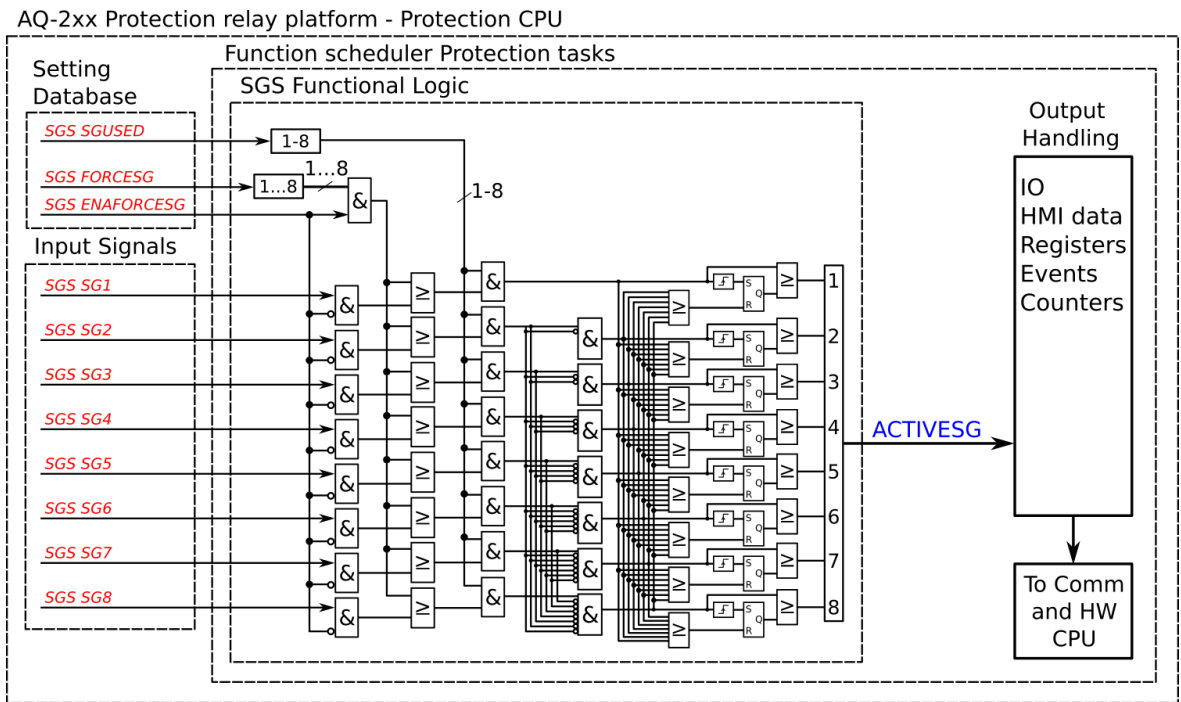
Table. 4.5.1 - 113. Event messages.

Event block name	Event names
GNSIG	Common Start ON/OFF
GNSIG	Common Trip ON/OFF

4.5.2 Setting group selection

All device types support up to eight (8) separate setting groups. The Setting group selection function block controls the availability and selection of the setting groups. By default, only Setting group 1 (SG1) is active and therefore the selection logic is idle. When more than one setting group is enabled, the setting group selector logic takes control of the setting group activations based on the logic and conditions the user has programmed.

Figure. 4.5.2 - 58. Simplified function block diagram of the setting group selection function.

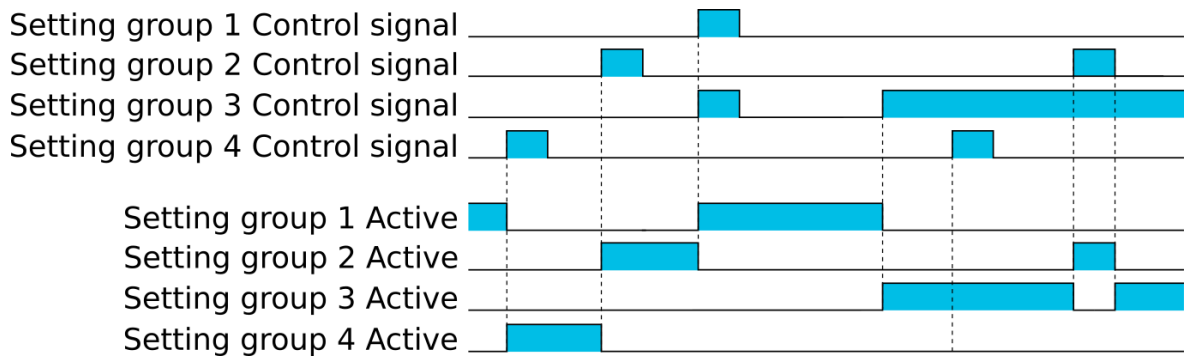


Setting group selection can be applied to each of the setting groups individually by activating one of the various internal logic inputs and connected digital inputs. The user can also force any of the setting groups on when the "Force SG change" setting is enabled by giving the wanted quantity of setting groups as a number in the communication bus or in the local HMI, or by selecting the wanted setting group from *Control* → *Setting groups*. When the forcing parameter is enabled, the automatic control of the local device is overridden and the full control of the setting groups is given to the user until the "Force SG change" is disabled again.

Setting groups can be controlled either by pulses or by signal levels. The setting group controller block gives setting groups priority values for situations when more than one setting group is controlled at the same time: the request from a higher-priority setting group is taken into use.

Setting groups follow a hierarchy in which setting group 1 has the highest priority, setting group 2 has second highest priority etc. If a static activation signal is given for two setting groups, the setting group with higher priority will be active. If setting groups are controlled by pulses, the setting group activated by pulse will stay active until another setting groups receives and activation signal.

Figure. 4.5.2 - 59. Example sequences of group changing (control with pulse only, or with both pulses and static signals).



Settings and signals

The settings of the setting group control function include the active setting group selection, the forced setting group selection, the enabling (or disabling) of the forced change, the selection of the number of active setting groups in the application, as well as the selection of the setting group changed remotely. If the setting group is forced to change, the corresponding setting group must be enabled and the force change must be enabled. Then, the setting group can be set from communications or from HMI to any available group. If the setting group control is applied with static signals right after the "Force SG" parameter is released, the application takes control of the setting group selection.

Table. 4.5.2 - 114. Settings of the setting group selection function.

Name	Range	Default	Description
Active setting group	<ul style="list-style-type: none"> • SG1 • SG2 • SG3 • SG4 • SG5 • SG6 • SG7 • SG8 	SG1	Displays which setting group is active.
Force setting group	<ul style="list-style-type: none"> • None • SG1 • SG2 • SG3 • SG4 • SG5 • SG6 • SG7 • SG8 	None	The selection of the overriding setting group. After "Force SG change" is enabled, any of the configured setting groups in the device can be overridden. This control is always based on the pulse operating mode. It also requires that the selected setting group is specifically controlled to ON after "Force SG" is disabled. If there are no other controls, the last set setting group remains active.
Force setting group change	<ul style="list-style-type: none"> • Disabled • Enabled 	Disabled	The selection of whether the setting group forcing is enabled or disabled. This setting has to be active before the setting group can be changed remotely or from a local HMI. This parameter overrides the local control of the setting groups and it remains on until the user disables it.

Name	Range	Default	Description
Used setting groups	<ul style="list-style-type: none"> • SG1 • SG1...2 • SG1...3 • SG1...4 • SG1...5 • SG1...6 • SG1...7 • SG1...8 	SG1	The selection of the activated setting groups in the application. Newly-enabled setting groups use default parameter values.
Remote setting group change	<ul style="list-style-type: none"> • None • SG1 • SG2 • SG3 • SG4 • SG5 • SG6 • SG7 • SG8 	None	This parameter can be controlled through SCADA to change the setting group remotely. Please note that if a higher priority setting group is being controlled by a signal, a lower priority setting group cannot be activated with this parameter.

Table. 4.5.2 - 115. Signals of the setting group selection function.

Name	Description
Setting group 1	The selection of Setting group 1 ("SG1"). Has the highest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, no other SG requests will be processed.
Setting group 2	The selection of Setting group 2 ("SG2"). Has the second highest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, no requests with a lower priority than SG1 will be processed.
Setting group 3	The selection of Setting group 3 ("SG3"). Has the third highest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, no requests with a lower priority than SG1 and SG2 will be processed.
Setting group 4	The selection of Setting group 4 ("SG4"). Has the fourth highest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, no requests with a lower priority than SG1, SG2 and SG3 will be processed.
Setting group 5	The selection of Setting group 5 ("SG5"). Has the fourth lowest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, SG6, SG7 and SG8 requests will not be processed.
Setting group 6	The selection of Setting group 6 ("SG6"). Has the third lowest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, SG7 and SG8 requests will not be processed.
Setting group 7	The selection of Setting group 7 ("SG7"). Has the second lowest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, only SG8 requests will not be processed.
Setting group 8	The selection of Setting group 8 ("SG8"). Has the lowest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, all other SG requests will be processed regardless of the signal status of this setting group.

Events

The setting group selection function block (abbreviated "SGS" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

Table. 4.5.2 - 116. Event messages.

Event block name	Event names
SGS	SG2...8 Enabled/Disabled
SGS	SG1...8 Request ON/OFF
SGS	Remote Change SG Request ON/OFF
SGS	Local Change SG Request ON/OFF
SGS	Force Change SG ON/OFF
SGS	SG Request Fail Not configured SG ON/OFF
SGS	Force Request Fail Force ON/OFF
SGS	SG Req. Fail Lower priority Request ON/OFF
SGS	SG1...8 Active ON/OFF

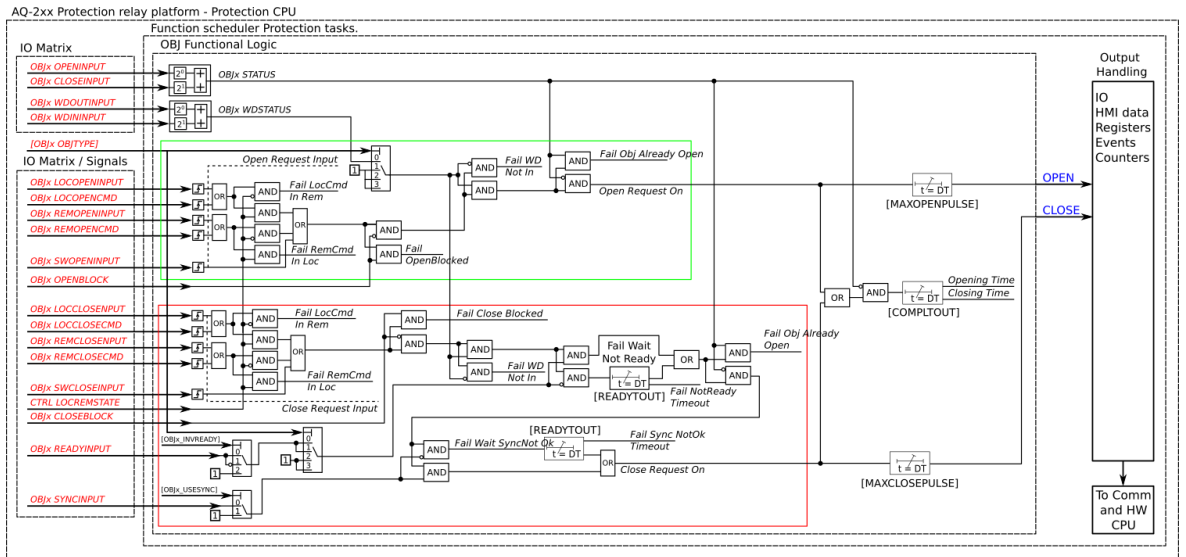
4.5.3 Object control and monitoring

The object control and monitoring function takes care of both for circuit breakers and disconnectors. The monitoring and controlling are based on the statuses of the device's configured digital inputs and outputs. The number of controllable and monitored objects in each device depends on the device type and amount of digital inputs. One controllable object requires a minimum of two (2) output contacts. The status monitoring of one monitored object usually requires two (2) digital inputs. Alternatively, object status monitoring can be performed with a single digital input: the input's active state and its zero state (switched to 1 with a NOT gate in the Logic editor).

An object can be controlled manually or automatically. Manual control can be done by local control, or by remote control. Local manual control can be done by devices front panel (HMI) or by external push buttons connected to devices digital inputs. Manual remote control can be done through one of the various communication protocols available (Modbus, IEC101/103/104 etc.). The function supports the modes "Direct control" and "Select before execute" while controlled remotely. Automatic controlling can be done with functions like auto-reclosing function (ANSI 79).

The main outputs of the function are the OBJECT OPEN and OBJECT CLOSE control signals. Additionally, the function reports the monitored object's status and applied operations. The setting parameters are static inputs for the function, which can only be changed by the user in the function's setup phase.

Figure. 4.5.3 - 60. Simplified function block diagram of the object control and monitoring function.



Settings

The following parameters help the user to define the object. The operation of the function varies based on these settings and the selected object type. The selected object type determines how much control is needed and which setting parameters are required to meet those needs.

Table. 4.5.3 - 117. Object settings and status parameters.

Name	Range	Default	Description
Local/Remote status	<ul style="list-style-type: none"> Local Remote 	Remote	Displays the status of the device's "local/remote" switch. Local controls cannot override the open and close commands while device is in "Remote" status. The remote controls cannot override the open and close commands while device is in "Local" status.
Object status force to	<ul style="list-style-type: none"> Normal Openreq On Closereq On Opensignal On Closesignal On WaitNoRdy On WaitNoSnc On NotrdyFail On NosyncFail On Opentout On Clotout On OpenreqUSR On CloreqUSR On 	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
OBJ LN mode	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	On	Set mode of OBJ block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.

Name	Range	Default	Description
OBJ LN behaviour	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	-	Displays the mode of OBJ block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
Object name	-	Objectx	The user-set name of the object, at maximum 32 characters long.
Object type	<ul style="list-style-type: none"> Withdrawable circuit breaker Circuit breaker Disconnecter (MC) Disconnecter (GND) 	Circuit breaker	The selection of the object type. This selection defines the number of required digital inputs for the monitored object. This affects the symbol displayed in the HMI and the monitoring of the circuit breaker. It also affects whether the withdrawable cart is in/out status is monitored. See the next table ("Object types") for a more detailed look at which functionalities each of the object types have.
Objectx Breaker status	<ul style="list-style-type: none"> Intermediate Open Closed Bad 	-	Displays the status of breaker. Intermediate is displayed when neither of the status signals (open or close) are active. Bad status is displayed when both status signals (open and close) are active.
Objectx Withdraw status	<ul style="list-style-type: none"> WDIntermediate WDCartOut WDCart In WDBad Not in use 	-	Displays the status of circuit breaker cart. WDIntermediate is displayed when neither of the status signals (in or out) are active. WDBad status is displayed when both status signals (in and out) are active. If the selected object type is not set to "Withdrawable circuit breaker", this setting displays the "No in use" option.
Additional status information	<ul style="list-style-type: none"> Open Blocked Open Allowed Close Blocked Close Allowed Object Ready Object Not Ready Sync Ok Sync Not Ok 	-	Displays additional information about the status of the object.
Use Synchrocheck	<ul style="list-style-type: none"> Not in use Synchrocheck in use 	Not in use	Selects whether the "Synchrocheck" condition is in use for the circuit breaker close command. If "In use" is selected the input chosen to "Sync.check status in" has to be active to be able to close circuit breaker. Synchrocheck status can be either an internal signal generated by synchrocheck function or digital input activation with an external synchrocheck device.
Use Object ready	<ul style="list-style-type: none"> Ready High Ready Low Not in use 	Not in use	Selects whether the "Object ready" condition is in use for the circuit breaker close command. If in use the signal connected to "Object ready status In" has to be high or low to be able to close the breaker (depending on "Ready High or Low" selection).
Open requests	$0 \dots 2^{32} - 1$	-	Displays the number of successful "Open" requests.
Close requests	$0 \dots 2^{32} - 1$	-	Displays the number of successful "Close" requests.

Name	Range	Default	Description
Open requests failed	0...2 ³² -1	-	Displays the number of failed "Open" requests.
Close requests failed	0...2 ³² -1	-	Displays the number of failed "Close" requests.
Clear statistics	<ul style="list-style-type: none"> • - • Clear 	-	Clears the request statistics, setting them back to zero (0). Automatically returns to "-" after the clearing is finished.

Table. 4.5.3 - 118. Object types.

Name	Functionalities	Description
Withdrawable circuit breaker	Breaker cart position Circuit breaker position Circuit breaker control Object ready check before closing breaker Synchrochecking before closing breaker Interlocks	The monitor and control configuration of the withdrawable circuit breaker.
Circuit breaker	Position indication Control Object ready check before closing breaker Synchrochecking before closing breaker Interlocks	The monitor and control configuration of the circuit breaker.
Disconnecter (MC)	Position indication Control	The position monitoring and control of the disconnecter.
Disconnecter (GND)	Position indication	The position indication of the earth switch.

Table. 4.5.3 - 119. I/O.

Signal	Range	Description
Objectx Open Status In	Digital input or other logical signal selected by the user (SWx)	A link to a physical digital input. The monitored object's OPEN status. "1" refers to the active open state of the monitored object.
Objectx Close Status In		A link to a physical digital input. The monitored object's CLOSE status. "1" refers to the active close state of the monitored object.
Withdrw.CartIn.Status In		A link to a physical digital input. The monitored withdrawable object's position is IN. "1" means that the withdrawable object cart is in.
Withdrw.CartOut.Status In		A link to a physical digital input. The monitored withdrawable object's position is OUT. "1" means that the withdrawable object cart is pulled out.

Signal	Range	Description
Objectx Ready status In		A link to a physical digital input. Indicates that status of the monitored object. "1" means that the object is ready and the spring is charged for a close command.
Sync.Check status In		A link to a physical digital input or a synchrocheck function. "1" means that the synchrocheck conditions are met and the object can be closed.
Objectx Open Command	OUT1...OUTx	The physical "Open" command pulse to the device's output relay.
Objectx Close Command		The physical "Close" command pulse to the device's output relay.

Table. 4.5.3 - 120. Operation settings.

Name	Range	Step	Default	Description
Breaker traverse time	0.02...500.00 s	0.02 s	0.2 s	Determines the maximum time between open and close statuses when the breaker switches. If this set time is exceeded and both open and closed status inputs are active, the status "Bad" is activated in the "Objectx Breaker status" setting. If neither of the status inputs are active after this delay, the status "Intermediate" is activated.
Sync wait timeout	0.02...500.00 s	0.02 s	0.2 s	If synchrocheck is used, the object will wait for a "synchrocheck ok" signal before giving the closing command. This parameter will cancel the command if synchronization is not achieved on time.
Maximum Close command pulse length	0.02...500.00 s	0.02 s	0.2 s	Determines the maximum length for a Close pulse from the output relay to the controlled object. If the object operates faster than this set time, the control pulse is reset and a status change is detected.
Maximum Open command pulse length	0.02...500.00 s	0.02 s	0.2 s	Determines the maximum length for a Open pulse from the output relay to the controlled object. If the object operates faster than this set time, the control pulse is reset and a status change is detected.
Control termination timeout	0.02...500.00 s	0.02 s	10 s	Determines the control pulse termination timeout. If the object has not changed its status in this given time the function will issue error event and the control is ended. This parameter is common for both open and close commands.
Final trip pulse length	0.00...500.00 s	0.02 s	0.2 s	Determines the length of the final trip pulse length. When the object has executed the final trip, this signal activates. If set to 0 s, the signal is continuous. If auto-recloser function controls the object, "final trip" signal is activated only when there are no automatic reclosings expected after opening the breaker.

Table. 4.5.3 - 121. Control settings (DI and Application).

Signal	Range	Description
Access level for MIMIC control	<ul style="list-style-type: none"> • User • Operator • Configurator • Super user 	Defines what level of access is required for MIMIC control. The default is the "Configurator" level.
Objectx LOCAL Close control input	Digital input or other logical signal selected by the user	The local Close command from a physical digital input (e.g. a push button).
Objectx LOCAL Open control input		The local Open command from a physical digital input (e.g. a push button).
Objectx REMOTE Close control input		The remote Close command from a physical digital input (e.g. RTU).
Objectx REMOTE Open control input		The remote Open command from a physical digital input (e.g. RTU).
Objectx Application Close		The Close command from the application. Can be any logical signal.
Objectx Application Open		The Close command from the application. Can be any logical signal.

Blocking and interlocking

The interlocking and blocking conditions can be set for each controllable object, with Open and Close set separately. Blocking and interlocking can be based on any of the following: other object statuses, a software function or a digital input.

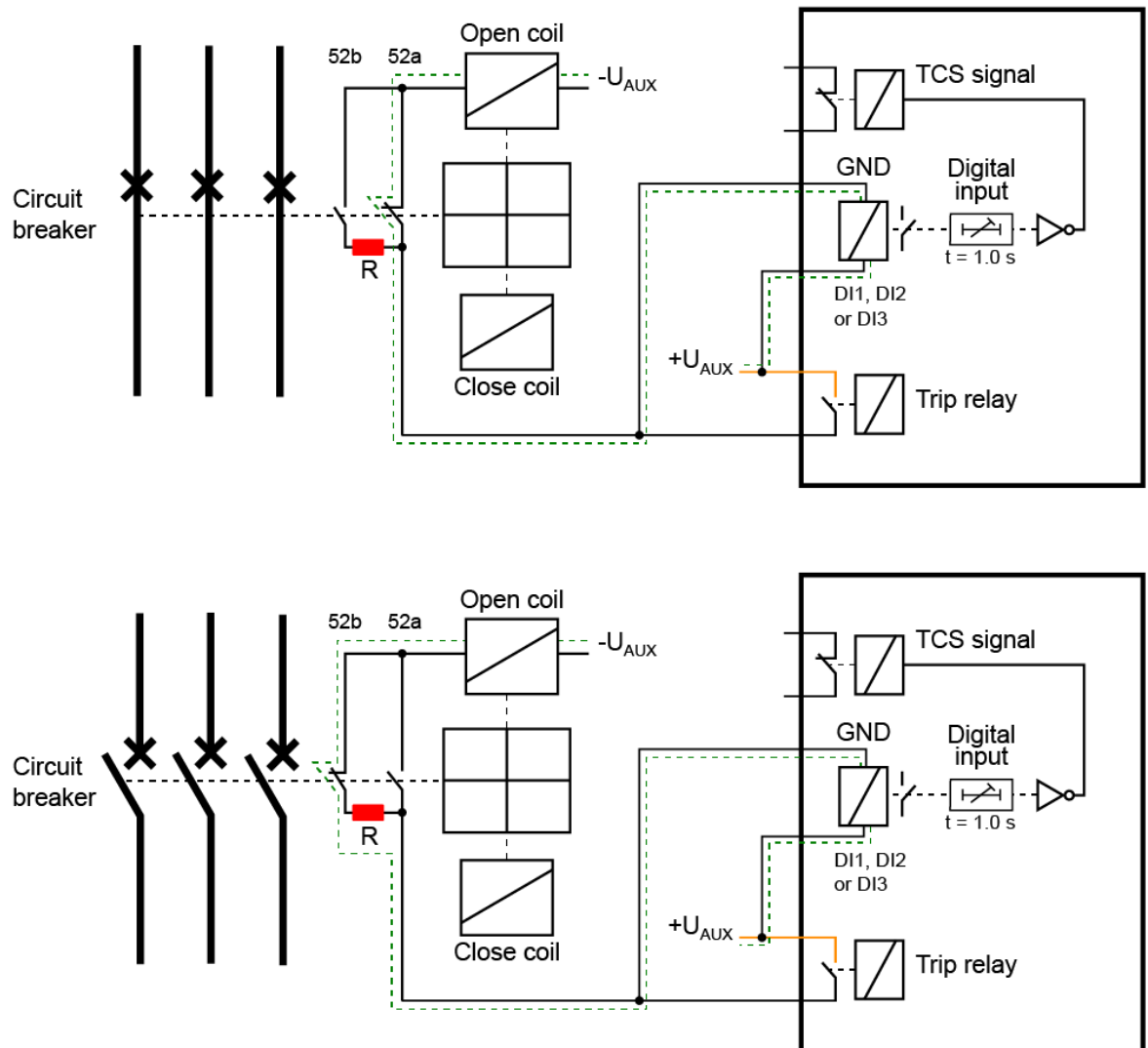
In order for the blocking signal to be received on time, it has to reach the function 5 ms before the control command.

Trip circuit supervision

Trip circuit supervision monitors the wiring from auxiliary power supply, through the device's digital output, and all the way to the open coil of the breaker. It is recommended to supervise the health of the trip circuit when breaker is closed.

The figure below presents an application scheme for trip circuit supervision with one digital input and a non-latched trip output. With this connection the current keeps flowing to the open coil of the breaker via the breaker's closing auxiliary contacts (52b) even after the circuit breaker is opened. This requires a resistor which reduces the current: this way the coil is not energized and the relay output does not need to cut off the coil's inductive current.

Figure. 4.5.3 - 61. Trip circuit supervision with one DI and one non-latched trip output.



Note that the digital input that monitors the circuit is normally closed, and the same applies to the alarm relay if one is used. For monitoring and especially trip circuit supervision purposes it is recommended to use a normally closed contact to confirm the wiring's condition. An active digital input generates a less than 2 mA current to the circuit, which is usually small enough not to make the breaker's open coil operate.

When the trip relay is controlled and the circuit breaker is opening, the digital input is shorted by the trip contact as long as the breaker opens. Normally, this takes about 100 ms if the relay is non-latched. A one second activation delay should, therefore, be added to the digital input. An activation delay that is slightly longer than the circuit breaker's operations time should be enough. When circuit breaker failure protection (CBFP) is used, adding its operation time to the digital input activation time is useful. The whole digital input activation time is, therefore, $t_{DI} = t_{CB} + t_{IEDrelease} + t_{CBFP}$.

Figure. 4.5.3 - 62. Trip circuit supervision with high-speed output. High-speed outputs have an internal input for trip circuit supervision.

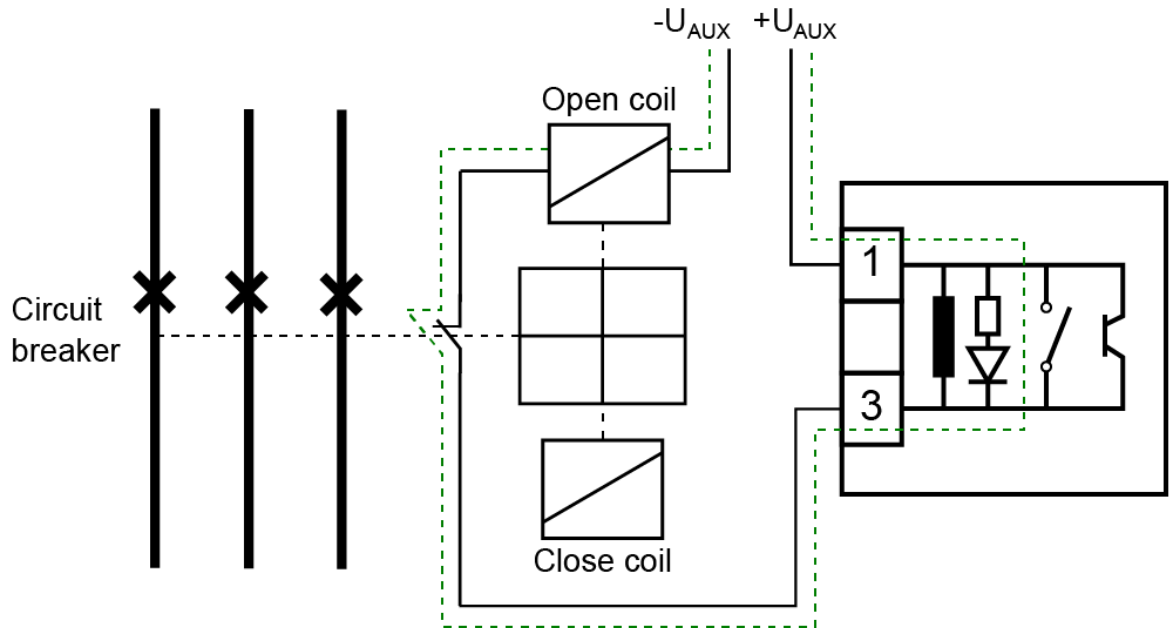


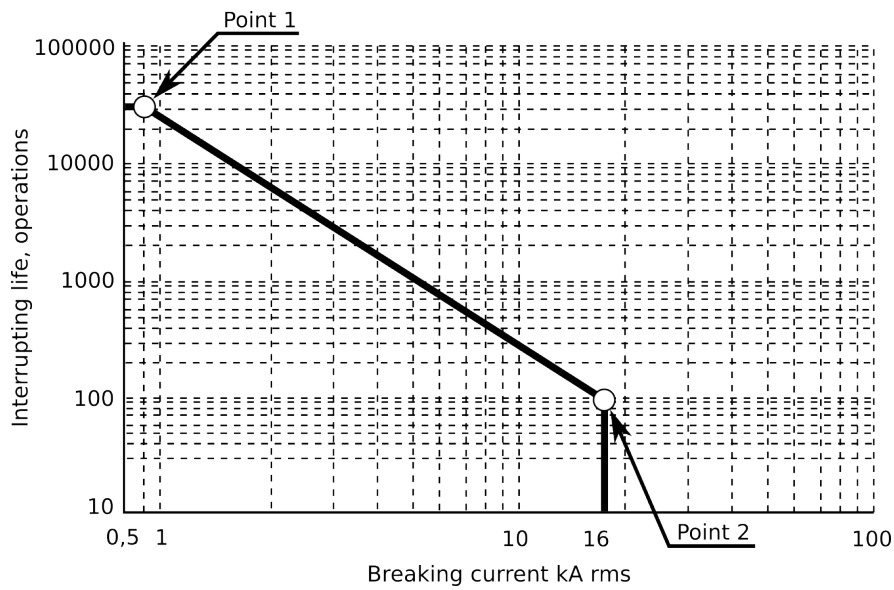
Table. 4.5.3 - 122. Trip circuit supervision settings (Control → Objects → Object X → APP CONTR → Condition monitoring).

Name	Range	Default	Description
ObjectX Trip circuit supervision	<ul style="list-style-type: none"> Disabled Enabled 	Disabled	Enables the trip circuit supervision function.
ObjectX TCS Alarm activation delay	0.02...500.00 s	0.20 s	Time delay before TCS alarm is activated.
Object1 TCS input	-	-	Defines the supervised digital input, high-speed output or other signal.

Object condition monitoring (circuit breaker wear monitor)

Each object has integrated circuit breaker wear monitor. The circuit breaker wear function is used for monitoring the circuit breaker's lifetime and its maintenance needs caused by interrupting currents and mechanical wear. The function uses the circuit breaker's manufacturer-supplied data for the breaker operating cycles in relation to the interrupted current magnitudes.

Figure. 4.5.3 - 63. Example of the circuit breaker interrupting life operations. Points 1 and 2 are user settable.



The function is triggered from the circuit breaker's "Open" command output and it monitors the three-phase current values in both the tripping moment and the normal breaker opening moment. The maximum value of interrupting life operations for each phase is calculated from these currents. The value is cumulatively deducted from the starting operations starting value. The user can set up two separate alarm levels, which are activated when the value of interrupting life operations is below the setting limit. The "Trip contact" setting defines the output that triggers the current monitoring at the breaker's "Open" command. The function's outputs are ALARM 1 and ALARM 2 signals which can be used for direct I/O controlling and user logic programming.

Figure above indicates that the circuit breaker is capable of 30 000 operations at its rated operating current of 630 A, and 100 operations at its rated fault current of 16 kA. Based on this, a single operation at 5 kA corresponds to $30\,000/1000 = 30$ operations at the rated current. If the breaker had 20 000 operations of life remaining before this trip, then one 5 kA operation reduces its remaining life by 30 operations. Therefore, after the 5 kA trip, the breaker has 19 970 rated-current operations left.

The function block uses analog current measurement values and always uses the RMS magnitude of the current measurement input.

Table. 4.5.3 - 123. Measurement inputs of the circuit breaker wear function.

Signal	Description
IL1RMS	RMS measurement of phase L1 (A) current
IL2RMS	RMS measurement of phase L2 (B) current
IL3RMS	RMS measurement of phase L3 (C) current

Condition monitoring parameters can be found from *Control* → *Objects* → *Object X* → *APP CONTR* → *Condition Monitoring*.

Table. 4.5.3 - 124. Breaker supervision settings and status indications.

Name	Range	Default	Description
Condition monitoring	<ul style="list-style-type: none"> Disabled Enabled 	Disabled	Enables the breaker condition monitoring function.
Monitoring CT side	<ul style="list-style-type: none"> CT1 CT2 	CT1	Defines which current measurement module is used by the function.
Condition monitor status	<ul style="list-style-type: none"> Normal Alarm1 On Alarm2 On 	-	Displays the status of the monitor.
Open operations	0...4 294 967 295	-	Displays the total number of breaker open operations.
Operation time open	0...4 294 967 295 ms	-	Displays the latest breaker opening time.
Close operations	0...4 294 967 295	-	Displays the total number of breaker close operations.
Operation time close	0...4 294 967 295 ms	-	Displays the latest breaker closing time.
L1 Operations Left	0...4 294 967 295	-	Displays the number of operations left in each phase.
L2 Operations Left			
L3 Operations Left			
L1 Cumulative abrasion	0...4 294 967 295 kA ² t	-	Displays the amount of abrasion in each phase. See contact abraction calculation formula below.
L2 Cumulative abrasion			
L3 Cumulative abrasion			
Maximum cumulative abrasion	0...4 294 967 295 kA ² t	-	Displays the value of the phase with most cumulated abrasion.
Object Cumulated operations	0...4 294 967 295	-	Displays the total number of operations.
Clear condition monitoring statistics	<ul style="list-style-type: none"> - Clear 	-	Clears the operation statistics.
Operations with Current 1 Value allowed	0...200 000	50000	Defines the number of operations with lower current values. See figure above.
Current 1 Value	0.00...100.00 kA	1.00 kA	Defines the lower current turnpoint. See figure above.
Operations with Current 2 Value allowed	0...200 000	100	Defines number of operations with higher current values. See figure above.
Current 2 Value	0.00...100.00 kA	20.00 kA	Defines the higher current turnpoint. See figure above.

Name	Range	Default	Description
Condition Alarm 1 Enable	<ul style="list-style-type: none"> Disabled Enabled 	Disabled	Enables Alarm 1.
Condition Alarm 1 when operations less than	0...200 000	1000	When the number of operations left is less than value set here, Alarm 1 will activate.
Abrasion sum threshold alarm	0...1 000 000 kA ² t	200 000 kA ² t	When the cumulated abrasion exceeds this value, contact abrasion alarm signal is activated
Condition Alarm 2 Enable	<ul style="list-style-type: none"> Disabled Enabled 	Disabled	Enables Alarm 2.
Condition Alarm 2 when operations less than	0...200 000	100	When the number of operations left is less than value set here, Alarm 2 will activate.
Abrasion sum threshold warning	0...1 000 000 kA ² t	200 000 kA ² t	When the cumulated abrasion exceeds this value, contact abrasion warning signal is activated

Contact abrasion is often approximated as being proportional to the arc energy during interruption. AQ-200 series devices calculate contact abrasion for each breaker opening using the following formula:

Figure. 4.5.3 - 64. Contact abrasion calculation formula.

$$\textit{Contact abrasion} = I^2 * t$$

Where:

- I is the measured current at the moment the device receives the open command.
- t is the measured opening time of the breaker.

The breaker opening time starts when the open command is issued and ends when the device receives the breaker open status input. For the abrasion calculation to start from a fault-initiated trip, the TRIP signals must be connected to the "Object application open" input, instead of the matrix.

If the fault current at the time of starting the circuit breaker opening is 5 kA and the total time difference between the open command and the circuit breaker open status is 100 ms, the contact abrasion for that circuit breaking will be calculated as follows:

Figure. 4.5.3 - 65. Contact abrasion example calculation.

$$\textit{Contact abrasion} = 5kA^2 * 0,1s = 2,5kA^2 * s$$

The total abrasion cumulates each time the object is opened. Abrasion is calculated separately for each phase.

- When the cumulative abrasion of any phase exceeds the "Object abrasion sum threshold alarm" setting, the "Object contact abrasion alarm" output activates.
- When the cumulative abrasion of any phase exceeds the "Object abrasion sum threshold warning" setting, the "Object contact abrasion warning" output activates.

Events and registers

The object control and monitoring function (abbreviated "OBJ" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function also provides a resettable cumulative counter for OPEN, CLOSE, OPEN FAILED, and CLOSE FAILED events.

Table. 4.5.3 - 125. Event messages of the OBJ function.

Event block name	Description
OBJX	Object Intermediate
OBJX	Object Open
OBJX	Object Close
OBJX	Object Bad
OBJX	WD Intermediate
OBJX	WD Out
OBJX	WD in
OBJX	WD Bad
OBJX	Open Request ON/OFF
OBJX	Open Command ON/OFF
OBJX	Close Request ON/OFF
OBJX	Close Command ON/OFF
OBJX	Open Blocked ON/OFF
OBJX	Close Blocked ON/OFF
OBJX	Object Ready
OBJX	Object Not Ready
OBJX	Sync Ok
OBJX	Sync Not Ok
OBJX	Open Command Fail
OBJX	Close Command Fail
OBJX	Final trip ON/OFF
OBJX	Contact Abrasion Alarm ON/OFF
OBJX	Switch Operating Time Exceeded ON/OFF
OBJX	XCBR Loc ON/OFF

Event block name	Description
OBJX	XSWI Loc ON/OFF
OBJX	OBJX Cond monitoring alarm 1 ON/OFF
OBJX	OBJX Cond monitoring alarm 2 ON/OFF
OBJX	OBJX Trip Circuit Supervision ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers. The table below presents the structure of the function's register content.

Table. 4.5.3 - 126. Register content.

Name	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Recorded Object opening time	Time difference between the object receiving an "Open" command and the object receiving the "Open" status.
Recorded Object closing time	Time difference between the object receiving a "Close" command and object receiving the "Closed" status.
Object status	The status of the object.
WD status	The status of the withdrawable circuit breaker.
Open fail	The cause of an "Open" command's failure.
Close fail	The cause of a "Close" command's failure.
Open command	The source of an "Open" command.
Close command	The source of an "Open" command.
General status	The general status of the function.

4.5.4 Indicator object monitoring

The indicator object monitoring function takes care of the status monitoring of disconnectors. The function's sole purpose is indication and does not therefore have any control functionality. To control circuit breakers and/or disconnectors, please use the Object control and monitoring function. The monitoring is based on the statuses of the configured device's digital inputs. The number of monitored indicators in a device depends on the device type and available inputs. The status monitoring of one monitored object usually requires two (2) digital inputs. Alternatively, object status monitoring can be performed with a single digital input: the input's active state and its zero state (switched to 1 with a NOT gate in the Logic editor).

The outputs of the function are the monitored indicator statuses (Open, Close, Intermediate and Bad). The setting parameters are static inputs for the function, which can only be changed by the use in the function's setup phase.

The inputs of the function are the binary status indications. The function generates general time stamped ON/OFF events to the common event buffer from each of the following signals: OPEN, CLOSE, BAD and INTERMEDIATE event signals. The time stamp resolution is 1 ms.

Settings

Function uses available hardware and software digital signal statuses. These input signals are also setting parameters for the function.

Table. 4.5.4 - 127. Indicator status.

Name	Range	Default	Description
Indicator name ("Ind. Name")	-	IndX	The user-set name of the object, at maximum 32 characters long.
IndicatorX Object status ("Ind.X Object Status")	<ul style="list-style-type: none"> Intermediate Open Closed Bad 	-	Displays the status of the indicator object. Intermediate status is displayed when neither of the status conditions (open or close) are active. Bad status is displayed when both of the status conditions (open and close) are active.

Table. 4.5.4 - 128. Indicator I/O.

Signal	Range	Description
IndicatorX Open input ("Ind.X Open Status In")	Digital input or other logical signal selected by the user (SWx)	A link to a physical digital input. The monitored indicator's OPEN status. "1" refers to the active "Open" state of the monitored indicator.
IndicatorX Close input ("Ind.X Close Status In")	Digital input or other logical signal selected by the user (SWx)	A link to a physical digital input. The monitored indicator's CLOSE status. "1" refers to the active "Close" state of the monitored indicator.

Events

The indicator object monitoring function (abbreviated "CIN" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

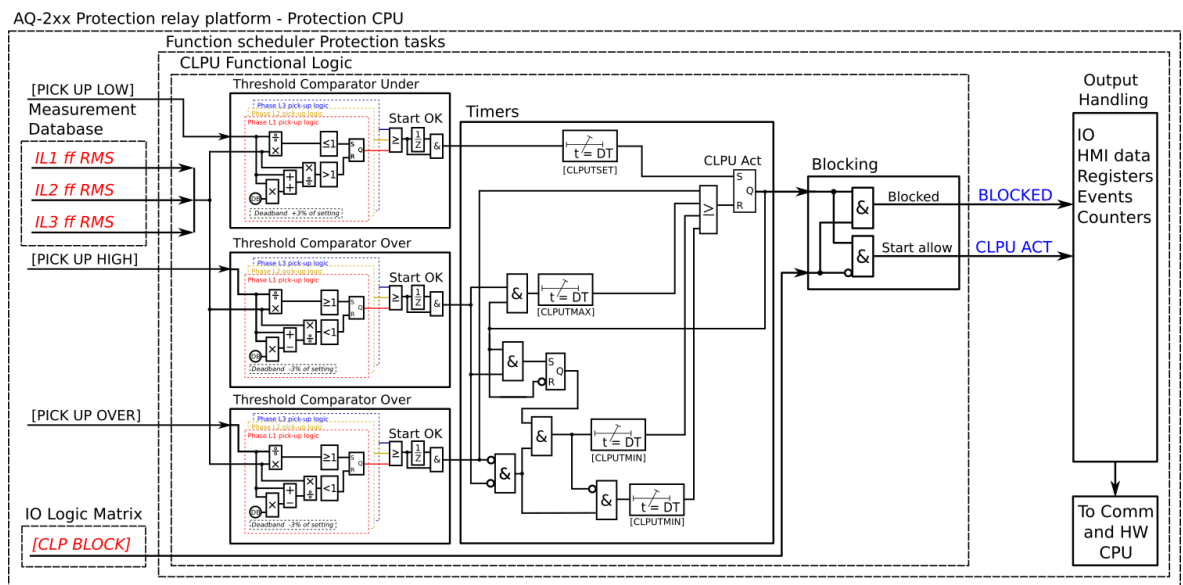
Table. 4.5.4 - 129. Event messages (instances 1-10).

Event block name	Event names
CIN1...10	Intermediate
CIN1...10	Open
CIN1...10	Close
CIN1...10	Bad

4.5.5 Cold load pick-up (CLPU)

The cold load pick-up function is used for detecting so-called cold load situations, where a loss of load diversity has occurred after distribution has been re-energized. The characteristics of cold load situations vary according to the types of loads individual feeders have. This means that this function needs to be set specifically according to the load type of the feeder it is monitoring. For example, in residential areas there are relatively many thermostat-controlled devices (such as heating and cooling machinery) which normally run in asynchronous cycles. When restoring power after a longer power outage, these devices demand the full start-up power which can cause the inrush current to be significantly higher than what the load current was before the outage. This is uncommon in industrial environments since the restoring of the production process takes several hours, or even days, and the power level goes back to the level it was before the outage. However, some areas of the industrial network may find the cold load pick-up function useful.

Figure. 4.5.5 - 66. Simplified function block diagram of the cold load pick-up function.



Measured input

The function block uses fundamental frequency component of phase current measurement values.

Table. 4.5.5 - 130. Measurement inputs of the cold load pick-up function.

Signal	Description
$I_{L1} \text{ RMS}$	Fundamental frequency component of phase L1 (A) current
$I_{L2} \text{ RMS}$	Fundamental frequency component of phase L2 (B) current
$I_{L3} \text{ RMS}$	Fundamental frequency component of phase L3 (C) current

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible change them by editing the setting group.

Table. 4.5.5 - 131. General settings.

Name	Range	Default	Description
CLPU LN mode	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	On	Set mode of CLP block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
Measurement side	<ul style="list-style-type: none"> Side 1 Side 2 	Side 1	Defines which current measurement module is used by the function. Only visible when there is more than one module.
Condition	<ul style="list-style-type: none"> Normal Curr low Overcurrent On CLPU On CLPU blocked 	Normal	Displays the status of the function.

Pick-up settings

The I_{low} , I_{high} and I_{over} setting parameters control the the pick-up and activation of the cold load pick-up function. They define the maximum and minimum allowed measured current before action from the function. The function constantly calculates the ratio between the setting values and the measured magnitude (I_m) for each of the three phases. The reset ratio of 97 % is built into the function and is always relative to the setting value. The setting value is common for all measured phases. When the I_m exceeds the setting value (in single, dual or all phases) it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.5.5 - 132. Pick-up settings.

Name	Range	Step	Default	Description
I_{low}	0.01...40.00×In	0.01×In	0.20×In	The pick-up setting for low current detection. All measured currents must be below this setting in order for the cold load pick-up signal to be activated.
I_{high}	0.01...40.00×In	0.01×In	1.20×In	The pick-up setting for high current detection. All measured currents must exceed this setting in order for the cold load pick-up signal to be activated.
I_{over}	0.01...40.00×In	0.01×In	2.00×In	The pick-up setting for overcurrent detection. If this setting is exceeded by any of the measured currents, the cold load pick-up signal is released immediately.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.5.5 - 133. Information displayed by the function.

Name	Range	Description
CLPU LN behaviour	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	<p>Displays the mode of CLP block.</p> <p>This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.</p>
CLP condition	<ul style="list-style-type: none"> • Normal • Curr low • Overcurrent On • CLPU On • CLPU blocked 	<p>Displays status of the control function.</p>

Function blocking

The blocking signal is evaluated at the start of each program cycle. The blocking signals are connected to the function's dedicated input, which can be configured in the *IO → Blocking Input Control* tab of the function.

- When the pick-up element activates and the blocking signal is not active, a CLPU ACT signal is generated, and the function starts or continues with the trip time countdown.
- When the pick-up element activates and the blocking signal is active, a BLOCKED signal is generated, and the function does not process the event further.
- When CLPU ACT signal is already active and the blocking input signal becomes active, the CLPU ACT signal is reset and BLOCKED signal is generated. The release time characteristics are then processed in the same way as when the pick-up signal is reset.

The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics

The behavior of the function's operating timers can be set for activation as well as for the situation monitoring and release of the cold load pick-up.

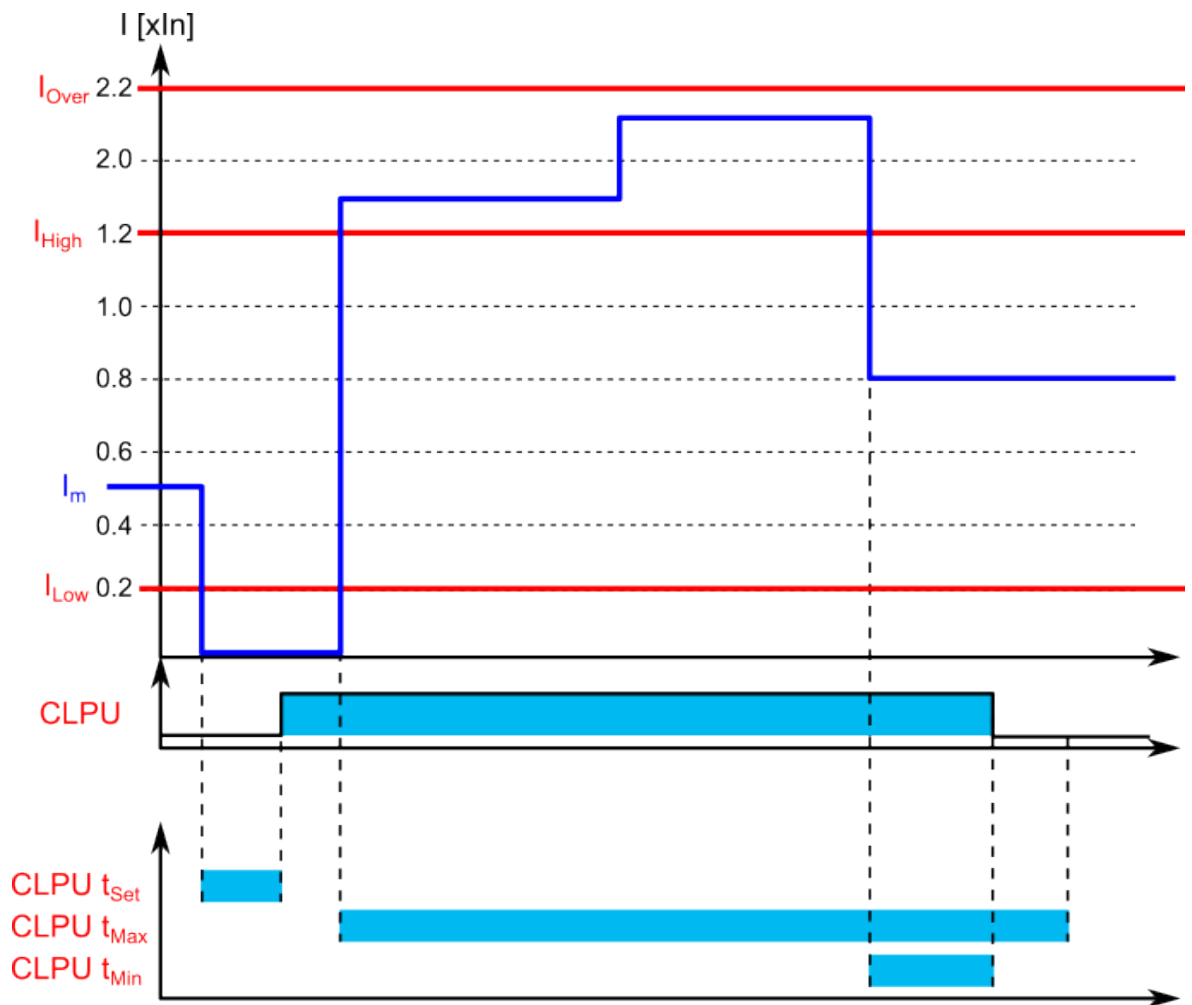
The table below presents the setting parameters for the function's time characteristics.

Table. 4.5.5 - 134. Setting parameters for operating time characteristics.

Name	Range	Step	Default	Description
T _{set}	0.000...1800.000s	0.005s	10.000s	The function's start timer which defines how long the <i>I_{low}</i> condition has to last before the cold load pick-up is activated.
T _{max}	0.000...1800.000s	0.005s	30.000s	The function's maximum timer which defines how long the starting condition can last and for how long the current is allowed to be over <i>I_{high}</i> .
T _{min}	0.000...1800.000s	0.005s	0.040s	The function's minimum timer which defines how long the starting condition has to last at the minimum. If the start-up sequence includes more than one inrush situation, this parameter may be used to prolong the cold load pick-up time over the first inrush. Additionally, this parameter operates as the "reclaim" time for the function in case the inrush current is not immediately initiated in the start-up sequence.

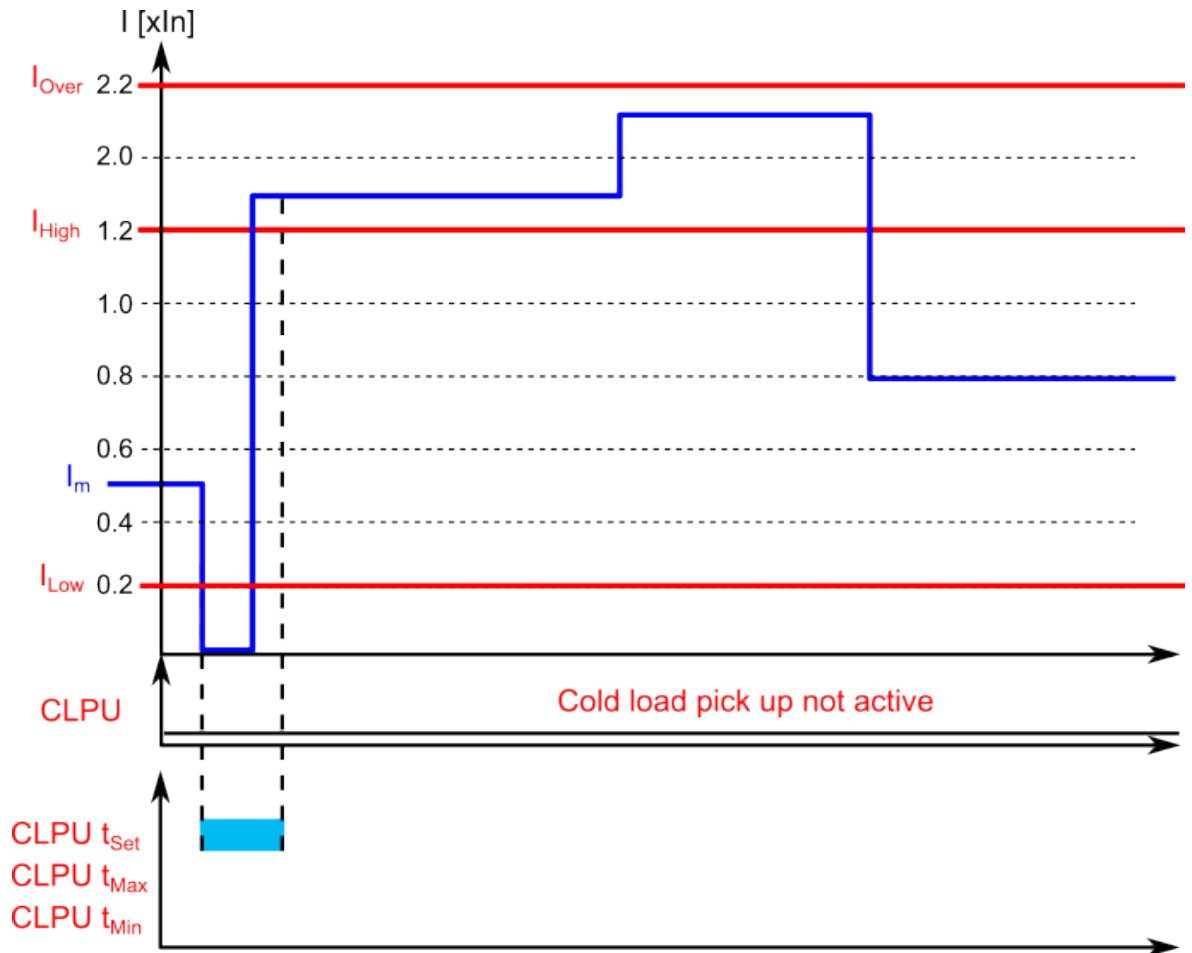
The six examples below showcase some typical cases with the cold load pick-up function.

Figure. 4.5.5 - 67. Example of timers and pick-up parameters (normal CLPU situation).



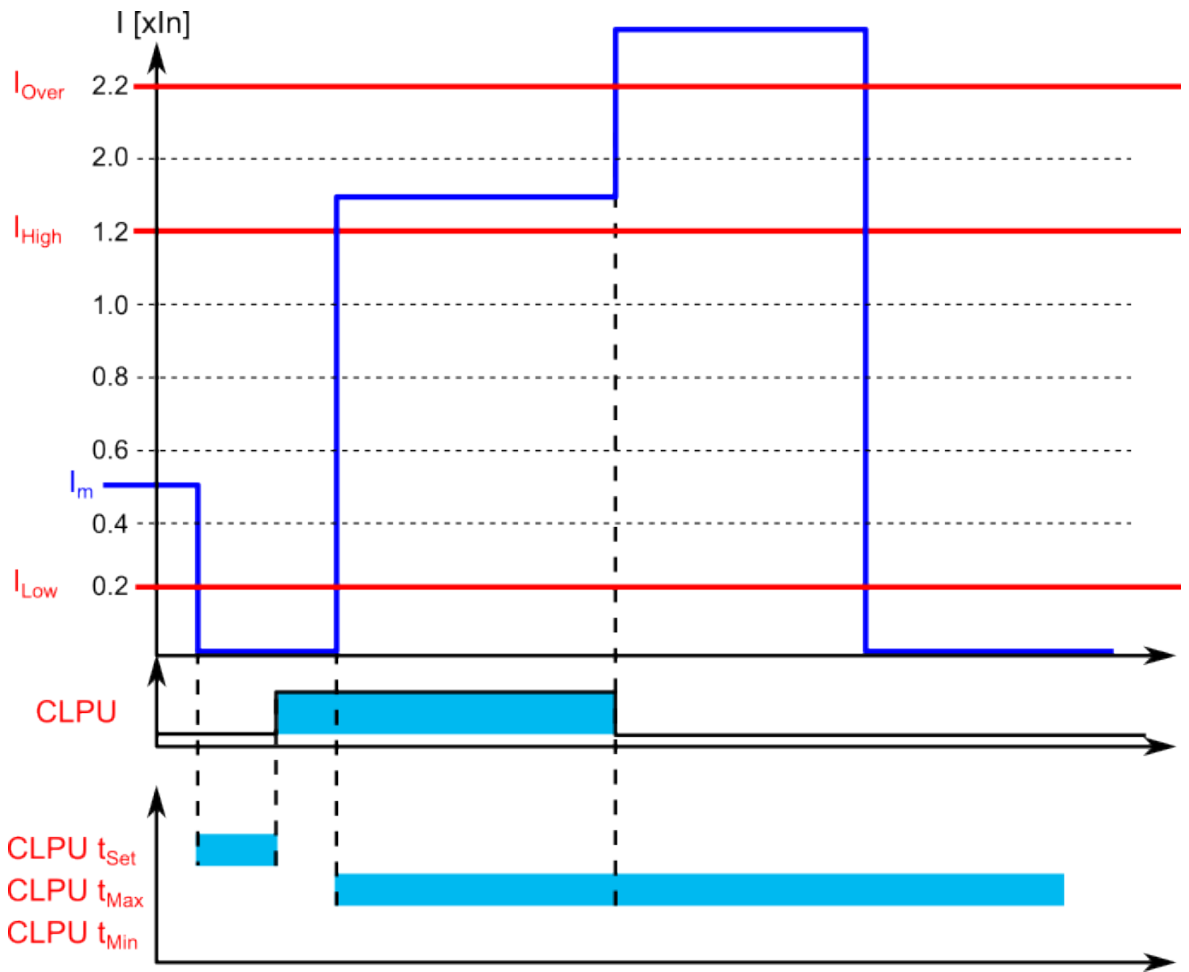
In the example above, the cold load pick-up function activates after the measured current dips below the I_{low} setting and has been there for T_{set} amount of time. When the current exceeds the I_{high} setting value, a timer starts counting towards the T_{max} time. The pick-up current is cleared before the the counter reaches the T_{max} time, when the measured current goes between of I_{low} and the I_{high} . This is when the start-up condition is considered to be over. The cold load pick-up signal can be prolonged beyond this time by setting the T_{min} to a value higher than 0.000 s.

Figure. 4.5.5 - 68. Example of timers and pick-up parameters (no cold load pick-up, I_{low} too short).



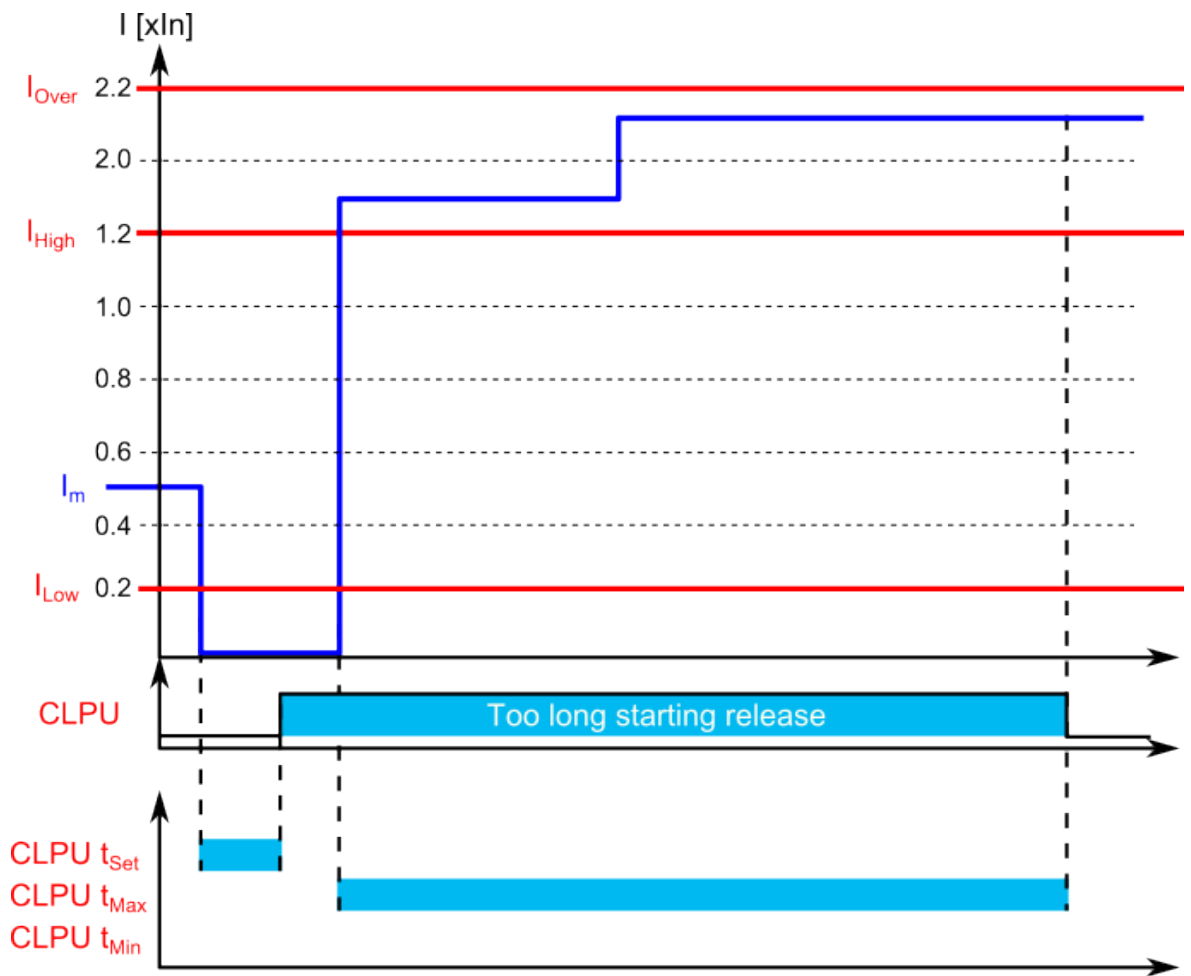
In the example above, the cold load pick-up function does not activate even when the measured current dips below the I_{low} setting, because the T_{set} is not exceeded and therefore no cold load pick-up signal is issued. If the user wants the function to activate within a shorter period of time, the T_{set} parameter can be set to a lower value. If the user wants no delay, the T_{set} can be zero seconds and the operation will be immediate.

Figure. 4.5.5 - 69. Example of timers and pick-up parameters (activated pick-up and instant release due to overcurrent).



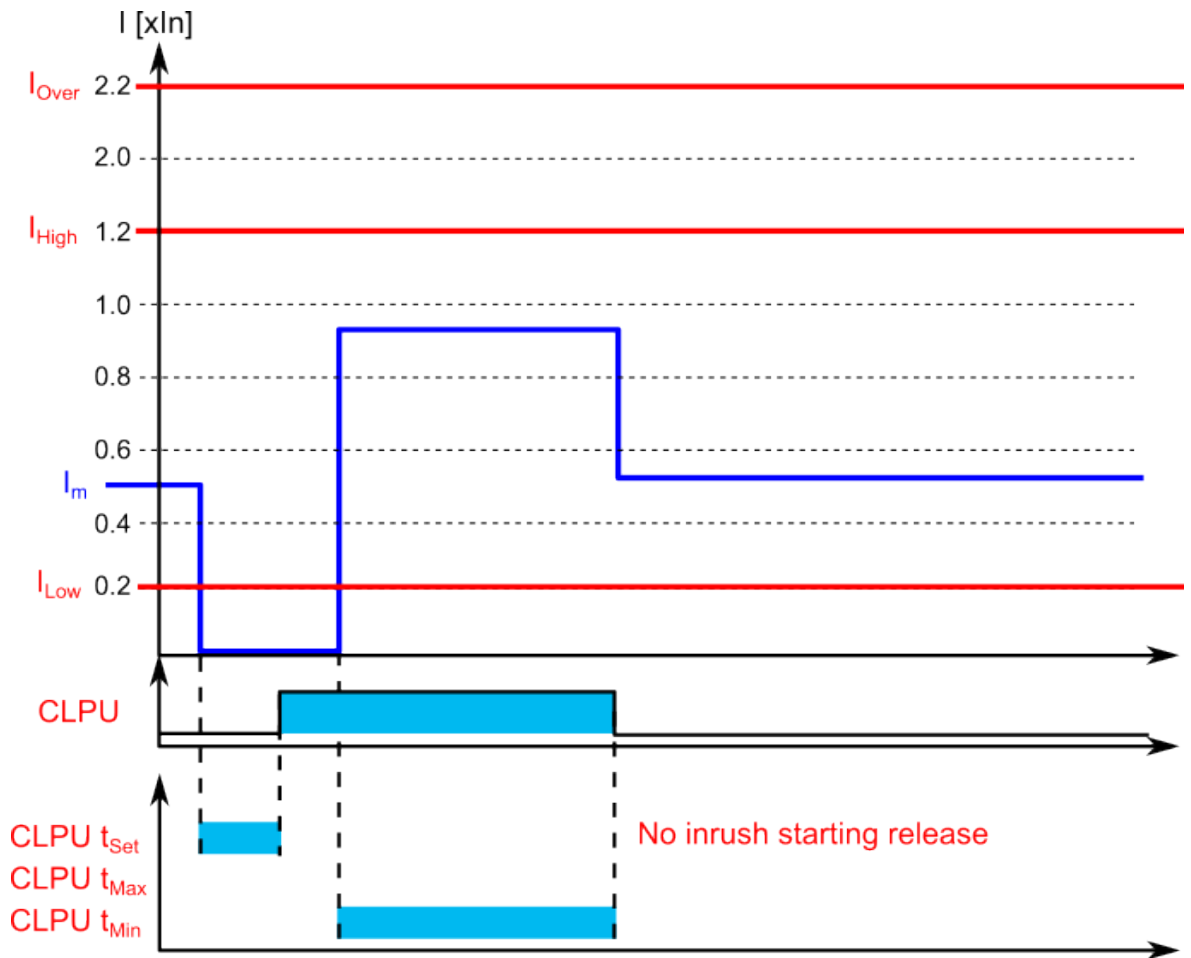
In the example above, the cold load pick-up function activates after the measured current dips below the I_{low} setting and has been there for T_{set} amount of time. When the I_m exceeds the I_{high} setting, a counter starts counting towards the T_{max} time. The measured current exceeds the I_{over} setting during the start-up situation and causes the cold load pick-up signal to be released immediately.

Figure. 4.5.5 - 70. Example of timers and pick-up parameters (activated pick-up and instant release due to too long starting).



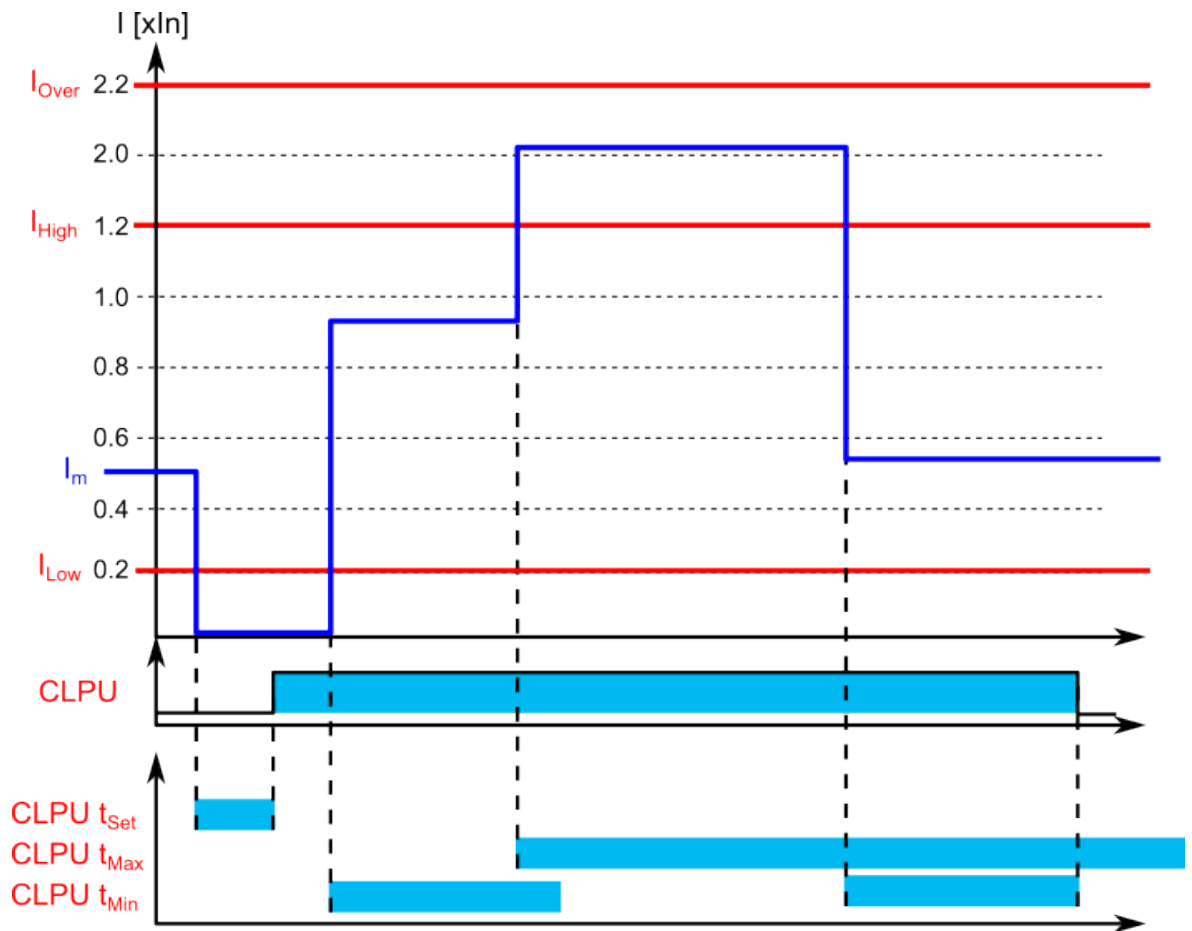
In the example above, the cold load pick-up function activates after the measured current has stayed below the I_{low} setting for a T_{set} amount of time. When the current exceeds the I_{high} setting, a timer starts counting towards the T_{max} time. The measured current stays above the I_{high} setting until the T_{max} is reached, which causes the release of the cold load pick-up signal.

Figure. 4.5.5 - 71. Example of timers and pick-up parameters (no inrush current detected in the starting).



In the example above, the cold load pick-up function activates after the measured current has stayed below the I_{Low} setting for a T_{set} amount of time. The current stays between the I_{Low} setting and the I_{high} setting, so the cold load pick-up signal is active for T_{min} time. As no inrush current is detected during that time, the signal is released.

Figure. 4.5.5 - 72. Example of timers and pick-up parameters (an inrush current detected during T_{min} time).



In the example above, the cold load pick-up function activates after the measured current has stayed below the I_{low} setting for a T_{set} amount of time. The current increases to between the I_{low} setting and the I_{high} setting, which causes a counter to start counting towards the T_{min} time. Before the counter reaches T_{min} , the current exceeds the I_{high} setting, which causes a counter to start counting towards the T_{max} time. The cold load pick-up signal remains active until the T_{max} has been reached, or until the start-up is over and the T_{min} time is over.

Events and registers

The cold load pick-up function (abbreviated "CLP" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the CLPU ACT and BLOCKED events.

Table. 4.5.5 - 135. Event messages.

Event block name	Event names
CLP1	LowStart ON/OFF
CLP1	HighStart ON/OFF
CLP1	LoadNormal ON/OFF

Event block name	Event names
CLP1	Overcurrent ON/OFF
CLP1	CLPUActivated ON/OFF
CLP1	Block ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for ACTIVATED, BLOCKED, etc. The table below presents the structure of the function's register content.

Table. 4.5.5 - 136. Register content.

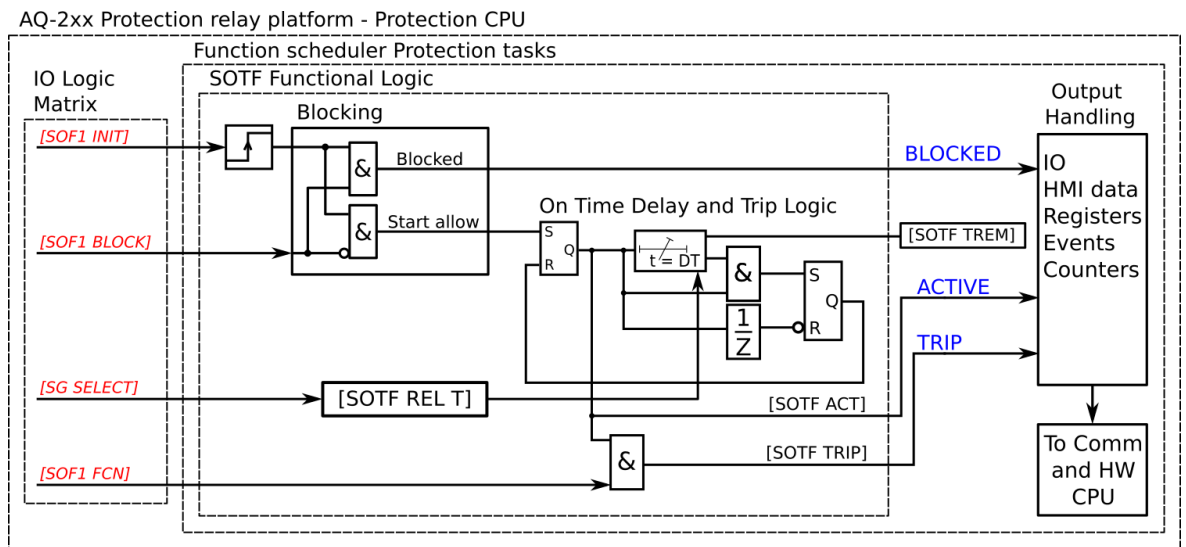
Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
L1/L2/L3 current	Phase currents on trigger time
Time to CLPUact	Time remaining before the function is active
CLPU active time	The time the function has been active before starting
Start-up time	Recorded starting time
Releasing time of CLPU	Reclaim time counter
Setting group in use	Setting group 1...8 active

4.5.6 Switch-on-to-fault (SOTF)

The switch-on-to-fault (SOTF) function is used for speeding up the tripping when the breaker is closed towards a fault or forgotten earthing to reduce the damage in the fault location. The function can be used to control protection functions, or it can be used to directly trip a breaker if any of the connected protection functions starts during the set SOTF time. The operation of the function is instant after the conditions are met and any one signal connected to the "*Function input*" input activates.

The function can be initiated by a digital input, or by a circuit breaker "Close" command connected to the "*SOTF activate input*" input. The duration of the SOTF-armed condition can be set by the "Release time for SOTF" setting parameter; it can be changed if the application so requires through setting group selection.

Figure. 4.5.6 - 73. Simplified function block diagram of the switch-on-to-fault function.



Input signals

The function block does not use analog measurement inputs. Instead, its operation is based entirely on binary signal statuses.

Table. 4.5.6 - 137. Input signals.

Input	Description
Activate input	The digital input or logic signal for the function to arm and start calculating the SOTF time. Any binary signal can be used to activate the function and start the calculation. The rising edge of the signal is considered as the start of the function.
Block input	The input for blocking the function. Any binary signal can be used to block the function from starting.
Function input	The function input activates the function's instant trip if applied when the function is calculating the SOTF time.

Settings

The switch-on-to-fault function has one setting and it determines how long the function remains active after it has been triggered. If the inputs receive any of the set signals during this time, the function's trip is activated.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.5.6 - 138. Settings of the function.

Name	Range	Default	Description
SOTF LN mode	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	On	Set mode of SOF block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.

Name	Range	Default	Description
SOTF force status to	<ul style="list-style-type: none"> • Normal • Blocked • Active • Trip 	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
Release time for SOTF	0.000...1800.000s	1.000s	The time the function is active after triggering.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.5.6 - 139. Information displayed by the function.

Name	Range	Description
SOTF LN behaviour	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	Displays the mode of SOTF block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
SOTF condition	<ul style="list-style-type: none"> • Normal • Init • Active • Trip • Blocked 	Displays status of the control function.

Function blocking

The function can be blocked by activating the BLOCK input. This prevents the function's active time from starting.

Events and registers

The switch-on-to-fault function (abbreviated "SOF" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the INIT, BLOCKED, ACTIVE and TRIP events.

Table. 4.5.6 - 140. Event messages.

Event block name	Event names
SOF1	SOTF Init ON/OFF
SOF1	SOTF Block ON/OFF

Event block name	Event names
SOF1	SOTF Active ON/OFF
SOF1	SOTF Trip ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON process data of ACTIVATED events. The table below presents the structure of the function's register content.

Table. 4.5.6 - 141. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Used SG	Setting group 1...8 active
SOTF remaining time	The time remaining of the set release time.
SOTF been active time	The time the function has been active.

4.5.7 Milliampere output control

The milliamp current loop is the prevailing process control signal in many industries. It is an ideal method of transferring process information because a current does not change as it travels from a transmitter to a receiver. It is also much more simple and cost-effective.

The benefits of 4...20 mA loops:

- the dominant standard in many industries
- the simplest option to connect and configure
- uses less wiring and connections than other signals, thus greatly reducing initial setup costs
- good for travelling long distances, as current does not degrade over long connections like voltage does
- less sensitive to background electrical noise
- detects a fault in the system incredibly easily since 4 mA is equal to 0 % output.

Milliampere (mA) outputs

The device supports up to two (2) independent mA option cards. Each card has four (4) mA output channels and one (1) mA input channel. If the device has an mA option card, enable mA outputs at *Control* → *Device IO* → *mA outputs*. The outputs are activated in groups of two: channels 1 and 2 are activated together, as are channels 3 and 4.

Table. 4.5.7 - 142. Main settings (output channels).

Name		Range	Default	Description
mA option card 1	Enable mA output channels 1 and 2	<ul style="list-style-type: none"> • Disabled • Enabled 	Disabled	Enables and disables the outputs of the mA output card 1.
	Enable mA output channels 3 and 4			

Name		Range	Default	Description
mA option card 2	Enable mA output channels 5 and 6	<ul style="list-style-type: none"> Disabled Enabled 	Disabled	Enables and disables the outputs of the mA output card 2.
	Enable mA output channels 7 and 8			

Table. 4.5.7 - 143. Settings for mA output channels.

Name	Range	Step	Default	Description
Enable mA output channel	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	Enables and disables the selected mA output channel. If the channel is disabled, the channel settings are hidden.
Magnitude selection for mA output channel	<ul style="list-style-type: none"> Currents Voltages Powers Impedance and admittance Other 	-	Currents	Defines the measurement category that is used for mA output control.
Magnitude of mA output channel	(dependent on the measurement category selection)	-	(dependent on the measurement category selection)	Defines the measurement magnitude used for mA output control. The available measurements depend on the selection of the "Magnitude selection for mA output channel" parameter.
Input value 1	$-10^7 \dots 10^7$	0.001	0	The first input point in the mA output control curve.
Scaled mA output value 1	0.0000...24.0000mA	0.0001mA	0mA	The mA output value when the measured value is equal to or less than Input value 1.
Input value 2	$-10^7 \dots 10^7$	0.001	1	The second input point in the mA output control curve.
Scaled mA output value 2	0.0000...24.0000mA	0.0001mA	0mA	The mA output value when the measured value is equal to or greater than Input value 2.

Figure. 4.5.7 - 74. Example of the effects of mA output channel settings.

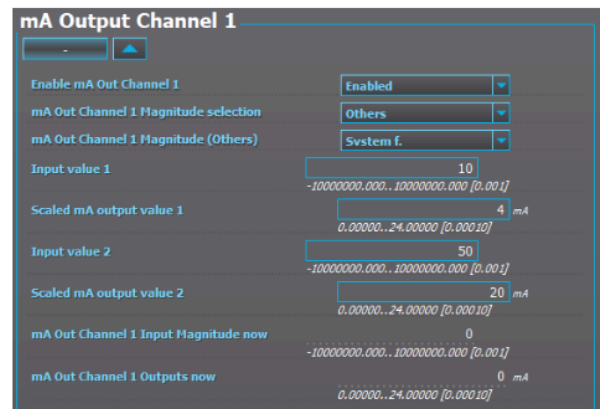
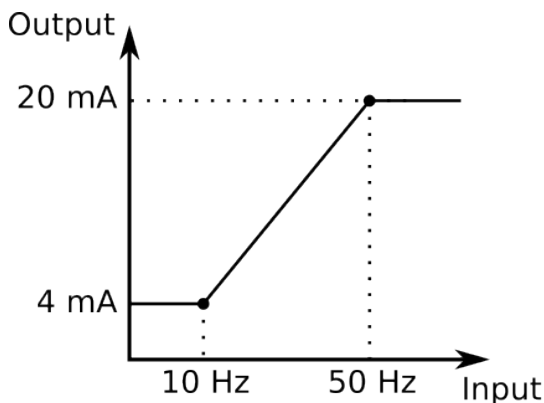


Table. 4.5.7 - 144. Hardware indications.

Name	Range	Description
Hardware in mA output channels 1...4	<ul style="list-style-type: none"> • None • Slot A • Slot B • Slot C • Slot D • Slot E • Slot F • Slot G • Slot H • Slot I • Slot J • Slot K • Slot L • Slot M • Slot N • Too many cards installed 	Indicates the option card slot where the mA output card is located.
Hardware in mA output channels 5...8		

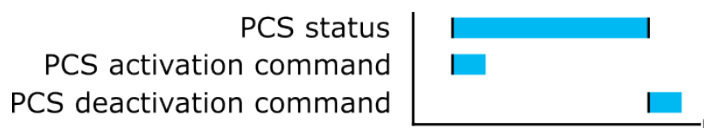
Table. 4.5.7 - 145. Measurement values reported by mA output cards.

Name	Range	Step	Description
mA in Channel 1	0.0000...24.0000mA	0.0001mA	Displays the measured mA value of the selected input channel.
mA in Channel 2			
mA Out Channel Input Magnitude now	$-10^7 \dots 10^7$	0.001	Displays the input value of the selected mA output channel at that moment.
mA Out Channel Outputs now	0.0000...24.0000mA	0.0001mA	Displays the output value of the selected mA output channel at that moment.

4.5.8 Programmable control switch

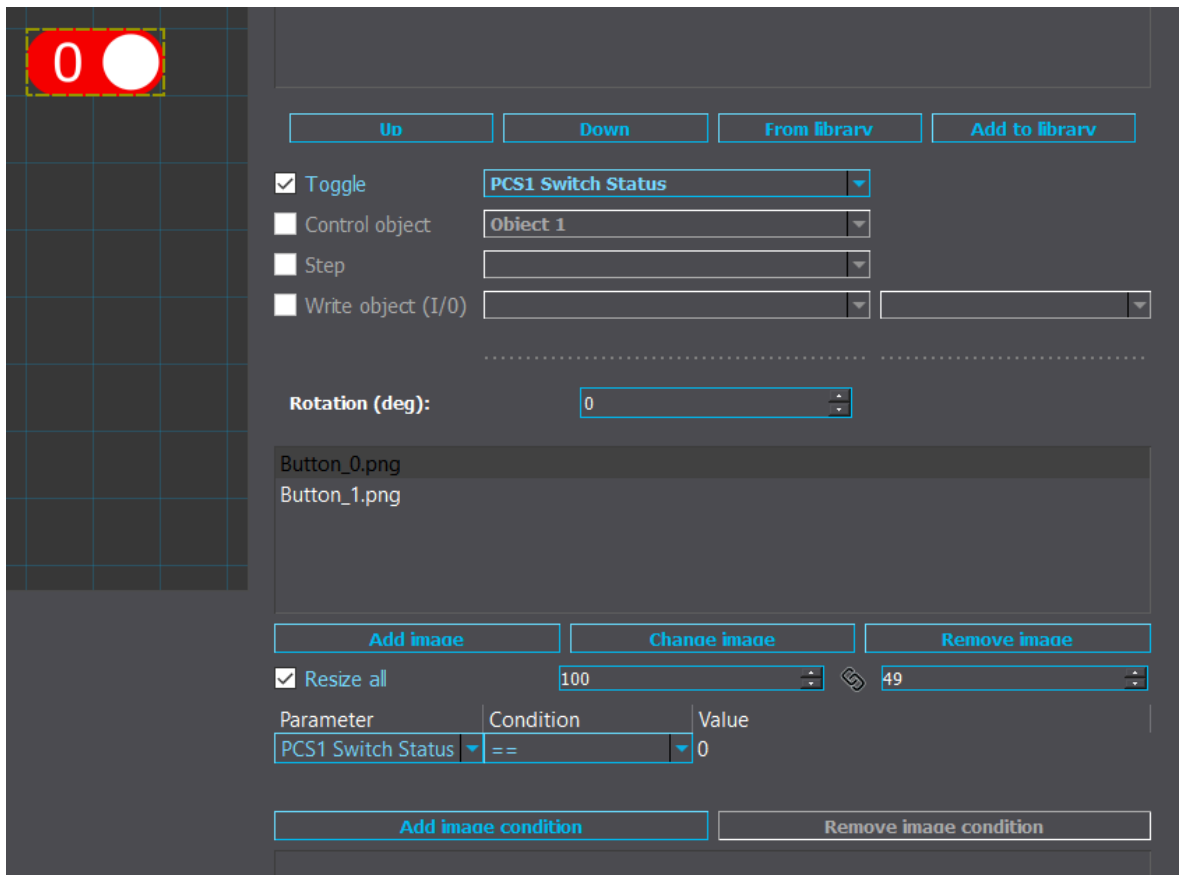
The programmable control switch is a control function that controls its binary output signal. This output signal can be controlled locally from the device's mimic or remotely from the RTU. The main purpose of programmable control switches is to block or enable function and to change function properties by changing the setting group. However, this binary signal can also be used for any number of other purposes, just like all other binary signals. Once a programmable control switch has been activated or disabled, it remains in that state until given a new command to switch to the opposite state (see the image below). The switch cannot be controlled by an auxiliary input, such as digital inputs or logic signals; it can only be controlled locally (mimic) or remotely (RTU).

Figure. 4.5.8 - 75. When a PCS has been controlled "ON" or "OFF", the PCS will keep its state.



Setting up a switch in the mimic editor

Figure. 4.5.8 - 76. Programmable control switch setup in the mimic editor.



When an item has been added to the mimic, a collection of toggleable buttons can be found from the library with the "From library" button. To make an item a "programmable control switch", select one of the programmable switches (PCS1...5 Switch status) from the "Toggle" dropdown menu. After this select one of the images in the item ("Button_0.png" and "Button_1.png" in the example image above) and then choose the corresponding programmable control switch as the image condition. In the example image "Button_0.png" is displayed when "PCS1 Switch Status == 0". Set the other image (in this case "Button_1.png") to "PCS1 Switch Status == 1". When this is done, the image displayed by the item will follow the status of the programmable control switch.

If more than five toggleable switches are needed, logical inputs can also be set for the same purpose. The only difference is that the status of logical inputs are set to zero when the processor is rebooted, whereas programmable control switches keep the status.

Settings.

These settings can be accessed at *Control* → *Device I/O* → *Programmable control switch*.

Table. 4.5.8 - 146. Settings.

Name	Range	Default	Description
Switch name	-	Switchx	The user-settable name of the selected switch. The name can be up to 32 characters long.

Name	Range	Default	Description
Access level for Mimic control	<ul style="list-style-type: none"> User Operator Configurator Super user 	Configurator	Determines which access level is required to be able to control the programmable control switch via the Mimic.

Events

The programmable control switch function (abbreviated "PCS" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp. The function offers five (5) independent switches. The function's output signals can be used for direct I/O controlling and user logic programming.

Table. 4.5.8 - 147. Event messages.

Event block name	Event names
PCS	Switch 1 ON/OFF
PCS	Switch 2 ON/OFF
PCS	Switch 3 ON/OFF
PCS	Switch 4 ON/OFF
PCS	Switch 5 ON/OFF

4.5.9 Function buttons

AQ 250 devices have twelve (12) physical function buttons in the front panel of the device. The main purpose of function buttons is to block or enable functions and to change function properties by changing the setting group. However, this binary signal can also be used for any number of other purposes, just like all other binary signals.

Function buttons have two operation modes: "Press release" and "Toggle On/Off". In "Press release" mode the button status is active while the button is pressed down. In "Toggle On/Off" mode the button status toggles between "On" and "Off". Each button has a user configurable LED at the top left corner of the button. The LED can be configured to activate red, orange or green color from button status or any other logical binary signal.

General button settings and LED activation settings can be set at *Control* → *Device IO* → *Function Button Settings*.



NOTICE!

The status of the function button outputs can only be controlled from the front panel i.e. can't be controlled remotely. Therefore it is recommended to use "a virtual button" (programmable control switches or logical inputs) if a toggleable signal must be controlled both locally and remotely.

Table. 4.5.9 - 148. User button settings

Name	Range	Step	Default	Description
Access level for function buttons	<ul style="list-style-type: none"> User Operator Configurator Super user 	-	Operator	Determines which access level is required to be able to control the buttons.
Consider Local/ Remote switch for push-buttons	<ul style="list-style-type: none"> No Yes 	-	No	When set to "Yes", the buttons can be operated only when the "L/R" button has been set to "Local" mode .
User editable description button 1...12	-	-	BTN1...12	Description of the button. If "Function button" view has been added to the "Carousel design", these descriptions are used for the buttons.
Function button 1...12 mode	Press release Toggle On/Off	-	Press release	Defines the operation mode of the button. In "Press release" mode the button signal is active while the button is pressed down. In "Toggle On/Off" mode the button signal changes status between "On" and "Off" each time the button is pressed.

Table. 4.5.9 - 149. Function button output signals

Signal name	Description
Status Function Button 1...12 ON/OFF	"On" and "Off" status of each button

4.5.10 Analog input scaling curves

Sometimes when measuring with RTD inputs, milliampere inputs and digital inputs the measurement might be inaccurate because the signal coming from the source is inaccurate. One common example of this is tap changer location indication signal not changing linearly from step to step. If the output difference between the steps are not equal to each other, measuring the incoming signal accurately is not enough. "Analog input scaling curves" menu can be used to take these inaccuracies into account.

Analog input scaling curve settings can be found at *Measurement* → *AI(mA, DI volt) scaling* menu.

Currently following measurements can be scaled with analog input scaling curves:

- RTD inputs and mA inputs in "RTD & mA input" option cards
- mA inputs in "4x mA output & 1x mA input" option cards
- mA input in "4x mA input & 1x mA output" option cards
- Digital input voltages

Table. 4.5.10 - 150. Main settings (input channel).

Name	Range	Step	Default	Description
Analog input scaling	<ul style="list-style-type: none"> Disabled Activated 	-	Disabled	Enables and disables the input.

Name	Range	Step	Default	Description
Scaling curve 1...10	<ul style="list-style-type: none"> • Disabled • Activated 	-	Disabled	Enables and disables the scaling curve and the input measurement.
Curve 1...10 input signal select	<ul style="list-style-type: none"> • S7 mA Input • S8 mA Input • S15 mA Input • S16 mA Input • DI1...DI20 Voltage • RTD S1...S16 Resistance • mA In 1 (I card 1) • mA In 2 (I card 2) • mA In 1 (T card 1) • mA In 2 (T card 1) • mA In 3 (T card 1) • mA In 4 (T card 1) • mA In 1 (T card 2) • mA In 2 (T card 2) • mA In 3 (T card 2) • mA In 4 (T card 2) 	-	S7 mA Input	Defines the measurement used by scaling curve.
Curve 1...10 input signal filtering	<ul style="list-style-type: none"> • No • Yes 	-	No	Enables calculation of the average of received signal.
Curve 1...10 input signal filter time constant	0.005...3800.000 s	0.005 s	1 s	Time constant for input signal filtering. This parameter is visible when "Curve 1...4 input signal filtering" has been set to "Yes".
Curve 1...10 input signal out of range set	<ul style="list-style-type: none"> • No • Yes 	-	No	Enables out of range signals. If input signal is out of minimum and maximum limits, "ASC1...4 input out of range" signal is activated.
Curve1...10 input minimum	-1 000 000.00...1 000 000.00	0.00001	0	Defines the minimum input of the curve. If input is below the set limit, "ASC1...4 input out of range" is activated.
Curve 1...10 input	-1 000 000.00...1 000 000.00	0.00001	-	Displays the input measurement received by the curve.
Curve1...10 input maximum	-1 000 000.00...1 000 000.00	0.00001	0	Defines the maximum input of the curve. If input is above the set limit, "ASC1...4 input out of range" is activated.

Name	Range	Step	Default	Description
Curve1...10 output	-1 000 000.00...1 000 000.00	0.00001	-	Displays the output of the curve.

The input signal filtering parameter calculates the average of received signals according to the set time constant. This is why rapid changes and disturbances (such as fast spikes) are smothered. The Nyquist rate states that the filter time constant must be at least double the period time of the disturbance process signal. For example, the value for the filter time constant is 2 seconds for a 1 second period time of a disturbance oscillation.

$$H(s) = \frac{Wc}{s+Wc} = \frac{1}{1+s/Wc}$$

When the curve signal is out of range, it activates the "ASC1...10 input out of range" signal, which can be used inside logic or with other functions of the device. The signal can be assigned directly to an output relay or to an LED in the I/O matrix. The "Out of range" signal is activated, when the measured signal falls below the set input minimum limit, or when it exceeds the input maximum limit.

If for some reason the input signal is lost, the value is fixed to the last actual measured cycle value. The value does not go down to the minimum if it has been something else at the time of the signal breaking.

Table. 4.5.10 - 151. Output settings and indications.

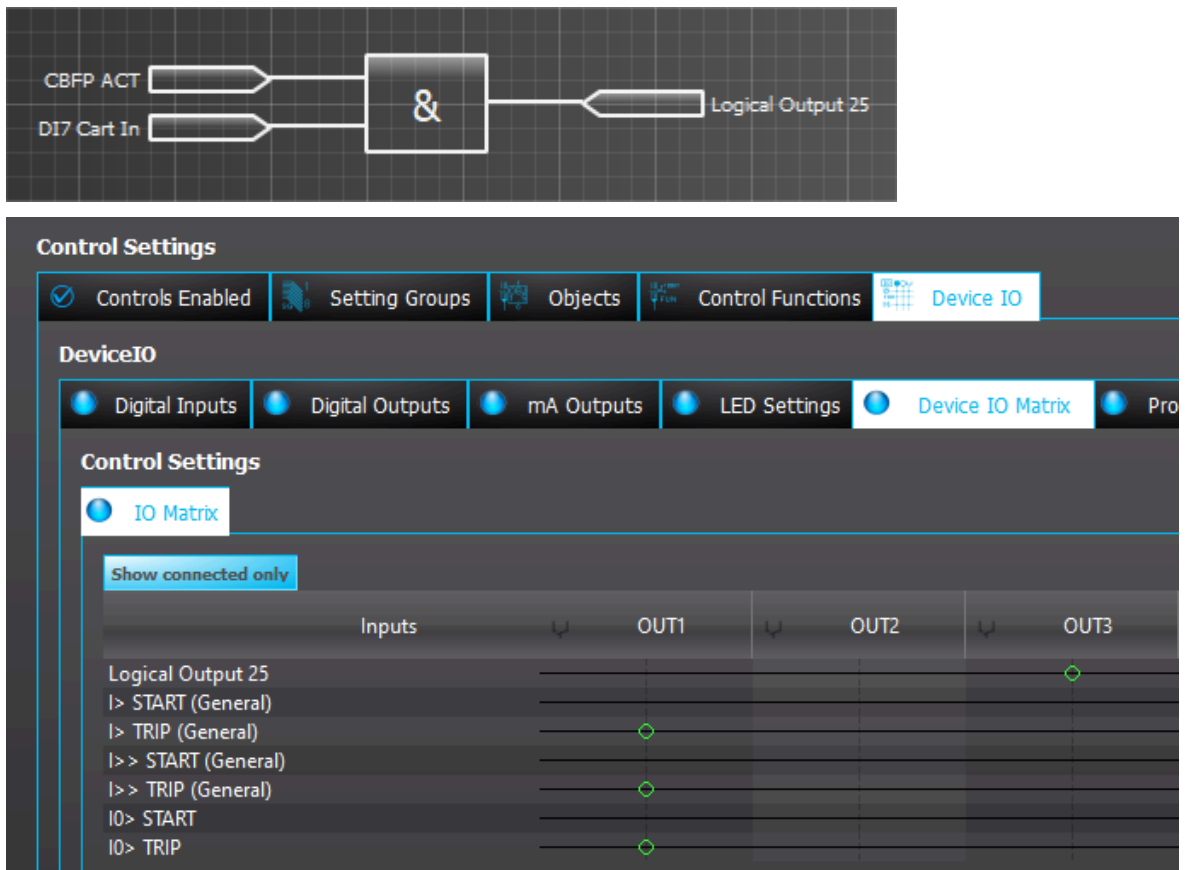
Name	Range	Step	Default	Description
Curve 1...10 update cycle	5...10 000ms	5ms	150ms	Defines the length of the input measurement update cycle. If the user wants a fast operation, this setting should be fairly low.
Scaled value handling	<ul style="list-style-type: none"> • Floating point • Integer out (Floor) • Integer (Ceiling) • Integer (Nearest) 	-	Floating point	Rounds the milliampere signal output as selected.
Input value 1	0...4000	0.000 01	0	The measured input value at Curve Point 1.
Scaled output value 1	$-10^7...10^7$	0.000 01	0	Scales the measured milliampere signal at Point 1.
Input value 2	0...4000	0.000 01	1	The measured input value at Curve Point 2.
Scaled output value 1	$-10^7...10^7$	0.000 01	0	Scales the measured milliampere signal at Point 2.

Name	Range	Step	Default	Description
Add curvepoint 3...20	<ul style="list-style-type: none"> Not used Used 	-	Not used	Allows the user to create their own curve with up to twenty (20) curve points, instead of using a linear curve between two points.

4.5.11 Logical outputs

Logical outputs are used for sending binary signals out from a logic that has been built in the logic editor. Logical signals can be used for blocking functions, changing setting groups, controlling digital outputs, activating LEDs, etc. The status of logical outputs can also be reported to a SCADA system. 64 logical outputs are available. The figure below presents a logic output example where a signal from the circuit breaker failure protection function controls the digital output relay number 3 ("OUT3") when the circuit breaker's cart status is "In".

Figure. 4.5.11 - 77. Logic output example. Logical output is connected to an output relay in matrix.



Logical output descriptions

Logical outputs can be given a description. The user defined description are displayed in most of the menus:

- logic editor
- matrix
- block settings
- event history
- disturbance recordings
- etc.

Table. 4.5.11 - 152. Logical output user description.

Name	Range	Default	Description
User editable description LO1...64	1...31 characters	Logical output 1...64	Description of the logical output. This description is used in several menu types for easier identification.



NOTICE!

After editing user descriptions the event history will start to use the new description only after resetting the HMI. HMI can be reset from *General* → *Device info* → *HMI restart*.

Events

The logical outputs (abbreviated "LOGIC" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp. The function's output signals can be used for direct I/O controlling and user logic programming.

Table. 4.5.11 - 153. Event messages.

Event block name	Event names
LOGIC1	Logical out 1...32 ON/OFF
LOGIC3	Logical out 33...64 ON/OFF

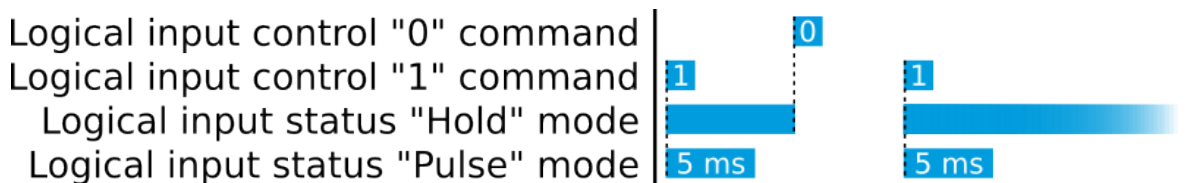
4.5.12 Logical inputs

Logical inputs are binary signals that a user can control manually to change the behavior of the device or to give direct control commands. Logical inputs can be controlled with a virtual switch built in the mimic and from a SCADA system. Logical inputs are volatile signals: their status will always return to "0" when the device is rebooted. 32 logical inputs are available.

Logical inputs have two modes available: Hold and Pulse. When a logical input which has been set to "Hold" mode is controlled to "1", the input will switch to status "1" and it stays in that status until it is given a control command to go to status "0" or until the device is rebooted. When a logical input which has been set to "Pulse" mode is controlled to "1", the input will switch to status "1" and return back to "0" after 5 ms.

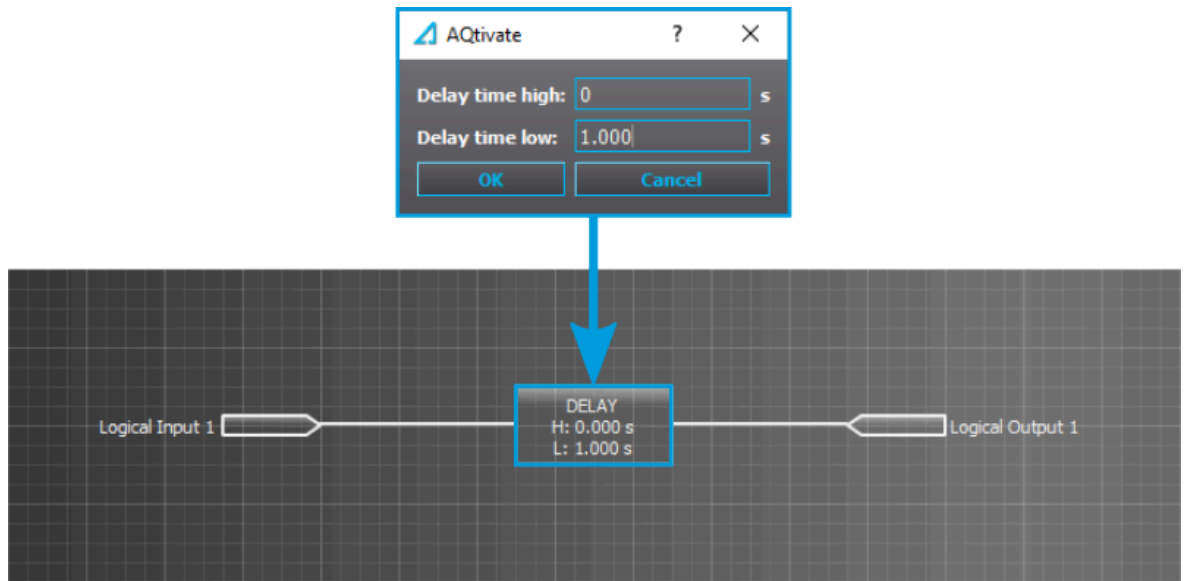
The figure below presents the operation of a logical input in Hold mode and in Pulse mode.

Figure. 4.5.12 - 78. Operation of logical input in "Hold" and "Pulse" modes.



A logical input pulse can also be extended by connecting a DELAY-low gate to a logical output, as has been done in the example figure below.

Figure. 4.5.12 - 79. Extending a logical input pulse.



Logical input control "1" command
 Logical input status "Pulse" mode
 Logical output status

1
 5 ms
 Delay low setting

Logical input descriptions

Logical inputs can be given a description. The user defined description are displayed in most of the menus:

- logic editor
- matrix
- block settings
- event history
- disturbance recordings
- etc.

Table. 4.5.12 - 154. Logical input user description.

Name	Range	Default	Description
User editable description LI1...32	1...31 characters	Logical input 1...32	Description of the logical input. This description is used in several menu types for easier identification.



NOTICE!

After editing user descriptions the event history will start to use the new description only after resetting the HMI. HMI can be reset from *General* → *Device info* → *HMI restart*.

Events

The logical outputs (abbreviated "LOGIC" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp. The function's output signals can be used for direct I/O controlling and user logic programming.

Table. 4.5.12 - 155. Event messages.

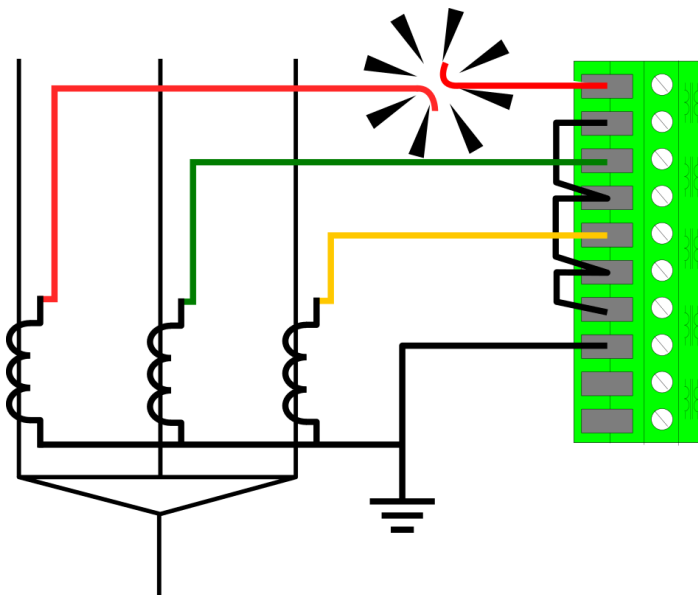
Event block name	Event names
LOGIC2	Logical in 1...32 ON/OFF

4.6 Monitoring functions

4.6.1 Current transformer supervision

The current transformer supervision function (abbreviated CTS in this document) is used for monitoring the CTs as well as the wirings between the device and the CT inputs for malfunctions and wire breaks. An open CT circuit can generate dangerously high voltages into the CT secondary side, and cause unintended activations of current balance monitoring functions.

Figure. 4.6.1 - 80. Secondary circuit fault in phase L1 wiring.



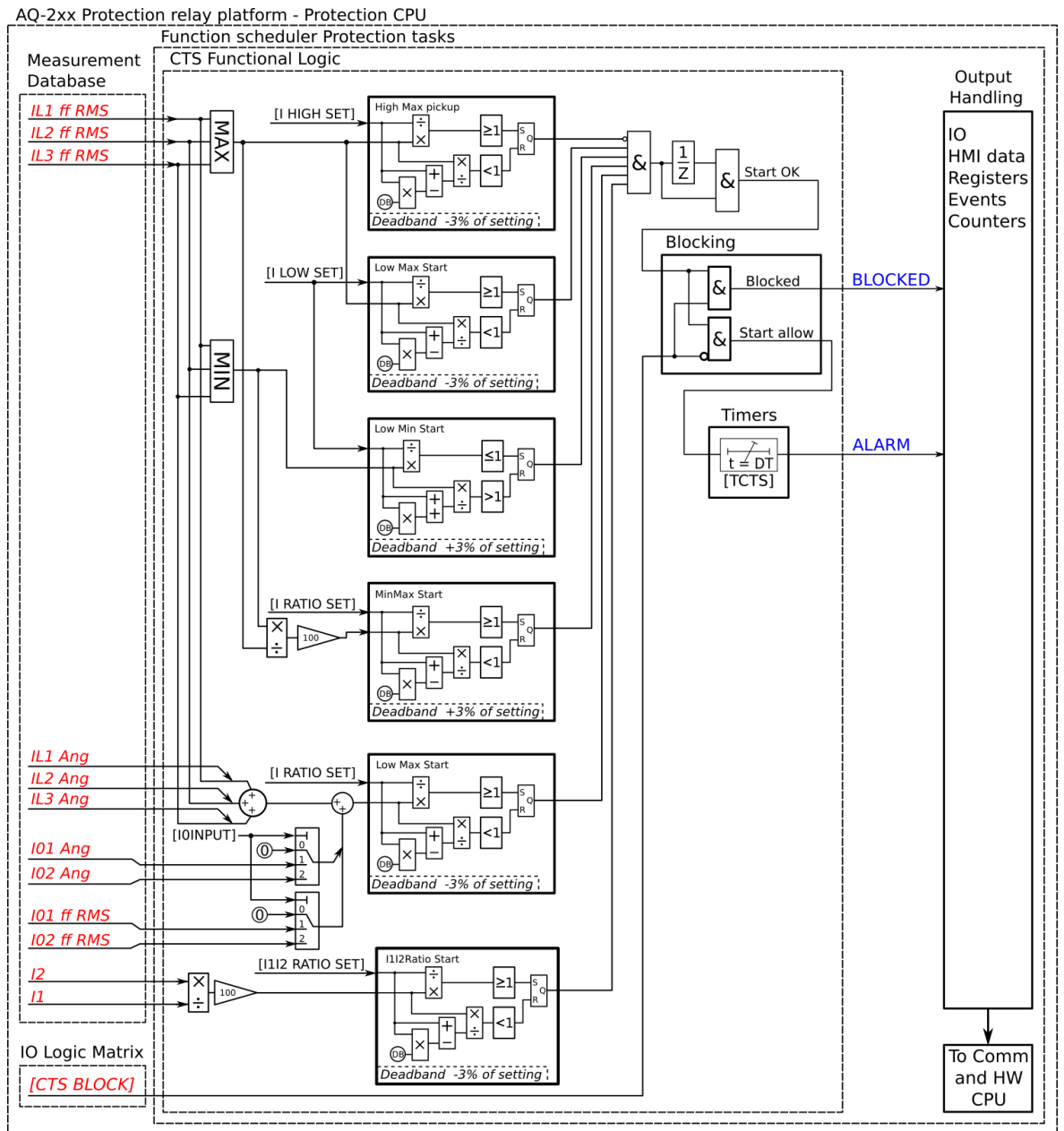
The function constantly monitors the instant values and the key calculated magnitudes of the phase currents. Additionally, the residual current circuit can be monitored if the residual current is measured from a dedicated residual current CT. The user can enable and disable the residual circuit monitoring at will.

The following conditions have to be met simultaneously for the function alarm to activate:

- None of the three-phase currents exceeds the I_{set} high limit setting.
- At least one of the three-phase currents exceeds the I_{set} low limit setting.
- At least one of the three-phase currents are below the I_{set} low limit setting.
- The ratio between the calculated minimum and maximum of the three-phase currents is below the I_{set} ratio setting.

- The ratio between the negative sequence and the positive sequence exceeds the $I2/I1$ ratio setting.
- The calculated difference $(IL1+IL2+IL3+I0)$ exceeds the I_{sum} difference setting (optional).
- The above-mentioned condition is met until the set time delay for alarm.

Figure. 4.6.1 - 81. Simplified function block diagram of the CTS function.



Measured input

The function block uses fundamental frequency component of phase current measurement values and residual current measurement values. The function supervises the angle of each current measurement channel. Positive sequence current and negative sequence currents are calculated from the phase currents. The user can select what is used for the residual current measurement: nothing, the I01 channel, or the I02 channel.

Table. 4.6.1 - 156. Measured inputs of the CTS function.

Signal	Description
I_{L1RMS}	Fundamental frequency component of phase L1 (A) current
I_{L2RMS}	Fundamental frequency component of phase L2 (B) current
I_{L3RMS}	Fundamental frequency component of phase L3 (C) current
I_{01RMS}	Fundamental frequency component of residual input I01
I_{02RMS}	Fundamental frequency component of residual input I02

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.6.1 - 157. General settings of the function.

Name	Range	Default	Description
CTS LN mode	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	On	Set mode of CTS block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
CTS force status to	<ul style="list-style-type: none"> Normal Alarm Blocked 	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
I0 input selection	<ul style="list-style-type: none"> Not in use I01 I02 	Not in use	Selects the measurement input for the residual current. If the residual current is measured with a separate CT, the residual current circuit can be monitored with the CTS function as well. However, this does not apply to summing connections (Holmgren, etc.). If the phase current CT is summed with I01 or I02, this selection should be set to "Not in use".
I0 direction	<ul style="list-style-type: none"> Add Subtract 	Add	Defines the polarity of residual current channel connection.
Compensate natural unbalance	<ul style="list-style-type: none"> - Comp 	-	When activated while the line is energized, the currently present calculated residual current is compensated to 0.

Pick-up settings

The I_{set} and I_{0set} setting parameters control the current-dependent pick-up and activation of the current transformer supervision function. They define the minimum and maximum allowed measured current before action from the function. The function constantly calculates the ratio between the setting values and the measured magnitude (I_m) for each of the three phases and for the selected residual current input. The reset ratio of 97 % and 103% are built into the function and is always relative to the I_{set} value. The setting value is common for all measured amplitudes, and when the I_m exceeds the I_{set} value (in single, dual or all currents) it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.6.1 - 158. Pick-up settings.

Name	Range	Step	Default	Description
I_{set} high limit	0.01...40.00× I_n	0.01× I_n	1.20× I_n	Determines the pick-up threshold for phase current measurement. This setting limit defines the upper limit for the phase current's pick-up element. If this condition is met, it is considered as fault and the function is not activated.
I_{set} low limit	0.01...40.00× I_n	0.01× I_n	0.10× I_n	Determines the pick-up threshold for phase current measurement. This setting limit defines the lower limit for the phase current's pick-up element. This condition has to be met for the function to activate.
I_{set} ratio	0.01...100.00%	0.01%	10.00%	Determines the pick-up ratio threshold between the minimum and maximum values of the phase current. This condition has to be met for the function to activate.
$I_{2/1}$ ratio	0.01...100.00%	0.01%	49.00%	Determines the pick-up ratio threshold for the negative and positive sequence currents calculated from the phase currents. This condition has to be met for the function to activate. The ratio is 50 % for a full single-phasing fault (i.e. when one of the phases is lost entirely). Setting this at 49 % allows a current of 0.01 × I_n to flow in one phase, while the other two are at nominal current.
I_{sum} difference	0.01...40.00× I_n	0.01× I_n	0.10× I_n	Determines the pick-up ratio threshold for the calculated residual phase current and the measured residual current. If the measurement circuit is healthy, the sum of these two currents should be 0.
Time delay for alarm	0.000...1800.000s	0.005s	0.5s	Determines the delay between the activation of the function and the alarm.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.6.1 - 159. Information displayed by the function.

Name	Range	Step	Description
CTS LN behaviour	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	-	Displays the mode of CTS block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.

Name	Range	Step	Description
Uncompensated residual unbalance Pri	<ul style="list-style-type: none"> • Normal • Start • Trip • Blocked 	-	Displays the natural unbalance of current after compensating it with <i>Compensate natural unbalance</i> parameter.
Natural unbalance ang	-360.00...360.00 deg	0.01 deg	Displays the natural unbalance of angle after compensating it with <i>Compensate natural unbalance</i> parameter.
Measured current difference Isum, I0	0.00...50.00 xIn	0.01 xIn	Current difference between summed phases and residual current.
Measured angle difference Isum, I0	-360...360 deg	0.01 deg	Angle difference between summed phases and residual current.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

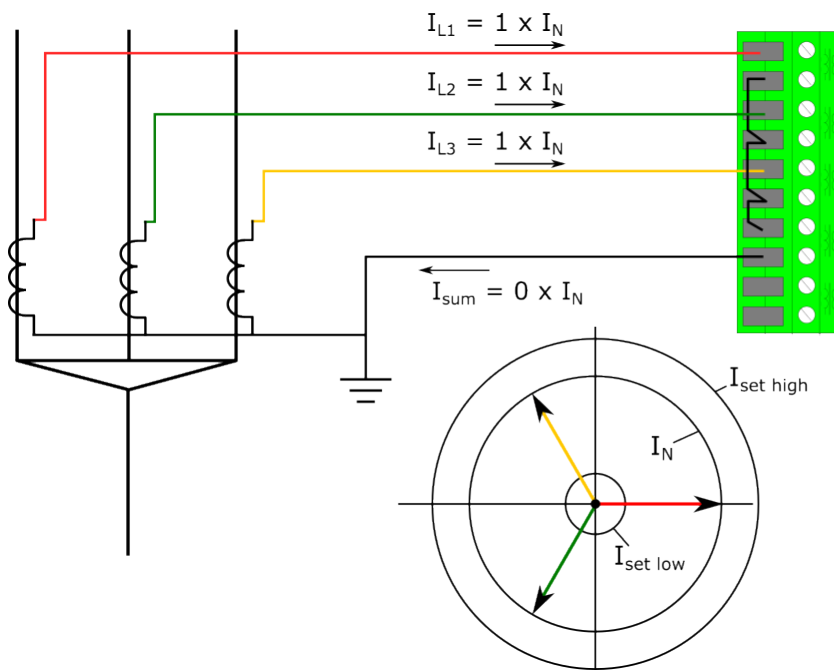
Operating time characteristics

This function supports definite time delay (DT). For detailed information on this delay type please refer to the chapter "[General properties of a protection function](#)" and its section "[Operating time characteristics](#)".

Typical cases of current transformer supervision

The following nine examples present some typical cases of the current transformer supervision and their setting effects.

Figure. 4.6.1 - 82. All works properly, no faults.



Settings:

I_{set} High limit = $1.20 \times I_N$
 I_{set} Low limit = $0.10 \times I_N$
 I_{set} ratio = 10.00 %
 $I1/I2$ ratio = 49.00 %
 I_0 input = Not in use

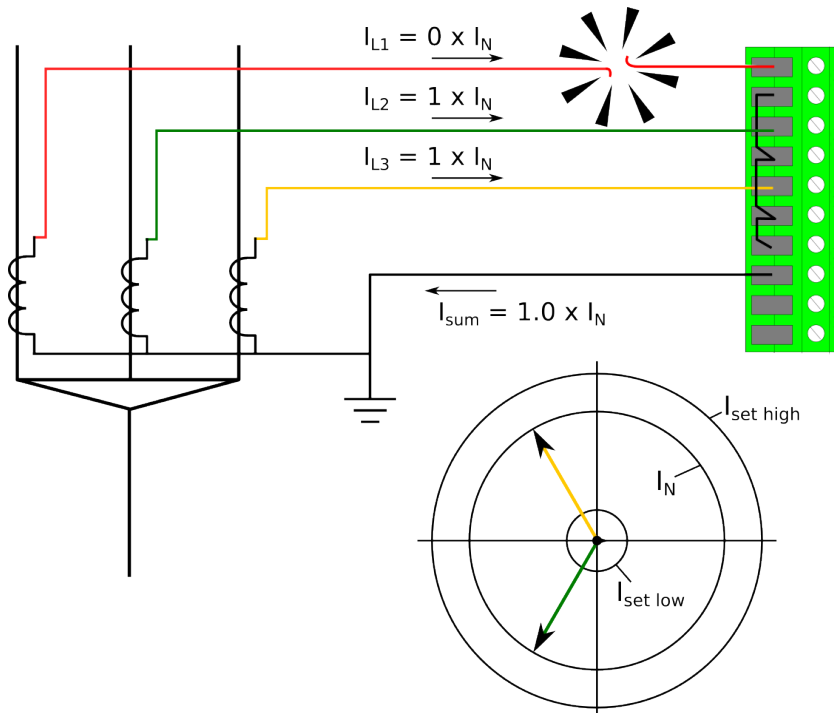
Measurements:

$I_{min} = 1 \times I_N$
 $I_{max} = 1 \times I_N$
 $I1 = 1 \times I_N$
 $I2 = 0 \times I_N$
 $I_{min}/I_{max} = 1$
 $I2/I1 = 0\%$

CTS conditions:

I_{set} High limit ≤ 1
 I_{set} Low limit low ≤ 0
 I_{set} Low limit high > 1
 I ratio ≤ 0
 $I_{unbalance}$ ratio $> = 0$

Figure. 4.6.1 - 83. Secondary circuit fault in phase L1 wiring.



Settings:

I_{set} High limit = $1.20 \times I_N$
 I_{set} Low limit = $0.10 \times I_N$
 I_{set} ratio = 10.00 %
 $I1/I2$ ratio = 49.00 %
 I_0 input = Not in use

Measurements:

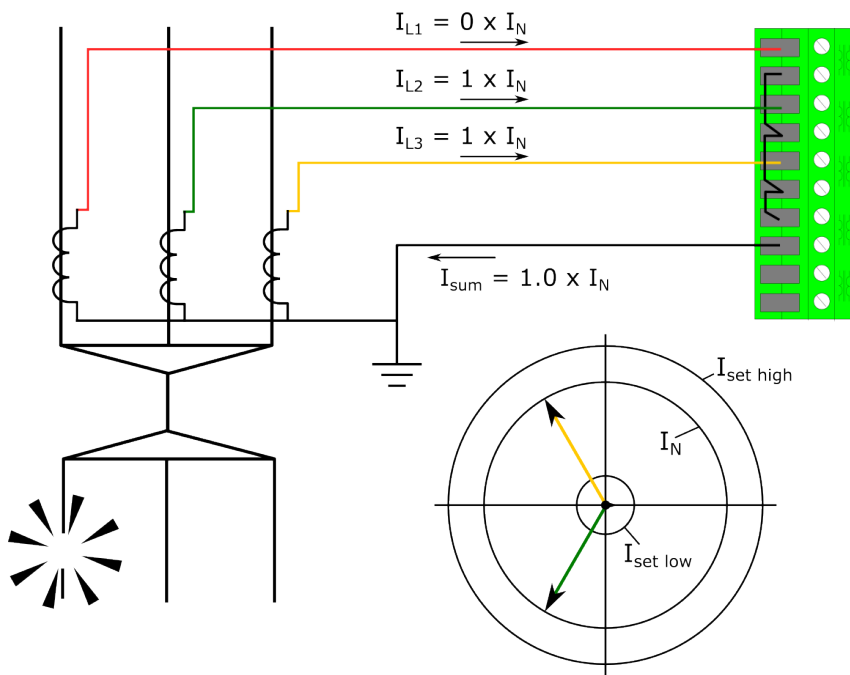
$I_{min} = 0 \times I_N$
 $I_{max} = 1 \times I_N$
 $I1 = 0.67 \times I_N$
 $I2 = 0.33 \times I_N$
 $I_{min}/I_{max} = 0$
 $I2/I1 = 50\%$

CTS conditions:

I_{set} High limit ≤ 1
 I_{set} Low limit low ≤ 1
 I_{set} Low limit high > 1
 I ratio ≤ 1
 $I_{unbalance}$ ratio $> = 1$

When a fault is detected and all conditions are met, the CTS timer starts counting. If the situation continues until the set time has passed, the function issues an alarm.

Figure. 4.6.1 - 84. Primary circuit fault in phase L1 wiring.



Settings:

I_{set} High limit = $1.20 \times I_N$
 I_{set} Low limit = $0.10 \times I_N$
 I_{set} ratio = 10.00 %
 I1/I2 ratio = 49.00 %
 I_0 input = Not in use

Measurements:

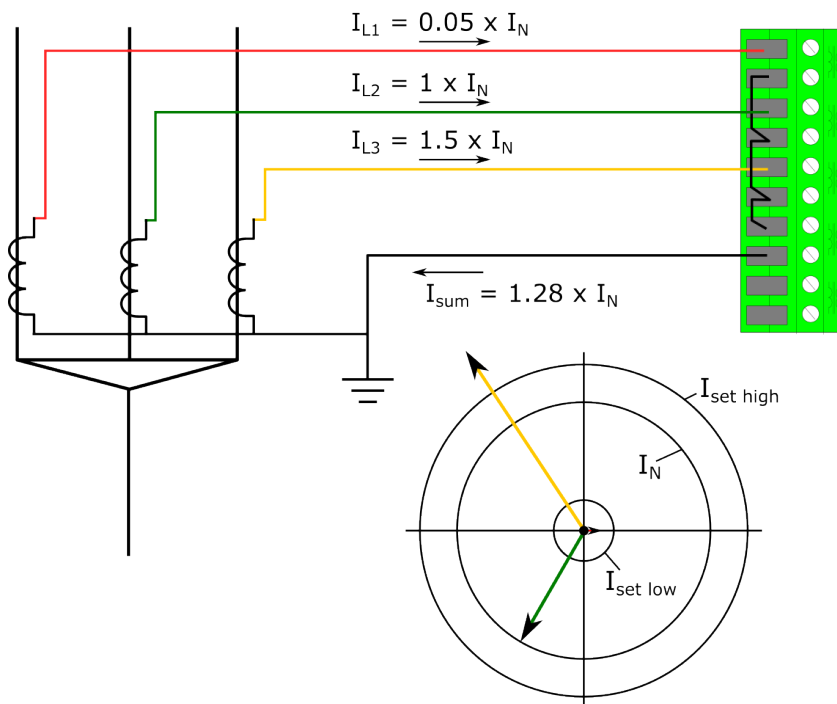
I_{min} = $0 \times I_N$
 I_{max} = $1 \times I_N$
 $I1$ = $0.67 \times I_N$
 $I2$ = $0.33 \times I_N$
 I_{min}/I_{max} = 0
 $I2/I1$ = 50%

CTS conditions:

I_{set} High limit ≤ 1
 I_{set} Low limit low ≤ 1
 I_{set} Low limit high > 1
 I ratio < 1
 $I_{unbalance}$ ratio > 1

In this example, distinguishing between a primary fault and a secondary fault is impossible. However, the situation meets the function's activation conditions, and if this state (secondary circuit fault) continues until the set time has passed, the function issues an alarm. This means that the function supervises both the primary and the secondary circuit.

Figure. 4.6.1 - 85. No wiring fault but heavy unbalance.



Settings:

I_{set} High limit = $1.20 \times I_N$
 I_{set} Low limit = $0.10 \times I_N$
 I_{set} ratio = 10.00 %
 I1/I2 ratio = 49.00 %
 I_0 input = Not in use

Measurements:

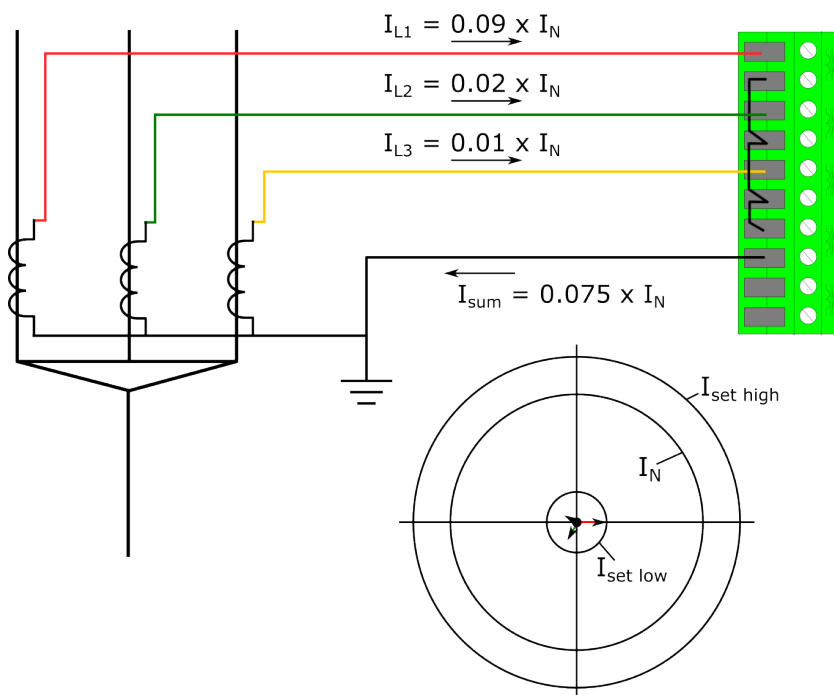
I_{min} = $0.05 \times I_N$
 I_{max} = $1.50 \times I_N$
 $I1$ = $0.85 \times I_N$
 $I2$ = $0.43 \times I_N$
 I_{min}/I_{max} = 0.7 %
 $I2/I1$ = 50.03 %

CTS conditions:

I_{set} High limit ≤ 0
 I_{set} Low limit low ≤ 1
 I_{set} Low limit high > 1
 I ratio ≤ 1
 $I_{unbalance}$ ratio > 1

If any of the phases exceed the I_{set} high limit setting, the operation of the function is not activated. This behavior is applied to short-circuits and earth faults even when the fault current exceeds the I_{set} high limit setting.

Figure. 4.6.1 - 86. Low current and heavy unbalance.



Settings:

- I_{set} High limit = $1.20 \times I_N$
- I_{set} Low limit = $0.10 \times I_N$
- I_{set} ratio = 10.00 %
- I1/I2 ratio = 49.00 %
- I_0 input = Not in use

Measurements:

- I_{min} = $0.01 \times I_N$
- I_{max} = $0.09 \times I_N$
- I1 = $0.04 \times I_N$
- I2 = $0.03 \times I_N$
- I_{min}/I_{max} = 11.0 %
- I2/I1 = 62.92 %

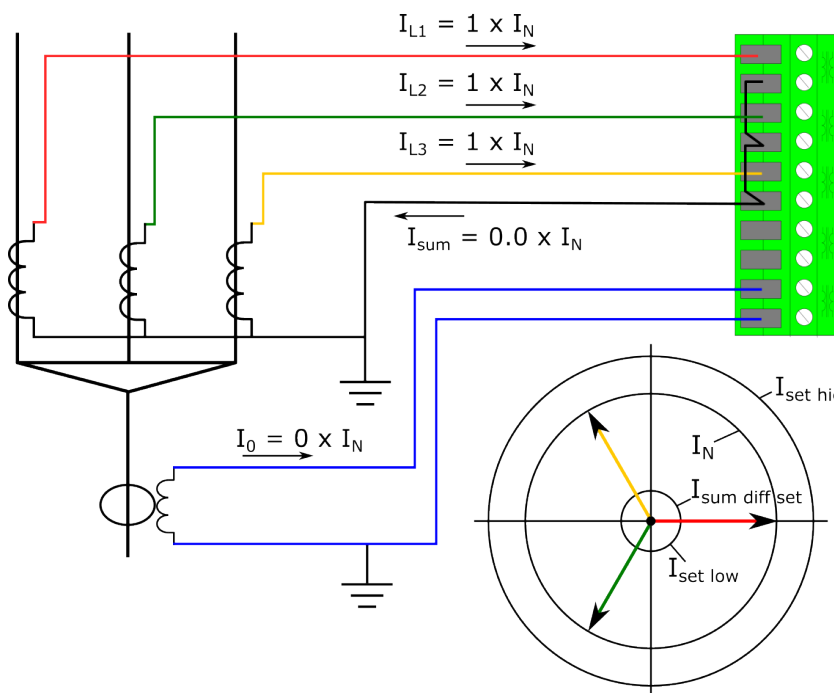
CTS conditions:

- I_{set} High limit ≤ 1
- I_{set} Low limit low ≤ 1
- I_{set} Low limit high ≥ 0
- I ratio ≤ 1
- $I_{unbalance}$ ratio ≥ 1

If all of the measured phase magnitudes are below the I_{set} low limit setting, the function is not activated even when the other conditions (inc. the unbalance condition) are met.

If the I_{set} high limit and I_{set} low limit setting parameters are adjusted according to the application's normal behavior, the operation of the function can be set to be very sensitive for broken circuit and conductor faults.

Figure. 4.6.1 - 87. Normal situation, residual current also measured.



Settings:

- I_{set} High limit = $1.20 \times I_N$
- I_{set} Low limit = $0.10 \times I_N$
- I_{set} ratio = 10.00 %
- I1/I2 ratio = 49.00 %
- I_0 input = I_{01}
- I_{sum} Difference = $0.10 \times I_N$

Measurements:

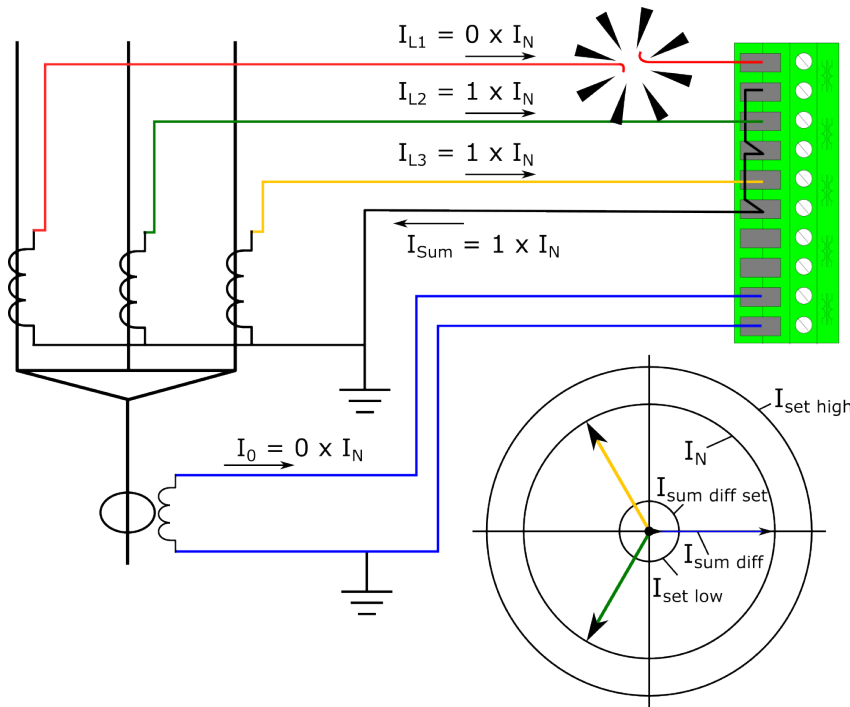
- I_{min} = $1 \times I_N$
- I_{max} = $1 \times I_N$
- I1 = $1 \times I_N$
- I2 = $0 \times I_N$
- I_{min}/I_{max} = 1
- I2/I1 = 0
- I_{sum} Difference = $0.0 \times I_N$

CTS conditions:

- I_{set} High limit ≤ 1
- I_{set} Low limit low ≤ 0
- I_{set} Low limit high ≥ 1
- I ratio ≤ 0
- $I_{unbalance}$ ratio ≥ 0

When the residual condition is added with the "I0 input selection", the sum of the current and the residual current are compared against each other to verify the wiring condition.

Figure. 4.6.1 - 88. Broken secondary phase current wiring.



Settings:

- I_{set} High limit = $1.20 \times I_N$
- I_{set} Low limit = $0.10 \times I_N$
- I_{set} ratio = 10.00 %
- I1/I2 ratio = 49.00 %
- I_0 input = I_{01}
- I_{sum} Difference = $0.10 \times I_N$

Measurements:

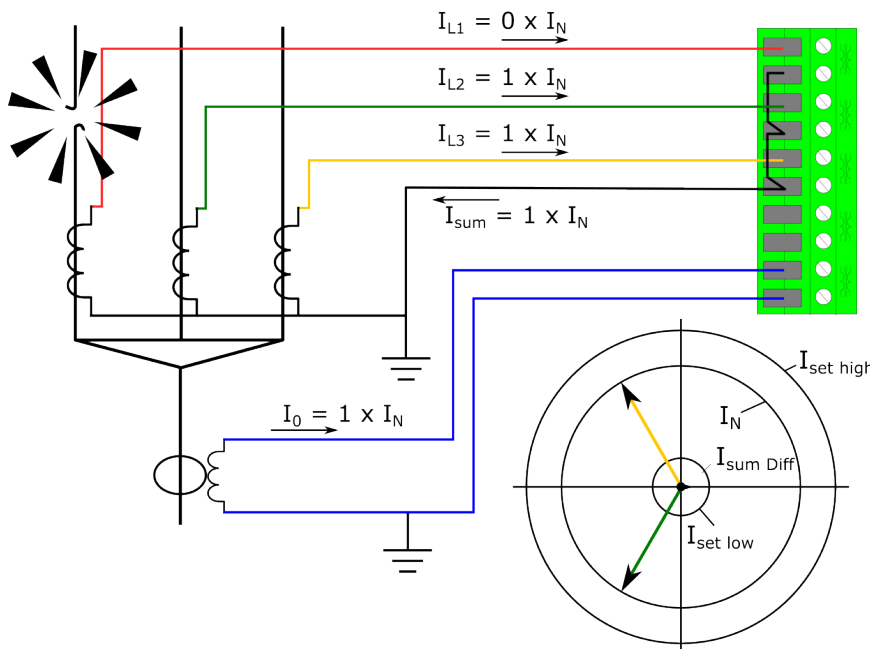
- I_{min} = $1 \times I_N$
- I_{max} = $0 \times I_N$
- I1 = $0.67 \times I_N$
- I2 = $0.33 \times I_N$
- I_{min}/I_{max} = 0
- I2/I1 = 50 %
- I_{sum} Difference = $1.0 \times I_N$

CTS conditions:

- I_{set} High limit ≤ 1
- I_{set} Low limit low ≤ 1
- I_{set} Low limit high ≥ 1
- I ratio ≤ 1
- $I_{unbalance}$ ratio > 1
- I_{sum} Difference > 1

When phase current wire is broken all of the conditions are met in the CTS and alarm shall be issued in case if the situation continues until the set alarming time is met.

Figure. 4.6.1 - 89. Broken primary phase current wiring.



Settings:

- I_{set} High limit = $1.20 \times I_N$
- I_{set} Low limit = $0.10 \times I_N$
- I_{set} ratio = 10.00 %
- I1/I2 ratio = 49.00 %
- I_0 input = I_{01}
- I_{sum} Difference = $0.10 \times I_N$

Measurements:

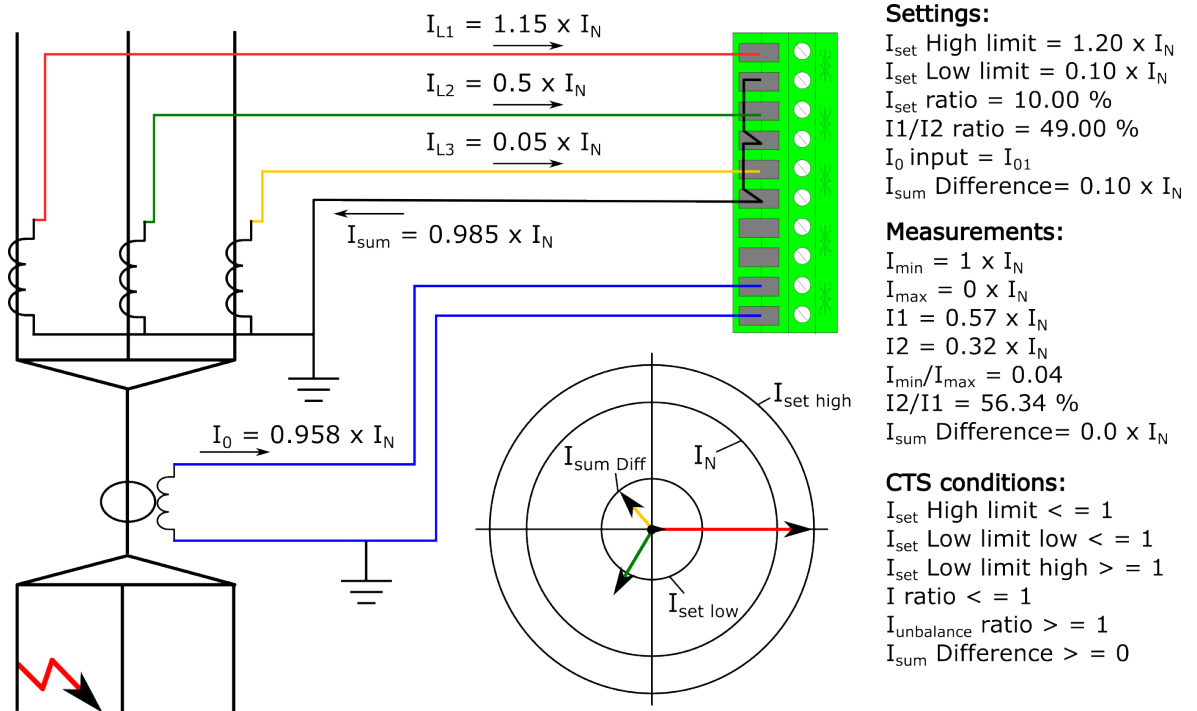
- I_{min} = $0 \times I_N$
- I_{max} = $1 \times I_N$
- I1 = $0.67 \times I_N$
- I2 = $0.33 \times I_N$
- I_{min}/I_{max} = 0
- I2/I1 = 50 %
- I_{sum} Difference = $0.0 \times I_N$

CTS conditions:

- I_{set} High limit ≤ 1
- I_{set} Low limit low ≤ 1
- I_{set} Low limit high > 1
- I ratio ≤ 1
- $I_{unbalance}$ ratio > 1
- I_{sum} Difference > 0

In this example, all other condition are met except the residual difference. That is now $0 \times I_N$, which indicates a primary side fault.

Figure. 4.6.1 - 90. Primary side high-impedance earth fault.



In this example there is a high-impedance earth fault. It does not activate the function, if the measurement conditions are met, while the calculated and measured residual current difference does not reach the limit. The I_{sum} difference setting should be set according to the application in order to reach maximum security and maximum sensitivity for the network earthing.

Events and registers

The current transformer supervision function (abbreviated "CTS" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the CTS ALARM and BLOCKED events.

Table. 4.6.1 - 160. Event messages.

Event block name	Event names
CTS1	Alarm ON/OFF
CTS1	Block ON/OFF
CTS2	Alarm ON/OFF
CTS2	Block ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers; this information is available for all provided instances separately. The register of the function records the ON event process data for ACTIVATED, BLOCKED, etc. The table below presents the structure of the function's register content.

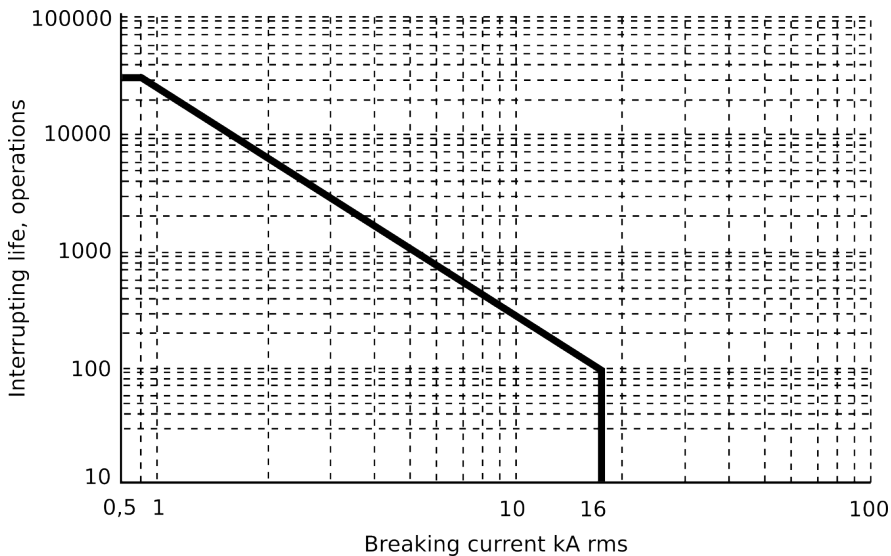
Table. 4.6.1 - 161. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Trigger currents	The phase currents (L1, L2 & L3), the residual currents (I01 & I02), and the sequence currents (I1 & I2) on trigger time.
Time to CTSact	Time remaining before alarm activation.
Fault type	The status code of the monitored current.
Setting group in use	Setting group 1...8 active

4.6.2 Circuit breaker wear monitoring

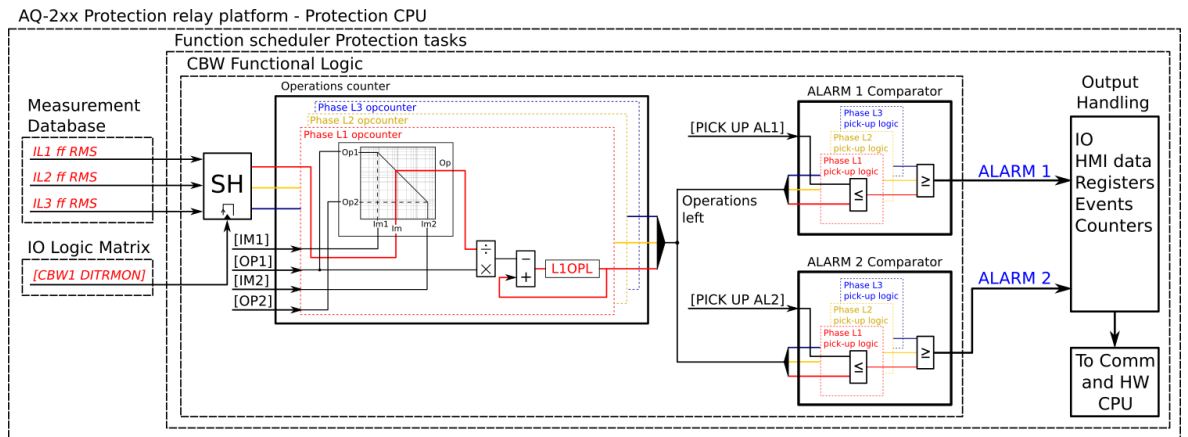
The circuit breaker wear function is used for monitoring the circuit breaker's lifetime and its maintenance needs caused by interrupting currents and mechanical wear. The function uses the circuit breaker's manufacturer-supplied data for the breaker operating cycles in relation to the interrupted current magnitudes.

Figure. 4.6.2 - 91. Example of the circuit breaker interrupting life operations.



The function is triggered from the circuit breaker's "Open" command output and it monitors the three-phase current values in both the tripping moment and the normal breaker opening moment. The maximum value of interrupting life operations for each phase is calculated from these currents. The value is cumulatively deducted from the starting operations starting value. The user can set up two separate alarm levels, which are activated when the value of interrupting life operations is below the setting limit. The "Trip contact" setting defines the output that triggers the current monitoring at the breaker's "Open" command.

Figure. 4.6.2 - 92. Simplified function block diagram of the circuit breaker wear function.



Measured input

The function block uses fundamental frequency component of phase current measurement values.

Table. 4.6.2 - 162. Measurement inputs of the circuit breaker wear function.

Signal	Description
$I_{L1}RMS$	Fundamental frequency component of phase L1 (A) current
$I_{L2}RMS$	Fundamental frequency component of phase L2 (B) current
$I_{L3}RMS$	Fundamental frequency component of phase L3 (C) current

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by switching the setting group.

Table. 4.6.2 - 163. General settings.

Name	Range	Default	Description
CBW LN mode	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	On	Set mode of CBW block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
CBW force status to	<ul style="list-style-type: none"> Normal Alarm1 On Alarm2 On 	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
CBW in side	<ul style="list-style-type: none"> Side 1 Side 2 	Side 1	Defines which current measurement module is used by the function.

Circuit breaker characteristics settings

The circuit breaker characteristics are set by two operating points, defined by the nominal breaking current, the maximum allowed breaking current and their respective operation settings. This data is provided by the circuit breaker's manufacturer.

Table. 4.6.2 - 164. Settings for circuit breaker characteristics.

Name	Range	Step	Default	Description
Operations 1	0...200 000	1	50 000	The number of interrupting life operations at the nominal current (Close - Open).
Operations 2	0...200 000	1	100	The number of interrupting life operations at the rated breaking current (Open).
Current 1 (I _{nom})	0...100.00kA	0.01kA	1kA	The rated normal current (RMS).
Current 2 (I _{max})	0...100.00kA	0.01kA	20kA	The rated short-circuit breaking current (RMS).

Pick-up settings

For the alarm stages Alarm 1 and Alarm 2, the user can set the pick-up level for the number of operations left. The pick-up setting is common for all phases and the alarm stage picks up if any of the phases goes below this setting.

Table. 4.6.2 - 165. Pick-up settings.

Name	Range	Default	Description
Alarm 1	<ul style="list-style-type: none"> • Disabled • Enabled 	Disabled	Enable and disable the Alarm 1 stage.
Alarm 1 Set	0...200 000	1 000	Defines the pick-up threshold for remaining operations. When the number of remaining operations is below this setting, the ALARM 1 signal is activated.
Alarm 2	<ul style="list-style-type: none"> • Disabled • Enabled 	Disabled	Enable and disable the Alarm 2 stage.
Alarm 2 Set	0...200 000	100	Defines the pick-up threshold for remaining operations. When the number of remaining operations is below this setting, the ALARM 2 signal is activated.

Setting example

Let us examine the settings, using a low-duty vacuum circuit breaker as an example. The image below presents the technical specifications provided by the manufacturer, with the data relevant to our settings highlighted in red:

Rated voltage, kV	24
Rated current, A	800
Rated power frequency test voltage, kV	50
Rated frequency, Hz	50/60
Rated impulse test voltage, kV peak	125
Partial discharge level at 1,1 rated voltage kV, pC	<10
Rated short-circuit breaking current, kA	16
Rated short-circuit making current, kA peak	41.5
Short time withstand current, 4s, kA	16
Mechanical life, CO cycles, not less than	30,000
Interrupting life operations, not less than	
at rated current	30,000
at breaking current	100
at other currents	see Fig.41
Closing time, ms, not more than	35
Opening time, ms, not more than	15
Breaking time, ms, not more than	25
Main contact resistance, μ Ohm, not more than	40
Maximum ambient temperature, C°	+55
Minimum ambient temperature, C°	-40
Design class (according to IEC 60932)	1
Electrical endurance class at rated IEEE/IEC duty	E2
Mechanical endurance class at rated IEEE/IEC duty	M2
Capacitive current switching class	C2
"Mechanical vibration and shock withstand capability, IEC 60721, IEC 60068"	Class 4M4
Maximum altitude above sea level, m	3000*
Maximum humidity, non condensing	98 %
Weight, kg - LD_1	35
Weight, kg - LD_6	55

Now, we set the stage as follows:

Parameter	Setting
Current 1	0.80 kA
Operation 1	30 000 operations
Current 2	16.00 kA
Operations 2	100 operations
Enable Alarm 1	Enabled
Alarm 1 Set	1000 operations
Enable Alarm 2	Enabled
Alarm 2 Set	100 operations

With these settings, Alarm 1 is issued when the cumulative interruption counter for any of the three phases dips below the set 1000 remaining operations ("Alarm 1 Set"). Similarly, when any of the counters dips below 100 remaining operations, Alarm 2 is issued.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.6.2 - 166. Information displayed by the function.

Name	Range	Description
CBW LN behaviour	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	Displays the mode of CBW block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
CBW condition	<ul style="list-style-type: none"> • Normal • Alarm1 On • Alarm2 On 	Displays the status of the function.
Breaker operations	-	Cumulative counter of "open" operations.
Alarm 1 counter	-	Alarm 1 operation counter.
Alarm 2 counter	-	Alarm 2 operation counter.
L1 Operations left	-	Operations left for phase L1.
L2 Operations left	-	Operations left for phase L2.
L3 Operations left	-	Operations left for phase L3.

Events and registers

The circuit breaker wear function (abbreviated "CBW" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The function's outputs can be used for direct I/O controlling and user logic programming. The events triggered by the function are recorded with a time stamp.

The function also provides a resettable cumulative counter for the "Open" operations as well as the ALARM 1 and ALARM 2 events.

Table. 4.6.2 - 167. Event messages.

Event block name	Event names
CBW1	CBWEAR1 Triggered
CBW1	CBWEAR1 Alarm 1 ON/OFF
CBW1	CBWEAR1 Alarm 2 ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data. The table below presents the structure of the function's register content.

Table. 4.6.2 - 168. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Trigger current	Phase currents on trigger time
Deducted Op	L1/L2/L3 Deducted operations from the cumulative sum
Operations left	L1/L2/L3 Operations left

4.6.3 Current total harmonic distortion (THD)

The total harmonic distortion (THD) function is used for monitoring the content of the current harmonic. The THD is a measurement of the harmonic distortion present, and it is defined as the ratio between the sum of all harmonic components' powers and the power of the fundamental frequency (RMS).

Harmonics can be caused by different sources in electric networks such as electric machine drives, thyristor controls, etc. The function's monitoring of the currents can be used to alarm of the harmonic content rising too high; this can occur when there is an electric quality requirement in the protected unit, or when the harmonics generated by the process need to be monitored.

The function constantly measures the phase and residual current magnitudes as well as the harmonic content of the monitored signals up to the 31st harmonic component. When the function is activated, the measurements are also available for the mimic and the measurement views in the HMI carousel. The user can also set the alarming limits for each measured channel if the application so requires.

The monitoring of the measured signals can be selected to be based either on an amplitude ratio or on the above-mentioned power ratio. The difference is in the calculation formula (as shown below):

Figure. 4.6.3 - 93. THD calculation formulas.

$$THD_P = \frac{I_{x2}^2 + I_{x3}^2 + I_{x4}^2 \dots I_{x31}^2}{I_{x1}^2}$$

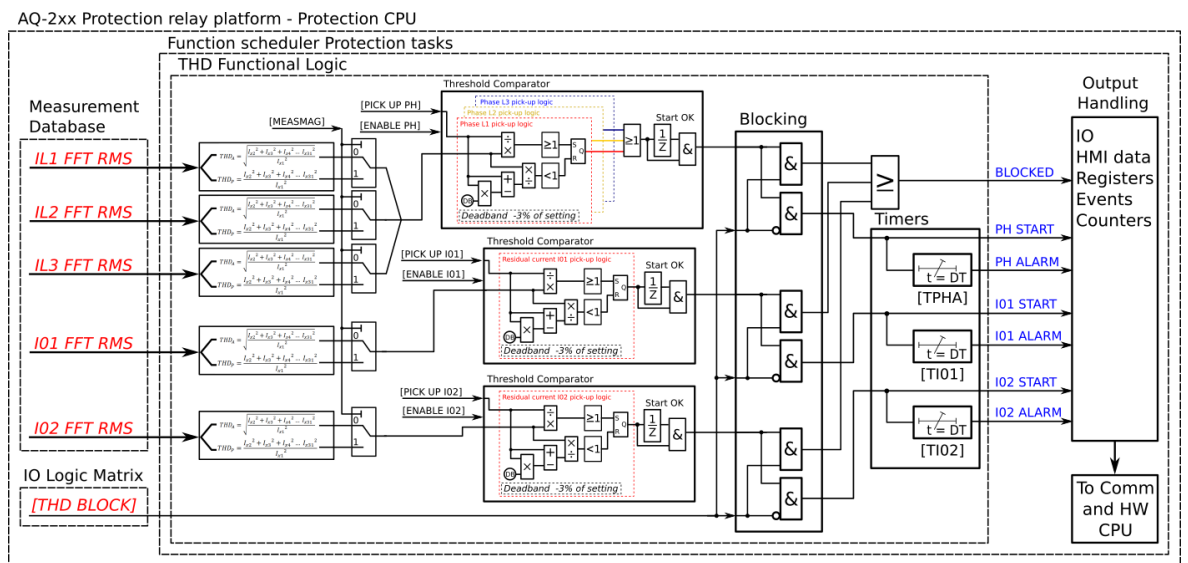
, where
 I = measured current,
 x = measurement input,
 n = harmonic number

$$THD_A = \sqrt{\frac{I_{x2}^2 + I_{x3}^2 + I_{x4}^2 \dots I_{x31}^2}{I_{x1}^2}}$$

, where
 I = measured current,
 x = measurement input,
 n = harmonic number

While both of these formulas exist, the power ratio (THD_P) is recognized by the IEEE, and the amplitude ratio (THD_A) is recognized by the IEC.

Figure. 4.6.3 - 94. Simplified function block diagram of the total harmonic distortion monitor function.



Measured input

The function block uses phase and residual current measurement channels. The function always uses FFT measurement of the whole harmonic spectrum of 32 components from each measured current channel. From these measurements the function calculates either the amplitude ratio or the power ratio.

Table. 4.6.3 - 169. Measurement inputs of the total harmonic distortion monitor function.

Signal	Description
IL1FFT	FFT measurement of phase L1 (A) current
IL2FFT	FFT measurement of phase L2 (B) current
IL3FFT	FFT measurement of phase L3 (C) current
IO1FFT	FFT measurement of residual IO1 current
IO2FFT	FFT measurement of residual IO2 current

The selection of the calculation method is made with a setting parameter (common for all measurement channels).

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.6.3 - 170. General settings.

Name	Range	Default	Description
THD> LN mode	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	On	Set mode of THD block. This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.
THD> in side	<ul style="list-style-type: none"> • CT1 • CT2 	CT1	Defines which current measurement module the function uses.
Measurement magnitude	<ul style="list-style-type: none"> • Amplitude • Power 	Amplitude	Defines which available measured magnitude the function uses.

Pick-up settings

The $Phase_{THD}$, $I01_{THD}$ and $I02_{THD}$ setting parameters control the the pick-up and activation of the function. They define the maximum allowed measured current THD before action from the function. Before the function activates alarm signals, their corresponding pick-up elements need to be activated with the setting parameters *Enable phase THD alarm*, *Enable I01 THD alarm* and *Enable I02 THD alarm*. The function constantly calculates the ratio between the setting values and the calculated THD for each of the three phases. The reset ratio of 97 % is built into the function and is always relative to the setting value. The setting value is common for all measured phases. When the calculated THD exceeds the pick-up value (in single, dual or all phases), it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.6.3 - 171. Pick-up settings.

Name	Range	Step	Default	Description
Enable phase THD alarm	<ul style="list-style-type: none"> • Enabled • Disabled 	-	Enabled	Enables and disables the THD alarm function from phase currents.
Enable I01 THD alarm	<ul style="list-style-type: none"> • Enabled • Disabled 	-	Enabled	Enables and disables the THD alarm function from residual current input I01.

Name	Range	Step	Default	Description
Enable I02 THD alarm	<ul style="list-style-type: none"> Enabled Disabled 	-	Enabled	Enables and disables the THD alarm function from residual current input I02.
Phase THD pick-up	0.10...100.00%	0.01%	10.00%	The pick-up setting for the THD alarm element from the phase currents. At least one of the phases' measured THD value has to exceed this setting in order for the alarm signal to activate.
I01 THD pick-up	0.10...100.00%	0.01%	10.00%	The pick-up setting for the THD alarm element from the residual current I01. The measured THD value has to exceed this setting in order for the alarm signal to activate.
I02 THD pick-up	0.10...100.00%	0.01%	10.00%	The pick-up setting for the THD alarm element from the residual current I02. The measured THD value has to exceed this setting in order for the alarm signal to activate.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.6.3 - 172. Information displayed by the function.

Name	Range	Description
THD> LN behaviour	<ul style="list-style-type: none"> On Blocked Test Test/Blocked Off 	<p>Displays the mode of THD block.</p> <p>This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.</p>
THD condition	<ul style="list-style-type: none"> Normal Start Alarm Blocked 	Displays status of the monitoring function.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for activation and reset

This function supports definite time delay (DT). The following table presents the setting parameters for the function's time characteristics.

Table. 4.6.3 - 173. Settings for operating time characteristics.

Name	Range	Step	Default	Description
Phase THD alarm delay	0.000...1800.000s	0.005s	10.000s	Defines the delay for the alarm timer from the phase currents' measured THD.
I01 THD alarm delay	0.000...1800.000s	0.005s	10.000s	Defines the delay for the alarm timer from the residual current I01's measured THD.
I02 THD alarm delay	0.000...1800.000s	0.005s	10.000s	Defines the delay for the alarm timer from the residual current I02's measured THD.

Events and registers

The total harmonic distortion monitor function (abbreviated "THD" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, ALARM and BLOCKED events.

Table. 4.6.3 - 174. Event messages.

Event block name	Event names
THD1	THD Start Phase ON/OFF
THD1	THD Start I01 ON/OFF
THD1	THD Start I02 ON/OFF
THD1	THD Alarm Phase ON/OFF
THD1	THD Alarm I01 ON/OFF
THD1	THD Alarm I02 ON/OFF
THD1	Blocked ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, ALARM and BLOCKED. The table below presents the structure of the function's register content.

Table. 4.6.3 - 175. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name

Register	Description
L1h, L2h, L3h Fault THD	Start/Alarm THD of each phase.
Setting group in use	Setting group 1...8 active.

4.6.4 Running hour counter

The running hour counter (abbreviated "RHC" in event block names) is capable of counting the running time of a motor, a generator, or a similar application.

The counter value can be added to the mimic view and read to SCADA.

Table. 4.6.4 - 176. Parameter descriptions

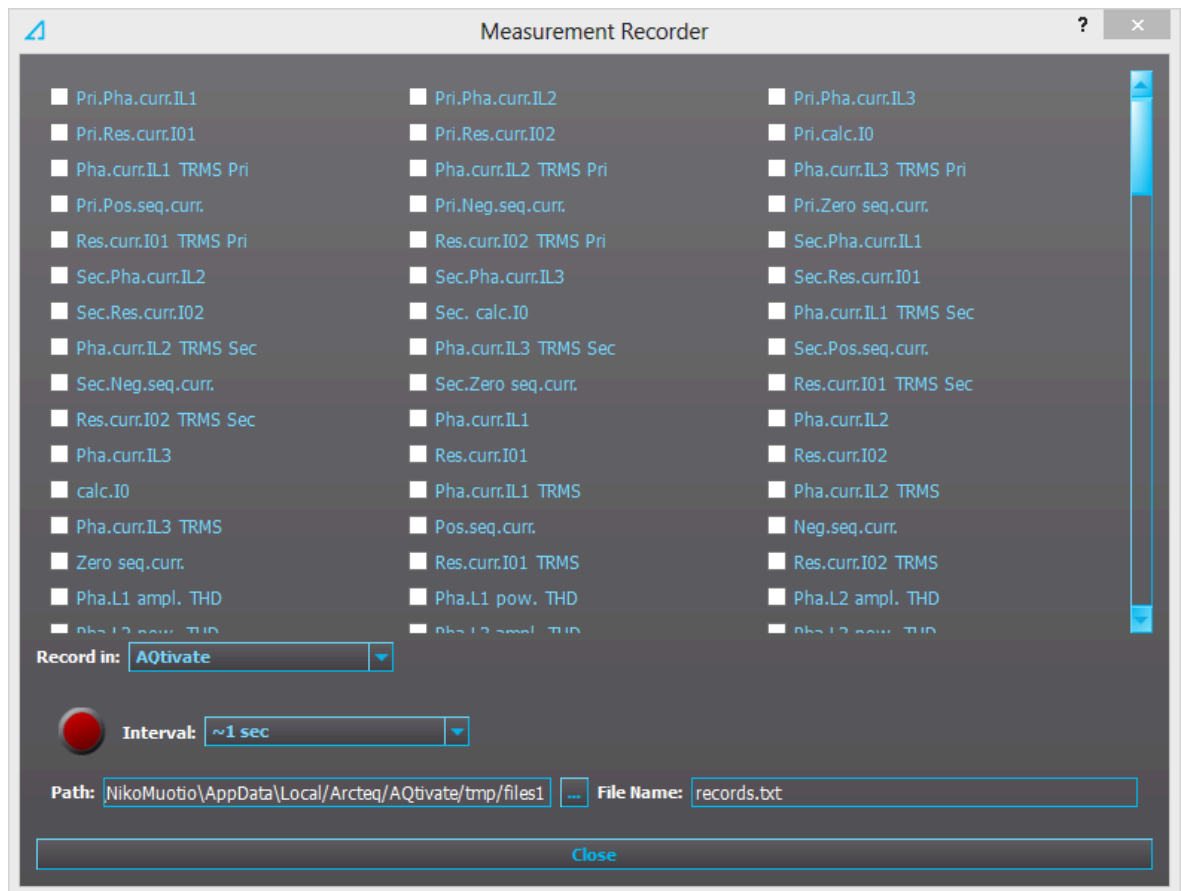
Name	Range	Description
Activate counter input	Any binary input	Counter runs whenever input set here is active.
Running hours	hh:mm:ss	Indicates running hours counted so far. This value can be edited by the user. The user input must be set in seconds, which is then converted by the device to hours, minutes and seconds (hh:mm:ss).
Start count	0...4294967295 Starts	Start counter.
Clear hours	<ul style="list-style-type: none"> • - • Clear 	Clears "Running hours" and "Start count".

The function (abbreviated "RHC" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

Table. 4.6.4 - 177. Event messages.

Event block name	Event name
RHC1	Running hour counter ON/OFF
RHC1	Running hour counter cleared ON/OFF

4.6.5 Measurement recorder



Measurements can be recorded to a file with the measurement recorder. The chosen measurements are recorded at selected intervals. In the "Measurement recorder" window, the measurements the user wants to be recorded can be selected by checking their respective check boxes. In order for the measurement recorder to activate, a connection to a device must be established via the setting tool software and its Live Edit mode must be enabled (see the setting tool manual for more information). Navigate to the measurement recorder through *Tools* → *Miscellaneous tools* → *Measurement recorder*. The recording interval can be changed from the "Interval" drop-down menu. From the "Record in" drop-down menu the user can also choose whether the measurements are recorded in the setting tool or in the device.

If the recording is done in the setting tool, both the setting tool software and its Live Edit mode have to be activated. The user can change the recording file location by editing the "Path" field. File names can also be changed with the "File name" field. Hitting the "Record" button (the big red circle) starts the recorder. Please note that closing the "Measurement recorder" window does not stop the recording; that can only be done by hitting the "Stop" button (the big blue circle).

If the recording is done in the device, only the recording interval needs to be set before recording can be started. The setting tool estimates the maximum recording time, which depends on the recording interval. When the measurement recorder is running, the measurements can be viewed in graph form with the AQtivate PRO software (see the image below).

Figure. 4.6.5 - 95. Measurement recorder values viewed with AQtivate PRO.

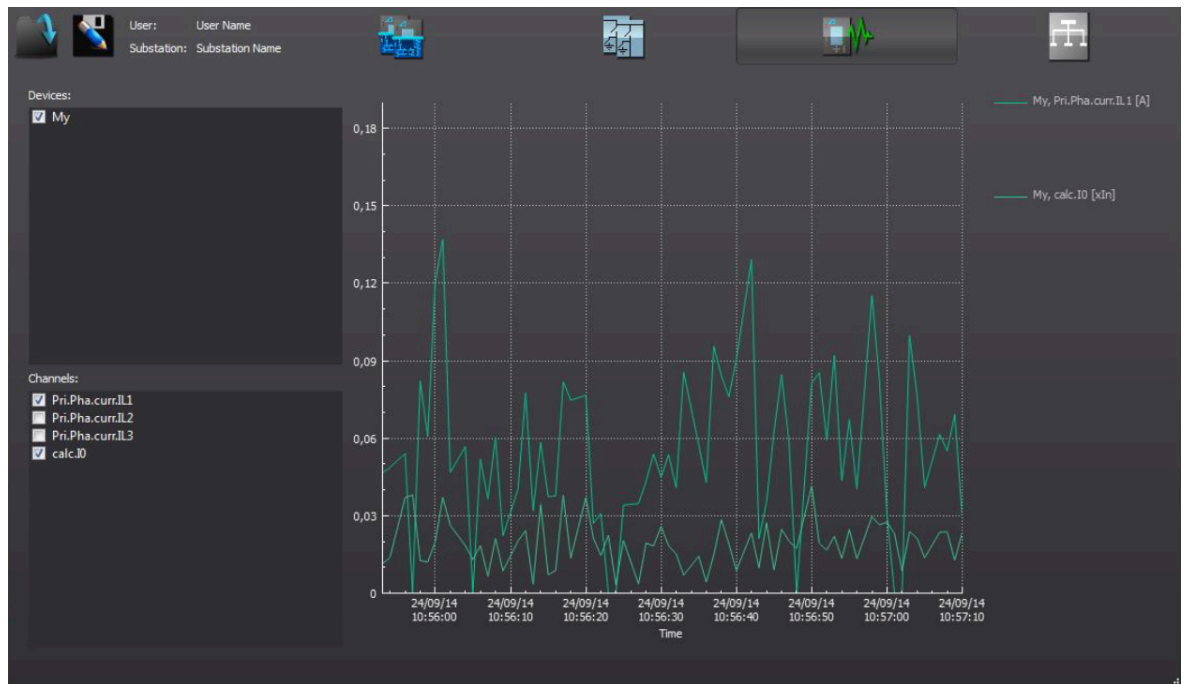


Table. 4.6.5 - 178. Available analog signals.

Current measurements	P-P Curr.I" L3	L1 Imp.React.Ind.E.Mvarh
Pri.Pha.Curr.IL1	P-P Curr.I"01	L1 Imp.React.Ind.E.kvarh
Pri.Pha.Curr.IL2	P-P Curr.I"02	L1 Exp/Imp React.Ind.E.bal.Mvarh
Pri.Pha.Curr.IL3	Pha.angle I" L1	L1 Exp/Imp React.Ind.E.bal.kvarh
Pri.Res.Curr.I01	Pha.angle I" L2	L2 Exp.Active Energy MWh
Pri.Res.Curr.I02	Pha.angle I" L3	L2 Exp.Active Energy kWh
Pri.Calc.I0	Res.Curr.angle I"01	L2 Imp.Active Energy MWh
Pha.Curr.IL1 TRMS Pri	Res.Curr.angle I"02	L2 Imp.Active Energy kWh
Pha.Curr.IL2 TRMS Pri	Calc.I"0.angle	L2 Exp/Imp Act. E balance MWh
Pha.Curr.IL3 TRMS Pri	I" Pos.Seq.Curr.angle	L2 Exp/Imp Act. E balance kWh
Pri.Pos.Seq.Curr.	I" Neg.Seq.Curr.angle	L2 Exp.React.Cap.E.Mvarh
Pri.Neg.Seq.Curr.	I" Zero.Seq.Curr.angle	L2 Exp.React.Cap.E.kvarh
Pri.Zero.Seq.Curr.	Voltage measurements	L2 Imp.React.Cap.E.Mvarh
Res.Curr.I01 TRMS Pri	U1Volt Pri	L2 Imp.React.Cap.E.kvarh
Res.Curr.I02 TRMS Pri	U2Volt Pri	L2 Exp/Imp React.Cap.E.bal.Mvarh
Sec.Pha.Curr.IL1	U3Volt Pri	L2 Exp/Imp React.Cap.E.bal.kvarh
Sec.Pha.Curr.IL2	U4Volt Pri	L2 Exp.React.Ind.E.Mvarh

Sec.Pha.Curr.IL3	U1Volt Pri TRMS	L2 Exp.React.Ind.E.kvarh
Sec.Res.Curr.I01	U2Volt Pri TRMS	L2 Imp.React.Ind.E.Mvarh
Sec.Res.Curr.I02	U3Volt Pri TRMS	L2 Imp.React.Ind.E.kvarh
Sec.Calc.I0	U4Volt Pri TRMS	L2 Exp/Imp React.Ind.E.bal.Mvarh
Pha.Curr.IL1 TRMS Sec	Pos.Seq.Volt.Pri	L2 Exp/Imp React.Ind.E.bal.kvarh
Pha.Curr.IL2 TRMS Sec	Neg.Seq.Volt.Pri	L3 Exp.Active Energy MWh
Pha.Curr.IL3 TRMS Sec	Zero.Seq.Volt.Pri	L3 Exp.Active Energy kWh
Sec.Pos.Seq.Curr.	U1Volt Sec	L3 Imp.Active Energy MWh
Sec.Neg.Seq.Curr.	U2Volt Sec	L3 Imp.Active Energy kWh
Sec.Zero.Seq.Curr.	U3Volt Sec	L3 Exp/Imp Act. E balance MWh
Res.Curr.I01 TRMS Sec	U4Volt Sec	L3 Exp/Imp Act. E balance kWh
Res.Curr.I02 TRMS Sec	U1Volt Sec TRMS	L3 Exp.React.Cap.E.Mvarh
Pha.Curr.IL1	U2Volt Sec TRMS	L3 Exp.React.Cap.E.kvarh
Pha.Curr.IL2	U3Volt Sec TRMS	L3 Imp.React.Cap.E.Mvarh
Pha.Curr.IL3	U4Volt Sec TRMS	L3 Imp.React.Cap.E.kvarh
Res.Curr.I01	Pos.Seq.Volt.Sec	L3 Exp/Imp React.Cap.E.bal.Mvarh
Res.Curr.I02	Neg.Seq.Volt.Sec	L3 Exp/Imp React.Cap.E.bal.kvarh
Calc.I0	Zero.Seq.Volt.Sec	L3 Exp.React.Ind.E.Mvarh
Pha.Curr.IL1 TRMS	U1Volt p.u.	L3 Exp.React.Ind.E.kvarh
Pha.Curr.IL2 TRMS	U2Volt p.u.	L3 Imp.React.Ind.E.Mvarh
Pha.Curr.IL3 TRMS	U3Volt p.u.	L3 Imp.React.Ind.E.kvarh
Pos.Seq.Curr.	U4Volt p.u.	L3 Exp/Imp React.Ind.E.bal.Mvarh
Neg.Seq.Curr.	U1Volt TRMS p.u.	L3 Exp/Imp React.Ind.E.bal.kvarh
Zero.Seq.Curr.	U2Volt TRMS p.u.	Exp.Active Energy MWh
Res.Curr.I01 TRMS	U3Volt p.u.	Exp.Active Energy kWh
Res.Curr.I02 TRMS	U4Volt p.u.	Imp.Active Energy MWh
Pha.L1 ampl. THD	Pos.Seq.Volt. p.u.	Imp.Active Energy kWh
Pha.L2 ampl. THD	Neg.Seq.Volt. p.u.	Exp/Imp Act. E balance MWh
Pha.L3 ampl. THD	Zero.Seq.Volt. p.u.	Exp/Imp Act. E balance kWh
Pha.L1 pow. THD	U1Volt Angle	Exp.React.Cap.E.Mvarh
Pha.L2 pow. THD	U2Volt Angle	Exp.React.Cap.E.kvarh
Pha.L3 pow. THD	U3Volt Angle	Imp.React.Cap.E.Mvarh

Res.I01 ampl. THD	U4Volt Angle	Imp.React.Cap.E.kvarh
Res.I01 pow. THD	Pos.Seq.Volt. Angle	Exp/Imp React.Cap.E.bal.Mvarh
Res.I02 ampl. THD	Neg.Seq.Volt. Angle	Exp/Imp React.Cap.E.bal.kvarh
Res.I02 pow. THD	Zero.Seq.Volt. Angle	Exp.React.Ind.E.Mvarh
P-P Curr.IL1	System Volt UL12 mag	Exp.React.Ind.E.kvarh
P-P Curr.IL2	System Volt UL12 mag (kV)	Imp.React.Ind.E.Mvarh
P-P Curr.IL3	System Volt UL23 mag	Imp.React.Ind.E.kvarh
P-P Curr.I01	System Volt UL23 mag (kV)	Exp/Imp React.Ind.E.bal.Mvarh
P-P Curr.I02	System Volt UL31 mag	Exp/Imp React.Ind.E.bal.kvarh
Pha.angle IL1	System Volt UL31 mag (kV)	Other measurements
Pha.angle IL2	System Volt UL1 mag	TM> Trip expect mode
Pha.angle IL3	System Volt UL1 mag (kV)	TM> Time to 100% T
Res.Curr.angle I01	System Volt UL2 mag	TM> Reference T curr.
Res.Curr.angle I02	System Volt UL2 mag (kV)	TM> Active meas curr.
Calc.I0.angle	System Volt UL3 mag	TM> T est.with act. curr.
Pos.Seq.Curr.angle	System Volt UL3 mag (kV)	TM> T at the moment
Neg.Seq.Curr.angle	System Volt U0 mag	TM> Max.Temp.Rise All.
Zero.Seq.Curr.angle	System Volt U0 mag (kV)	TM> Temp.Rise atm.
Pri.Pha.Curr.I"L1	System Volt U1 mag	TM> Hot Spot estimate
Pri.Pha.Curr.I"L2	System Volt U1 mag (kV)	TM> Hot Spot Max. All
Pri.Pha.Curr.I"L3	System Volt U2 mag	TM> Used k for amb.temp
Pri.Res.Curr.I"01	System Volt U2 mag (kV)	TM> Trip delay remaining
Pri.Res.Curr.I"02	System Volt U3 mag	TM> Alarm 1 time to rel.
Pri.Calc.I"0	System Volt U3 mag (kV)	TM> Alarm 2 time to rel.
Pha.Curr.I"L1 TRMS Pri	System Volt U4 mag	TM> Inhibit time to rel.
Pha.Curr.I"L2 TRMS Pri	System Volt U4 mag (kV)	TM> Trip time to rel.
Pha.Curr.I"L3 TRMS Pri	System Volt UL12 ang	S1 Measurement
I" Pri.Pos.Seq.Curr.	System Volt UL23 ang	S2 Measurement
I" Pri.Neg.Seq.Curr.	System Volt UL31 ang	S3 Measurement
I" Pri.Zero.Seq.Curr.	System Volt UL1 ang	S4 Measurement
Res.Curr.I"01 TRMS Pri	System Volt UL2 ang	S5 Measurement
Res.Curr.I"02 TRMS Pri	System Volt UL3 ang	S6 Measurement

Sec.Pha.Curr.I"L1	System Volt U0 ang	S7 Measurement
Sec.Pha.Curr.I"L2	System Volt U1 ang	S8 Measurement
Sec.Pha.Curr.I"L3	System Volt U2 ang	S9 Measurement
Sec.Res.Curr.I"01	System Volt U3 ang	S10 Measurement
Sec.Res.Curr.I"02	System Volt U4 ang	S11 Measurement
Sec.Calc.I"0	Power measurements	S12 Measurement
Pha.Curr.I"L1 TRMS Sec	L1 Apparent Power (S)	Sys.meas.frqs
Pha.Curr.I"L2 TRMS Sec	L1 Active Power (P)	f atm.
Pha.Curr.I"L3 TRMS Sec	L1 Reactive Power (Q)	f meas from
I" Sec.Pos.Seq.Curr.	L1 Tan(phi)	SS1.meas.frqs
I" Sec.Neg.Seq.Curr.	L1 Cos(phi)	SS1f meas from
I" Sec.Zero.Seq.Curr.	L2 Apparent Power (S)	SS2 meas.frqs
Res.Curr.I"01 TRMS Sec	L2 Active Power (P)	SS2f meas from
Res.Curr.I"02 TRMS Sec	L2 Reactive Power (Q)	L1 Bias current
Pha.Curr.I"L1	L2 Tan(phi)	L1 Diff current
Pha.Curr.I"L2	L2 Cos(phi)	L1 Char current
Pha.Curr.I"L3	L3 Apparent Power (S)	L2 Bias current
Res.Curr.I"01	L3 Active Power (P)	L2 Diff current
Res.Curr.I"02	L3 Reactive Power (Q)	L2 Char current
Calc.I"0	L3 Tan(phi)	L3 Bias current
Pha.Curr.I"L1 TRMS	L3 Cos(phi)	L3 Diff current
Pha.Curr.I"L2 TRMS	3PH Apparent Power (S)	L3 Char current
Pha.Curr.I"L3 TRMS	3PH Active Power (P)	HV I0d> Bias current
I" Pos.Seq.Curr.	3PH Reactive Power (Q)	HV I0d> Diff current
I" Neg.Seq.Curr.	3PH Tan(phi)	HV I0d> Char current
I" Zero.Seq.Curr.	3PH Cos(phi)	LV I0d> Bias current
Res.Curr.I"01 TRMS	Energy measurements	LV I0d> Diff current
Res.Curr.I"02 TRMS	L1 Exp.Active Energy MWh	LV I0d> Char current
Pha.IL"1 ampl. THD	L1 Exp.Active Energy kWh	Curve1 Input
Pha.IL"2 ampl. THD	L1 Imp.Active Energy MWh	Curve1 Output
Pha.IL"3 ampl. THD	L1 Imp.Active Energy kWh	Curve2 Input
Pha.IL"1 pow. THD	L1 Exp/Imp Act. E balance MWh	Curve2 Output

Figure. 4.6.6 - 96. 12 latest recordings can be accessed from HMI if "VrecRegisters" view has been enabled in "Carousel designer" tool.

I>Trip	10/02/2025 08:12:09.580	A-B-C	
I>Trip	10/02/2025 08:11:18.084	B-C	
I>Trip	10/02/2025 08:11:04.012	B-C	
I>Trip	10/02/2025 08:10:44.619	B-C	I>Trip 10/02/2025 08:12:09.580 A-B-C
I>>>Trip	10/02/2025 08:03:38.431	-	SG1
I>>>Trip	10/02/2025 08:02:50.259	-	Mag 1 :0.00
I>>Trip	10/02/2025 08:02:39.069	-	Mag 2 :0.00
I>>>>Trip	10/02/2025 08:02:28.479	-	Mag 3 :0.00
I>Trip	10/02/2025 08:02:20.968	-	Mag 4 :0.00
-	-	-	Mag 5 :0.00
-	-	-	Mag 6 :0.00
-	-	-	Mag 7 :0.00
			Mag 8 :0.00

Measured input

The function block uses analog current and voltage measurement values. Based on these values, the device calculates the primary and secondary values of currents, voltages, powers, and impedances as well as other values.

The user can set up to eight (8) magnitudes to be recorded when the function is triggered. An overcurrent fault type, a voltage fault type, and a tripped stage can be recorded and reported straight to SCADA.

NOTICE!


 The available measurement values depend on the device type. If only current analog measurements are available, the recorder can solely use signals which only use current. The same applies, if only voltage analog measurements are available.

Table. 4.6.6 - 179. Current based measurements available.

Currents	Description
IL1 (ff), IL2 (ff), IL3 (ff), IO1 (ff), IO2 (ff)	The fundamental frequency current measurement values (RMS) of phase currents and of residual currents.
IL1TRMS, IL2TRMS, IL3TRMS, IO1TRMS, IO2TRMS	The TRMS current measurement values of phase currents and of residual currents.
IL1,2,3 & IO1/IO2 2 nd h., 3 rd h., 4 th h., 5 th h., 7 th h., 9 th h., 11 th h., 13 th h., 15 th h., 17 th h., 19 th h.	The magnitudes of phase current components: Fundamental, 2 nd harmonic, 3 rd harmonic, 4 th harmonic, 5 th harmonic 7 th , harmonic 9 th , harmonic 11 th , harmonic 13 th , harmonic 15 th , harmonic 17 th , harmonic 19 th harmonic current.
I1, I2, IOZ	The positive sequence current, the negative sequence current and the zero sequence current.

I0CalcMag	The residual current calculated from phase currents.
IL1Ang, IL2Ang, IL3Ang, I01Ang, I02Ang, I0CalcAng, I1Ang, I2Ang	The angles of each measured current.

Table. 4.6.6 - 180. Other measurements available.

Others	Description
System f.	The tracking frequency in use at that moment.
Ref f1	The reference frequency 1.
Ref f2	The reference frequency 2.
M thermal T	The motor thermal temperature.
F thermal T	The feeder thermal temperature.
T thermal T	The transformer thermal temperature.
RTD meas 1...16	The RTD measurement channels 1...16.
Ext RTD meas 1...8	The external RTD measurement channels 1...8 (ADAM module).

Reported values

When triggered, the function holds the recorded values of up to eight channels, as set. In addition to this tripped stage, the overcurrent fault type and the voltage fault types are reported to SCADA.

Table. 4.6.6 - 181. Reported values.

Name	Range	Description
Tripped stage	<ul style="list-style-type: none"> • - • I> Trip • I>> Trip • I>>> Trip • I>>>> Trip • IDir> Trip • IDir>> Trip • IDir>>> Trip • IDir>>>> Trip • U> Trip • U>> Trip • U>>> Trip • U>>>> Trip • U< Trip • U<< Trip • U<<< Trip • U<<<< Trip • IO> TRIP • IO>> Trip • IO>>> Trip • IO>>>> Trip • IODir> Trip • IODir>> Trip • IODir>>> Trip • IODir>>>> Trip • f> Trip • f>> Trip • f>>> Trip • f>>>> Trip • f< Trip • f<< Trip • f<<< Trip • f<<<< Trip • P> Trip • P< Trip • Prev> Trip • T> Trip • I2> Trip • I2>> Trip • I2>>> Trip • I2>>>> Trip • U1/2 > Trip • U1/2 >> Trip • U1/2 >>> Trip • U1/2 >>>> Trip • U0> Trip • U0>> Trip • U0>>> Trip • U0>>>> Trip 	The tripped stage.
Overcurrent fault type	<ul style="list-style-type: none"> • A-G • B-G • A-B • C-G • A-C • B-C • A-B-C 	The overcurrent fault type.

Name	Range	Description
Voltage fault type	<ul style="list-style-type: none"> • A(AB) • B(BC) • A-B(AB-BC) • C(CA) • A-C(AB-CA) • B-C(BC-CA) • A-B-C • Overfrequency • Underfrequency • Overpower • Underpower • Reversepower • Thermal overload • Unbalance • Harmonic overcurrent • Residual overvoltage 	The voltage fault type.
Magnitude 1...8	0.000...1800.000 A/V/p.u.	The recorded value in one of the eight channels.

Events

The fault register function (abbreviated "VREC" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

Table. 4.6.6 - 182. Event messages.

Event block name	Event name
VREC1	Recorder triggered ON/OFF

4.6.7 Event logger

Event logger records status changes of protection functions, digital inputs, logical signals etc. Events are recorded with a timestamp. The time stamp resolution is 1 ms. Up to 15 000 events can be stored at once. When 15 000 events have been recorded, the event history will begin to remove the oldest events to make room for new events. You can find more information about event masks in the selected function's "Events" tab. Event masks determine what is recorded into the event history; they are configured in each function's individual settings in the *Protection*, *Control* and *Monitoring* menu. Event history is accessible with PC setting tool (*Tools* → *Events and Logs* → *Event history*) and from the device HMI if "Events" view has been configured with Carousel designer in PC setting tool.

Event overload detection

Continuous generation of a high number of nuisance events may have adverse effects on the operation and communication capabilities of the device. A high number of nuisance events may end up being generated due to mistakes in configuration and/or installation. For example, mistakes in logic configuration or RTD sensor wiring, in conjunction with suitable event mask settings may generate an excessive number of unintended events. Event overload detector looks for a condition where over 200 events are being generated inside one (1) second window (more than 1 event every 5 milliseconds on average). If such a condition is detected, further events are blocked and an IRF (Internal Relay Fault-message) is issued. The event blocking is released and the IRF can be cleared after 5 seconds if the overload condition has been corrected. Other device operations, such as protection and communication, remain available even during the event overload condition.

4.6.8 Disturbance recorder (DR)

The disturbance recorder is a high-capacity (64 MB permanent flash memory) and fully digital recorder integrated to the protection relay. The maximum sample rate of the recorder's analog channels is 64 samples per cycle. Up to 20 analog recording channels and 96 digital channels are supported. Maximum capacity of recordings is 100.

The recorder provides an effective tool to analyze the performance of the power system during network disturbance situations. The recorder's output is in general COMTRADE format and it is compatible with most recording viewers and injection devices. The files are based on the IEEE standard C37.111-1999. Captured recordings can be injected as playback with secondary testing tools that support the COMTRADE file format. Playback of files might help to analyze the fault, or can be simply used for educational purposes.

Analog and digital recording channels

Table. 4.6.8 - 183. Analog recording channels.

Signal	Description
IL1	Phase current I_{L1}
IL2	Phase current I_{L2}
IL3	Phase current I_{L3}
I01c	Residual current I_{01} coarse*
I01f	Residual current I_{01} fine*
I02c	Residual current I_{02} coarse*
I02f	Residual current I_{02} fine*
IL1"	Phase current I_{L1} (CT card 2)
IL2"	Phase current I_{L2} (CT card 2)
IL3"	Phase current I_{L3} (CT card 2)
I01"c	Residual current I_{01} coarse* (CT card 2)
I01"f	Residual current I_{01} fine* (CT card 2)
I02"c	Residual current I_{02} coarse* (CT card 2)
I02"f	Residual current I_{02} fine* (CT card 2)
U1(2)VT1	Line-to-neutral U_{L1} or line-to-line voltage U_{L12} (VT card 1)
U2(3)VT1	Line-to-neutral U_{L2} or line-to-line voltage U_{L23} (VT card 1)
U3(1)VT1	Line-to-neutral U_{L3} or line-to-line voltage U_{L31} (VT card 1)
U0(ss)VT1	Zero sequence voltage U_0 or synchrocheck voltage U_{SS} (VT card 1)
F tracked 1	Tracked frequency of reference 1
F tracked 2	Tracked frequency of reference 2

Signal	Description
F tracked 3	Tracked frequency of reference 3
ISup	Current measurement module voltage supply supervision (CT card 1)
ISup"	Current measurement module voltage supply supervision (CT card 2)
USup	Voltage measurement module voltage supply supervision (VT card 1)
IL1""	Phase current I_{L1} (CT card 3)
IL2""	Phase current I_{L2} (CT card 3)
IL3""	Phase current I_{L3} (CT card 3)
I01""c	Residual current I_{01} coarse* (CT card 3)
I01""f	Residual current I_{01} fine* (CT card 3)
I02""c	Residual current I_{02} coarse* (CT card 3)
I02""f	Residual current I_{02} fine* (CT card 3)
ISup_3	Current measurement module voltage supply supervision (CT card 3)
UL1(2)VT2	Line-to-neutral U_{L1} or line-to-line voltage U_{L12} (VT card 2)
UL2(3)VT2	Line-to-neutral U_{L2} or line-to-line voltage U_{L23} (VT card 2)
UL3(1)VT2	Line-to-neutral U_{L3} or line-to-line voltage U_{L31} (VT card 2)
U0(SS)VT2	Zero sequence voltage U_0 or synchrocheck voltage U_{ss} (VT card 2)
USup_2	Voltage measurement module voltage supply supervision (VT card 2)

***NOTE:** There are two signals for each residual current channel in the disturbance recorder: coarse and fine. A coarse signal is capable of sampling in the full range of the current channel but suffers a loss of accuracy at very low currents. A fine signal is capable of sampling at very low currents and with high accuracy but cuts off at higher currents. Table below lists performance of both channels with fine and coarse gain.

Table. 4.6.8 - 184. Residual current channel performance with coarse or residual gain.

Channel	Coarse gain range	Fine gain range	Fine gain peak
I01	0...150 A	0...10 A	15 A
I02	0...75 A	0...5 A	8 A

Recording settings and triggering

Disturbance recorder can be triggered manually or automatically by using the dedicated triggers. Every signal listed in "Digital recording channels" can be selected to trigger the recorder.

The number of analog and digital channels together with the sample rate and the time setting affect the recording size. See calculation examples below in the section titled "Estimating the maximum length of total recording time". The recording size affects how many recordings can be stored at a time, but the number can't exceed 100 recordings.

Table. 4.6.8 - 185. Recorder control settings.

Name	Range	Description
Recorder enabled	<ul style="list-style-type: none"> Enabled Disabled 	Enables and disables the disturbance recorder function.
Recorder status	<ul style="list-style-type: none"> Recorder ready Recording triggered Recording and storing Storing recording Recorder full Wrong config 	<p>Indicates the status of recorder.</p> <p>"Wrong config" is activated if:</p> <ul style="list-style-type: none"> "Pre-triggering time" is longer than "Max length of recording" setting "Max amount of recordings" is "1" and "Recording mode" is "FIFO". "1ms" digital channel sample rate is selected when analog channel sample rate is 8 or 16 s/c.
Clear record	0...2 ³² -1	Clears selected recording. If "1" is inserted, first recording will be cleared from memory. If "10" is inserted, tenth (10th) recording will be cleared from memory.
Manual trigger	<ul style="list-style-type: none"> - Trig 	Triggers disturbance recording manually. This parameter will return back to "-" automatically.
Clear all records	<ul style="list-style-type: none"> - Clear 	Clears all disturbance recordings.
Clear newest record	<ul style="list-style-type: none"> - Clear 	Clears the newest stored disturbance recording.
Clear oldest record	<ul style="list-style-type: none"> - Clear 	Clears the oldest stored disturbance recording.
Max. number of recordings	0...100	Displays the maximum number of recordings that can be stored in the device's memory with settings currently in use. The maximum number of recordings can go up to 100.
Max. length of a recording	0.000...1800.000s	Displays the maximum length of a single recording.
Max. location of the pre-trigger	0.000...1800.000s	Displays the highest pre-triggering time that can be set with the settings currently in use.
Recordings in memory	0...100	Displays how many recordings are stored in the memory.


Table. 4.6.8 - 186. Recorder trigger setting.

Name	Description
Recorder trigger	Selects the trigger input(s). Clicking the "Edit" button brings up a pop-up window, and checking the boxes enable the selected triggers.


Table. 4.6.8 - 187. Recorder settings.

Name	Range	Default	Description
Recording length	0.100...1800.000s	1s	Sets the length of a recording.
Recording mode	<ul style="list-style-type: none"> FIFO Keep olds 	FIFO	Selects what happens when the memory is full. "FIFO" (= first in, first out) replaces the oldest stored recording with the latest one. "Keep olds" does not accept new recordings.
Analog channel samples	<ul style="list-style-type: none"> 64s/c 32s/c 16s/c 8s/c 	64s/c	Selects the sample rate of the disturbance recorder in samples per cycle. The samples are saved from the measured wave according to this setting.
Digital channel samples	<ul style="list-style-type: none"> 5 ms 1 ms 	5 ms	The fixed sample rate of the recorded digital channels. Recorded digital channels can be chosen with "Recorder digital channels" below. NOTE: 1 ms sample rate can't be used when analog channel sample rate is 8 or 16 s/c.
Pretriggering time	0.2...30.0s	0.2s	Sets the recording length before the trigger.
Analog recording CH1...CH20	0...8 freely selectable channels	-	Selects the analog channel for recording. Please see the list of all available analog channels in the section titled "Analog and digital recording channels".
Automatically get recordings	<ul style="list-style-type: none"> Disabled Enabled 	Disabled	Enables and disables the automatic transfer of recordings. The recordings are taken from the device's protection CPU and transferred to the device's FTP directory in the communication CPU; the FTP client then automatically loads the recordings from the device and transfers them further to the SCADA system. Please note that when this setting is enabled, all new disturbance recordings will be pushed to the FTP server of the device. Up to six (6) recordings can be stored in the FTP at once. Once those six recordings have been retrieved and removed, more recordings will then be pushed to the FTP. When a recording has been sent to the FTP server of the device, it is no longer accessible through setting tools <i>Disturbance recorder</i> → <i>Get DR files</i> command.
Recorder digital channels	0...96 freely selectable channels	-	Selects the digital channel for recording. Please see the list of all available digital channels in the section titled "Analog and digital recording channels".

NOTICE!

 The disturbance recorder is not ready unless the "Max. length of a recording" parameter is showing some value other than zero. At least one trigger input has to be selected in the "Recorder Trigger" setting to fulfill this term.

NOTICE!

 When writing new disturbance recorder settings to the device, any existing recordings in the device memory will be deleted.

Estimating the maximum length of total recording time

Once the disturbance recorder's settings have been made and loaded to the device, the device automatically calculates and displays the total length of recordings. However, if the user wishes to confirm this calculation, they can do so with the following formula. Please note that the formula assumes there are no other files in the FTP that share the 64 MB space.

$$\frac{\text{Total sample reserve}}{(f_n * (Ch_{an} + 1) * SR) + (200 \text{ Hz} * Ch_{dig})}$$

Where:

- total sample reserve = the number of samples available in the FTP when no other files are saved; calculated by dividing the total number of available bytes by 4 bytes (=the size of one sample); e.g. 64 306 588 bytes/4 bytes = 16 076 647 samples.
- f_n = the nominal frequency (Hz).
- Ch_{an} = the number of analog channels recorded; "+ 1" stands for the time stamp for each recorded sample.
- SR = the selected sample rate (s/c).
- 200 Hz = the rate at which digital channels are always recorded, i.e. 5 ms.
- Ch_{dig} = the number of digital channels recorded.

For example, let us say the nominal frequency is 50 Hz, the selected sample rate is 64 s/c, nine (9) analog channels and two (2) digital channels record. The calculation is as follows:

$$\frac{16\,076\,647 \text{ samples}}{(50 \text{ Hz} * (9 + 1) * 64) + (200 \text{ Hz} * 2)} \approx 496 \text{ s}$$

Therefore, the maximum recording length in our example is approximately 496 seconds.

Application example

This chapter presents an application example of how to set the disturbance recorder and analyze its output. The recorder is configured by using the setting tool software or device HMI, and the results are analyzed with the AQviewer software (is automatically downloaded and installed with AQtivate). Registered users can download the latest tools from the Arcteq website (arcteq.fi/downloads/).

In this example, we want the recordings to be made according to the following specifications:

- the recording length is 6.0 s
- the sample rate is 64 s/c (therefore, with a 50 Hz system frequency a sample is taken every 312.5 μ s)
- the analog channels 1...8 are used
- digital channels are tracked every 5 ms
- the first activation of the overcurrent stage trip ($I > TRIP$) triggers the recorder
- the pre-triggering time is 5 (ie. how long is recorded before the $I > TRIP$ signal) and the post-triggering time is 1 s

The image below shows how these settings are placed in the setting tool.

Figure. 4.6.8 - 97. Disturbance recorder settings.

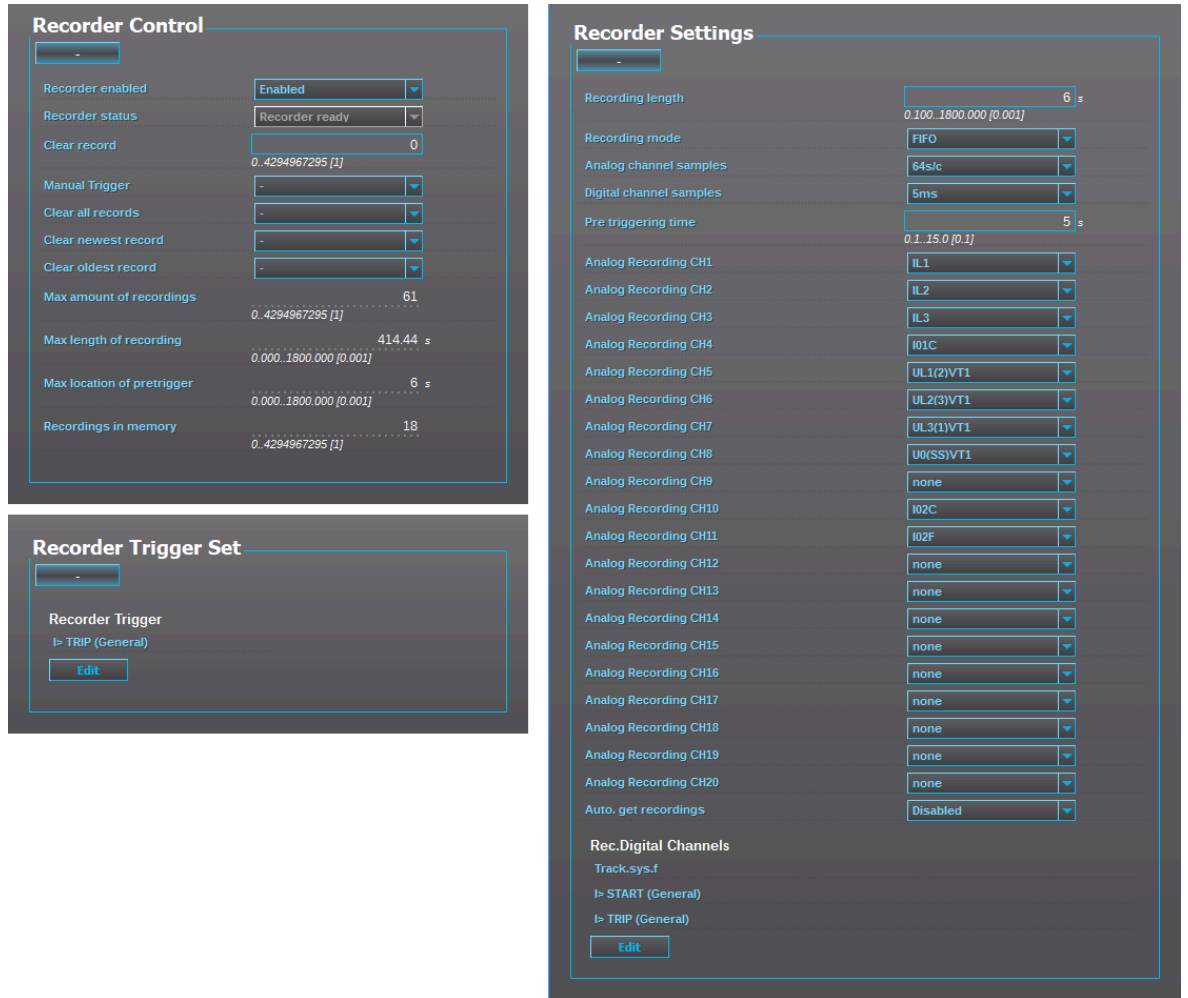
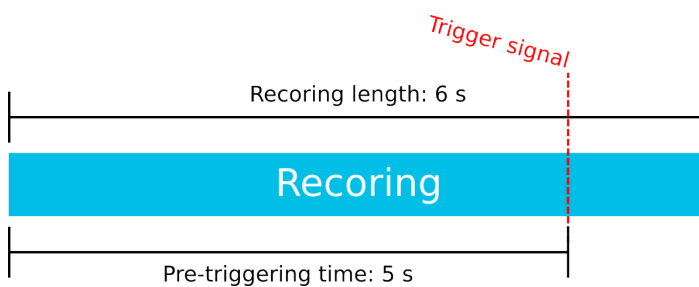
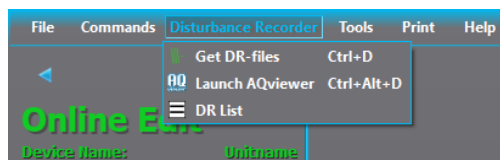


Figure. 4.6.8 - 98. Effects of recording length and pre-triggering time signals. This example is based on the settings shown above.



When there is at least one recording in the device's memory, that recording can be analyzed by using the AQviewer software (see the image below). However, the recording must first be made accessible to AQviewer. The user can read it from the device's memory (*Disturbance recorder* → *Get DR-files*). Alternatively, the user can load the recordings individually (*Disturbance recorder* → *DR List*) from a folder in the PC's hard disk drive; the exact location of the folder is described in *Tools* → *Settings* → *DR path*.



The user can also launch the AQviewer software from the *Disturbance recorder* menu. AQviewer software instructions can be found in AQtivate Instruction manual (<https://www.arcteq.com/documents-and-software/>).

Events

The disturbance recorder function (abbreviated "DR" in event block names) generates events and registers from the status changes in the events listed below. Events cannot be masked off. The events triggered by the function are recorded with a time stamp.

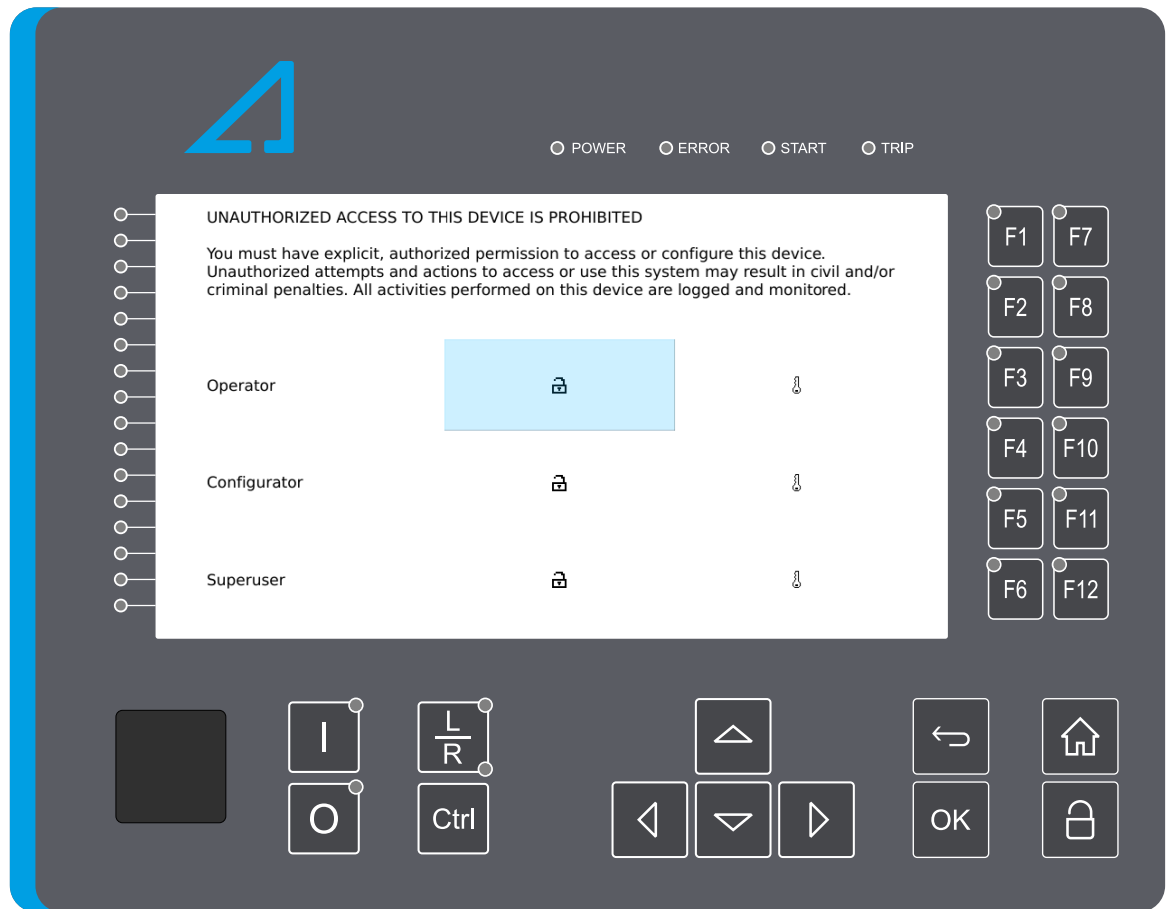
Table. 4.6.8 - 188. Event messages.

Event block name	Event names
DR1	Recorder triggered ON/OFF
DR1	Recorder memory cleared
DR1	Oldest record cleared
DR1	Recorder memory full ON/OFF
DR1	Recording ON/OFF
DR1	Storing recording ON/OFF
DR1	Newest record cleared

4.6.9 User access control

As a factory default, no user level is locked with a password in a device. In order to activate the different user levels, push the **Lock** button on the device's front panel and set the desired passwords for the user levels.

Figure. 4.6.9 - 99. User access control view.



NOTICE!

Passwords can only be set locally in an HMI.

You can set a new password for a user level by selecting the key icon next to the user level's name. After this you can lock the user level by pressing the Return key while the lock is selected. If you need to change the password, you can select the key icon again and give a new password. To remove the password, set the password to "0" (zero). Please note that in order to do this the user level whose password is being changed must be unlocked.

As a general rule the access levels are divided as follows:

- User: Can view any menus and settings but cannot change any settings, nor operate breakers or other equipment.
- Operator: Can view any menus and settings but cannot change any settings BUT can operate breakers and other equipment.
- Configurator: Can change most settings such as basic protection pick-up levels or time delays, breaker control functions, signal descriptions etc. and can operate breakers and other equipment.
- Super user: Can change any setting and can operate breakers and other equipment.

Advanced user access control settings

More detailed settings for user access can be found from *Monitoring* → *User Access Control* menu.

Table. 4.6.9 - 189. UAC settings.

Name	Range	Default	Description
Enable user group - Operator	<ul style="list-style-type: none"> Enabled Disabled 	Enabled	Enables or disables "Operator" user group.
Enable user group - Configurator	<ul style="list-style-type: none"> Enabled Disabled 	Enabled	Enables or disables "Configurator" user group.
Minimum password length	0...128	1	Sets the minimum character length for passwords.
Number of fail attempts before lock	0...1000	3	Sets the number of failed attempts allowed before locking the user level.
Lock period after max fail attempts	0...86400000 s	0 s	Wait time after locking a user level.
HMI session period before logout	5...86400 s	900 s	Time delay for logging out in the HMI. Timer will start the countdown when there are no front panel button presses.
Setting tool session period before logout	5...86400 s	900 s	Time delay for logging out in the setting tool. Timer will start the countdown when there are no key presses or mouse movement.

Table. 4.6.9 - 190. UAC management.

Name	Range	Default	Description
Enable UAC management	<ul style="list-style-type: none"> Enabled Disabled 	Disabled	If UAC has been enabled, the function will set default passwords for the user levels, if no passwords have been set. The function will also monitor if the passwords have been expired.
Enable default passwords	<ul style="list-style-type: none"> Enabled Disabled 	Disabled	If enabled, user levels will use the default passwords, if no passwords have been set. The default passwords are: <ul style="list-style-type: none"> Operator: Oper17 Configurator: Conf12 Super user: Supr98
Password change interval - Operator	0...1000 day(s)	0 day(s)	Required interval for changing passwords. If the password hasn't been changed on time, "Password expired" parameter will change to "True", diagnostic alarm will be activated and an entry to the audit log will be added.
Password change interval - Configurator	0...1000 day(s)	0 day(s)	
Password change interval - Superuser	0...1000 day(s)	0 day(s)	
Password expired - Operator	<ul style="list-style-type: none"> False True 	-	If the password hasn't been changed before the "password change interval" has expired, this parameter will change to "True"

Name	Range	Default	Description
Password expired - Configurator	<ul style="list-style-type: none"> False True 	-	
Password expired - Superuser	<ul style="list-style-type: none"> False True 	-	
Default password unchanged - Operator	<ul style="list-style-type: none"> False True 	-	
Default password unchanged - Configurator	<ul style="list-style-type: none"> False True 	-	Indicates if the user level is using the default password or a user configured password.
Default password unchanged - Superuser	<ul style="list-style-type: none"> False True 	-	
Default password unchanged - Superuser	<ul style="list-style-type: none"> False True 	-	
Password last changed - Operator	DD/MM/YYYY HH:mm:ss	-	Timestamp of the last time the password has been changed for the user level.
Password last changed - Configurator	DD/MM/YYYY HH:mm:ss	-	
Password last changed - Superuser	DD/MM/YYYY HH:mm:ss	-	

5 Communication

5.1 Connections menu

"Connections" menu is found under "Communication" menu. It contains all basic settings of the default back panel ethernet port and RS-485 serial port as well as settings of communication option cards.

Table. 5.1 - 191. Ethernet settings.

Name	Range	Description
IP address	0.0.0.0...255.255.255.255	Set IP address of the ethernet port in the back of the device.
Netmask	0.0.0.0...255.255.255.255	Set netmask of the ethernet port in the back of the device.
Gateway	0.0.0.0...255.255.255.255	Set gateway of the ethernet port in the back of the device.
MAC-Address	00-00-00-00-00-00...FF-FF-FF-FF-FF-FF	Indication of MAC address of the device.
Storm Protection	<ul style="list-style-type: none"> • Disable • Enable 	When enabled, the Storm protection functionality of the internal switch in the device is enabled. This functionality aims to protect the device from excess ethernet traffic caused by storm situation. When enabled, the packet rate allowed to pass through on the ingress port towards the device, is limited to 150 packets per second. Multicast packets are also included in the packet limit.
Double Ethernet card mode	<ul style="list-style-type: none"> • Switch • HSR • PRP 	If the device has a double ethernet option card it is possible to choose its mode.
COM A and Ethernet option card connection	<ul style="list-style-type: none"> • Block all • Allow both directions • Allow COM A to option card • Allow option card to COM A 	If the device has ethernet option card it is possible to determine the allowed direction of data.
Double Ethernet link events	<ul style="list-style-type: none"> • Disable • Enable 	Disables or enables "Double Ethernet Link A down" and "Double Ethernet Link B down" logic signals and events.
Double Ethernet PRP ports	<ul style="list-style-type: none"> • AB • BA 	LanA and LanB port assignment for communication cards that support PRP.

Table. 5.1 - 192. Ethernet security settings.

Name	Description
Enable back Ethernet port	Enable/Disable back panel Ethernet port communication.
Enable front Ethernet port	Enable/Disable front panel Ethernet port communication.

Name	Description
Enable SSH from front Ethernet port	Enable/Disable front panel Ethernet port SSH.
Enable FTP	Enable/Disable FTP server.
Enable discovery messages	Enable/Disable discovery messages. Discovery messages enable <i>Tools</i> → <i>Device list</i> menu in AQtivate setting tool to find all of the devices in the network.
Enable script running	Enable/Disable running scripts with <i>Tools</i> → <i>Run script</i> in AQtivate setting tool.

Virtual Ethernet enables the device to be connected to multiple different networks simultaneously via one physical Ethernet connection. Virtual Ethernet has its own separate IP address and network configurations. All Ethernet-based protocol servers listen for client connections on the IP addresses of both the physical Ethernet and the Virtual Ethernet.

Table. 5.1 - 193. Virtual Ethernet settings.

Name	Description
Enable virtual adapter (No / Yes)	Enable virtual adapter. Off by default.
IP address	Set IP address of the virtual adapter.
Netmask	Set netmask of the virtual adapter.
Gateway	Set gateway of the virtual adapter.

Table. 5.1 - 194. Ethernet Option Card settings.

Name	Range	Default	Description
Ethernet card type	<ul style="list-style-type: none"> None SFP RJ45 	Ready only	Indicates the ethernet card type.
Card mode	<ul style="list-style-type: none"> COM A IP Single virtual IP Dual virtual IP 	COM A IP	
Rate limit	<ul style="list-style-type: none"> No limit 12.5Mb/1Mb 30Mb/2Mb 	No limit	
Clock synchronization mode	<ul style="list-style-type: none"> IRIG-B PTP 	IRIG-B	Clock synchronization mode selection. See " Time synchronization " chapter for more information.
Card status	<ul style="list-style-type: none"> Port1 link ok Port2 link ok 	Read only	
Card status (all)	0...4294967295	Read only	
Port 1 dropped packet count	0...4294967295	Read only	

Name	Range	Default	Description
Port 2 dropped packet count	0...4294967295	Read only	
Enable port 1	<ul style="list-style-type: none"> No Yes 	No	
Port 1 SFP module status	<ul style="list-style-type: none"> Error OK 	Read only	
Port1 virtual Ethernet adapter IP address	0.0.0.0...255.255.255.255	10.15.1.0	
Port1 virtual Ethernet adapter netmask	0.0.0.0...255.255.255.255	255.255.255.0	
Port1 virtual Ethernet adapter gateway	0.0.0.0...255.255.255.255	10.15.1.254	
Port1 virtual Ethernet adapter MAC address	00-00-00-00-00-00...FF-FF-FF-FF-FF-FF	Read only	
Port 1 allowed protocols	<ul style="list-style-type: none"> IEC61850 GOOSE ModbusTCP IEC104 DNP TCP FTP OPC UA NTP LPM communication Settingtool communication PTP 	None	
Port 1 link status events	<ul style="list-style-type: none"> Enable Disable 	Enable	
Port 2 SFP module status	<ul style="list-style-type: none"> Error OK 	Read only	
Port 2 link status events	<ul style="list-style-type: none"> Enable Disable 	Enable	

The device is equipped with an RS-485 serial port. In the software it is identified as "Serial COM1" port.

Table. 5.1 - 195. Serial COM1 settings.

Name	Range	Description
Bitrate	<ul style="list-style-type: none"> 9600bps 19200bps 38400bps 	Bitrate used by RS-485 port.

Name	Range	Description
Databits	7...8	Databits used by RS-485 port.
Parity	<ul style="list-style-type: none"> • None • Even • Odd 	Paritybits used by RS-485 port.
Stopbits	1...2	Stopbits used by RS-485 port.
Protocol	<ul style="list-style-type: none"> • None • ModbusRTU • ModbusIO • IEC103 • SPA • DNP3 • IEC101 	Communication protocol used by RS-485 port.

The device supports communication option card type that has serial fiber ports (Serial COM2) an RS-232 port (Serial COM3).

Table. 5.1 - 196. Serial COM2 settings.

Name	Range	Description
Bitrate	<ul style="list-style-type: none"> • 9600bps • 19200bps • 38400bps 	Bitrate used by serial fiber channels.
Databits	7...8	Databits used by serial fiber channels.
Parity	<ul style="list-style-type: none"> • None • Even • Odd 	Paritybits used by serial fiber channels.
Stopbits	1...2	Stopbits used by serial fiber channels.
Protocol	<ul style="list-style-type: none"> • None • ModbusRTU • ModbusIO • IEC103 • SPA • DNP3 • IEC101 	Communication protocol used by serial fiber channels.
Echo	<ul style="list-style-type: none"> • Off • On 	Enable or disable echo.
Idle Light	<ul style="list-style-type: none"> • Off • On 	Idle light behaviour.

Table. 5.1 - 197. Serial COM3 settings.

Name	Range	Description
Bitrate	<ul style="list-style-type: none"> 9600bps 19200bps 38400bps 	Bitrate used by RS-232 port.
Databits	7...8	Databits used by RS-232 port.
Parity	<ul style="list-style-type: none"> None Even Odd 	Paritybits used by RS-232 port.
Stopbits	1...2	Stopbits used by RS-232 port.
Protocol	<ul style="list-style-type: none"> None ModbusRTU ModbusIO IEC103 SPA DNP3 IEC101 	Communication protocol used by RS-232 port.

5.2 Time synchronization

Time synchronization source can be selected with "Time synchronization" parameter at *Communication* → *Synchronization* → *General*.

Table. 5.2 - 198. General time synchronization source settings.

Name	Range	Description
Time synchronization source	<ul style="list-style-type: none"> Internal External NTP External serial IRIG-B PTP 	Selection of time synchronization source.

5.2.1 Internal

If no external time synchronization source is available the mode should be set to "internal". This means that the device clock runs completely on its own. Time can be set to the device with AQtivate setting tool with *Commands* → *Sync Time* command or in the clock view from the HMI. When using *Sync time* command AQtivate sets the time to device the connected computer is currently using. Please note that the clock doesn't run when the device is powered off.

5.2.2 NTP

When enabled, the NTP (Network Time Protocol) service can use external time sources to synchronize the device's system time. The NTP client service uses an Ethernet connection to connect to the NTP time server. NTP can be enabled by setting the primary time server and the secondary time server parameters to the address of the system's NTP time source(s).

Table. 5.2.2 - 199. Server settings.

Name	Range	Description
Primary time server address	0.0.0.0...255.255.255.255	Defines the address of the primary NTP server. Setting this parameter at "0.0.0.0" means that the server is not in use.
Secondary time server address	0.0.0.0...255.255.255.255	Defines the address of the secondary (or backup) NTP server. Setting this parameter at "0.0.0.0" means that the server is not in use.
NTP version	3...4	Defines the NTP version used.

Table. 5.2.2 - 200. Status.

Name	Range	Description
NTP quality for events	<ul style="list-style-type: none"> • No sync • Synchronized 	Displays the status of the NTP time synchronization at the moment. NOTE: This indication is not valid if another time synchronization method is used (external serial).
NTP-processed message count	0...4294967295	Displays the number of messages processed by the NTP protocol.

Additionally, the time zone of the device can be set by connecting to the device and the selecting the time zone at *Commands* → *Set time zone* in AQtivate setting tool.

5.2.3 PTP

The device supports IEEE 1588v2 precision time protocol synchronization in accordance with the PTP profiles defined in IEEE C37.238-2011/2017 and IEC 61850-9-3 (2016). The device can be configured to operate as a master, as a slave or in an automatic mode where the role is selected dynamically.

In typical operation the device functions as an ordinary clock and is configured either in slave mode or in auto mode. In both cases the device synchronizes to an external Grandmaster and does not normally act as a time source when a higher-priority clock is available. This is common in networks where a GPS-synchronized Grandmaster is present.

When operating in auto mode the device participates in the Best Master Clock Algorithm (BMCA) continuously comparing its clock quality with other PTP devices in the network. Based on this evaluation it automatically assumes the appropriate role—either master or slave.

When the device is explicitly configured in master mode it behaves as a pre-master if a GPS-synchronized Grandmaster is present. In this condition it advertises its clock properties but does not take over the Grandmaster role unless the higher-priority clock becomes unavailable.

To ensure redundancy at least one device often a protection relay is typically assigned a higher priority or explicitly set to master to act as a backup Grandmaster. If the GPS-synchronized master becomes unavailable this device takes over seamlessly and continuous time distribution.

If the device becomes a Grandmaster either because it is explicitly configured as master or because BMCA selects it in auto mode it provides the reference time for other devices. In this state the device is not synchronized to GPS and the time source relies solely on its internal oscillator. This ensures continued synchronization within the network even when the GPS-based master is lost although the absolute accuracy depends on the internal clock stability.

Settings

Select PTP as the time synchronization source from *Communication* → *Synchronization* → *General* menu.

The following settings are available in *Communication* → *Synchronization* → *PTP* menu.

Table. 5.2.3 - 201. PTP time synchronization settings.

Name	Range	Description
Power profile	<ul style="list-style-type: none"> None IEEE C37-238-2011 IEC61850-9-3 IEEE C37-238-2017 	Defines used power profile.
Role	<ul style="list-style-type: none"> Auto (Default) Master Slave 	In Auto mode, the device can take both the role of a clock source and clock consumer. In Master mode the device is forced to consider itself to be a clock source. In Slave mode the device is forced to be a clock consumer.
Mechanism	<ul style="list-style-type: none"> P2P (Default) E2E 	Delay measurement mechanism used. Peer-to-peer can utilize the PTP enabled switches as transparent to boundary clocks while End-to-end must be used if non-PTP enabled switches are found in the network.
Domain number	0...255	PTP devices can be set to belong to a grouping called domain. Devices in same domain is primarily being synchronized together.
Log announce interval		Mean time interval between successive announce messages.
Log delayReq interval		The minimum permitted mean time interval between successive Delay_Req messages
Log sync interval		Mean time interval between successive sync messages
Sync receipt timeout		Number of sync intervals that must pass without receipt of an sync message before the occurrence of the event SYNC_RECEIPT_TIMEOUT_EXPIRES
Announce receipt timeout		Number of announce intervals that must pass without receipt of an announce message before the occurrence of the event ANNOUNCE_RECEIPT_TIMEOUT_EXPIRES
Clock class		The traceability, synchronization state and expected performance of the time or frequency distributed by the Grandmaster PTP Instance
Clock accuracy		The expected accuracy of a PTP Instance when it is the Grandmaster PTP Instance, or in the event it becomes the Grandmaster PTP Instance
Priority 1		Priority setting used in the execution of the best master clock algorithm. Lower values take precedence
Priority 2		Priority setting used in the execution of the best master clock algorithm. Lower values take precedence

Name	Range	Description
VLAN enable	<ul style="list-style-type: none"> Disabled Enabled 	Enable VLAN header for PTP communication
VLAN priority	0...7	Priority setting for VLAN
VLAN ID	0...4095	VLAN identification setting
Reconfigure PTP	<ul style="list-style-type: none"> - Reconfigure 	Parameter to trig reconfiguration of the PTP application

Status indications

The following status indications are available in *Communication* → *Synchronization* → *PTP* menu.

Table. 5.2.3 - 202. PTP status indications

Name	Description
State	State of the PTP application (Master, Slave, Listening).
Best master	Identification of best master in network. Id consist of MAC address plus id number.
Last receive	Time when last synchronization frame was received.
Message sent	Diagnostic message counter.
Message receive	Diagnostic message counter.
PTP timesource	Diagnostic number describing the current time source.

5.3 Communication protocols

The following chapters will describe all available communication protocols. The device includes an RJ-45 ethernet port and an RS-485 serial port, which are able to use communication protocols. See other options for communication ports under "[Construction and installation](#)".

5.3.1 IEC 61850

The user can enable the IEC 61850 protocol in device models that support this protocol at *Communication* → *Protocols* → *IEC61850*. The device supports both Edition 1 and 2 of IEC 61850. The following services are supported by the device:

- Up to eight (8) data sets
- Report Control Blocks (both buffered and unbuffered reporting)
- Control ('Direct operate with normal security', 'Select before operate with normal security', 'Direct with enhanced security' and 'Select before operate with enhanced security' control sequences)
- Disturbance recording file transfer
- GOOSE
- Time synchronization

The device's current IEC 61850 setup can be viewed and edited with the IEC61850 tool (*Tools* → *Communication* → *IEC 61850*).

Settings

The general setting parameters for the IEC 61850 protocol are visible both in AQtivate and in the local HMI. The settings are described in the table below.

Table. 5.3.1 - 203. General settings.

Name	Range	Step	Default	Description
Enable IEC 61850	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	Enables and disables the IEC 61850 communication protocol.
Reconfigure IEC 61850	<ul style="list-style-type: none"> - Reconfigure 	-	-	Reconfigures IEC 61850 settings.
IEC61850 edition	<ul style="list-style-type: none"> Ed1 Ed2 	-	-	Displays the IEC61850 edition used by the device. Edition can be chosen by loading a new CID file at <i>Tools</i> → <i>Communication</i> → <i>IEC 61850</i> with <i>Open</i> button.
Control Authority switch	<ul style="list-style-type: none"> Remote Control Station Level Control 	-	Remote Control	The device can be set to allow object control via IEC 61850 only from clients that are of category Station level control. This would mean that other Remote control clients would not be allowed to control. In Remote control mode all IEC 61850 clients of both remote and station level category are allowed to control objects.
Ethernet port	<ul style="list-style-type: none"> All COM A Double ethernet card 	-	All	Determines which ports use IEC61850. Parameter is visible if double ethernet option card is found in the device.
Configure GOOSE Subscriber from CID file allowed	<ul style="list-style-type: none"> Disabled Allowed 	-	Disabled	In edition 2 of IEC 61850 GOOSE subscriber configuration is a part of the CID file. Determines if it is possible to import published GOOSE settings of another device with a CID file and set them to GOOSE input at <i>Tools</i> → <i>Communication</i> → <i>IEC 61850</i> → <i>GOOSE subscriptions</i> .
General deadband	0.1...10.0 %	0.1 %	2 %	Determines the general data reporting deadband settings.
Active energy deadband	0.1...1000.0 kWh	0.1 kWh	2 kWh	Determines the data reporting deadband settings for this measurement.
Reactive energy deadband	0.1...1000.0 kVar	0.1 kVar	2 kVar	Determines the data reporting deadband settings for this measurement.
Active power deadband	0.1...1000.0 kW	0.1 kW	2 kW	Determines the data reporting deadband settings for this measurement.
Reactive power deadband	0.1...1000.0 kVar	0.1 kVar	2 kVar	Determines the data reporting deadband settings for this measurement.
Apparent power deadband	0.1...1000.0 kVA	0.1 kVA	2 kVA	Determines the data reporting deadband settings for this measurement.

Name	Range	Step	Default	Description
Power factor deadband	0.01...0.99	0.01	0.05	Determines the data reporting deadband settings for this measurement.
Frequency deadband	0.01...1.00 Hz	0.01 Hz	0.1 Hz	Determines the data reporting deadband settings for this measurement.
Current deadband	0.01...50.00 A	0.01 A	5 A	Determines the data reporting deadband settings for this measurement.
Residual current deadband	0.01...50.00 A	0.01 A	0.2 A	Determines the data reporting deadband settings for this measurement.
Voltage deadband	0.01...5000.00 V	0.01 V	200 V	Determines the data reporting deadband settings for this measurement.
Residual voltage deadband	0.01...5000.00 V	0.01 V	200 V	Determines the data reporting deadband settings for this measurement.
Angle measurement deadband	0.1...5.0 deg	0.1 deg	1 deg	Determines the data reporting deadband settings for this measurement.
mA deadband	0.01...5.00 mA	0.01 mA	0.10 mA	Determines the data reporting deadband settings for this measurement.
Integration time	0...10 000 ms	1 ms	0 ms	Determines the integration time of the protocol. If this parameter is set to "0 ms", no integration time is in use. See chapter " Integration time " for more information.
GOOSE Ethernet port	<ul style="list-style-type: none"> All COM A Double ethernet card 	-	All	Determines which ports can use GOOSE communication. Visible if double ethernet option card is found in the device.

For more information on the IEC 61850 communication protocol support, please refer to the conformance statement documents (<https://www.arcteq.com/documents-and-software/> → AQ 200 series → Resources).

5.3.1.1 Logical device mode and logical node mode

Every protection block has its own behavior (LNBeh). This behavior is determined using a combination of the protection block's mode (LNMod) and the device's mode (LDMod).

In IEC61850 mode,

- LNMod can be reported and controlled through Mod data object in all logical nodes.
- LNBeh can be reported through Beh data object in all logical nodes.
- LDMod is only visible through logical node zero's Mod data object (LLN0.Mod).

Mode and behavior values

There are 5 values defined for mode and behavior: On, Blocked, Test, Test / Blocked and Off.

Table. 5.3.1.1 - 204. Behavior descriptions.

LNBeh	On	Blocked	Test	Test / Blocked	Off
Function working	Yes	Yes	Yes	Yes	No
Data quality	Relevant to data	Relevant to data	q.test = True	q.test = True	q.validity = Invalid
Output to process	Yes	No	Yes	No	No
Accept normal control	Yes	Yes	No	No	No
Accept test control	No	No	Yes	Yes	No

The communication services for the **data object Mod** do not care about the status of the LNBeh. Mod will always accept commands with **q.test = False**.

Data objects Mod, Beh and Health will always have **q.validity = Good**. Regardless of the status of LNBeh, the quality test attribute of Mod, Beh and Health shall be **q.test = False**.

Behavior determination

The values for LDMod and LNMod are settable by the user by using HMI, setting tool, or IEC 61850 client. The value for LNBeh are then determined using following rules.

- If either LDMod or LNMod is Off, LNBeh is Off.
- Otherwise,
 - If either LDMod or LNMod is set to either "Test" or "Test / Blocked" mode, LNBeh is in Test mode.
 - If either LDMod or LNMod is set to either "Blocked" or "Test / Blocked" mode, LNBeh is in Blocked mode.
 - If LNBeh still doesn't have anything, LNBeh is "On".

All the possible combinations are laid out in the following table.

Table. 5.3.1.1 - 205. All possible logical device and logical node combinations.

LDMod	LNMod	LNBeh
Off	Off	Off
	Test / Blocked	Off
	Test	Off
	Blocked	Off
	On	Off
Test / Blocked	Off	Off
	Test / Blocked	Test / Blocked
	Test	Test / Blocked
	Blocked	Test / Blocked
	On	Test / Blocked

LMod	LNMod	LNBeh
Test	Off	Off
	Test / Blocked	Test / Blocked
	Test	Test
	Blocked	Test / Blocked
	On	Test
Blocked	Off	Off
	Test / Blocked	Test / Blocked
	Test	Test / Blocked
	Blocked	Blocked
	On	Blocked
On	Off	Off
	Test / Blocked	Test / Blocked
	Test	Test
	Blocked	Blocked
	On	On

Processing of incoming data in different behaviors

This part only applies to incoming data with quality information.

The table below gives the functional processing of the data in different behavior states as defined by the standard. Logical nodes should process receiving data according to their quality information:

- Processed as valid - Reacts according to the quality.
- Processed as invalid - Reacts as if the quality of the data had been invalid.
- Processed as questionable - The application decides how to consider the status value.
- Not processed - Do not belong to communication services, no quality bit can be evaluated.

Table. 5.3.1.1 - 206. Processing of incoming data in different behaviors as defined by the standard.

	On	Blocked	Test	Test / Blocked	Off
q.validity = Good q.test = False	Processed as valid	Processed as valid	Processed as valid	Processed as valid	Not processed
q.validity = Questionable q.test = False	Processed as questionable	Processed as questionable	Processed as questionable	Processed as questionable	Not processed
q.validity = Good q.test = True	Processed as invalid	Processed as invalid	Processed as valid	Processed as valid	Not processed

	On	Blocked	Test	Test / Blocked	Off
q.validity = Questionable q.test = True	Processed as invalid	Processed as invalid	Processed as questionable	Processed as questionable	Not processed
q.validity = Invalid q.test = True/ False	Processed as invalid	Processed as invalid	Processed as invalid	Processed as invalid	Not processed

Arcteq's implementation treats "Processed as questionable" and "Processed as invalid" in the same way with "Not processed". Only "Processed as valid" is passed to the application.

Table. 5.3.1.1 - 207. Arcteq's implementation of processing of incoming data in different behaviors.

	On	Blocked	Test	Test / Blocked	Off
q.validity = Good q.test = False	Processed as valid	Processed as valid	Processed as valid	Processed as valid	
q.validity = Questionable q.test = False					
q.validity = Good q.test = True			Processed as valid	Processed as valid	
q.validity = Questionable q.test = True					
q.validity = Invalid q.test = True/False					

Using mode and behavior

Enabling LDMod and LNMod changing can be done at *General* → *Device info*.

Table. 5.3.1.1 - 208. Parameters to allow changing of LNMod and LDMod.

Name	Range	Default	Description
Allow setting of device mode	<ul style="list-style-type: none"> Prohibited From HMI/setting tool only Allowed 	Prohibited	<p>Allows global mode to be modified from setting tool, HMI and IEC61850.</p> <p>Prohibited: Cannot be changed.</p> <p>From HMI/setting tool only: Can only be changed from the setting tool or HMI.</p> <p>Allowed: Can be changed from the setting tool, HMI, and IEC 61850 client.</p>

Name	Range	Default	Description
Allow setting of individual LN mode	<ul style="list-style-type: none"> • Prohibited • From HMI/setting tool only • Allowed 	Prohibited	<p>Allow local modes to be modified from setting tool, HMI and IEC61850.</p> <p>This parameter is visible only when "Allow setting of device mode" is enabled.</p> <p>Prohibited: Cannot be changed.</p> <p>From HMI/setting tool only: Can only be changed from the setting tool or HMI</p> <p>Allowed: Can be changed from the setting tool, HMI, and IEC 61850 client.</p>

When enabled it is possible to change LDMod at *Communication* → *Protocols* → *IEC61850*.

Table. 5.3.1.1 - 209. Parameter for changing logical device mode.

Name	Range	Default	Description
Allow setting of device mode	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	On	<p>Set mode of logical device.</p> <p>This parameter is visible only when <i>Allow setting of device mode</i> is enabled in <i>General</i> menu.</p>

Each protection, control and monitoring function has its own logical node mode which can be changed individually. This parameter is found in the functions *Info*-menu. Each function also reports its behavior. Behavior of the function is influenced by the status of the device mode setting and the functions mode setting.

Table. 5.3.1.1 - 210. LNMod parameters.

Name	Range	Default	Description
LN mode	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	On	<p>Set mode of function logical node.</p> <p>This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.</p>
LN behavior	<ul style="list-style-type: none"> • On • Blocked • Test • Test/Blocked • Off 	On	<p>Displays the mode of the function logical node.</p> <p>This parameter is visible only when <i>Allow setting of individual LN mode</i> is enabled in <i>General</i> menu.</p>

5.3.1.2 GOOSE

Arcteq devices support both GOOSE publisher and GOOSE subscriber. GOOSE subscriber is enabled with the "GOOSE subscriber enable" parameter at *Communication* → *Protocols* → *IEC 61850/GOOSE*. The GOOSE inputs are configured using either the local HMI or the AQtivate software.

There are up to 64 GOOSE inputs available for use. Each of the GOOSE inputs also has a corresponding input quality signal which can also be used in internal logic. The quality is good, when the input quality status is "low" (that is, when the quality is marked as "0"). The value of the input quality can switch on as a result of a GOOSE time-out or a configuration error, for example. The status and quality of the various logical input signals can be viewed at the *GOOSE IN status* and *GOOSE IN quality* tabs at *Control → Device I/O → Logical signals*.

General GOOSE setting

The table below presents general settings for GOOSE publisher.

Table. 5.3.1.2 - 211. General GOOSE publisher settings.

Name	Range	Description
GOOSE control block 1 simulation bit	<ul style="list-style-type: none"> Disabled (Default) Enabled 	The publisher will publish frames with simulation bit active if enabled. For GOOSE simulation testing purposes.
GOOSE control block 2 simulation bit		

The table below presents general settings for GOOSE subscriber

Table. 5.3.1.2 - 212. General GOOSE subscriber settings.

Name	Range	Description
GOOSE subscriber enable	<ul style="list-style-type: none"> Disabled (Default) Enabled 	Enables or disables GOOSE subscribing for the device.
Not used GOOSE input Quality	<ul style="list-style-type: none"> Bad quality (1) Good quality (0) 	Defines what state should GOOSE input quality signal to be in the logic if the input has been set as "disabled".
Subscriber checks GoCRef	<ul style="list-style-type: none"> No (Default) Yes 	When subscriber sees GOOSE frame it checks APPID and Conf. Rev but can also check if GoCRef or SqNum match.
Subscriber checks SqNum		
Subscriber process simulation messages	<ul style="list-style-type: none"> No (Default) Yes 	Subscriber can be set to process frames which are published with simulation bit high if enabled. The subscriber can still subscribe to non-simulated frames from a publisher until that a simulated frame is received from a publisher. From that point on, only simulated frames are accepted from that publisher. For other publishers, non-simulated frames are accepted normally (given no simulated frame is received from that publisher). This behavior ends when the setting is set back to No.

GOOSE input settings

The table below presents the different settings available for all 64 GOOSE inputs.

These settings can be found from *Communication* → *Protocols* → *IEC61850/GOOSE* → *GOOSE Input Settings*.

Table. 5.3.1.2 - 213. GOOSE input settings.

Name	Range	Description
In use	<ul style="list-style-type: none"> No (Default) Yes 	Enables and disables the GOOSE input in question.
Application ID ("AppID")	0x0...0x3FFF	Defines the application ID that will be matched with the publisher's GOOSE control block.
Configuration revision ("ConfRev")	1...2 ³² -1	Defines the configuration revision that will be matched with the publisher's GOOSE control block.
Data index ("DataIdx")	0...99	Defines the data index of the value in the matched published frame. It is the status of the GOOSE input.
NextIdx is quality	<ul style="list-style-type: none"> No (Default) Yes 	Selects whether or not the next received input is the quality bit of the GOOSE input.
Data type	<ul style="list-style-type: none"> Boolean (Default) Integer Unsigned Floating point 	Selects the data type of the GOOSE input.
Control block reference	-	GOOSE subscriber can be set to check the GCB reference of the published GOOSE frame. This setting is automatically filled when Ed2 GOOSE configuration is done by importing cid file of the publisher.

GOOSE input descriptions

Each of the GOOSE inputs can be given a description. The user defined description are displayed in most of the menus:

- logic editor
- matrix
- block settings
- event history
- disturbance recordings
- etc.

These settings can be found from *Control* → *Device IO* → *Logical Signals* → *GOOSE IN Description*.

Table. 5.3.1.2 - 214. GOOSE input user description.

Name	Range	Default	Description
User editable description GI x	1...31 characters	GOOSE IN x	Description of the GOOSE input. This description is used in several menu types for easier identification.

GOOSE input values

Each of the GOOSE subscriber inputs (1...64) have indications listed in the following table. These indications can be found from *Communication* → *Protocols* → *IEC61850/GOOSE* → *GOOSE input values*.

Table. 5.3.1.2 - 215. GOOSE input indications

Name	Range	Description
Subscription status	<ul style="list-style-type: none"> Not Active Active 	When active correct data received and passed to application.
Processing simulation message	<ul style="list-style-type: none"> False True 	When true subscriber is processing simulation frames for this input (and rejecting non-simulated frames).
Needs commissioning	<ul style="list-style-type: none"> False True 	When true configuration doesn't match the received frame (goCRef, confRev).
Last received state number	0...4294967295	Status number (stNum) of the last data passed to application.
GOOSE IN X boolean value	0...1	GOOSE input 1...64 boolean value.
GOOSE IN X analog value	-3.4E+38...3.4E+38	GOOSE input 1...64 analog value.
GOOSE IN X quality	<ul style="list-style-type: none"> Old data Failure Oscillatory Bad reference Out of range Overflow Invalid Reserved/ Questionable Operator blocked Test Substituted Inaccurate Inconsistent 	GOOSE input quality indication.
GOOSE IN X time	DD/MM/YYYY HH:MM:SS	Time when publisher sent GOOSE frame.
GOOSE IN X time fraction	0...4294967295 μs	Microseconds of the publisher GOOSE frame.

GOOSE events

GOOSE signals generate events from status changes. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp and with process data values. The time stamp resolution is 1 ms.

Table. 5.3.1.2 - 216. GOOSE event

Event block name	Event name	Description
GOOSE1...GOOSE2	GOOSE IN 1...64 ON/OFF	Status change of GOOSE input.
GOOSE3...GOOSE4	GOOSE IN 1...64 quality Bad/Good	Status change of GOOSE inputs quality.
GOOSE5...GOOSE6	GOOSE Subscription status 1...64 Active/Not active	When active correct data received and passed to application.
GOOSE7...GOOSE8	GOOSE Processing simulated messages 1...64 True/False	When true subscriber is processing simulation frames for this input (and rejecting non-simulated frames).
GOOSE9...GOOSE10	GOOSE Subscription needs commissioning 1...64 True/False	When true configuration doesn't match the received frame (goCBRef, confRev).

Setting the publisher

The configuration of the GOOSE publisher is done using the IEC 61850 tool in AQtivate (*Tools* → *Communication* → *IEC 61850*). Refer to *AQtivate-200 Instruction manual* for more information on how to set up GOOSE publisher.

5.3.2 Modbus TCP and Modbus RTU

The device supports both Modbus TCP and Modbus RTU communication. Modbus TCP uses the Ethernet connection to communicate with Modbus TCP clients. Modbus RTU is a serial protocol that can be selected for the available serial ports.

The user can enable the Modbus TCP protocol at *Communication* → *Protocols* → *Modbus TCP*. The user can enable the Modbus RTU protocol at *Communication* → *Connections*.

The following Modbus function types are supported:

- Read multiple holding registers (function code 3)
- Write single holding register (function code 6)
- Write multiple holding registers (function code 16)
- Read/Write multiple registers (function code 23)

The following data can be accessed using both Modbus TCP and Modbus RTU:

- Device measurements
- Device I/O
- Commands
- Events
- Time

Once the configuration file has been loaded, the user can access the Modbus map of the device via the AQtivate software (*Tools* → *Communication* → *Modbus Map*). Please note that holding registers start from 1. Some masters might begin numbering holding register from 0 instead of 1; this will cause an offset of 1 between the device and the master. Modbus map can be edited with Modbus Configurator (*Tools* → *Communication* → *Modbus Configurator*).

Table. 5.3.2 - 217. Modbus TCP settings.

Parameter	Range	Description
Enable Modbus TCP	<ul style="list-style-type: none"> Disabled Enabled 	Enables and disables the Modbus TCP on the Ethernet port.
IP port	0...65 535	Defines the IP port used by Modbus TCP. The standard port (and the default setting) is 502.
Ethernet port	<ul style="list-style-type: none"> All COM A Double Ethernet card 	Defines which ethernet ports are available for Modbus connection. Visible if any double ethernet option card is installed in the device.
Event read mode	<ul style="list-style-type: none"> Get oldest available Continue previous connection New events only 	Get oldest event possible (Default) Continue with the event idx from previous connection Get only new events from connection time and forward.

Table. 5.3.2 - 218. Modbus RTU settings.

Parameter	Range	Description
Slave address	1...247	Defines the Modbus RTU slave address for the unit.

Reading events

Modbus protocol does not support time-stamped events by standard definition. This means that every vendor must come up with their own definition how to transfer events from the device to the client. Events can be read from HR17...HR22 holding registers. HR17 contains the event-code, HR18...20 contains the time-stamp in UTC, HR21 contains a sequential index and HR22 is reserved for future expansion. See the Modbus Map for more information. The event-codes and their meaning can be found from Event list (*Tools* → *Events and Logs* → *Event list* in setting tool). The event-code in HR17 is 0 if no new events can be found in the device event-buffer. Every time HR17 is read from client the event in event-buffer is consumed and on following read operation the next un-read event information can be found from event registers. HR11...HR16 registers contains a back-up of last read event. This is because some users want to double-check that no events were lost

5.3.3 IEC 103

IEC 103 is the shortened form of the international standard IEC 60870-5-103. The device is able to run as a secondary (slave) station. The IEC 103 protocol can be selected for the serial ports that are available in the device. A primary (master) station can then communicate with the device and receive information by polling from the slave device. The transfer of disturbance recordings is not supported.

The user can enable the IEC 103 protocol at *Communication* → *Connections*.

NOTE: Once the configuration file has been loaded, the IEC 103 map of the device can be found in the AQtivate software (*Tools* → *IEC 103 map*).

Table. 5.3.3 - 219. IEC 103 settings.

Name	Range	Step	Default	Description
Slave address	1...254	1	1	Defines the IEC 103 slave address for the unit.
Measurement interval	0...60 000 ms	1 ms	2000 ms	Defines the interval for the measurements update.

The following table presents the setting parameters for the IEC 103 protocol.

5.3.4 IEC 101/104

The standards IEC 60870-5-101 and IEC 60870-5-104 are closely related. Both are derived from the IEC 60870-5 standard. On the physical layer the IEC 101 protocol uses serial communication whereas the IEC 104 protocol uses Ethernet communication. The IEC 101/104 implementation works as a slave in the unbalanced mode.

For detailed information please refer to the IEC 101/104 interoperability document (<https://www.arcteq.com/documents-and-software/> → AQ-200 series → Resources → "AQ-200 IEC101 & IEC104 interoperability").

The user can enable the IEC104 protocol at *Communication* → *Protocols* → *IEC101/104*. The user can enable the IEC101 protocol at *Communication* → *Connections*.

IEC 101 settings

Table. 5.3.4 - 220. IEC 101 settings.

Name	Range	Step	Default	Description
Common address of ASDU	0...65 534	1	1	Defines the common address of the application service data unit (ASDU) for the IEC 101 communication protocol.
Common address of ASDU size	1...2	1	2	Defines the size of the common address of ASDU.
Link layer address	0...65 534	1	1	Defines the address for the link layer.
Link layer address size	1...2	1	2	Defines the address size of the link layer.
Information object address size	2...3	1	3	Defines the address size of the information object.
Cause of transmission size	1...2	1	2	Defines the cause of transmission size.

IEC101/104 measurement scaling coefficients

Table. 5.3.4 - 221. Measurement scaling coefficient settings.

Name	Range	Default	Description
General scaling coef.	<ul style="list-style-type: none"> • No scaling • 1/10 • 1/100 • 1/1000 • 1/10000 • 1/100000 • 1/1000000 • 10 • 100 • 1000 • 10000 • 100000 • 1000000 	No scaling	<p>Optional scaling factor for IEC101/IEC104 communication.</p> <p>Values from 1/10 to 1/1,000,000 apply a division to the measurement.</p> <p>Values from 10 to 1,000,000 apply a multiplication to the measurement.</p>
Active energy scaling coef.			
Reactive energy scaling coef.			
Active power scaling coef.			
Reactive power scaling coef.			
Apparent power scaling coef.			
Power factor scaling coef.			
Frequency scaling coef.			
Current scaling coef.			
Residual current scaling coef.			
Voltage scaling coef.			
Residual voltage scaling coef.			
Angle measurement scaling coef.			
mA scaling coef.			

IEC101/104 deadband settings

Table. 5.3.4 - 222. Analog change deadband settings.

Name	Range	Step	Default	Description
General deadband	0.1...10.0%	0.1%	2%	Determines the general data reporting deadband settings.
Active energy deadband	0.1...1000.0kWh	0.1kWh	2kWh	Determines the data reporting deadband settings for this measurement.
Reactive energy deadband	0.1...1000.0kVar	0.1kVar	2kVar	
Active power deadband	0.1...1000.0kW	0.1kW	2kW	

Name	Range	Step	Default	Description
Reactive power deadband	0.1...1000.0kVar	0.1kVar	2kVar	
Apparent power deadband	0.1...1000.0kVA	0.1kVA	2kVA	
Power factor deadband	0.01...0.99	0.01	0.05	
Frequency deadband	0.01...1.00Hz	0.01Hz	0.1Hz	
Current deadband	0.01...50.00A	0.01A	5A	
Residual current deadband	0.01...50.00A	0.01A	0.2A	
Voltage deadband	0.01...5000.00V	0.01V	200V	
Residual voltage deadband	0.01...5000.00V	0.01V	200V	
Angle measurement deadband	0.1...5.0deg	0.1deg	1deg	
mA measurement deadband	0.01...5.00 mA	0.01 mA	0.10 mA	
Integration time	0...10 000ms	1ms	-	Determines the integration time of the protocol. If this parameter is set to "0 ms", no integration time is in use. See chapter " Integration time " for more information.

5.3.5 SPA

The device can act as a SPA slave. SPA can be selected as the communication protocol for the RS-485 port (Serial COM1). When the device has a serial option card, the SPA protocol can also be selected as the communication protocol for the serial fiber (Serial COM2) ports or RS-232 (Serial COM3) port. Please refer to the chapter "[Construction and installation](#)" in the device manual to see the connections for these modules.

The data transfer rate of SPA is 9600 bps, but it can also be set to 19 200 bps or 38 400 bps. As a slave the device sends data on demand or by sequenced polling. The available data can be measurements, circuit breaker states, function starts, function trips, etc. The full SPA signal map can be found in *AQtivate (Tools → SPA map)*.

The SPA event addresses can be found at *Tools → Events and logs → Event list*.

The user can enable the SPA protocol at *Communication → Connections*.

Table. 5.3.5 - 223. SPA setting parameters.

Name	Range	Description
SPA address	1...899	SPA slave address.
UTC time sync	<ul style="list-style-type: none"> • Disabled • Enabled 	Determines if UTC time is used when synchronizing time. When disabled it is assumed time synchronization uses local time. If enabled it is assumed that UTC time is used. When UTC time is used the timezone must be set at <i>Commands</i> → <i>Set time zone</i> .

**NOTICE!**

To access SPA map and event list, an .aqs configuration file should be downloaded from the device.

5.3.6 DNP3

DNP3 is a protocol standard which is controlled by the DNP Users Group (www.dnp.org). The implementation of a DNP3 slave is compliant with the DNP3 subset (level) 2, but it also contains some functionalities of the higher levels. For detailed information please refer to the DNP3 Device Profile document (<https://www.arcteq.com/documents-and-software/> → AQ-200 series → Resources).

The user can enable the DNP3 TCP protocol at *Communication* → *Protocols* → *DNP3*. The user can enable the DNP3 serial protocol at *Communication* → *Connections*.

General settings

The following table describes the DNP3 setting parameters.

Table. 5.3.6 - 224. Settings.

Name	Range	Step	Default	Description
Enable DNP3 TCP	<ul style="list-style-type: none"> • Disabled • Enabled 	-	Disabled	Enables and disables the DNP3 TCP communication protocol when the Ethernet port is used for DNP3. If a serial port is used, the DNP3 protocol can be enabled from <i>Communication</i> → <i>DNP3</i> .
IP port	0...65 535	1	20 000	Defines the IP port used by the protocol.
Ethernet port	<ul style="list-style-type: none"> • All • COM A • Double Ethernet card 	-	All	Defines which ethernet ports are available for Modbus connection. Visible if any double ethernet option card is installed in the device.
Slave address	1...65 519	1	1	Defines the DNP3 slave address of the unit.
Master address	1...65 534	1	2	Defines the address for the allowed master.
Link layer time-out	0...60 000ms	1ms	0ms	Defines the length of the time-out for the link layer.
Link layer retries	1...20	1	1	Defines the number of retries for the link layer.

Name	Range	Step	Default	Description
Diagnostic - Error counter	0...2 ³² -1	1	-	Counts the total number of errors in received and sent messages.
Diagnostic - Transmitted messages	0...2 ³² -1	1	-	Counts the total number of transmitted messages.
Diagnostic - Received messages	0...2 ³² -1	1	-	Counts the total number of received messages.

Default variations

Table. 5.3.6 - 225. Default variations.

Name	Range	Default	Description
Group 1 variation (BI)	<ul style="list-style-type: none"> Var 1 Var 2 	Var 1	Selects the variation of the binary signal.
Group 2 variation (BI change)	<ul style="list-style-type: none"> Var 1 Var 2 	Var 2	Selects the variation of the binary signal change.
Group 3 variation (DBI)	<ul style="list-style-type: none"> Var 1 Var 2 	Var 1	Selects the variation of the double point signal.
Group 4 variation (DBI change)	<ul style="list-style-type: none"> Var 1 Var 2 	Var 2	Selects the variation of the double point signal.
Group 20 variation (CNTR)	<ul style="list-style-type: none"> Var 1 Var 2 Var 5 Var 6 	Var 1	Selects the variation of the control signal.
Group 22 variation (CNTR change)	<ul style="list-style-type: none"> Var 1 Var 2 Var 5 Var 6 	Var 5	Selects the variation of the control signal change.
Group 30 variation (AI)	<ul style="list-style-type: none"> Var 1 Var 2 Var 3 Var 4 Var 5 	Var 5	Selects the variation of the analog signal.
Group 32 variation (AI change)	<ul style="list-style-type: none"> Var 1 Var 2 Var 3 Var 4 Var 5 Var 7 	Var 5	Selects the variation of the analog signal change.

DNP3 measurement scaling coefficients

Table. 5.3.6 - 226. Measurement scaling coefficient settings.

Name	Range	Default	Description
General scaling coef.	<ul style="list-style-type: none"> • No scaling • 1/10 • 1/100 • 1/1000 • 1/10000 • 1/100000 • 1/1000000 • 10 • 100 • 1000 • 10000 • 100000 • 1000000 	No scaling	Optional scaling factor for SPA communication. Values from 1/10 to 1/1,000,000 apply a division to the measurement. Values from 10 to 1,000,000 apply a multiplication to the measurement.
Active energy scaling coef.			
Reactive energy scaling coef.			
Active power scaling coef.			
Reactive power scaling coef.			
Apparent power scaling coef.			
Power factor scaling coef.			
Frequency scaling coef.			
Current scaling coef.			
Residual current scaling coef.			
Voltage scaling coef.			
Residual voltage scaling coef.			
Angle measurement scaling coef.			
mA scaling coef.			

DNP3 deadband settings

Table. 5.3.6 - 227. Analog change deadband settings.

Name	Range	Step	Default	Description
General deadband	0.1...10.0%	0.1%	2%	Determines the general data reporting deadband settings.
Active energy deadband	0.1...1000.0kWh	0.1kWh	2kWh	Determines the data reporting deadband settings for this measurement.
Reactive energy deadband	0.1...1000.0kVar	0.1kVar	2kVar	
Active power deadband	0.1...1000.0kW	0.1kW	2kW	

Name	Range	Step	Default	Description
Reactive power deadband	0.1...1000.0kVar	0.1kVar	2kVar	
Apparent power deadband	0.1...1000.0kVA	0.1kVA	2kVA	
Power factor deadband	0.01...0.99	0.01	0.05	
Frequency deadband	0.01...1.00Hz	0.01Hz	0.1Hz	
Current deadband	0.01...50.00A	0.01A	5A	
Residual current deadband	0.01...50.00A	0.01A	0.2A	
Voltage deadband	0.01...5000.00V	0.01V	200V	
Residual voltage deadband	0.01...5000.00V	0.01V	200V	
Angle measurement deadband	0.1...5.0deg	0.1deg	1deg	
mA deadband	0.01...5.00 mA	0.01 mA	0.10 mA	
Integration time	0...10 000ms	1ms	0ms	Determines the integration time of the protocol. If this parameter is set to "0 ms", no integration time is in use. See chapter " Integration time " for more information.

5.3.7 Modbus I/O

The Modbus I/O protocol can be selected to communicate on the available serial ports. The Modbus I/O is actually a Modbus/RTU master implementation that is dedicated to communicating with serial Modbus/RTU slaves such as RTD input modules. Up to three (3) Modbus/RTU slaves can be connected to the same bus polled by the Modbus I/O implementation. These are named I/O Module A, I/O Module B and I/O Module C. Each of the modules can be configured using parameters in the following two tables.

Table. 5.3.7 - 228. Module settings.

Name	Range	Description
I/O module X address	0...247	Defines the Modbus unit address for the selected I/O Module (A, B, or C). If this setting is set to "0", the selected module is not in use.
Module x type	<ul style="list-style-type: none"> ADAM-4018+ ADAM-4015 	Selects the module type.

Name	Range	Description
Channels in use	Channel 0...Channel 7 (or None)	Selects the number of channels to be used by the module.

Table. 5.3.7 - 229. Channel settings.

Name	Range	Step	Default	Description
Thermocouple type	<ul style="list-style-type: none"> • +/- 20mA • 4...20mA • Type J • Type K • Type T • Type E • Type R • Type S 	-	4...20mA	Selects the thermocouple or the mA input connected to the I/O module. Types J, K, T and E are nickel-alloy thermocouples, while Types R and S are platinum/rhodium-alloy thermocouples.
Input value	-101.0...2000.0	0.1	-	Displays the input value of the selected channel.
Input status	<ul style="list-style-type: none"> • Invalid • OK 	-	-	Displays the input status of the selected channel.

5.3.8 OPCUA

Table. 5.3.8 - 230. OPCUA settings.

Name	Range	Step	Default	Description
OPCUA mode	<ul style="list-style-type: none"> • Disabled • Enabled 	-	Disabled	Enables or disables the OPCUA protocol.
OPCUA reconfigure	<ul style="list-style-type: none"> • - • Reconfigure 	-	-	Reconfigures the OPCUA and takes the settings configured in <i>Tools</i> → <i>Communication</i> → <i>OPCUA</i> into use.
OPCUA Flat struct enable	<ul style="list-style-type: none"> • Disabled • Enabled 	-	Disabled	

5.3.9 Integration time

When integration time is not used, measurement values are updated only when the change exceeds the configured deadband. If the deadband is set too low, measurements may be reported too frequently, creating unnecessary traffic. If the deadband is configured too high, the measurement may almost never update. When integration time is used, large changes are still reported quickly, but smaller changes are accumulated over time and eventually reported even if the deadband is not very sensitive.

With integration time enabled, the following parameters determine when a measurement is reported:

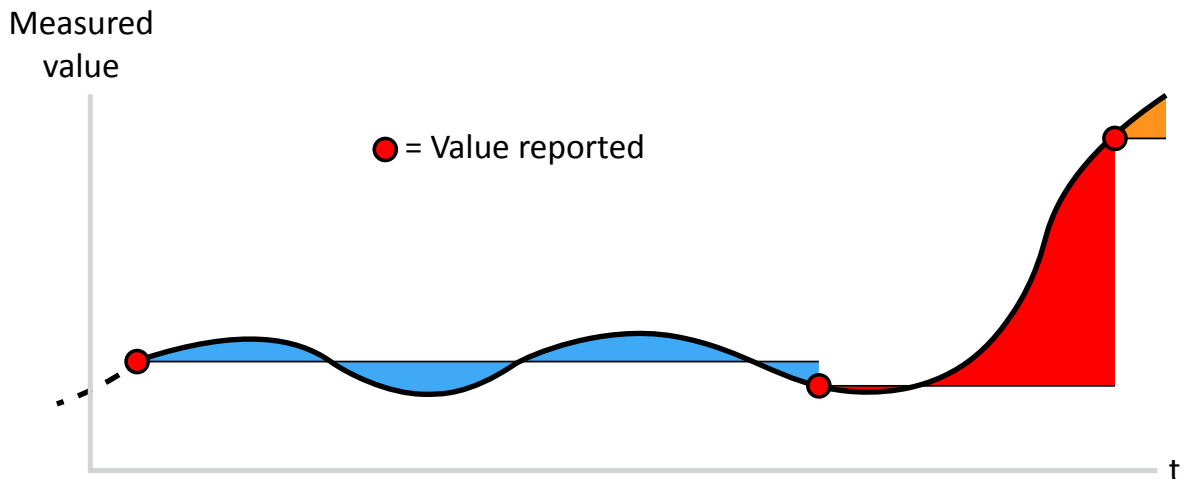
- deadband setting of the measurement
- integration time setting
- latest reported measurement value
- measured value.

An integrated value is calculated over time using these parameters. Once this integrated value exceeds the deadband, a new measurement update is sent.

Figure. 5.3.9 - 100. Integration time formula.

$$\text{Integrated value} = |\text{Measured value} - \text{Latest reported value}| * \left(\frac{t}{\text{Integration time}} \right)$$

Figure. 5.3.9 - 101. Example graph showing how integration time affects measurement reporting. Small changes take longer to increase the integrated value over the deadband setting (blue area). Big changes meet the deadband criteria faster (red area).



The time it takes for a value to be updated with the configured settings can be roughly estimated with the following formula:

Figure. 5.3.9 - 102. Measurement reporting delay when integration time is used.

$$t = \frac{\text{Deadband setting} * \text{Integration time setting}}{|\text{Measured value} - \text{Latest reported value}|}$$

If the latest reported value was 5.00 A and the measurement rises up to 6.00 A and stays stable, and the deadband setting for current is 2 A and the integration time setting is 1 s, we get the following result:

Figure. 5.3.9 - 103. Calculation example for estimating reporting time when integration time is in use.

$$t = \frac{2A * 1s}{|6A - 5A|} = 2s$$

5.4 Analog fault registers

At *Communication* → *General I/O* → *Analog fault registers* the user can set up to twelve (12) channels to record the measured value when a protection function starts or trips. These values can be read in two ways: locally from this same menu, or through a communication protocol if one is in use.

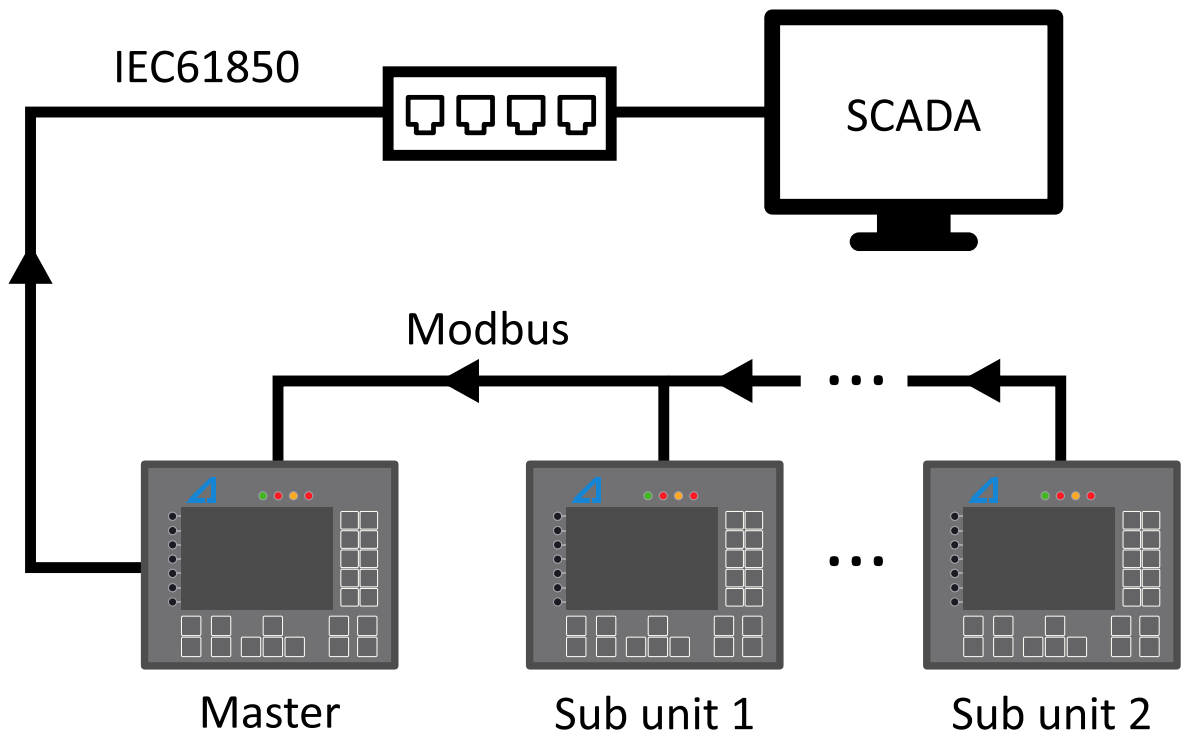
The following table presents the setting parameters available for the 12 channels.

Table. 5.4 - 231. Fault register settings.

Name	Range	Step	Default	Description
Select record source	Not in use I>, I>>, I>>>, I>>>> (IL1, IL2, IL3) Id>, Id>>, Id>>>, Id>>>> (IL1, IL2, IL3) IO>, IO>>, IO>>>, IO>>>> (IO) IOd>, IOd>>, IOd>>>, IOd>>>> (IO) FLX (Fault locator)	-	Not in use	Selects the protection function and its stage to be used as the source for the fault register recording. The user can choose between non-directional overcurrent, directional overcurrent, non-directional earth fault, directional earth fault, and fault locator functions.
Select record trigger	<ul style="list-style-type: none"> • TRIP signal • START signal • START and TRIP signals 	-	TRIP signal	Selects what triggers the fault register recording: the selected function's TRIP signal, its START signal, or either one.
Recorded fault value	- 1000 000.00...1 000 000.00	0.01	-	Displays the recorded measurement value at the time of the selected fault register trigger.

5.5 Modbus Gateway

Figure. 5.5 - 104. Example setup of Modbus Gateway application.



The device can be setup as a Modbus Gateway (i.e. master). Modbus Gateway device can import messages (measurements, status signals etc.) from external Arcteq and third-party devices. RS-485 serial communication port. Up to 32 sub units can be connected to a master unit. These messages can then be used for controlling logic in the master device, display the status in user created mimic. Binary signals can be reported forward to SCADA with IEC61850, IEC101, IEC103, IEC104, Modbus, DNP3 or SPA.

Modbus Gateway and its basic settings can be found from *Communication* → *Modbus Gateway*. General settings-menu displays the health of connection to each sub unit.

Table. 5.5 - 232. General settings

Name	Range	Description
Modbus Gateway mode	<ul style="list-style-type: none"> Disabled (Default) Enabled 	Enables or disables Modbus Gateway.
Modbus Gateway reconfigure	- Reconfigure	Setting this parameter to "Reconfigure" takes new settings into use. Parameter returns back to "-" automatically.
Quality of Modbus Sub unit 1...32	<ul style="list-style-type: none"> OK Old data Data questionable Modbus error Send fail Receive fail 	Quality of each connected sub unit.

Imported signals

Modbus Gateway supports importing of measurements, bits, double bits, counters and integer signals. Up to 128 signals can be imported of each signal type with the exception of double bits (32).

Table. 5.5 - 233. Imported signals

Name	Range
Imported measurement 1-128	-3.4E+38...3.4E+38
Imported bit signal 1-128	0...1
Imported double bit data 1-32	0...3
Imported counter data 1-128	0...4294967295
Imported integer signal 1-128	-2147483648...2147483647

To assign the signals use Modbus Gateway editor (*Tools* → *Communication* → *Modbus Gateway*). Detailed description of this tool can be found in *AQtivate Instruction manual* (<https://www.arcteq.com/documents-and-software/>).

All imported signals can be given a description. The description will be displayed in most of menus with the signal (logic editor, matrix, block settings etc.).

Table. 5.5 - 234. Imported signal user description.

Name	Range	Default	Description
Describe measurement x	1...31 characters	Acq. Meas x	User settable description for the signal. This description is used in several menu types for easier identification.
Describe bit signal x		Acq. Bit x	
Describe double bit signal x		Acq. Binary x	
Describe counter signal x		Acq. Counter x	
Describe integer signal x		Acq. Integer x	

Events

The Modbus Gateway generates events the status changes in imported bits and double bits. The user can select which event messages are stored in the main event buffer: ON, OFF, or both.

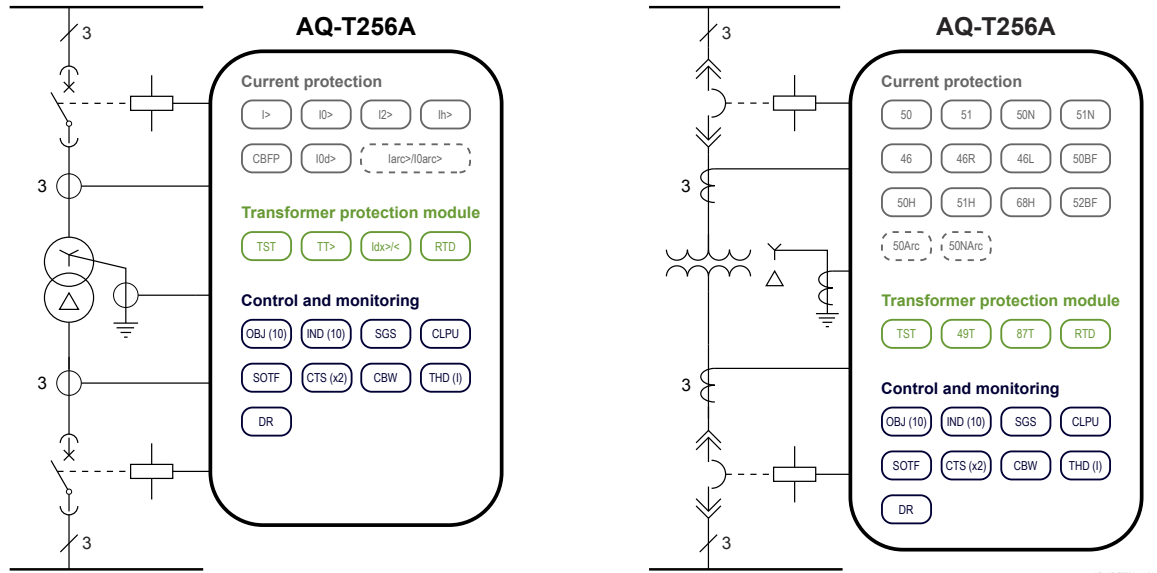
Table. 5.5 - 235. Event messages

Event block name	Event names
MGWB1	Bit 1...Bit 32 (ON, OFF)
MGWB2	Bit 33...Bit 64 (ON, OFF)
MGWB3	Bit 65...Bit 96 (ON, OFF)
MGWB4	Bit 97...Bit 128 (ON, OFF)
MGWD1	Double Bit 1... Double bit 16 (ON/ON, OFF/OFF, ON/OFF, OFF/ON)
MGWD2	Double Bit 17... Double bit 32 (ON/ON, OFF/OFF, ON/OFF, OFF/ON)

6 Connections and application examples

6.1 Connections of AQ-T256

Figure. 6.1 - 105. AQ-T256 application example with function block diagram.

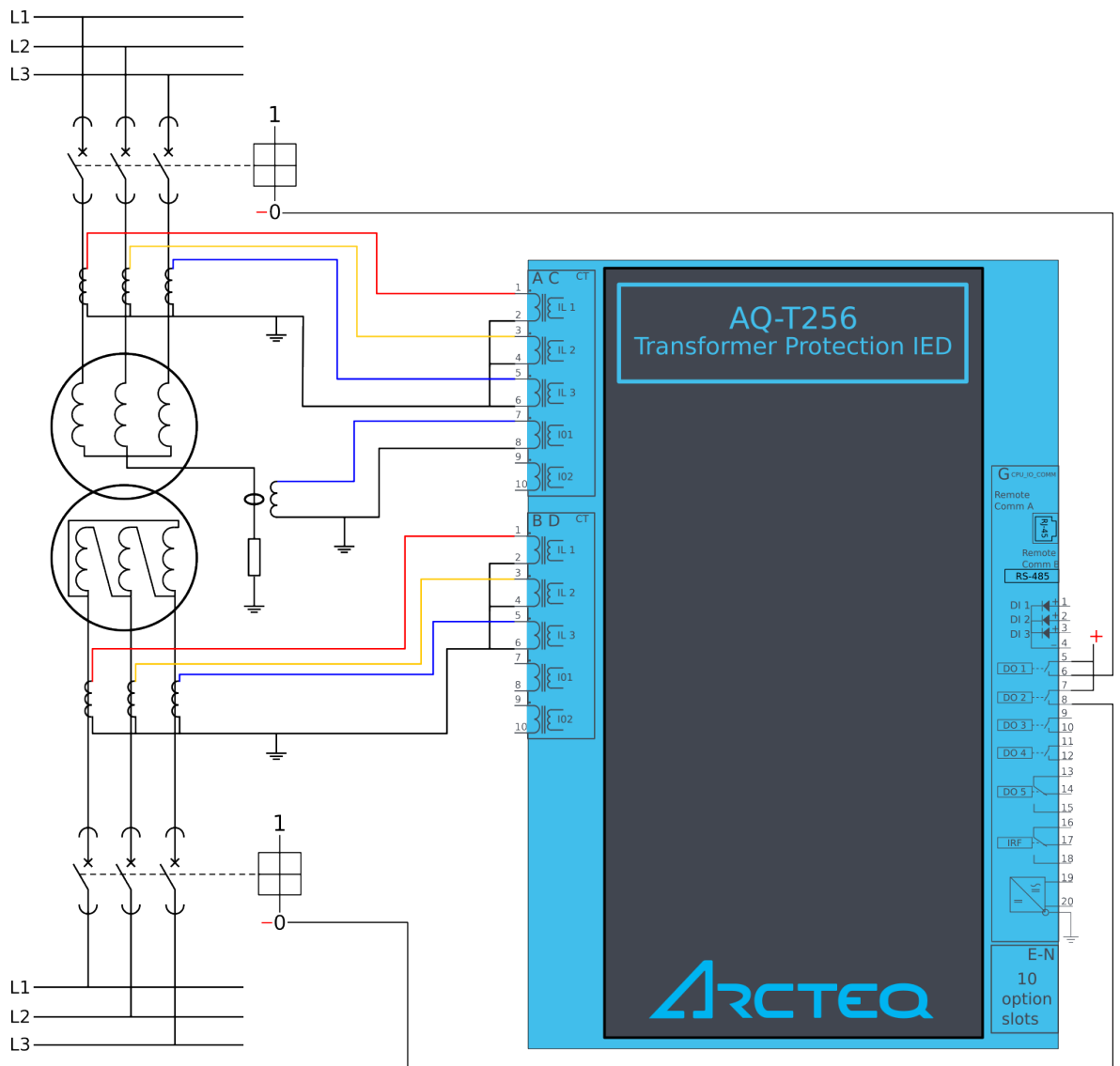


6.2 Application example and its connections

This chapter presents an application example for the two-winding transformer differential device. The example is a regular differential scheme with restricted earth fault protection on the high-voltage side.

As can be seen in the image below, the example application has two current transformers. The first (upper) CT has the three phase current as well as the residual current (I01) connected. The second CT also has the three phase currents but no residual current connected.

Figure. 6.2 - 106. Application example and its connections.



7 Construction and installation

7.1 Construction

AQ-X256 is a member of the modular and scalable AQ-200 series, and it includes ten (10) configurable and modular add-on card slots. As a standard configuration the device includes the CPU module (which consists of the CPU, a number of inputs and outputs, and the power supply) as well as two separate current measurement modules.

The images below present the modules of both the non-optional model (AQ-X256-XXXXXXX-AAAAAAAAA) and the fully optional model (AQ-X256-XXXXXXX-BBBBCCCCJ).

Figure. 7.1 - 107. Modular construction of AQ-X256-XXXXXXX-AAAAAAAAA

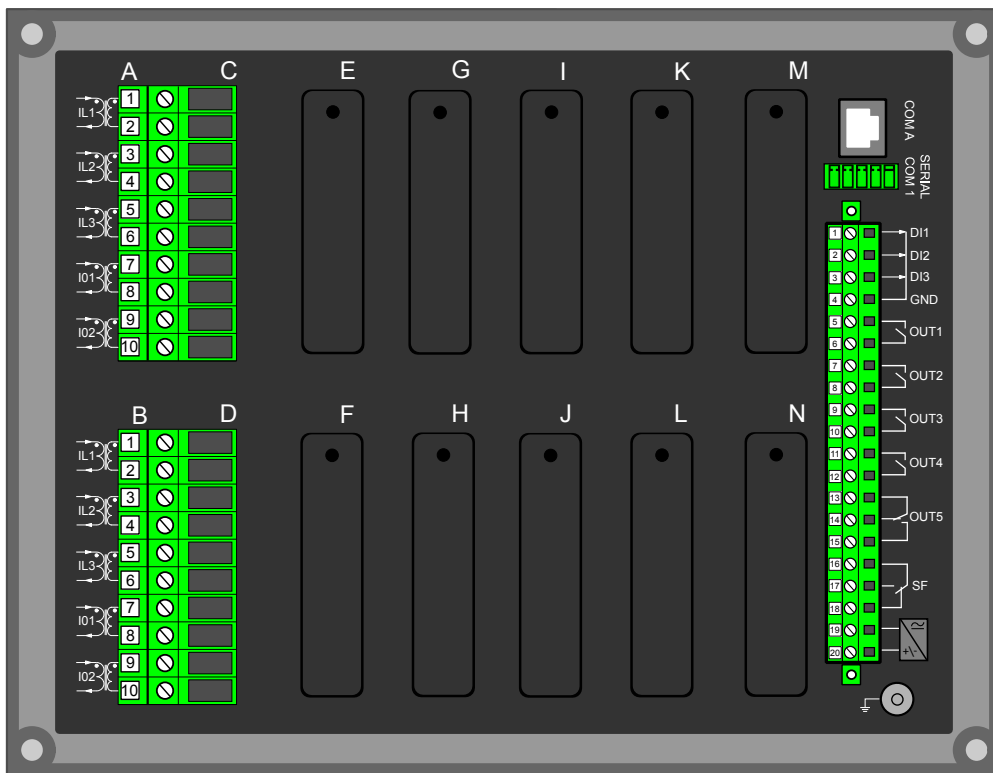
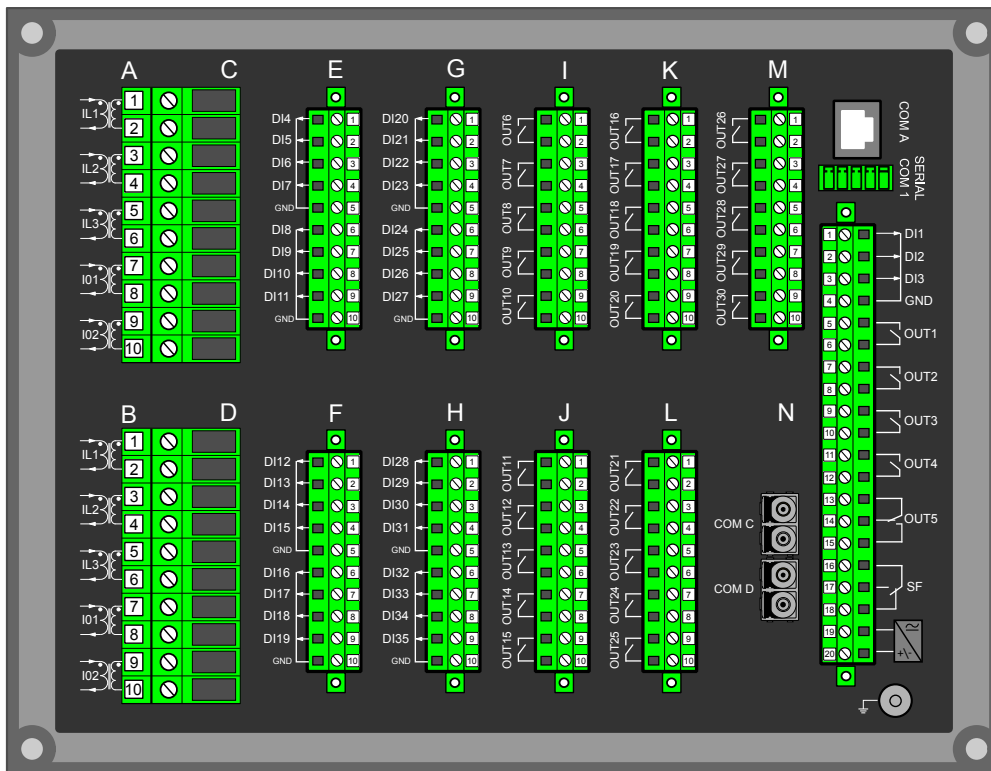


Figure. 7.1 - 108. Modular construction of AQ-X256-XXXXXX-BBBBCCCCJ



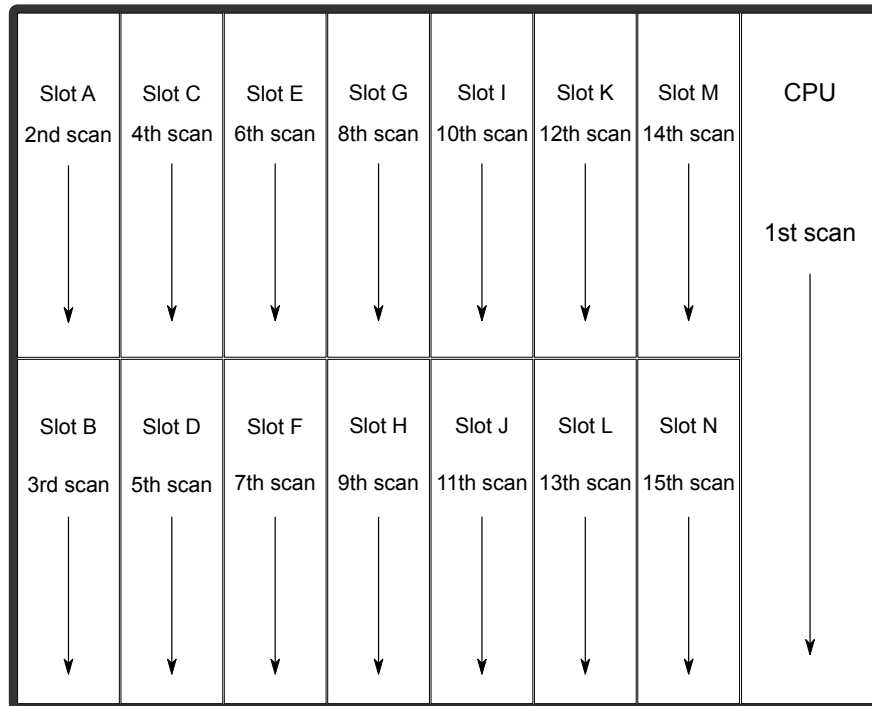
The modular structure of AQ-X256 allows for scalable solutions for different application requirements. In non-standard configurations Slots from E to N accept all available add-on modules, such as digital I/O modules, integrated arc protection and other special modules. The only difference between the slots affecting device scalability is that Slots M and N both also support communication options.

Start-up scan searches for modules according to their type designation code. If the module content is not what the device expects, the device issues a hardware configuration error message. In field upgrades, therefore, add-on modules must be ordered from Arcteq Relays Ltd. or its representative who can then provide the module with its corresponding unlocking code to allow the device to operate correctly once the hardware configuration has been upgraded.

When an I/O module is inserted into the device, the module location affects the naming of the I/O. The I/O scanning order in the start-up sequence is as follows: the CPU module I/O, Slot E, Slot F, Slot G and so on. This means that the digital input channels DI1, DI2 and DI3 as well as the digital output channels OUT1, OUT2, OUT3, OUT4 and OUT5 are always located in the CPU module. If additional I/O cards are installed, their location and card type affect the I/O naming.

The figure below presents the start-up hardware scan order of the device as well as the I/O naming principles.

Figure. 7.1 - 109. AQ-X255 hardware scanning and I/O naming principles.



1. Scan
The start-up system; detects and self-tests the CPU module, voltages, communication and the I/O; finds and assigns "DI1", "DI2", "DI3", "OUT1", "OUT2", "OUT3", "OUT4" and "OUT5".
2. Scan
Scans Slot A, which should always remain empty in AQ-X256 devices. If it is not empty, the device issues an alarm.
3. Scan
Scans Slot B, which should always remain empty in AQ-X256 devices, If it is not empty, the device issues an alarm.
4. Scan
Scans Slot C and finds the five channels of the first CT module (fixed for AQ-X256). If the CTM is not found, the device issues an alarm.
5. Scan
Scans Slot D and finds the five channels of the second CT module (fixed for AQ-X256). If the CTM is not found, the device issues an alarm.
6. Scan
Scans Slot E, and moves to the next slot if Slot E is empty. If the scan finds an 8DI module (that is, a module with eight digital inputs), it reserves the designations "DI4", "DI5", "DI6", "DI7", "DI8", "DI9", "DI10" and "DI11" to this slot. If the scan finds a DO5 module (that is, a module with five digital outputs), it reserves the designations "OUT6", "OUT7", "OUT8", "OUT9" and "OUT10" to this slot. The I/O is then added if the type designation code (e.g. AQ-P215-PH0AAAA-BBC) matches with the existing modules in the device. If the code and the modules do not match, the device issues an alarm. An alarm is also issued if the device expects to find a module here but does not find one.
7. Scan
Scans Slot F, and moves to the next slot if Slot F is empty. If the scan finds an 8DI module, it reserves the designations "DI4", "DI5", "DI6", "DI7", "DI8", "DI9", "DI10" and "DI11" to this slot. If Slot E also has an 8DI module (and therefore has already reserved these designations), the device reserves the designations "DI12", "DI13", "DI14", "DI15", "DI16", "DI17", "DI18" and "DI19" to this slot. If the scan finds a 5DO module, it reserves the designations "OUT6", "OUT7", "OUT8", "OUT9" and "OUT10" to this slot. Again, if Slot E also has a 5DO and has therefore already reserved these designations, the device reserves the designations "OUT11", "OUT12", "OUT13", "OUT14" and "OUT15" to this slot.

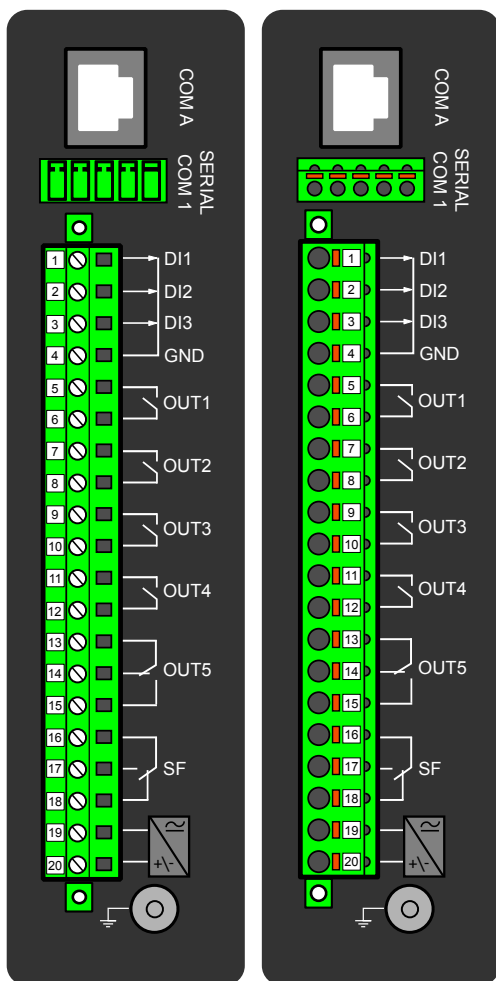
8. – 15. Scan

A similar operation to Scan 7 (checks which designations have been reserved by modules in previous slots and numbers the new ones accordingly).

The fully optioned example case of AQ-X256-XXXXXXX-BBBBCCCCJ (the first image pair, on the right) has a total of 35 digital input channels available: three (DI1...DI3) in the CPU module, and the rest in Slots E...H in groups of eight. It also has a total of 30 digital output channels available: five (DO1...DO5) in the CPU module, and the rest in Slots I...M in groups of five. Additionally, there is a double (LC) fiber Ethernet communication option card installed in Slot N.

7.2 CPU module

Figure. 7.2 - 110. CPU module can be equipped with standard screw terminals or spring cage terminals for connection.



Connector	Description
COM A	Communication port A, or the RJ-45 port. Used for the setting tool connection and for SCADA communication.
COM B	Communication port B, or the RS-485 port. Used for SCADA communication. The pins have the following designations: <ul style="list-style-type: none"> • Pin 1 = DATA + • Pin 2 = DATA - • Pin 3 = GND • Pins 4 & 5 = Terminator resistor enabled by shorting.

Connector	Description
X1-1	Digital input 1, nominal threshold voltage 24 V, 110 V or 220 V.
X1-2	Digital input 2, nominal threshold voltage 24 V, 110 V or 220 V.
X1-3	Digital input 3, nominal threshold voltage 24 V, 110 V or 220 V.
X1-4	Common GND for digital inputs 1, 2 and 3.
X1-5:6	Output relay 1, with a normally open (NO) contact.
X1-7:8	Output relay 2, with a normally open (NO) contact.
X1-9:10	Output relay 3, with a normally open (NO) contact.
X1-11:12	Output relay 4, with a normally open (NO) contact.
X1-13:14:15	Signaling relay 5, with a changeover contact. Not to be used in trip coil control.
X1-16:17:18	System fault's signaling relay, with a changeover contact. Pins 16 and 17 are closed when the unit has a system fault or is powered OFF. Pins 16 and 18 are closed when the unit is powered ON and there is no system fault.
X1-19:20	Power supply IN. Either 88...265 VAC/DC (model A; order code "H") or 18...75 DC (model B; order code "L"). Positive side (+) to Pin 20.
GND	The device's earthing connector.

By default, the CPU module (combining the CPU, the I/O and the power supply) includes two standard communication ports and the device's basic digital I/O.

The digital output controls can be set by the user with software. Digital outputs are controlled in 5 ms program cycles. All output contacts are mechanical. The rated voltage of the NO/NC outputs is 250 VAC/DC.

Digital inputs

The current consumption of the digital inputs is 2 mA when activated. The range of the operating voltage is 24 V/110 V/220 V depending on the ordered hardware. All digital inputs are scanned in 5 ms program cycles.

The settings described in the table below can be found at *Control* → *Device I/O* → *Digital input settings* in the device settings.

Table. 7.2 - 236. Digital input settings.

Name	Range	Step	Default	Description
Dlx Polarity	<ul style="list-style-type: none"> NO (Normally open) NC (Normally closed) 	-	NO	Selects whether the status of the digital input is 1 or 0 when the input is energized.
Dlx Activation delay	0.000...1800.000 s	0.001 s	0.000 s	Defines the delay for the status change from 0 to 1.
Dlx Drop-off time	0.000...1800.000 s	0.001 s	0.000 s	Defines the delay for the status change from 1 to 0.

Name	Range	Step	Default	Description
Dlx AC mode	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	Selects whether or not a 30-ms deactivation delay is added to account for alternating current.

Digital outputs

The digital output controls can be set by the user with software. Digital outputs are controlled in 5 ms program cycles. All output contacts are mechanical. The rated voltage of the NO/NC outputs is 250 VAC/DC.

Table. 7.2 - 237. Digital output settings.

Name	Range	Description
Out x Polarity	<ul style="list-style-type: none"> NO NC 	<p>Determines the normal status of the output relay.</p> <p>Digital outputs are configured as "normally open" relays by default. Each output can be changed to "normally closed" using the "OUTx Polarity" parameter.</p> <p>Please note that this change is implemented in software only. If the device is powered off, the outputs will revert to an open state and return to the configured polarity once power is restored.</p> <p>If a truly "normally closed" contact is required, use the changeover relay OUT5 available in the CPU module of the device.</p> <p>An NC output signal does not open during a Communication or Protection reset.</p>

Digital input and output descriptions

CPU card digital inputs and outputs can be given a description. The user defined description are displayed in most of the menus:

- logic editor
- matrix
- block settings
- event history
- disturbance recordings
- etc.

Table. 7.2 - 238. Digital input and output user description.

Name	Range	Default	Description
User editable description Dlx	1...31 characters	Dlx	Description of the digital input. This description is used in several menu types for easier identification.
User editable description OUTx		OUTx	Description of the digital output. This description is used in several menu types for easier identification.



NOTICE!

After editing user descriptions the event history will start to use the new description only after resetting the HMI. HMI can be reset from *General* → *Device info* → *HMI restart*.

Scanning cycle

All digital inputs are scanned in a 5 ms cycle, meaning that the state of an input is updated every 0...5 milliseconds. When an input is used internally in the device (either in setting group change or logic), it takes additional 0...5 milliseconds to operate. Theoretically, therefore, it takes 0...10 milliseconds to change the setting group when a digital input is used for group control or a similar function. In practice, however, the delay is between 2...8 milliseconds about 95 % of the time. When a digital input is connected directly to a digital output (OUT1...OUTx), it takes an additional 5 ms round. Therefore, when a digital input controls a digital output internally, it takes 0...15 milliseconds in theory and 2...13 milliseconds in practice.

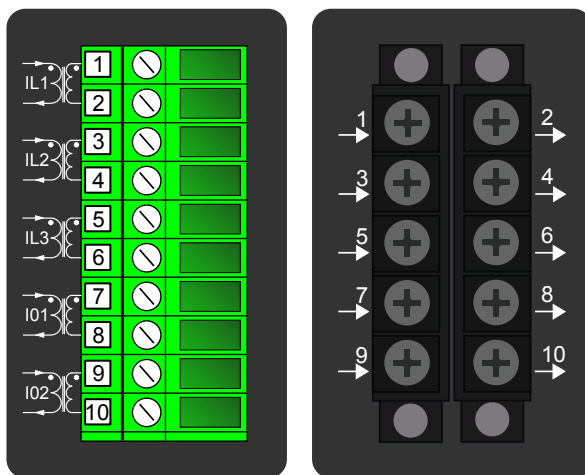


NOTICE!

The mechanical delay of the relay is **not** included in these approximations!

7.3 Current measurement module

Figure. 7.3 - 111. Module connections with standard and ring lug terminals.



Connector	Description
CTM 1-2	Phase current measurement for phase L1 (A).
CTM 3-4	Phase current measurement for phase L2 (B).
CTM 5-6	Phase current measurement for phase L3 (C).
CTM 7-8	Coarse residual current measurement IO1.
CTM 9-10	Fine residual current measurement IO2.

A basic current measurement module with five channels includes three-phase current measurement inputs as well as coarse and fine residual current inputs. The CT module is available with either standard or ring lug connectors.

The current measurement module is connected to the secondary side of conventional current transformers (CTs). The nominal current for the phase current inputs is 5 A. The input nominal current can be scaled for secondary currents of 1...10 A. The secondary currents are calibrated to nominal currents of 1 A and 5 A, which provide $\pm 0.5\%$ inaccuracy when the range is $0.005...4 \times I_n$.

The measurement ranges are as follows:

- Phase currents 25 mA...250 A (RMS)
- Coarse residual current 5 mA...150 A (RMS)
- Fine residual current 1 mA...75 A (RMS)

The characteristics of phase current inputs are as follows:

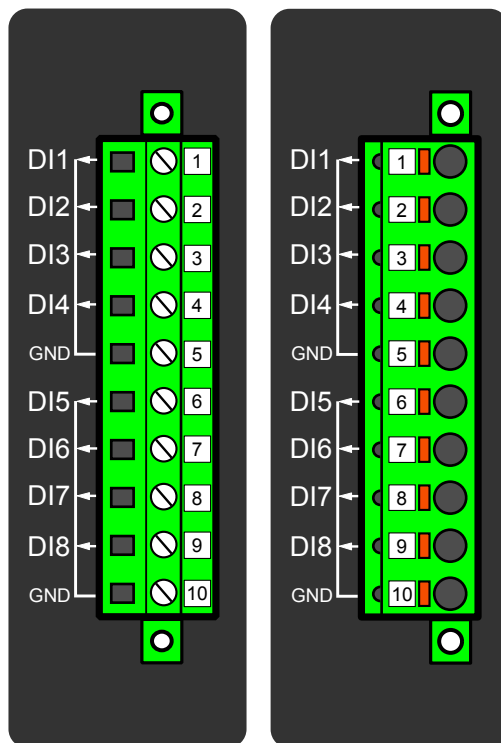
- The angle measurement inaccuracy is less than ± 0.2 degrees with nominal current.
- The frequency measurement range of the phase current inputs is 6...1800 Hz with standard hardware.
- The sample rate of the signal is 64 samples/cycle when the system frequency ranges from 6 Hz to 75 Hz.

For further details please refer to the "[Current measurement](#)" chapter in the "Technical data" section of this document.

7.4 Option cards

7.4.1 Digital input module (optional)

Figure. 7.4.1 - 112. Digital input module (DI8) with eight add-on digital inputs. Can be equipped with standard screw terminals or spring cage terminals for connection.



Connector	Description (x = the number of digital inputs in other modules that precede this one in the configuration)
X 1	DIx + 1
X 2	DIx + 2
X 3	DIx + 3
X 4	DIx + 4

Connector	Description (x = the number of digital inputs in other modules that precede this one in the configuration)
X 5	Common earthing for the first four digital inputs.
X 6	Dlx + 5
X 7	Dlx + 6
X 8	Dlx + 7
X 9	Dlx + 8
X 10	Common earthing for the other four digital inputs.

The DI8 module is an add-on module with eight (8) galvanically isolated digital inputs. This module can be ordered directly to be installed into the device in the factory, or it can be upgraded in the field after the device's original installation when required. The properties of the inputs in this module are the same as those of the inputs in the main processor module. The current consumption of the digital inputs is 2 mA when activated, while the range of the operating voltage is from 0...265 VAC/DC. The activation and release thresholds are set in the software and the resolution is 1 V. All digital inputs are scanned in 5 ms program cycles, and their pick-up and release delays as well as their NO/NC selection can be set with software.

For the naming convention of the digital inputs provided by this module please refer to the chapter titled "[Construction and installation](#)".

For technical details please refer to the chapter titled "[Digital input module](#)" in the "Technical data" section of this document.

The hardware configuration code of this module is "B". For more information, please refer to the "[Ordering information](#)" chapter of this document.

Setting up the activation and release delays

The settings described in the table below can be found at *Control* → *Device I/O* → *Digital input settings* in the device settings.

Table. 7.4.1 - 239. Digital input settings of DI8 module.

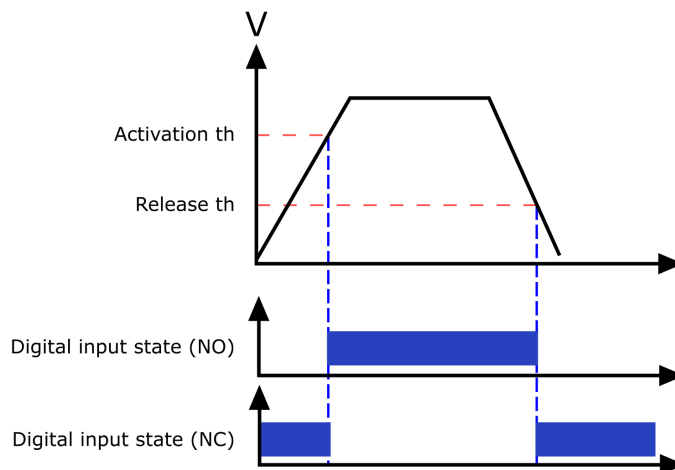
Name	Range	Step	Default	Description
Dlx Polarity	<ul style="list-style-type: none"> NO (Normally open) NC (Normally closed) 	-	NO	Selects whether the status of the digital input is 1 or 0 when the input is energized.
Dlx Activation threshold	16.0...200.0 V	0.1 V	88 V	Defines the activation threshold for the digital input. When "NO" is the selected polarity, the measured voltage exceeding this setting activates the input. When "NC" is the selected polarity, the measured voltage exceeding this setting deactivates the input.
Dlx Release threshold	10.0...200.0 V	0.1 V	60V	Defines the release threshold for the digital input. When "NO" is the selected polarity, the measured voltage below this setting deactivates the input. When "NC" is the selected polarity, the measured voltage below this setting activates the input.

Name	Range	Step	Default	Description
Dlx Activation delay	0.000...1800.000 s	0.001 s	0.000 s	Defines the delay when the status changes from 0 to 1. Not visible when DI has been set to AC mode with "Dlx AC mode" parameter.
Dlx Drop-off time	0.000...1800.000 s	0.001 s	0.000 s	Defines the delay when the status changes from 1 to 0.
Dlx AC Mode	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	Selects whether or not a 30-ms deactivation delay is added to take the alternating current into account. The "Dlx Release threshold" parameter is hidden and forced to 10 % of the set "Dlx Activation threshold" parameter.
Dlx Counter	$0 \dots 2^{32} - 1$	1	0	Displays the number of times the digital input has changed its status from 0 to 1.
Dlx Clear counter	<ul style="list-style-type: none"> - Clear 	-	-	Resets the Dlx counter value to zero.

The user can set the activation threshold individually for each digital input. When the activation and release thresholds have been set properly, they will result in the digital input states to be activated and released reliably. The selection of the normal state between normally open (NO) and normally closed (NC) defines whether or not the digital input is considered activated when the digital input channel is energized.

The diagram below depicts the digital input states when the input channels are energized and de-energized.

Figure. 7.4.1 - 113. Digital input state when energizing and de-energizing the digital input channels.



Digital input descriptions

Option card inputs can be given a description. The user defined description are displayed in most of the menus:

- logic editor
- matrix
- block settings
- event history
- disturbance recordings
- etc.

Table. 7.4.1 - 240. Digital input user description.

Name	Range	Default	Description
User editable description Dlx	1...31 characters	Dlx	Description of the digital input. This description is used in several menu types for easier identification.



NOTICE!

After editing user descriptions the event history will start to use the new description only after resetting the HMI. HMI can be reset from *General* → *Device info* → *HMI restart*.

Digital input voltage measurements

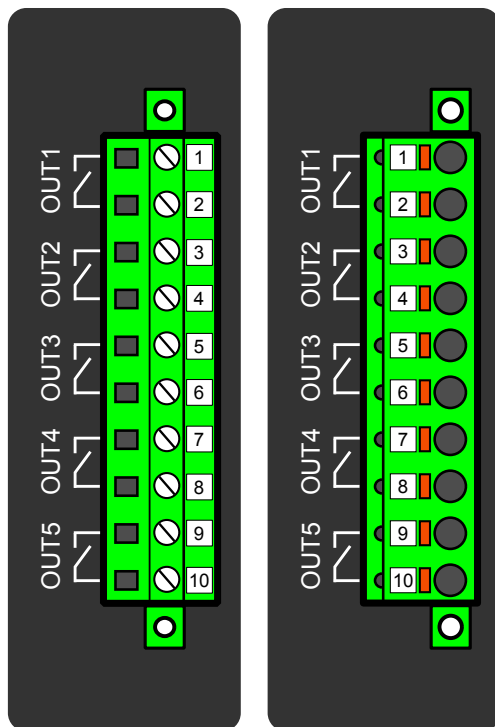
Digital input option card channels measure voltage on each channel. The measured voltage can be seen at *Control* → *Device IO* → *Digital inputs* → *Digital input voltages*.

Table. 7.4.1 - 241. Digital input channel voltage measurement.

Name	Range	Step	Description
Dlx Voltage now	0.000...275.000 V	0.001 V	Voltage measurement of a digital input channel.

7.4.2 Digital output module (optional)

Figure. 7.4.2 - 114. Digital output module (DO5) with five add-on digital outputs. Can be equipped with standard screw terminals or spring cage terminals for connection.



Connector	Description
X 1-2	OUTx + 1 (1 st and 2 nd pole NO)

Connector	Description
X 3-4	OUTx + 2 (1 st and 2 nd pole NO)
X 5-6	OUTx + 3 (1 st and 2 nd pole NO)
X 7-8	OUTx + 4 (1 st and 2 nd pole NO)
X 9-10	OUTx + 5 (1 st and 2 nd pole NO)

The DO5 module is an add-on module with five (5) mechanical type digital outputs. This module can be ordered directly to be installed into the device in the factory, or it can be upgraded in the field after the device's original installation when required. The properties of the outputs in this module are the same as those of the outputs in the main processor module. Output control logic is user configurable. All digital outputs are controlled in 5 ms program cycles. The rated voltage of the outputs is 250 VAC/DC.

For the naming convention of the digital outputs provided by this module please refer to the chapter titled "[Construction and installation](#)".

For technical details please refer to the chapter titled "[Digital output module](#)" in the "Technical data" section of this document.

The hardware configuration code of this module is "C". For more information, please refer to the "[Ordering information](#)" chapter of this document.

Digital output settings

The parameters described in the table below can be found at *Control* → *Device I/O* → *Digital Outputs* → *Digital Output Settings* in the device settings.

Table. 7.4.2 - 242. Digital output user description.

Name	Range	Default	Description
OUTx Polarity	<ul style="list-style-type: none"> • NO • NC 	NO	<p>Digital outputs are configured as "normally open" relays by default. Each output can be changed to "normally closed" using the "OUTx Polarity" parameter. Please note that this change is implemented in software only. If the device is powered off, the outputs will revert to an open state and return to the configured polarity once power is restored.</p> <p>If a truly "normally closed" contact is required, use the changeover relay OUT5 available in the CPU module of the device.</p>

Digital output descriptions

Option card outputs can be given a description. The user defined description are displayed in most of the menus:

- logic editor
- matrix
- block settings
- event history
- disturbance recordings
- etc.

The parameters described in the table below can be found at *Control* → *Device I/O* → *Digital Outputs* → *Digital Output Descriptions* in the device settings.

Table. 7.4.2 - 243. Digital output user description.

Name	Range	Default	Description
User editable description OUTx	1...31 characters	OUTx	Description of the digital output. This description is used in several menu types for easier identification.

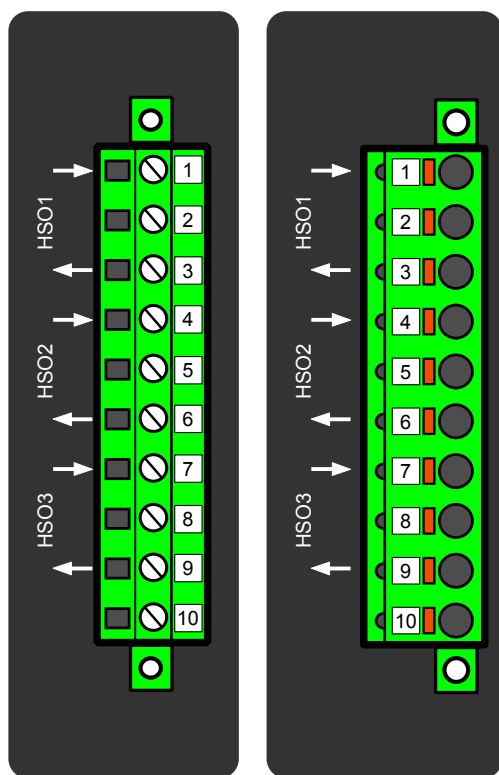


NOTICE!

After editing user descriptions the event history will start to use the new description only after resetting the HMI. HMI can be reset from *General* → *Device info* → *HMI restart*.

7.4.3 High-speed and high-current output module (optional)

Figure. 7.4.3 - 115. High-speed and high-current output module with three add-on high-speed outputs. Can be equipped with standard screw terminals or spring cage terminals for connection.



Connector	Description
X 1	HSOx + 1 in
X 2	N/A
X 3	HSOx + 1 out
X 4	HSOx + 2 in
X 5	N/A
X 6	HSOx + 2 out
X 7	HSOx + 3 in

Connector	Description
X 8	N/A
X 9	HSOx + 3 out
X 10	N/A

The high-speed and high-current module is an add-on module with three (3) hybrid outputs consisting of a semiconductor and a relay connected in parallel. This module can be ordered directly to be installed into the device in the factory, or it can be upgraded in the field after the device's original installation when required. Output control logic is user configurable. All high-speed outputs are controlled in 1 ms program cycles.

For technical details please refer to the chapter titled "[High-speed output module](#)" in the "Technical data" section of this document.

The hardware configuration code of this module is "R". For more information, please refer to the "[Ordering information](#)" chapter of this document.

HSO Input Settings menu

The parameters described in the table below can be found at *Control* → *Device I/O* → *HSO Inputs* → *HSO Input Settings* in the device settings.

Table. 7.4.3 - 244. HSO input parameters.

Name	Range	Step	Default	Description
HSO1...9 TCS Polarity	NC (Normally closed)	-	NC	The inputs on high-speed output cards are normally closed contacts, meaning they remain in the closed state under normal conditions and indicate '0' when the circuit is energized.
HSO1...9 TCS Drop-off time	0.000...1800.000 s	0.001 s	0.200 s	Defines the delay when the status changes from 0 to 1.
HSO1...9 TCS AC Mode	<ul style="list-style-type: none"> Disabled Enabled 	-	Disabled	Selects whether or not a 30 ms deactivation delay is added to take the alternating current into account. The "DIx Release threshold" parameter is hidden and forced to 10 % of the set "DIx Activation threshold" parameter.
HSO1...9 TCS Counter	0...4294967295	1	0	Displays the number of times the input has changed its status from 0 to 1.
HSO1...9 TCS Clear counter	<ul style="list-style-type: none"> - Clear 	-	-	Resets the input activation counter value to zero.

HSO Output Settings menu

The parameters described in the table below can be found at *Control* → *Device I/O* → *HSO Outputs* → *HSO Output Settings* in the device settings.

Table. 7.4.3 - 245. HSO output parameters.

Name	Range	Step	Default	Description
HSO1...9 Polarity	<ul style="list-style-type: none"> • NO • NC 	-	NO	The inputs on high-speed output cards are normally closed contacts, meaning they remain in the closed state under normal conditions and indicate '0' when the circuit is energized.

HSO output and input descriptions

Option card outputs and inputs can be given a description. The user defined description are displayed in most of the menus:

- logic editor
- matrix
- block settings
- event history
- disturbance recordings
- etc.

Table. 7.4.3 - 246. HSO input and output user description.

Name	Range	Default	Description
User editable description HSOx	1...31 characters	HSOx	Description of the high-speed output. This description is used in several menu types for easier identification.
User editable description HSO1...9 TCS	1...31 characters	HSO1...9 TCS	Description of the high-speed output. This description is used in several menu types for easier identification.

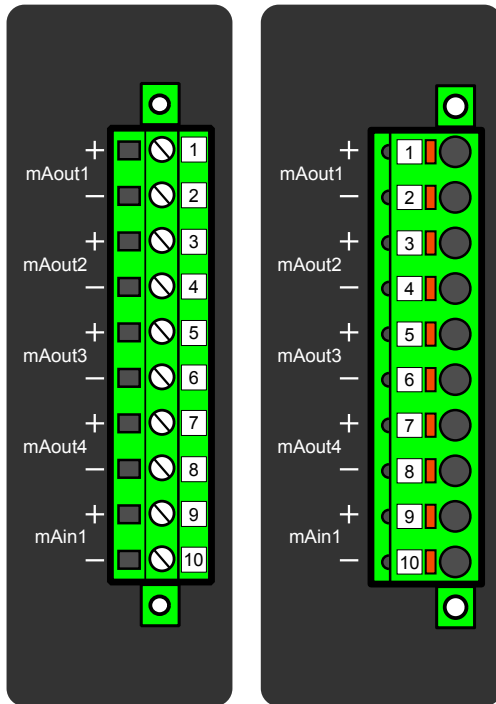


NOTICE!

After editing user descriptions the event history will start to use the new description only after resetting the HMI. HMI can be reset from *General* → *Device info* → *HMI restart*.

7.4.4 Milliampere output module (4x mA out & 1x mA in) (optional)

Figure. 7.4.4 - 116. Milliampere output (mA) I/O module connections. Can be equipped with standard screw terminals or spring cage terminals for connection.



Connector	Description
Pin 1	mA OUT 1 + connector (0...24 mA)
Pin 2	mA OUT 1 – connector (0...24 mA)
Pin 3	mA OUT 2 + connector (0...24 mA)
Pin 4	mA OUT 2 – connector (0...24 mA)
Pin 5	mA OUT 3 + connector (0...24 mA)
Pin 6	mA OUT 3 – connector (0...24 mA)
Pin 7	mA OUT 4 + connector (0...24 mA)
Pin 8	mA OUT 4 – connector (0...24 mA)
Pin 9	mA IN 1 + connector (0...33 mA)
Pin 10	mA IN 1 – connector (0...33 mA)

The milliampere output (mA) I/O module is an add-on module with four (4) mA outputs and one (1) mA input. Both the outputs and the input are in two galvanically isolated groups, with one pin for the positive (+) connector and one pin for the negative (–) connector.

This module can be ordered directly to be installed into the device in the factory, or it can be upgraded in the field after the device's original installation when required.

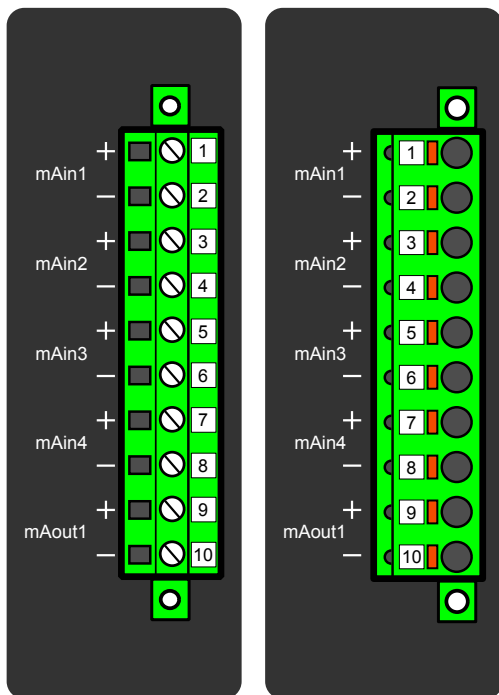
The user sets the mA I/O with the mA outputs control function. This can be done at *Control* → *Device I/O* → *mA outputs* in the device configuration settings.

For further information please refer to the chapter titled "[Milliampere output module \(4 x mA out & 1 x mA in\)](#)" in the "Technical data" section of this manual.

The hardware configuration code of this module is "I". For more information, please refer to the "[Ordering information](#)" chapter of this document.

7.4.5 Milliampere input module (4x mA in & 1x mA out) (optional)

Figure. 7.4.5 - 117. Milliampere input (mA) I/O module connections. Can be equipped with standard screw terminals or spring cage terminals for connection.



Connector	Description
Pin 1	mA IN 1 + connector (0...24 mA)
Pin 2	mA IN 1 – connector (0...24 mA)
Pin 3	mA IN 2 + connector (0...24 mA)
Pin 4	mA IN 2 – connector (0...24 mA)
Pin 5	mA IN 3 + connector (0...24 mA)
Pin 6	mA IN 3 – connector (0...24 mA)
Pin 7	mA IN 4 + connector (0...24 mA)
Pin 8	mA IN 4 – connector (0...24 mA)
Pin 9	mA OUT 1 + connector (0...33 mA)
Pin 10	mA OUT 1 – connector (0...33 mA)

The milliampere input (mA) I/O module is an add-on module with four (4) mA inputs and one (1) mA output. Both the inputs and the output are in two galvanically isolated groups, with one pin for the positive (+) connector and one pin for the negative (–) connector.

This module can be ordered directly to be installed into the device in the factory, or it can be upgraded in the field after the device's original installation when required.

The user sets the mA I/O with the mA output control function. This can be done at *Control* → *Device I/O* → *mA outputs* in the device configuration settings.

For further information please refer to the chapter titled "[Milliampere input module \(1x mA out & 4x mA in\)](#)" in the "Technical data" section of this manual.

The hardware configuration code of this module is "T". For more information, please refer to the "[Ordering information](#)" chapter of this document.

7.4.6 Point sensor arc protection module (optional)

Figure. 7.4.6 - 118. Arc protection module. Can be equipped with standard screw terminals or spring cage terminals for connection.

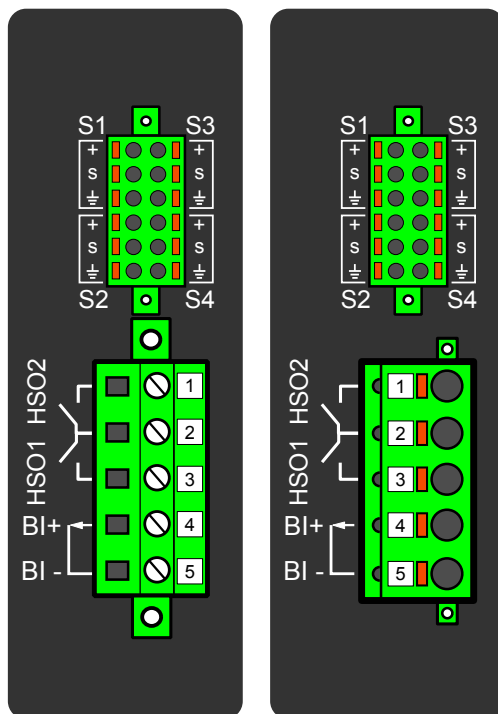


Table. 7.4.6 - 247. Module connections.

Connector	Description
S1	Light sensor channels 1...4 with positive ("+"), sensor ("S") and earth connectors.
S2	
S3	
S4	
X 1	HSO2 (+, NO)
X 2	Common battery positive terminal (+) for the HSOs.
X 3	HSO1 (+, NO)

Connector	Description
X 4	Binary input 1 (+ pole)
X 5	Binary input 1 (– pole)

The arc protection module is an add-on module with four (4) light sensor channels, two (2) high-speed semiconductor outputs and one (1) binary input. This module can be ordered directly to be installed into the device in the factory, or it can be upgraded in the field after the device's original installation when required. Each channel can have up to three (3) light sensors serially connected to it.

High-speed outputs can be used as signaling outputs. HSO1 and HSO2 can send overcurrent or light information to external AQ 100 or AQ 250 series devices.

The rated voltage of the binary input is 24 VDC. The pick-up threshold is ≥ 16 VDC. The binary input can be used for receiving external light signal or other signals related to arc protection applications. Please note that the binary input's delay is 5...10ms.



NOTICE!

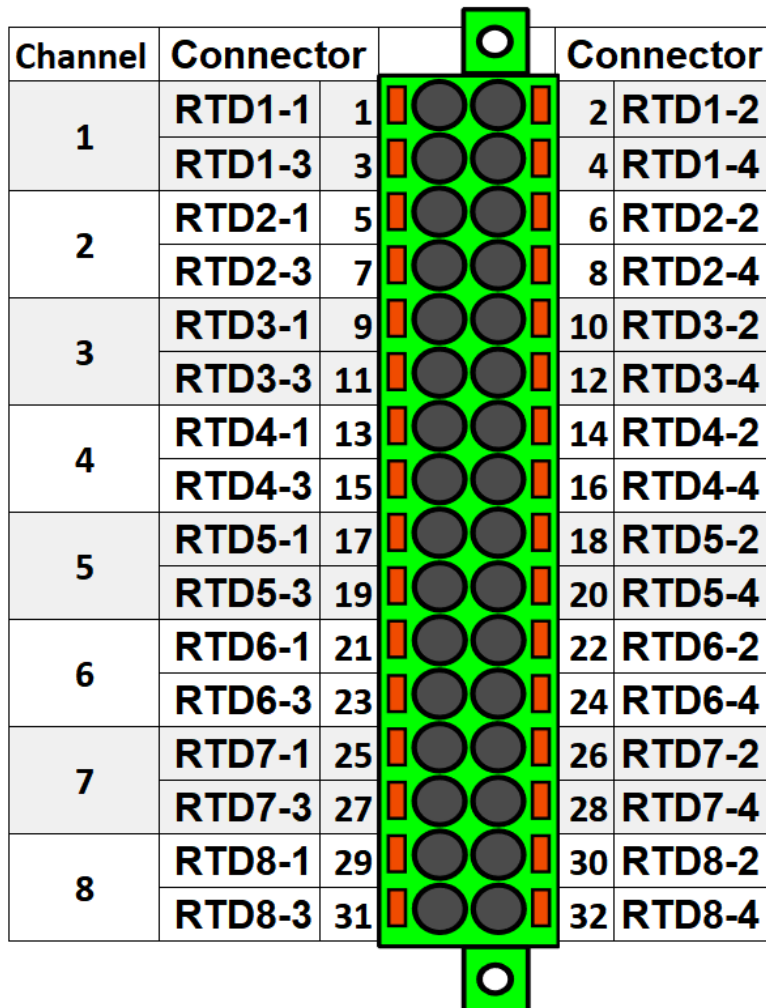
BI1, HSO1 and HSO2 are not visible in the *Binary inputs* and *Binary outputs* menus (*Control* → *Device I/O*), they can only be programmed in the arc protection function matrix menu (*Protection* → *Arc protection* → *I/O* → *Direct output control* and *HSO control*).

For further information please refer to the chapter titled "[Point sensor arc protection module](#)" in the "Technical data" section of this manual.

The hardware configuration code of this module is "D". For more information, please refer to the "[Ordering information](#)" chapter of this document.

7.4.7 RTD input module (optional)

Figure. 7.4.7 - 119. RTD input module connectors.

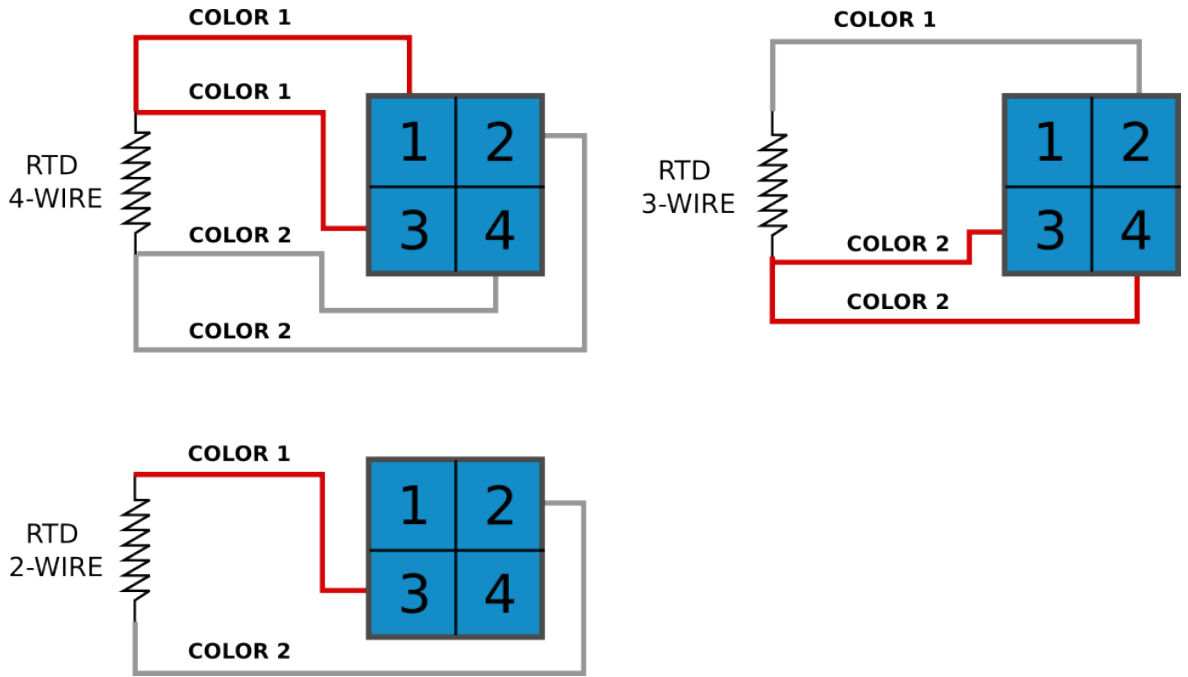


The RTD input module is an add-on module with eight (8) RTD input channels. Each input supports 2-wire, 3-wire and 4-wire RTD sensors. The sensor type can be selected with software for two groups, four channels each. The card supports Pt100 and Pt1000 sensors.

For further information please refer to the chapter titled "[RTD input module](#)" in the "Technical data" section of this manual.

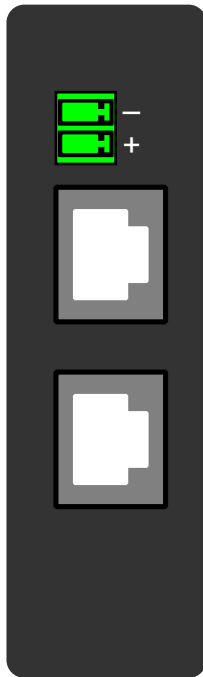
The hardware configuration code of this module is "F". For more information, please refer to the "[Ordering information](#)" chapter of this document.

Figure. 7.4.7 - 120. RTD sensor connection types.



7.4.8 Double RJ45 Ethernet & IRIG-B communication module (optional)

Figure. 7.4.8 - 121. Double RJ-45 10/100 Mbps Ethernet communication module.



Connector	Description
Two-pin connector	<ul style="list-style-type: none"> IRIG-B input
RJ-45 connectors	<ul style="list-style-type: none"> Two Ethernet ports RJ-45 connectors 10BASE-T and 100BASE-TX

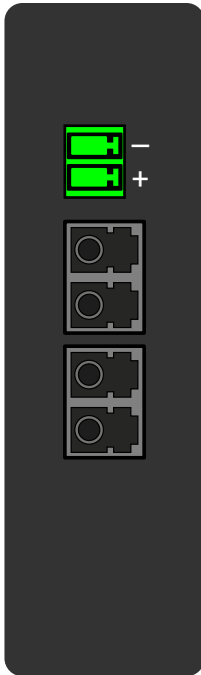
This option card supports daisy chain configurations.

For further information please refer to the chapter titled "[Double RJ45 Ethernet & IRIG-B communication module](#)" in the "Technical data" section of this manual.

The hardware configuration code of this module is "G". For more information, please refer to the "[Ordering information](#)" chapter of this document.

7.4.9 Double SFP Ethernet & IRIG-B communication module (optional)

Figure. 7.4.9 - 122. Double SFP 100 Mbps Ethernet communication module.



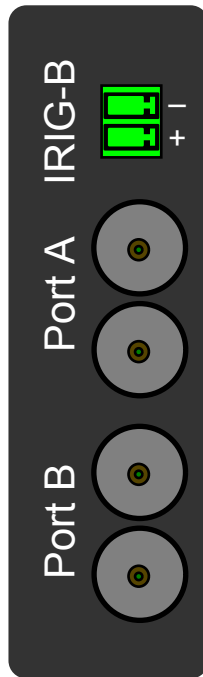
Connector	Description
Two-pin connector	<ul style="list-style-type: none"> IRIG-B input
SFP slots	<ul style="list-style-type: none"> Two SFP slots Compatible SFP modules available as accessories

For further information please refer to the chapter titled "[Double SFP Ethernet & IRIG-B communication module](#)" in the "Technical data" section of this manual.

The hardware configuration code of this module is "Q". For more information, please refer to the "[Ordering information](#)" chapter of this document.

7.4.10 Double ST 100 Ethernet & IRIG-B communication module (optional)

Figure. 7.4.10 - 123. Double ST 100 Mbps Ethernet communication module connectors.



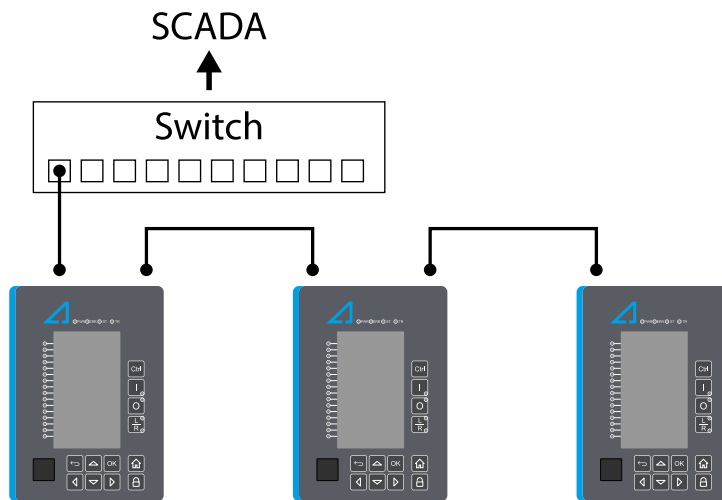
Connector	Description
Two-pin connector	<ul style="list-style-type: none"> IRIG-B input
ST connectors	<ul style="list-style-type: none"> Duplex ST connectors 62.5/125 μm or 50/125 μm multimode fiber Transmitter wavelength: 1260...1360 nm (nominal: 1310 nm) Receiver wavelength: 1100...1600 nm 100BASE-FX Up to 2 km

This option cards supports redundant ring configuration and multidrop configurations. Please note that each ring can only contain AQ 250 series devices, and any third party devices must be connected to a separate ring.

For further information please refer to the chapter titled "[Double ST Ethernet & IRIG-B communication module](#)" in the "Technical data" section of this manual.

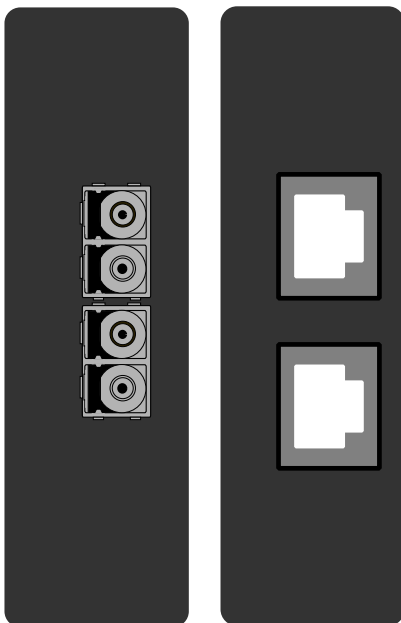
The hardware configuration code of this module is "H". For more information, please refer to the "[Ordering information](#)" chapter of this document.

Figure. 7.4.10 - 124. Example of a multidrop configuration.



7.4.11 Double LC or RJ45 (HSR/PRP) Ethernet communication module (optional)

Figure. 7.4.11 - 125. LC and RJ45 100 Mbps Ethernet module connectors.



Card type	Description
LC ports	<ul style="list-style-type: none"> • Communication port D, 100 Mbps LC fiber connector. • 62.5/125 μm or 50/125 μm multimode (glass). • Wavelength 1300 nm. • HSR and PRP protocols supported.
RJ45	<ul style="list-style-type: none"> • RJ-45 connectors. • 10BASE-T and 100BASE-TX. • HSR and PRP protocols supported.

For further information please refer to the chapters titled "[Double LC \(HSR/PRP\) Ethernet communication module](#)" and "[Double RJ45 \(HSR/PRP\) Ethernet communication module](#)" in the "Technical data" section of this manual.

The hardware configuration codes of these modules are "J" (Double LC 100Mb Ethernet) and "K" (Double RJ45 100Mb Ethernet). For more information, please refer to the "[Ordering information](#)" chapter of this document.

7.4.12 Serial RS-232 communication module (optional)

Figure. 7.4.12 - 126. Serial RS-232 module connectors.

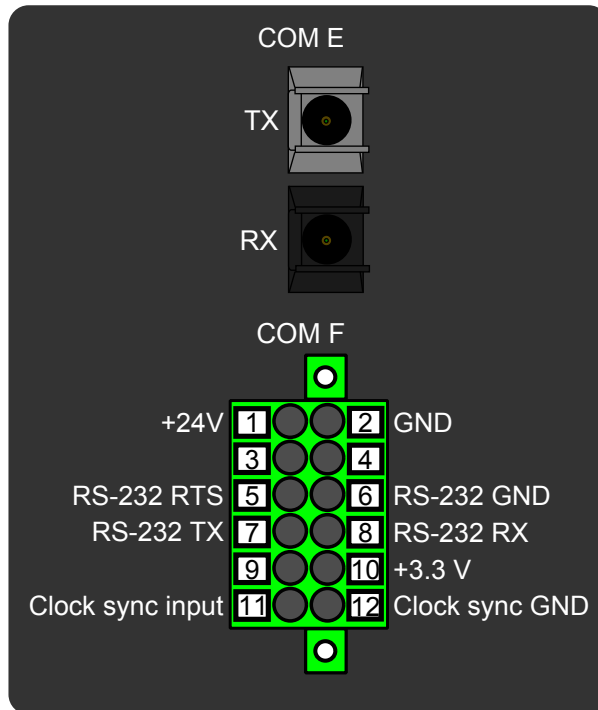


Table. 7.4.12 - 248. Module connections.

Connector	Pin	Name	Description
COM E	-	Serial fiber	<ul style="list-style-type: none"> Serial-based communications Port options: <ul style="list-style-type: none"> Glass/glass Plastic/plastic Glass/plastic Plastic/glass Wavelength 660 nm Compatible with 50/125 μm, 62.5/125 μm, 100/140 μm, and 200 μm Plastic-Clad Silica (PCS) fiber Compatible with ST connectors
COM F	1	+24 V input	Optional external auxiliary voltage for serial fiber.
	2	GND	
	3	-	Not in use.
	4	-	

Connector	Pin	Name	Description
	5	RS-232 RTS	Serial based communications.
	6	RS-232 GND	
	7	RS-232 TX	
	8	RS-232 RX	
	9	-	Not in use.
	10	+3.3 V output (spare)	Spare power source for external equipment (45 mA).
	11	Clock sync input	Clock synchronization input (supports IRIG-B).
	12	Clock sync GND	

The option card includes two serial communication interfaces: COM E is a serial fiber interface with glass/glass, plastic/plastic, glass/plastic and plastic/glass options, COM F is an RS-232 interface.

For further information please refer to the chapter titled "[RS-232 & serial fiber communication module](#)" in the "Technical data" section of this manual.

The hardware configuration codes of these modules are "L", "M", "N" and "O". For more information, please refer to the "[Ordering information](#)" chapter of this document.

7.5 Dimensions and installation

The device can be installed either to a standard 19" rack or to a switchgear panel with cutouts. The desired installation type is defined in the order code.

The figures below describe the device dimensions (first figure), the device installation (second), and the panel cutout dimensions and device spacing (third).

Figure. 7.5 - 127. Device dimensions.

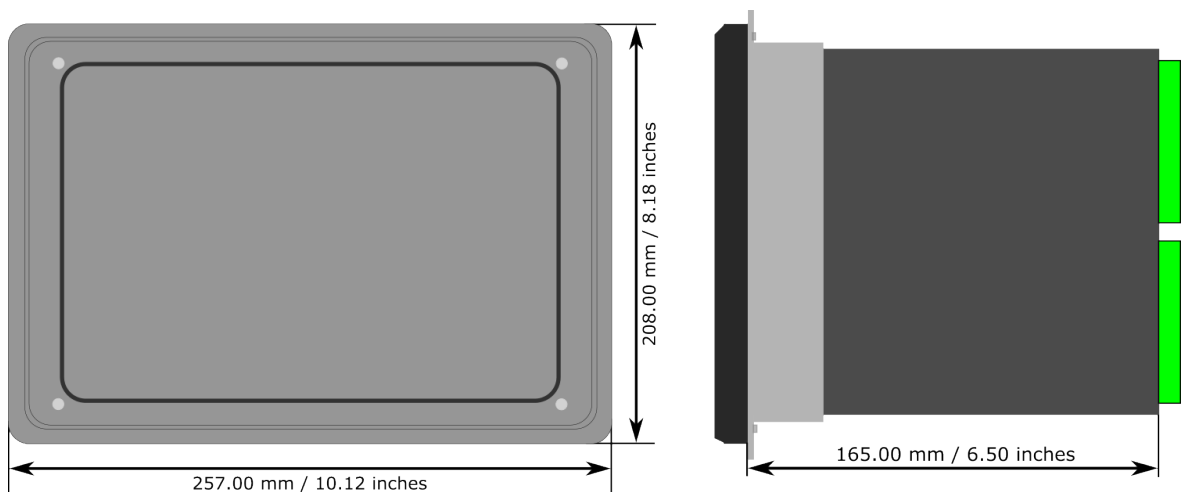


Figure. 7.5 - 128. Device installation.

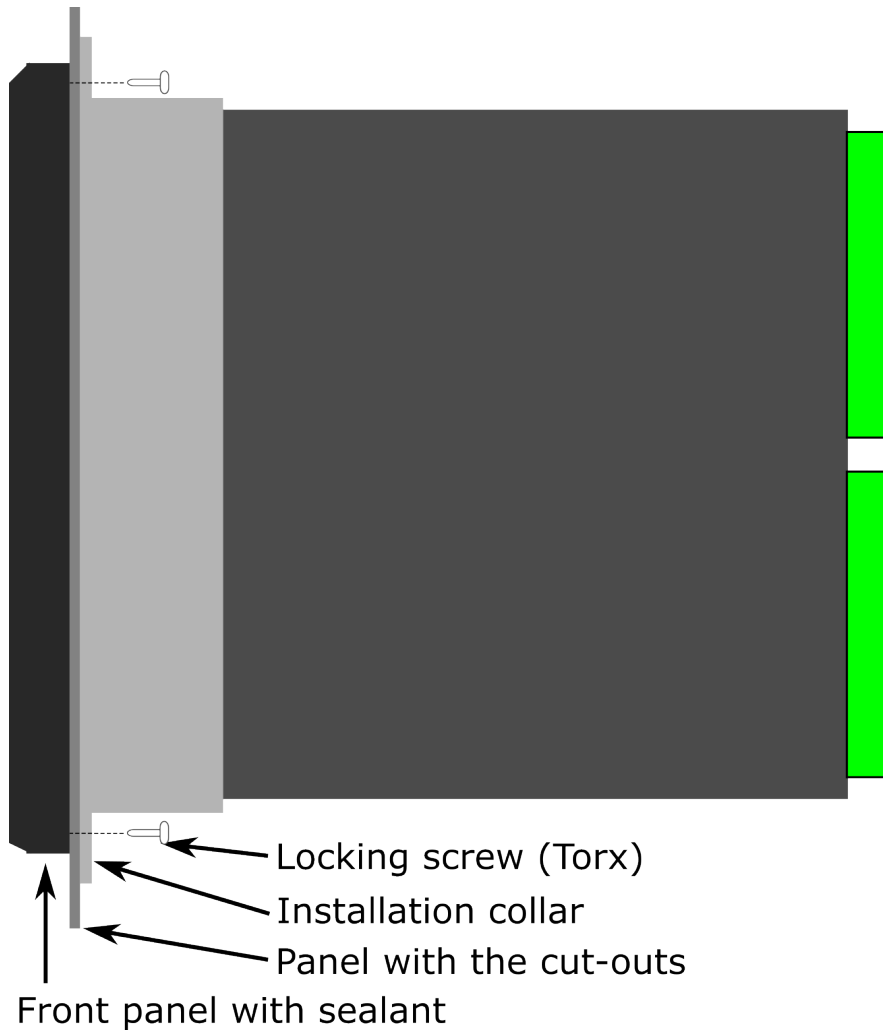
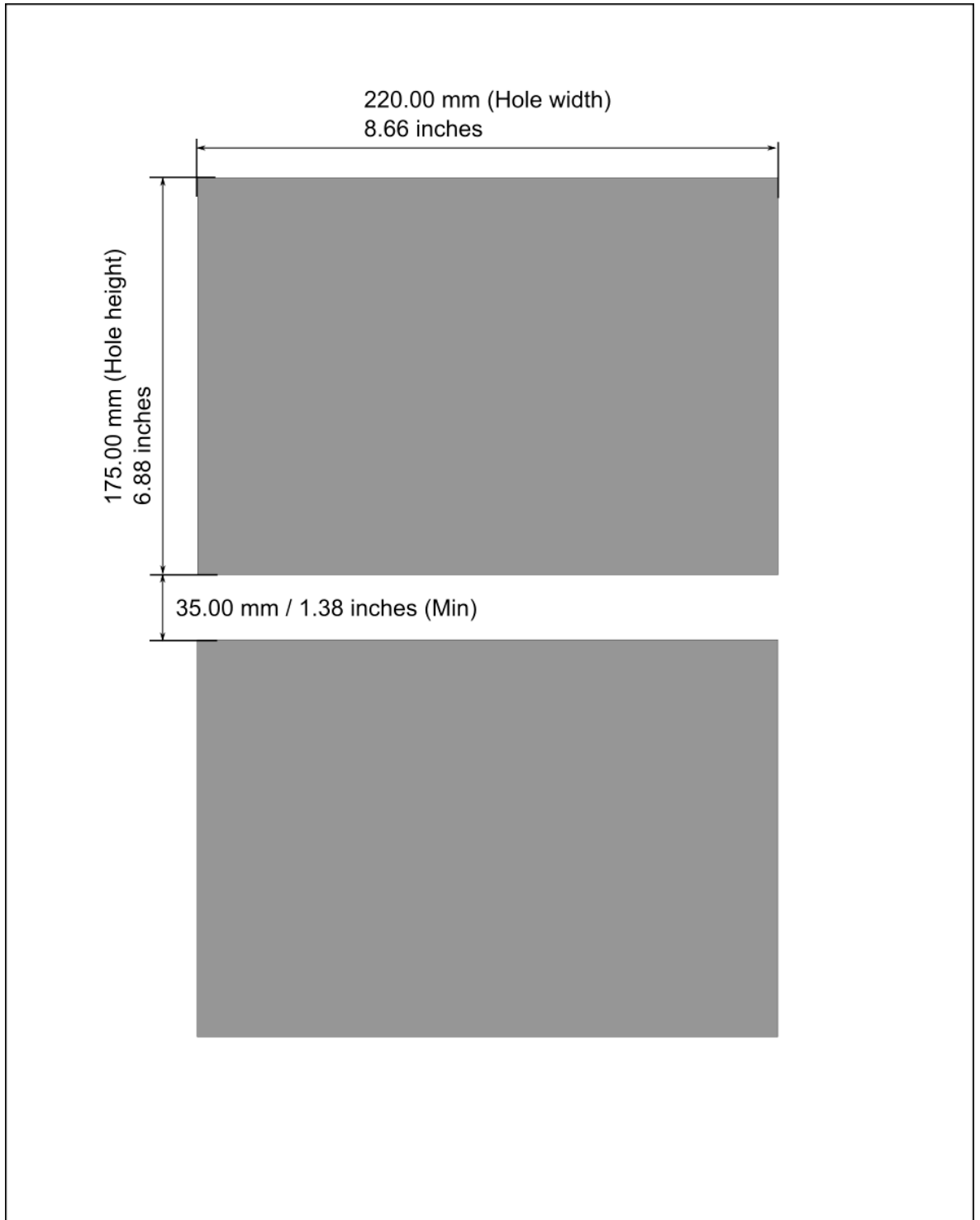


Figure. 7.5 - 129. Panel cut-out and spacing of the devices.



8 Technical data

8.1 Hardware

8.1.1 Measurements

8.1.1.1 Current measurement

Table. 8.1.1.1 - 249. Technical data for the current measurement module.

General information	
Spare part code	#SP-2XX-CM
Compatibility	AQ 210 series AQ 250 series AQ-ONE
Connections	
Measurement channels/CT inputs	Three phase current inputs: IL1 (A), IL2 (B), IL3 (C) Two residual current inputs: Coarse residual current input I01, Fine residual current input I02
Phase current inputs (A, B, C)	
Sample rate	64 samples per cycle in frequency range 6...75Hz
Rated current I_N	5 A (configurable 0.2...10 A)
Thermal withstand	20 A (continuous) 100 A (for 10 s) 500 A (for 1 s) 1250 A (for 0.01 s)
Frequency measurement range	From 6...75Hz fundamental, up to the 31 st harmonic current
Current measurement range	5 mA...250 A (RMS)
Current measurement inaccuracy	$0.005...4.000 \times I_N < \pm 0.5 \%$ or $< \pm 15 \text{ mA}$ $4...20 \times I_N < \pm 0.5 \%$ $20...50 \times I_N < \pm 1.0 \%$
Angle measurement inaccuracy	$< \pm 0.2^\circ$ ($I > 0.1 \text{ A}$) $< \pm 1.0^\circ$ ($I \leq 0.1 \text{ A}$)
Burden (50/60 Hz)	$< 0.1 \text{ VA}$
Transient overreach	$< 8 \%$
Coarse residual current input (I01)	
Rated current I_N	1 A (configurable 0.1...10 A)

Thermal withstand	25 A (continuous) 100 A (for 10 s) 500 A (for 1 s) 1250 A (for 0.01 s)
Frequency measurement range	From 6...75 Hz fundamental, up to the 31 st harmonic current
Current measurement range	5 mA...150 A (RMS)
Current measurement inaccuracy	0.002...10.000 × I _N < ±0.5 % or < ±3 mA 10...150 × I _N < ±0.5 %
Angle measurement inaccuracy	< ±0.2° (I > 0.05 A) < ±1.0° (I ≤ 0.05 A)
Burden (50/60Hz)	<0.1 VA
Transient overreach	<5 %
Fine residual current input (I02)	
Rated current I _N	0.2 A (configurable 0.001...10 A)
Thermal withstand	25 A (continuous) 100 A (for 10 s) 500 A (for 1 s) 1250 A (for 0.01 s)
Frequency measurement range	From 6...75 Hz fundamental, up to the 31 st harmonic current
Current measurement range	1 mA...75 A (RMS)
Current measurement inaccuracy	0.002...25.000 × I _N < ±0.5 % or < ±0.6 mA 25...375 × I _N < ±1.0 %
Angle measurement inaccuracy	< ±0.2° (I > 0.01 A) < ±1.0° (I ≤ 0.01 A)
Burden (50/60Hz)	<0.1 VA
Transient overreach	<5 %
Screw connection terminal block (standard)	
Nominal cross section (solid or stranded wire)	4 mm ²
Ring lug terminal block connection (option)	
Ring terminal dimensions	Max 8mm diameter, with minimum 3,5mm screw hole

**NOTICE!**

Current measurement accuracy has been verified with 50/60 Hz.

The amplitude difference is 0.2 % and the angle difference is 0.5 degrees higher at 16.67 Hz and other frequencies.

8.1.1.2 Frequency measurement

Table. 8.1.1.2 - 250. Frequency measurement accuracy.

Frequency measurement performance	
Frequency measuring range	6...75 Hz fundamental, up to the 31 st harmonic current or voltage
Inaccuracy	10 mHz

8.1.2 CPU & Power supply

Table. 8.1.2 - 251. General information for the CPU module.

General information	
Spare part code	#SP-250-CPU
Compatibility	AQ 210 series AQ 250 series AQ-ONE
Terminal block connection	
Solid or stranded wire Nominal cross section	2.5 mm ²
RS-485 serial terminal block connection	
Maximum cross section (solid or stranded wire)	1.5 mm ²

8.1.2.1 Auxiliary voltage

Table. 8.1.2.1 - 252. Power supply model A

Rated values	
Rated auxiliary voltage	80...265 V (AC/DC)
Power consumption	< 20 W (no option cards) < 40 W (maximum number of option cards)
Maximum permitted interrupt time	< 40 ms with 110 VDC
DC ripple	< 15 %
Other	
Minimum recommended fuse rating	MCB C2

Table. 8.1.2.1 - 253. Power supply model B

Rated values	
--------------	--

Rated auxiliary voltage	18...72 VDC
Power consumption	< 20 W (no option cards) < 40 W (maximum number of option cards)
Maximum permitted interrupt time	< 40 ms with 24 VDC
DC ripple	< 15 %
Other	
Minimum recommended fuse rating	MCB C2

8.1.2.2 CPU communication ports

Table. 8.1.2.2 - 254. Front panel local communication port.

Port	
Port media	Copper Ethernet RJ-45
Number of ports	1
Port protocols	PC-protocols FTP
Features	
Data transfer rate	100 MB/s
System integration	Can't be used for system protocols, only for local programming

Table. 8.1.2.2 - 255. Rear panel system communication port A.

Port	
Port media	Copper Ethernet RJ-45
Number of ports	1
Features	
Port protocols	IEC 61850 (1st edition) IEC61850 (2nd edition) IEC 104 Modbus/TCP DNP3 FTP
Data transfer rate	100 MB/s
System integration	Can be used for system protocols and for local programming

Table. 8.1.2.2 - 256. Rear panel system communication port B.

Port

Port media	Copper RS-485
Number of ports	1
Features	
Port protocols	Modbus/RTU IEC 103 IEC 101 DNP3 SPA
Data transfer rate	65 580 kB/s
System integration	Can be used for system protocols

8.1.2.3 CPU digital inputs

Table. 8.1.2.3 - 257. CPU model-isolated digital inputs, with thresholds defined by order code.

Rated values	
Rated auxiliary voltage	265 V (AC/DC)
Nominal voltage	Order code defined: 24, 110, 220 V (AC/DC)
Pick-up threshold Release threshold	Order code defined: 19, 90, 170 V Order code defined: 14, 65, 132 V
Scanning rate	5 ms
Settings	
Pick-up delay	Software settable: 0...1800 s
Polarity	Software settable: Normally On/Normally Off
Current drain	2 mA

8.1.2.4 CPU digital outputs

Table. 8.1.2.4 - 258. Digital outputs (Normally Open)

Rated values	
Rated auxiliary voltage	265 V (AC/DC)
Continuous carry	5 A
Make and carry 0.5 s Make and carry 3 s	30 A 15 A
Breaking capacity, DC (L/R = 40 ms) at 48 VDC at 110 VDC at 220 VDC	1 A 0.4 A 0.2 A

Control rate	5 ms
Settings	
Polarity	Software settable: Normally Open / Normally Closed

Table. 8.1.2.4 - 259. Digital outputs (Change-Over)

Rated values	
Rated auxiliary voltage	265 V (AC/DC)
Continuous carry	2.5 A
Make and carry 0.5 s Make and carry 3 s	30 A 15 A
Breaking capacity, DC (L/R = 40 ms) at 48 VDC at 110 VDC at 220 VDC	1 A 0.3 A 0.15 A
Control rate	5 ms
Settings	
Polarity	Software settable: Normally Open / Normally Closed

**CAUTION!**

Please note, that signaling relay 5 and system fault's signaling relay are designed only for signaling purposes, and are not to be used in trip coil control.

8.1.3 Option cards

8.1.3.1 Digital input module

Table. 8.1.3.1 - 260. Technical data for the digital input module.

Spare part code	#SP-250-DI8
Compatibility	AQ 210 series models AQ 250 series models AQ-ONE
Rated values	
Rated auxiliary voltage	5...265 V (AC/DC)
Current drain	2 mA
Scanning rate Activation/release delay	5 ms 5...11 ms
Settings	

Pick-up threshold Release threshold	Software settable: 16...200 V, setting step 1 V Software settable: 10...200 V, setting step 1 V
Pick-up delay	Software settable: 0... 1800 s
Drop-off delay	Software settable: 0... 1800 s
Polarity	Software settable: Normally On/Normally Off
Terminal block connection	
Solid or stranded wire Nominal cross section	2.5 mm ²

8.1.3.2 Digital output module

Table. 8.1.3.2 - 261. Technical data for the digital output module.

Spare part code	#SP-250-DO5
Compatibility	AQ 210 series models AQ 250 series models AQ-ONE
Rated values	
Rated auxiliary voltage	265 V (AC/DC)
Continuous carry	5 A
Make and carry 0.5 s Make and carry 3 s	30 A 15 A
Breaking capacity, DC (L/R = 40 ms) at 48 VDC at 110 VDC at 220 VDC	1 A 0.4 A 0.2 A
Control rate	5 ms
Settings	
Polarity	Software settable: Normally On/Normally Off
Terminal block connection	
Maximum cross section (solid or stranded wire)	2.5 mm ²

8.1.3.3 High-speed and high-current output module

Table. 8.1.3.3 - 262. Technical data for the high-speed and high-current output module.

Spare part code	#SP-250-HSO
Compatibility	AQ 250 series models AQ-ONE

High-speed output rated values	
Rated auxiliary voltage	265 V (AC/DC)
Continuous carry	10 A
Make and carry 0.5 s Make and carry 3 s	30 A 15 A
Breaking capacity, DC (L/R = 40 ms) at 48 VDC at 110 VDC at 220 VDC	10 A
Control rate	1 ms
Operating time	Typically under 4 ms
Trip Circuit Supervision input rated values	
Rated auxiliary voltage	265 V (AC/DC)
Nominal voltage	Order code defined: 24, 110, 220 V (AC/DC)
Pick-up threshold	Order code defined: 19, 90, 170 V
Release threshold	Order code defined: 14, 65, 132 V
Scanning rate	5 ms
High-speed output settings	
Polarity	Software settable: Normally On/Normally Off
Trip Circuit Supervision input settings	
Release delay	Software settable: 0.000...1800.000 s
Polarity	Normally Closed
Current drain	2 mA
Terminal block connection	
Maximum cross section (solid or stranded wire)	2.5 mm ²

8.1.3.4 Milliampere output module (4 x mA out & 1 x mA in)

Table. 8.1.3.4 - 263. Technical data for the milliampere output module.

Spare part code	#SP-2XX-MA
Compatibility	AQ 210 series models AQ 250 series models AQ-ONE
Signals	
Output magnitudes Input magnitudes	4 x mA output signal (DC) 1 x mA input signal (DC)

mA input	
Range (hardware)	0...33 mA
Range (measurement)	0...24 mA
Inaccuracy	±0.1 mA
Update cycle	5...10 000 ms, setting step 5 ms
Response time at 5 ms cycle	~ 15 ms (13...18 ms)
Update cycle time inaccuracy	Max. +20 ms above the set cycle
mA input scaling range	0...4000 mA
Output scaling range	-1 000 000.0000...1 000 000.0000, setting step 0.0001
mA output	
Inaccuracy at 0...24 mA	±0.01 mA
Response time at 5 ms cycle [fixed]	< 5 ms
mA output scaling range	0...24 mA, setting step 0.001 mA
Source signal scaling range	-1 000 000.000...1 000 000.0000, setting step 0.0001
Terminal block connection	
Maximum cross section (solid or stranded wire)	2.5 mm ²

8.1.3.5 Milliampere input module (1x mA out & 4x mA in)

Table. 8.1.3.5 - 264. Technical data for the milliampere input module.

Spare part code	#SP-250-MAIN
Compatibility	AQ 250 series models AQ-ONE
Signals	
Input magnitudes	4 × mA input signal (DC)
Output magnitudes	1 × mA output signal (DC)
mA input	
Range (hardware)	0...33 mA
Range (measurement)	0...24 mA
Inaccuracy	±0.1 mA
Update cycle	5...10 000 ms, setting step 5 ms
Response time at 5 ms cycle	~ 15 ms (13...18 ms)
Update cycle time inaccuracy	Max. +20 ms above the set cycle
mA input scaling range	0...4000 mA
Output scaling range	-1 000 000.0000...1 000 000.0000, setting step 0.0001
mA output	
Inaccuracy at 0...24 mA	±0.01 mA
Response time at 5 ms cycle [fixed]	< 5 ms

mA output scaling range	0...24 mA, setting step 0.001 mA
Source signal scaling range	-1 000 000.000...1 000 000.0000, setting step 0.0001
Terminal block connection	
Maximum cross section (solid or stranded wire)	2.5 mm ²

8.1.3.6 Point sensor arc protection module

Table. 8.1.3.6 - 265. Technical data for the point sensor arc protection module.

Spare part code	#SP-2XX-ARC
Compatibility	AQ 210 series models AQ 250 series models AQ-ONE
Connections	
Input arc point sensor channels	S1, S2, S3, S4 (pressure and light, or light only)
Sensors per channel	3
Maximum cable length	200 m
Performance	
Pick-up light intensity	8, 25 or 50 kLx (the sensor is selectable in the order code)
Point sensor detection radius	180 degrees
Start and instant operating time (light only)	Typically <5 ms with dedicated semiconductor outputs (HSO) Typically <10 ms regular output relays

Table. 8.1.3.6 - 266. High-Speed Outputs (HSO1...2)

Rated values	
Rated auxiliary voltage	250 VDC
Continuous carry	2 A
Make and carry 0.5 s Make and carry 3 s	10 A 6 A
Breaking capacity, DC (L/R = 40 ms)	1 A/110 W
Control rate	5 ms
Operation delay	<1 ms
Polarity	Normally Off
Contact material	Semiconductor



CAUTION!

Please note that signaling relay 5 and system fault's signaling relay are designed only for signaling purposes! They are not to be used in trip coil control.

Table. 8.1.3.6 - 267. Binary input channel

Rated values	
Voltage withstand	265 VDC
Nominal voltage Pick-up threshold Release threshold	24 VDC ≥16 VDC ≤15 VDC
Scanning rate	5 ms
Polarity	Normally Off
Current drain	3 mA

Table. 8.1.3.6 - 268. Terminal block connections

Arc point sensor terminal block connections	
Maximum cross section (Solid or stranded wire)	1.5 mm ²
Binary input and HSO terminal block connections	
Maximum cross section (solid or stranded wire)	2.5 mm ²



NOTICE!

The polarity must be correct!

8.1.3.7 RTD input module

Table. 8.1.3.7 - 269. Technical data for the RTD input module.

Spare part code	#SP-2xx-RTD
Compatibility	AQ 210 series models AQ 250 series models AQ-ONE
Channels 1-8	
2/3/4-wire RTD	
Pt100 or Pt1000	
Terminal block connection	
Maximum cross section (solid or stranded wire)	1.5 mm ²

8.1.3.8 Double RJ-45 Ethernet & IRIG-B communication module

Table. 8.1.3.8 - 270. Technical data for the double RJ-45 Ethernet communication module.

Spare part code	#SP-2XX-ETH-RJ45
Compatibility	AQ 210 series models AQ 250 series models AQ-ONE
Ethernet connector features	
Protocols	IEC 61850 IEC 104 Modbus/TCP DNP3 FTP
Data transfer rate	100 MB/s
System integration	Can be used for system protocols and for local programming
Number of ports	2
Communication ports	Copper Ethernet RJ-45
IRIG-B Connector	
Maximum cross section (solid or stranded wire)	1.5 mm ²

8.1.3.9 Double SFP Ethernet & IRIG-B communication module

Table. 8.1.3.9 - 271. Technical data for the double SFP Ethernet communication module.

Spare part code	#SP-250-ETH-SFP
Compatibility	AQ 250 series models AQ-ONE
Ethernet connector features	
Protocols	IEC 61850 IEC 104 Modbus/TCP DNP3 FTP
Data transfer rate	100 MB/s
System integration	Can be used for system protocols and for local programming
Number of ports	2
Communication ports	SFP
IRIG-B Connector	

Maximum cross section (solid or stranded wire)	1.5 mm ²
--	---------------------

8.1.3.10 Double ST Ethernet & IRIG-B communication module

Table. 8.1.3.10 - 272. Technical data for the double ST 100 Mbps Ethernet communication module.

Spare part code	#SP-2XX-2XST
Compatibility	AQ 210 series models AQ 250 series models AQ-ONE
Protocols	
Protocols	IEC61850 DNP/TCP Modbus/TCP IEC104 FTP
ST connectors	
Connector type	Duplex ST connectors 62.5/125 µm or 50/125 µm multimode fiber 100BASE-FX
Number of connectors	2
Transmitter wavelength	1260...1360 nm (nominal: 1310 nm)
Receiver wavelength	1100...1600 nm
Maximum distance	2 km
Data transfer rate	100 MB/s
IRIG-B Connector	
Maximum cross section (solid or stranded wire)	1.5 mm ²

8.1.3.11 Double LC (HSR/PRP) Ethernet communication module

Table. 8.1.3.11 - 273. Technical data for the double LC 100 Mbps Ethernet communication module.

Spare part code	#SP-2XX-2LC(HSR/PRP)
Compatibility	AQ 210 series models AQ 250 series models AQ-ONE
Protocols	

Protocols	IEC 61850 IEC 104 Modbus/TCP DNP3 FTP
Redundancy	HSR and PRP
Data transfer rate	100 MB/s
System integration	Can be used for system protocols and for local programming
Ports	
Number of fiber ports	2
Communication port	LC fiber connector Wavelength 1300 nm
Fiber cable	50/125 µm or 62.5/125 µm multimode (glass)

8.1.3.12 Double RJ-45 (HSR/PRP) Ethernet communication module

Table. 8.1.3.12 - 274. Technical data for the double RJ-45 100 Mbps Ethernet communication module.

Spare part code	#SP-2XX-2RJ45(HSR/PRP)
Compatibility	AQ 210 series models AQ 250 series models AQ-ONE
Features	
Protocols	IEC 61850 IEC 104 Modbus/TCP DNP3 FTP
Redundancy	HSR and PRP
Data transfer rate	100 MB/s
System integration	Can be used for system protocols and for local programming
Ports	
Number of ports	2
Communication port	Copper Ethernet RJ-45

8.1.3.13 RS-232 & serial fiber communication module

Table. 8.1.3.13 - 275. Technical data for the RS-232 & serial fiber communication module.

PP Spare part code	#SP-2XX-232PP
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PG Spare part code	#SP-2XX-232PG
GP Spare part code	#SP-2XX-232GP
GG Spare part code	#SP-2XX-232GG
Compatibility	AQ 210 series models AQ 250 series models AQ-ONE
Serial fiber connections	
Connection types	<ul style="list-style-type: none"> • Plastic - Plastic • Plastic - Glass • Glass - Plastic • Glass - Glass
Wavelength (plastic)	660 nm
Wavelength (glass)	820 nm
Cable type	1 mm plastic fiber
RS-232 terminal block connections	
Maximum cross section (solid or stranded wire)	1.5 mm ²

8.1.4 Display

Table. 8.1.4 - 276. Technical data for the HMI TFT display.

General information	
Spare part code	#SP-200-DISP
Compatibility	AQ-250 series models
Dimensions and resolution	
Number of dots/resolution	800 x 480
Size	154.08 × 85.92 mm (6.06 × 3.38 in)
Display	
Type of display	TFT
Color	RGB color

8.2 Functions

8.2.1 Protection functions

8.2.1.1 Non-directional overcurrent protection ($I>$; 50/51)

Table. 8.2.1.1 - 277. Technical data for the non-directional overcurrent function.

Measurement inputs	
Current inputs	Phase current inputs: I_{L1} (A), I_{L2} (B), I_{L3} (C)
Current input magnitudes	RMS phase currents TRMS phase currents Peak-to-peak phase currents
Pick-up	
Pick-up current setting	$0.10 \dots 50.00 \times I_n$, setting step $0.01 \times I_n$
Inrush 2nd harmonic blocking	$0.10 \dots 50.00 \% I_{fund}$, setting step $0.01 \% I_{fund}$
Inaccuracy: - Current - 2 nd harmonic blocking	$\pm 0.5 \% I_{set}$ or $\pm 15 \text{ mA}$ ($0.10 \dots 4.0 \times I_{set}$) $\pm 1.0 \%$ -unit of the 2 nd harmonic setting
Operation time	
Definite time function operating time setting	$0.000 \dots 1800.000 \text{ s}$, setting step 0.005 s
Inaccuracy: - Definite time: I_m/I_{set} ratio > 3 - Definite time: I_m/I_{set} ratio = $1.05 \dots 3$	$\pm 1.0 \%$ or $\pm 20 \text{ ms}$ $\pm 1.0 \%$ or $\pm 30 \text{ ms}$
IDMT setting parameters: - k Time dial setting for IDMT - A IDMT constant - B IDMT constant - C IDMT constant	$0.01 \dots 25.00$, step 0.01 $0 \dots 250.0000$, step 0.0001 $0 \dots 250.0000$, step 0.0001 $0 \dots 250.0000$, step 0.0001
Inaccuracy: - IDMT operating time - IDMT minimum operating time	$\pm 1.5 \%$ or $\pm 20 \text{ ms}$ $\pm 20 \text{ ms}$
Retardation time (overshoot)	$< 30 \text{ ms}$
Instant operation time	
Start time and instant operation time (trip): - I_m/I_{set} ratio = 2 - I_m/I_{set} ratio = 5 - I_m/I_{set} ratio = 10	Typically 25 ms Typically 16 ms Typically 12 ms
Reset	
Reset ratio	97 % of the pick-up current setting
Reset time setting Inaccuracy: Reset time	$0.000 \dots 150.000 \text{ s}$, step 0.005 s $\pm 1.0 \%$ or $\pm 50 \text{ ms}$

Instant reset time and start-up reset	<50 ms
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NOTICE!

The release delay does not apply to phase-specific tripping!

8.2.1.2 Non-directional earth fault protection ($I_{0>}$; 50N/51N)

Table. 8.2.1.2 - 278. Technical data for the non-directional earth fault function.

Measurement inputs	
Current input (selectable)	Residual current channel I ₀₁ (Coarse) Residual current channel I ₀₂ (Fine) Calculated residual current: I _{L1} (A), I _{L2} (B), I _{L3} (C)
Current input magnitudes	RMS residual current (I ₀₁ , I ₀₂ or calculated I ₀) TRMS residual current (I ₀₁ or I ₀₂) Peak-to-peak residual current (I ₀₁ or I ₀₂)
Pick-up	
Used magnitude	Measured residual current I ₀₁ (1 A) Measured residual current I ₀₂ (0.2 A) Calculated residual current I _{0Calc} (5 A)
Pick-up current setting	0.0001...40.00 × I _n , setting step 0.0001 × I _n
Inaccuracy: - Starting I ₀₁ (1 A) - Starting I ₀₂ (0.2 A) - Starting I _{0Calc} (5 A)	±0.5 %I _{0set} or ±3 mA (0.005...10.0 × I _{set}) ±1.5 %I _{0set} or ±1.0 mA (0.005...25.0 × I _{set}) ±1.0 %I _{0set} or ±15 mA (0.005...4.0 × I _{set})
Operating time	
Definite time function operating time setting	0.000...1800.000 s, setting step 0.005 s
Inaccuracy: - Definite time: I _m /I _{set} ratio > 3 - Definite time: I _m /I _{set} ratio = 1.05...3	±1.0 % or ±20 ms ±1.0 % or ±30 ms
IDMT setting parameters: - k Time dial setting for IDMT - A, B, C IDMT constants	0.01...25.00, step 0.01 0...250.0000, step 0.0001
Inaccuracy: - IDMT operating time - IDMT minimum operating time	±1.5 % or ±20 ms ±20 ms
Retardation time (overshoot)	<30 ms
Instant operation time	
Start time and instant operation time (trip): - I _m /I _{set} ratio > 3.5 - I _m /I _{set} ratio = 1.05...3.5	<50 ms (typically 35 ms) <55 ms
Reset	

Reset ratio	97 % of the pick-up current setting
Reset time setting Inaccuracy: Reset time	0.000...150.000 s, step 0.005 s ±1.0 % or ±50 ms
Instant reset time and start-up reset	<50 ms

**NOTICE!**

The operation and reset time accuracy does **not** apply when the measured secondary current in I02 is 1...20 mA. The pick-up is tuned to be more sensitive, and the operation times vary because of this.

8.2.1.3 Negative sequence overcurrent/ phase current reversal/ current unbalance protection (I2>; 46/46R/46L)

Table. 8.2.1.3 - 279. Technical data for the current unbalance function.

Measurement inputs	
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C)
Current input calculations	Positive sequence current (I ₁) Negative sequence current (I ₂)
Pick-up	
Used magnitude	Negative sequence component I _{2pu} Relative unbalance I ₂ /I ₁
Pick-up setting	0.01...40.00 × I _n , setting step 0.01 × I _n (I _{2pu}) 1.00...200.00 %, setting step 0.01 % (I ₂ /I ₁)
Minimum phase current (at least one phase above)	0.01...2.00 × I _n , setting step 0.01 × I _n
Inaccuracy: - Starting I _{2pu} - Starting I ₂ /I ₁	±1.0 %-unit or ±100 mA (0.10...4.0 × I _n) ±1.0 %-unit or ±100 mA (0.10...4.0 × I _n)
Operating time	
Definite time function operating time setting	0.000...1800.000 s, setting step 0.005 s
Inaccuracy: - Definite time (I _m /I _{set} ratio > 1.05)	±1.5 % or ±60 ms
IDMT setting parameters: - k Time dial setting for IDMT - A IDMT Constant - B IDMT Constant - C IDMT Constant	0.01...25.00, step 0.01 0...250.0000, step 0.0001 0...250.0000, step 0.0001 0...250.0000, step 0.0001
Inaccuracy: - IDMT operating time - IDMT minimum operating time	±2.0 % or ±30 ms ±20 ms
Retardation time (overshoot)	<5 ms
Instant operation time	

Start time and instant operation time (trip): - I_m/I_{set} ratio > 1.05	<70 ms
Reset	
Reset ratio	97 % of the pick-up setting
Reset time setting Inaccuracy: Reset time	0.000...150.000 s, step 0.005 s ± 1.5 % or ± 60 ms
Instant reset time and start-up reset	<55 ms

8.2.1.4 Harmonic overcurrent protection (I_h >; 50H/51H/68H)

Table. 8.2.1.4 - 280. Technical data for the harmonic overcurrent function.

Measurement inputs	
Current inputs	Phase current inputs: I_{L1} (A), I_{L2} (B), I_{L3} (C) Residual current channel I_{01} (Coarse) Residual current channel I_{02} (Fine)
Pick-up	
Harmonic selection	2 nd , 3 rd , 4 th , 5 th , 6 th , 7 th , 9 th , 11 th , 13 th , 15 th , 17 th or 19 th
Used magnitude	Harmonic per unit ($\times I_N$) Harmonic relative (I_h/I_L)
Pick-up setting	0.05...2.00 $\times I_N$, setting step 0.01 $\times I_N$ ($\times I_N$) 5.00...200.00 %, setting step 0.01 % (I_h/I_L)
Inaccuracy: - Starting $\times I_N$ - Starting $\times I_h/I_L$	<0.03 $\times I_N$ (2 nd , 3 rd , 5 th) <0.03 $\times I_N$ tolerance to I_h (2 nd , 3 rd , 5 th)
Operation time	
Definite time function operating time setting	0.000...1800.000 s, setting step 0.005 s
Inaccuracy: - Definite time (I_m/I_{SET} ratio >1.05)	± 1.0 % or ± 35 ms
IDMT setting parameters: k Time dial setting for IDMT A IDMT constant B IDMT constant C IDMT constant	0.01...25.00, step 0.01 0...250.0000, step 0.0001 0...250.0000, step 0.0001 0...250.0000, step 0.0001
Inaccuracy: - IDMT operating time - IDMT minimum operating time	± 1.5 % or ± 20 ms ± 20 ms
Instant operation time	
Start time and instant operation time (trip): I_m/I_{SET} ratio >1.05	<50 ms
Reset	

Reset ratio	95 % of the pick-up setting
Reset time setting Inaccuracy: Reset time	0.000...150.000 s, step 0.005 s $\pm 1.0\%$ or ± 35 ms
Instant reset time and start-up reset	<50 ms

NOTICE!

Harmonics generally: The amplitude of the harmonic content **must** be least $0.02 \times I_N$ when the relative mode (Ih/IL) is used!



Blocking: To achieve fast activation for blocking purposes with the harmonic overcurrent stage, note that the harmonic stage may be activated by a rapid load change or fault situation. An intentional activation lasts for approximately 20 ms if a harmonic component is not present. The harmonic stage stays active if the harmonic content is above the pick-up limit.

Tripping: When using the harmonic overcurrent stage for tripping, please ensure that the operation time is set to 20 ms (DT) or longer to avoid nuisance tripping caused by the above-mentioned reasons.

8.2.1.5 Circuit breaker failure protection (CBFP; 50BF/52BF)

Table. 8.2.1.5 - 281. Technical data for the circuit breaker failure protection function.

Measurement inputs	
Current inputs	Phase current inputs: I_{L1} (A), I_{L2} (B), I_{L3} (C) Residual current channel I_{01} (Coarse) Residual current channel I_{02} (Fine)
Current input magnitudes	RMS phase currents RMS residual current (I_{01} , I_{02} or calculated I_0)
Pick-up	
Monitored signals	Digital input status, digital output status, logical signals
Pick-up current setting: - I_{L1} ... I_{L3} - I_{01} , I_{02} , I_{0Calc}	$0.10 \dots 40.00 \times I_N$, setting step $0.01 \times I_N$ $0.005 \dots 40.00 \times I_N$, setting step $0.005 \times I_N$
Inaccuracy: - Starting phase current (5A) - Starting I_{01} (1 A) - Starting I_{02} (0.2 A) - Starting I_{0Calc} (5 A)	$\pm 0.5\% I_{SET}$ or ± 15 mA ($0.10 \dots 4.0 \times I_{SET}$) $\pm 0.5\% I_{0SET}$ or ± 3 mA ($0.005 \dots 10.0 \times I_{SET}$) $\pm 1.5\% I_{0SET}$ or ± 1.0 mA ($0.005 \dots 25.0 \times I_{SET}$) $\pm 1.0\% I_{0SET}$ or ± 15 mA ($0.005 \dots 4.0 \times I_{SET}$)
Operation time	
Definite time function operating time setting	0.050...1800.000 s, setting step 0.005 s
Inaccuracy: - Current criteria (I_M/I_{SET} ratio 1.05→) - DO or DI only	$\pm 1.0\%$ or ± 55 ms ± 15 ms
Reset	
Reset ratio	97 % of the pick-up current setting

Reset time	<50 ms
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8.2.1.6 Transformer thermal overload protection (TT>; 49T)

Table. 8.2.1.6 - 282. Technical data for the transformer thermal overload protection function.

Measurement inputs	
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C)
Current input magnitudes	TRMS phase currents (up to the 31 st harmonic)
Setting specifications	
Time constants τ	1 heating, 1 cooling
Time constant value	0.0...500.00 min, step 0.1 min
Service factor (maximum overloading)	0.01...5.00 \times I _N , step 0.01 \times I _N
Thermal model biasing	- Ambient temperature (Set -60.0...500.0 deg, step 0.1 deg, and RTD) - Negative sequence current
Thermal replica temperature estimates	Selectable between °C and °F
Outputs	
- Alarm 1 - Alarm 2 - Thermal trip - Trip delay - Restart inhibit	0...150 %, step 1 % 0...150 %, step 1 % 0...150 %, step 1 % 0.000...3600.000 s, step 0.005 s 0...150 %, step 1 %
Inaccuracy	
- Starting - Operating time	\pm 0.5 % of the set pick-up value \pm 5 % or \pm 500 ms

8.2.1.7 Transformer status monitoring

Table. 8.2.1.7 - 283. Technical data for the transformer status monitoring function.

Features	
Control scale	Common transformer data settings for all functions in the transformer module, the protection logic, the HMI and the I/O.
Settings	Transformer application nominal data
Other features	Status hours counters (normal load, overload, high overload) Transformer status signals Transformer data for functions
Outputs	
Light/no load	I _M < 0.2 \times I _N

Inrush HV side detected	$I_M < 0.2 \times I_N \rightarrow I_M > 1.3 \times I_N$
Inrush LV side detected	$I_M < 0.2 \times I_N \rightarrow I_M > 1.3 \times I_N$
Load normal	$I_M > 0.2 \times I_N \dots I_M < 1.0 \times I_N$
Overloading	$I_M > 1.0 \times I_N \dots I_M < 1.3 \times I_N$
High overload	$I_M > 1.3 \times I_N$
Inaccuracy	
Current detection	$\pm 3\%$ of the set pick-up value $> 0.5 \times I_N$ setting. $5 \text{ mA} < 0.5 \times I_N$ setting
Detection time	$\pm 0.5\%$ or $\pm 10 \text{ ms}$

8.2.1.8 Resistance temperature detectors (RTD)

Table. 8.2.1.8 - 284. Technical data of the resistance temperature detectors.

Inputs	
Resistance input magnitudes	Measured temperatures measured by RTD sensors
RTD channels	12 individual RTD channels
Settable alarms	24 alarms available (two per each RTD channel)
Pick-up	
Alarm setting range Inaccuracy Reset ratio	101.00...2000.00 deg, setting step 0.1 deg (either $<$ or $>$ setting) $\pm 3\%$ of the set pick-up value 97 % of the pick-up setting
Operation	
Operating time	Typically $< 500 \text{ ms}$

8.2.1.9 Generator/motor/transformer differential protection (I_{db} / I_{di} / I_{0dHV} / I_{0dLV} ; 87T/87G/87M/87N)

Table. 8.2.1.9 - 285. Technical data for the transformer differential protection function.

Measurement inputs	
Current inputs (CT1 and CT2 current measurement module)	Phase current inputs: I_{L1} (A), I_{L2} (B), I_{L3} (C) Residual current channel I_{01} (Coarse) Residual current channel I_{02} (Fine) Calculated residual current: I_{L1} (A), I_{L2} (B), I_{L3} (C)
Current input magnitudes	The phase currents of the high-voltage and the low-voltage sides. Residual current measurement for HV/LV REF protection. Phase currents 2 nd and 5 th harmonic measurement.

Characteristics (differential and REF)	
Differential calculation mode Bias calculation mode	Add or subtract (CT direction) Average or maximum (sensitivity)
ldb> pick-up Turnpoint 1 Slope 1 Turnpoint 2 Slope 2	0.01...100.00 %, step 0.01 %, default 10.00 % 0.01...50.00 × I _N , step 0.01 × I _N , default 1.00 × I _N 0.01...250.00 %, step 0.01 %, default 10.00 % 0.01...50.00 × I _N , step 0.01 × I _N , default 3.00 × I _N 0.01...250.00 % by step 0.01 %, default 200.00 %
ldi> pick-up	200.00...1500.00 %, step 0.01 %, default 600.00 %
Internal harmonic blocking selection	None, 2 nd harmonic, 5 th harmonic, both 2 nd and 5 th harmonic.
2 nd harmonic blocking pick-up	0.01...50.00 %, step 0.01 %, default 15.00 %
5 th harmonic blocking pick-up	0.01...50.00 %, step 0.01 %, default 35.00 %
Inaccuracy: - Differential current - 2 nd harmonic	±3.0 %I _{SET} or ±75 mA (0.10...4.0 × I _{SET}) ±1.5 %I _{SIDE1}
Instant operation time	
Instant operation time >1.05 × I _{SET}	<40 ms (Harmonic blocking active)
Instant operation time >3.00 × I _{SET}	<30 ms (Harmonic blocking active)
Instant operation time >3.00 × I _{SET}	~15 ms (No harmonic blocking)
Reset	
Reset ratio: differential current	97 % of the differential current setting (typically)
Reset time	<50 ms



NOTICE!

The harmonic current is set and calculated according to the highest amplitude of side 1, 2 or 3 currents (I_h%/I_{SIDE1/2/3}). The harmonic current is calculated individually for each phase.

8.2.1.10 Arc fault protection (I_{Arc}>/I_{0Arc}>; 50Arc/50NArc) (optional)

Table. 8.2.1.10 - 286. Technical data for the arc fault protection function.

Measurement inputs	
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C) Residual current channel I ₀₁ (Coarse) Residual current channel I ₀₂ (Fine)
Current input magnitudes	Sample-based phase current measurement Sample-based residual current measurement

Arc point sensor inputs	Channels S1, S2, S3, S4 (pressure and light sensor, or light-only sensor) Up to three (3) sensors per channel
System frequency operating range	6.00...75.00 Hz
Pick-up	
Pick-up current setting (phase current) Pick-up current setting (residual current) Pick-up light intensity	0.05...40.00 × I _N , setting step 0.01 × I _N 0.05...40.00 × I _N , setting step 0.01 × I _N 8, 25 or 50 kLx (the sensor is selected in the order code)
Starting inaccuracy (I _{Arc>} and I _{0Arc>})	±3 % of the set pick-up value > 0.5 × I _N setting. 5 mA < 0.5 × I _N setting.
Point sensor detection radius	180 degrees
Operation time	
Light only: - Semiconductor outputs HSO1 and HSO2 - Regular relay outputs	Typically 7 ms (3...12 ms) Typically 10 ms (6.5...15 ms)
Light + current criteria (zone 1...4): - Semiconductor outputs HSO1 and HSO2 - Regular relay outputs	Typically 10 ms (6.5...14 ms) Typically 14 ms (10...18 ms)
Arc BI only: - Semiconductor outputs HSO1 and HSO2 - Regular relay outputs	Typically 7 ms (2...12 ms) Typically 10 ms (6.5...15 ms)

8.2.2 Control functions

8.2.2.1 Setting group selection

Table. 8.2.2.1 - 287. Technical data for the setting group selection function.

Settings and control modes	
Setting groups	8 independent, control-prioritized setting groups
Control scale	Common for all installed functions which support setting groups
Control mode	
Local	Any binary signal available in the device
Remote	Force change overrule of local controls either from the setting tool, HMI or SCADA
Operation time	
Reaction time	<5 ms from receiving the control signal

8.2.2.2 Object control and monitoring

Table. 8.2.2.2 - 288. Technical data for the object control and monitoring function.

General	
Number of objects	10
Supported object types	Circuit breaker Circuit breaker with withdrawable cart Disconnecter (MC) Disconnecter (GND) Custom object image
Signals	
Input signals	Digital inputs Software signals
Output signals	Close command output Open command output
Operation time	
Breaker traverse time setting	0.02...500.00 s, setting step 0.02 s
Max. close/open command pulse length	0.02...500.00 s, setting step 0.02 s
Control termination time out setting	0.02...500.00 s, setting step 0.02 s
Inaccuracy: - Definite time operating time	±0.5 % or ±10 ms
Breaker control operation time	
External object control time	<75 ms
Object control during auto-reclosing	See the technical sheet for the auto-reclosing function.

Table. 8.2.2.2 - 289. Technical data for the circuit breaker wear monitoring function.

Pick-up	
Breaker characteristics settings: - Nominal breaking current - Maximum breaking current - Operations with nominal current - Operations with maximum breaking current	0.00...100.00 kA, setting step 0.001 kA 0.00...100.00 kA, setting step 0.001 kA 0...200 000 operations, setting step 1 operation 0...200 000 operations, setting step 1 operation
Pick-up setting for Alarm 1 and Alarm 2	0...200 000 operations, setting step 1 operation
Inaccuracy	
Inaccuracy for current/operations counter: - Current measurement element - Operation counter	$0.1 \times I_N > I < 2 \times I_N$ ±0.2 % of the measured current, rest 0.5 % ±0.5 % of operations deducted

8.2.2.3 Indicator object monitoring

Table. 8.2.2.3 - 290. Technical data for the indicator object monitoring function.

General	
Number of objects	10
Supported object types	Disconnecter (GND) Custom object image
Signals	
Input signals	Digital inputs Software signals

8.2.2.4 Cold load pick-up (CLPU)

Table. 8.2.2.4 - 291. Technical data for the cold load pick-up function.

Measurement inputs	
Current inputs	Phase current inputs: I_{L1} (A), I_{L2} (B), I_{L3} (C)
Current input magnitudes	RMS phase currents
Pick-up	
Pick-up current setting - LOW/HIGH/OVER	$0.01 \dots 40.00 \times I_N$, setting step $0.01 \times I_N$
Reset ratio	97 % of the pick-up current setting
Inaccuracy: - Current	$\pm 0.5 \% I_{SET}$ or $\pm 15 \text{ mA}$ ($0.10 \dots 4.0 \times I_{SET}$)
Operation time	
Definite time function operating time settings: - t_{SET} - t_{MAX} - t_{MIN}	$0.000 \dots 1800.000 \text{ s}$, setting step 0.005 s $0.000 \dots 1800.000 \text{ s}$, setting step 0.005 s $0.000 \dots 1800.000 \text{ s}$, setting step 0.005 s
Inaccuracy: - Definite time (I_M/I_{SET} ratio = 1.05/0.95)	$\pm 1.0 \%$ or $\pm 45 \text{ ms}$
Instant operation time	
CLPU activation and release	<45 ms (measured from the trip contact)



NOTICE!

A single-phase current (I_{L1} , I_{L2} or I_{L3}) is enough to prolong or release the blocking during an overcurrent condition.

8.2.2.5 Switch-on-to-fault (SOTF)

Table. 8.2.2.5 - 292. Technical data for the switch-on-to-fault function.

Initialization signals	
SOTF activate input	Any blocking input signal (Object closed signal, etc.)
Pick-up	
SOTF function input	Any blocking input signal (I> or similar)
SOTF activation time	
Activation time	<40 ms (measured from the trip contact)
SOTF release time	
Release time setting	0.000...1800.000 s, setting step 0.005 s
Inaccuracy: - Definite time	±1.0 % or ±30 ms
SOTF instant release time	<40 ms (measured from the trip contact)

8.2.3 Monitoring functions

8.2.3.1 Current transformer supervision

Table. 8.2.3.1 - 293. Technical data for the current transformer supervision function.

Measurement inputs	
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C) Residual current channel I ₀₁ (Coarse) (optional) Residual current channel I ₀₂ (Fine) (optional)
Current input magnitudes	RMS phase currents RMS residual current (I ₀₁ , I ₀₂) (optional)
Pick-up	
Pick-up current settings: - I _{SET} high limit - I _{SET} low limit - I _{SUM} difference - I _{SET} ratio - I ₂ /I ₁ ratio	0.10...40.00 × I _N , setting step 0.01 × I _N 0.10...40.00 × I _N , setting step 0.01 × I _N 0.10...40.00 × I _N , setting step 0.01 × I _N 0.01...100.00 %, setting step 0.01 % 0.01...100.00 %, setting step 0.01 %
Inaccuracy: - Starting I _{L1} , I _{L2} , I _{L3} - Starting I ₂ /I ₁ - Starting I ₀₁ (1 A) - Starting I ₀₂ (0.2 A)	±0.5 % I _{SET} or ±15 mA (0.10...4.0 × I _{SET}) ±1.0 % I _{2SET} / I _{1SET} or ±100 mA (0.10...4.0 × I _N) ±0.5 % I _{0SET} or ±3 mA (0.005...10.0 × I _{SET}) ±1.5 % I _{0SET} or ±1.0 mA (0.005...25.0 × I _{SET})
Time delay for alarm	
Definite time function operating time setting	0.000...1800.000 s, setting step 0.005 s

Inaccuracy_ - Definite time (I_M/I_{SET} ratio > 1.05)	$\pm 2.0\%$ or ± 80 ms
Instant operation time (alarm): - I_M/I_{SET} ratio > 1.05	<80 ms
Reset	
Reset ratio	97/103 % of the pick-up current setting
Instant reset time and start-up reset	<80 ms

8.2.3.2 Circuit breaker wear monitoring

Table. 8.2.3.2 - 294. Technical data for the circuit breaker wear monitoring function.

Pick-up	
Breaker characteristics settings: - Nominal breaking current - Maximum breaking current - Operations with nominal current - Operations with maximum breaking current	0.00...100.00 kA, setting step 0.001 kA 0.00...100.00 kA, setting step 0.001 kA 0...200 000 operations, setting step 1 operation 0...200 000 operations, setting step 1 operation
Pick-up setting for Alarm 1 and Alarm 2	0...200 000 operations, setting step 1 operation
Inaccuracy	
Inaccuracy for current/operations counter: - Current measurement element - Operation counter	$0.1 \times I_N > I < 2 \times I_N \pm 0.2\%$ of the measured current, rest 0.5 % $\pm 0.5\%$ of operations deducted

8.2.3.3 Current total harmonic distortion

Table. 8.2.3.3 - 295. Technical data for the total harmonic distortion function.

Input signals	
Current inputs	Phase current inputs: I_{L1} (A), I_{L2} (B), I_{L3} (C) Residual current channel I_{01} (Coarse) Residual current channel I_{02} (Fine)
Current input magnitudes	Current measurement channels (FFT result) up to the 31 st harmonic component.
Pick-up	
Operating modes	Power THD Amplitude THD
Pick-up setting for all comparators	0.10...200.00 % , setting step 0.01 %
Inaccuracy	$\pm 3\%$ of the set pick-up value $> 0.5 \times I_N$ setting; $5 \text{ mA} < 0.5 \times I_N$ setting.
Time delay	

Definite time function operating time setting for all timers	0.000...1800.000 s, setting step 0.005 s
Inaccuracy: - Definite time operating time - Instant operating time, when I_M/I_{SET} ratio > 3 - Instant operating time, when I_M/I_{SET} ratio $1.05 < I_M/I_{SET} < 3$	$\pm 0.5\%$ or ± 10 ms Typically <20ms Typically <25 ms
Reset	
Reset time	Typically <10 ms
Reset ratio	97 %

8.2.3.4 Event logger

Table. 8.2.3.4 - 296. Technical data for the event logger function.

General information	
Event history capacity	15 000 events
Event timestamp resolution	1 ms

8.2.3.5 Disturbance recorder

Table. 8.2.3.5 - 297. Technical data for the disturbance recorder function.

Recorded values	
Recorder analog channels	0...20 channels Freely selectable
Recorder digital channels	0...96 channels Freely selectable analog and binary signals 1 ms or 5 ms sample rate (FFT)
Performance	
Sample rate	8, 16, 32 or 64 samples/cycle
Recording length	0.000...1800.000 s, setting step 0.001 s The maximum length is determined by the chosen signals.
Number of recordings	0...100, 60 MB of shared flash memory reserved The maximum number of recordings according to the chosen signals and operation time setting combined

8.3 Tests and environmental

Electrical environment compatibility

Table. 8.3 - 298. Disturbance tests.

All tests	CE-approved and tested according to EN 60255-26
Emissions	
Conducted emissions: EN 60255-26 Ch. 5.2, CISPR 22	150 kHz...30 MHz
Radiated emissions: EN 60255-26 Ch. 5.1, CISPR 11	30...1 000 MHz
Immunity	
Electrostatic discharge (ESD): EN 60255-26, IEC 61000-4-2	Air discharge 15 kV Contact discharge 8 kV
Electrical fast transients (EFT): EN 60255-26, IEC 61000-4-4	Power supply input 4 kV, 5/50 ns, 5 kHz Other inputs and outputs 4 kV, 5/50 ns, 5 kHz NOTE: Shielded cable required for ethernet communication
Surge: EN 60255-26, IEC 61000-4-5	Between wires: 2 kV, 1.2/50 μ s Between wire and earth: 4 kV, 1.2/50 μ s
Radiated RF electromagnetic field: EN 60255-26, IEC 61000-4-3	f = 80...1 000 MHz, 10 V/m
Conducted RF field: EN 60255-26, IEC 61000-4-6	f = 150 kHz...80 MHz, 10 V (RMS)

Table. 8.3 - 299. Voltage tests.

Dielectric voltage test	
EN 60255-27, IEC 60255-5, EN 60255-1	2 kV, 50 Hz, 1 min
Impulse voltage test	
EN 60255-27, IEC 60255-5	5 kV, 1.2/50 μ s, 0.5 J

Physical environment compatibility

Table. 8.3 - 300. Mechanical tests.

Vibration test	
EN 60255-1, EN 60255-27, IEC 60255-21-1	2...13.2 Hz, \pm 3.5 mm 13.2...100 Hz, \pm 1.0 g
Shock and bump test	
EN 60255-1, EN 60255-27, IEC 60255-21-2	20 g, 1 000 bumps/dir.

Table. 8.3 - 301. Environmental tests.

Damp heat (cyclic)	
EN 60255-1, IEC 60068-2-30	Operational: +25...+55 °C, 93...97 % (RH), 12+12h
Dry heat	
EN 60255-1, IEC 60068-2-2	Storage: +70 °C, 16 h Operational: +55 °C, 16 h
Cold test	
EN 60255-1, IEC 60068-2-1	Storage: -40 °C, 16 h Operational: -20 °C, 16 h

Table. 8.3 - 302. Environmental conditions.

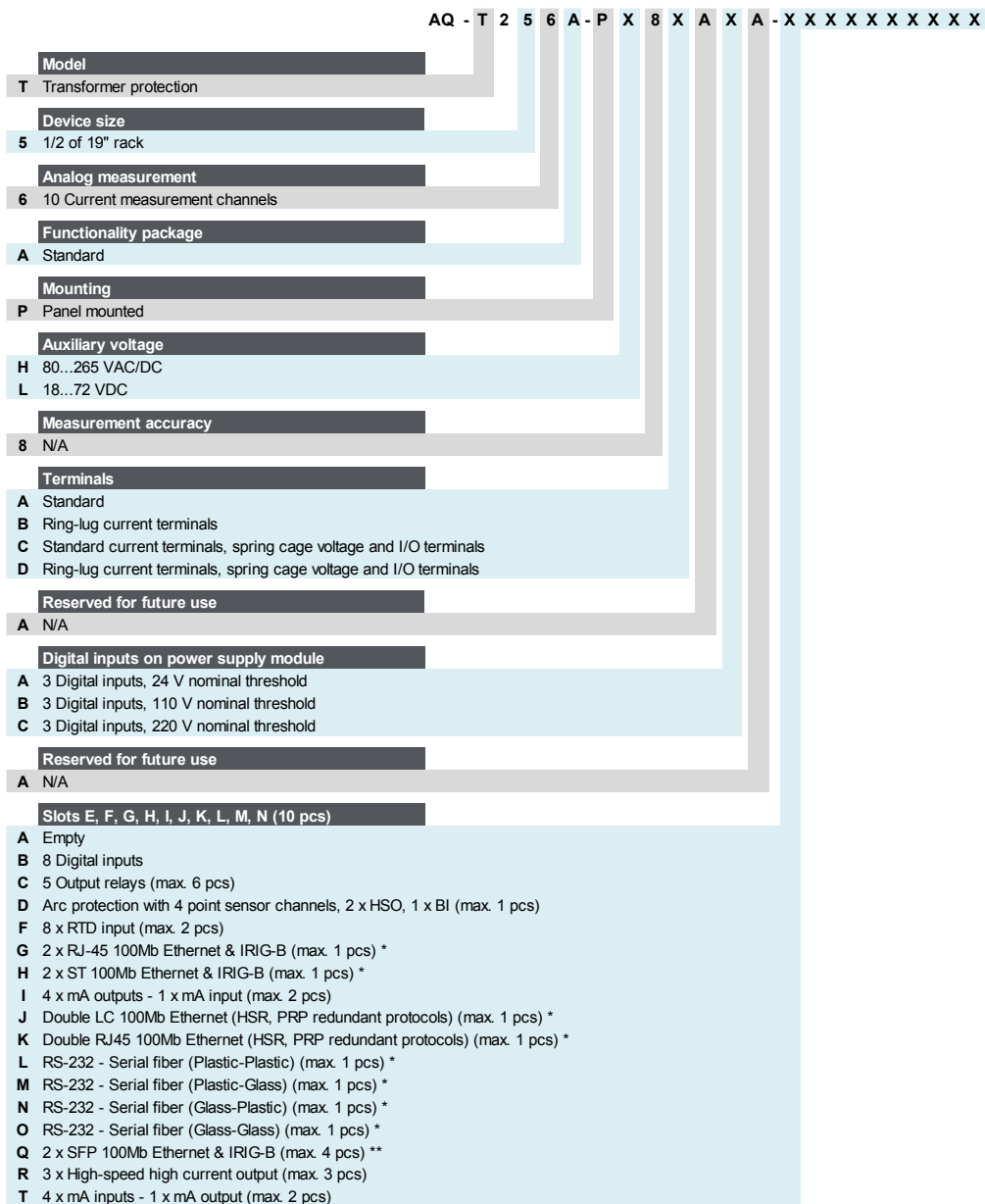
IP classes	
Casing protection class	IP54 (front) IP21 (rear)
Temperature ranges	
Ambient service temperature range	-35...+70 °C
Transport and storage temperature range	-40...+70 °C
Other	
Altitude	<2000 m
Overvoltage category	III
Pollution degree	2

Casing and package

Table. 8.3 - 303. Dimensions and weight.

Without packaging (net)	
Dimensions	Height: 208 mm Width: 257 mm (½ rack) Depth: 165 mm (no cards or connectors)
Weight	Appr. 3.4 kg
With packaging (gross)	
Dimensions	Height: 250 mm Width: 343 mm Depth: 256 mm
Weight	Appr. 4 kg

9 Ordering information



* Can only be applied to the two last slots.
** Can only be applied to the four last slots. Requires an SFP adapter. See "Accessories" list.

Accessories

Order code	Description	Note
AX007	External 6-channel 2 or 3 wires RTD Input module, pre-configured	Requires an external 24 VDC supply.
AX008	External 8-ch Thermocouple mA Input module, pre-configured	Requires an external 24 VDC supply.
AX020	SFP module LC 2 km multi-mode	2 km multi-mode fiber (1310 nm)

AX021	SFP module LC 40 km single-mode	40 km single-mode fiber (1310 nm)
AX022	SFP module LC 120 km single-mode	120 km single-mode fiber (1550 nm)
AX013	AQ 250 series raising frame 120mm	-
AQX014	AQ 250 series raising frame 40mm	-
AQX015	AQ 250 series wall mounting bracket	-
AQ-01A	Light point sensor unit (8,000 lux threshold)	Max. cable length 200 m
AQ-01B	Light point sensor unit (25,000 lux threshold)	Max. cable length 200 m
AQ-01C	Light point sensor unit (50,000 lux threshold)	Max. cable length 200 m
AQ-02A	Pressure and light point sensor unit (8,000 lux threshold)	Max. cable length 200 m
AQ-02B	Pressure and light point sensor unit (25,000 lux threshold)	Max. cable length 200 m
AQ-02C	Pressure and light point sensor unit (50,000 lux threshold)	Max. cable length 200 m

10 Contact and reference information

Manufacturer

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Visiting and postal address

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